

Máster Universitario en Ingeniería Industrial

Trabajo Fin de Máster

**Sistema de monitorización de variables físicas para el uso
de actividad deportiva**

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Resumen

Durante el presente proyecto se acomete el procedimiento de creación de un sistema de detección de movimientos de cara a la actividad deportiva, para la monitorización de ejercicios en el entorno del *fitness*. En él, se recorren los diferentes aspectos teóricos que conforman las metodologías de comunicación utilizadas, junto con la descripción del *hardware* implementado y el desarrollo del código que permiten alcanzar el propósito final.

El sistema está compuesto por dos *Printed Circuit Boards* (en adelante, PCBs), con el mismo diseño, y con las únicas diferencias de la existencia de un sensor de frecuencia cardíaca y una pantalla para uno de los nodos. Los componentes principales en los que se basa el algoritmo son un giroscopio más acelerómetro del fabricante Invensense (MPU-6050), que se encargará de la detección de la aceleración y la orientación de cada subsistema y un módulo *WiFi+Bluetooth* de la compañía Espressif (ESP-32-WROOM32D), que realizará las tareas de comunicación entre ambas PCBs mediante protocolo *Bluetooth Low Energy*, así como la conexión que se establece con la aplicación nativa del sistema y el envío mediante protocolo *WiFi* del correo electrónico correspondiente al final de cada sesión con los datos recogidos. El epicentro del sistema, conformado por estos dos circuitos integrados, se sustenta en otros componentes como un gestor de baterías, conversores de voltaje y elementos pasivos. El algoritmo utilizado se crea en lenguaje de programación C++ con la IDE de Arduino, por lo que se utilizan diferentes bibliotecas propias del programa, teniendo una estructura similar para ambos subsistemas, pero con varias funciones adicionales para el nodo principal, que se sitúa en la muñeca. Los movimientos registrados corresponden a ejercicios del tronco superior del cuerpo, por lo que el segundo nodo se coloca en la parte alta del brazo. Esta detección se basa principalmente en el registro de un punto inicial, un punto final, y la aceleración en el recorrido del movimiento, si lo hubiera, además de otros condicionantes. Al mismo tiempo, ambos puntos de análisis consultan la posición de su homónimo para determinar el ejercicio que se está realizando, agrupando los datos obtenidos en series compuestas por las repeticiones hechas. Adicionalmente se incorporan algunos ejercicios del tronco inferior manteniendo el esquema establecido, junto a otros añadidos en fase temprana.

La aplicación diseñada para la gestión del sistema cuenta con diferentes funciones, tales como el inicio de una sesión de entrenamiento, el análisis de las sesiones anteriores mediante la creación de un servidor HTTP o el acceso a la base de datos mediante el portal ThingSpeak, además de una pestaña de configuración con diferentes parámetros. De esta manera, el usuario puede controlar el sistema de forma remota como si de un producto comercial se tratara.

Tras las pruebas realizadas para los diferentes grupos musculares que se programan, se consigue un acierto del 96,62 %, lo que establece un mecanismo innovador y eficaz respecto al análisis realizado para el mercado y los artículos de investigación referentes al tema que se propone.

Abstract

During the present project, the process involved in creating a movement detection system oriented to the monitoring of exercises in the fitness environment is developed. In it, the theoretical aspects of the communication methods implemented are detailed, with the description of the hardware and the explanation of the code that allows reaching the final purpose.

The system is composed of two Printed Circuit Boards (PCBs), with the same design and with the only differences of the existence of a heart-rate sensor and a display for one of the nodes. The main components on which the algorithm is based are: a gyroscope + accelerometer of the manufacturer InvenSense (MPU-6050), in charge of the detection of the acceleration and the orientation of each subsystem, and a WiFi+Bluetooth module created by the company Espressif (ESP-32-WROOM-32D), that will do the communication tasks between both PCBs through Bluetooth Low Energy protocol, in addition to the connection that is established with the native application of the system and the sending through WiFi protocol of a corresponding e-mail at the end of the session with the recollected data. The epicenter of the system, composed of these two integrated circuits, is supported by other components such as a battery manager, voltage converters, and passive elements. The used algorithm is created in C++ language with the Arduino IDE, so different own libraries of the program are implemented, having a similar structure for both subsystems but with some additional functions for the primary node that is situated on the wrist. The registered moves are oriented to exercise focused on the high part of the body, so the second node is located on the superior part of the arm. This detection is based on the register of an initial point of analysis, a final point, and acceleration. At the same time, both nodes check the position of the other one to determine the exercise that is happening, grouping the obtained data in series composed by the repetitions done. In addition, some exercises of the low part of the body are implemented, keeping the established scheme with some extra functions in the early stages.

The designed application for the management of the system has different functions: the start of a new workout, the review of previous sessions through creating an HTTP server, access to the database through the ThingSpeak portal, and a configuration tab with different parameters. In this way, the user can control the system remotely like a commercial product.

After the test is done for the different muscle groups that are programmed, the system reaches a success percentage of 96,62 %, so an innovative and effective mechanism is set with regard to the review done of the market and research papers of the topic that is proposed.

Introducción

1. Introducción

En la denominada “revolución tecnológica” que se vive actualmente, donde lo digital está ampliando sus fronteras y ocupando la vida de millones de personas, existe un tipo de tecnología que se expande exponencialmente desde el inicio de la década pasada: el Internet de las Cosas (*Internet of Things*, IoT). Varios ejemplos se pueden encontrar en lo cotidiano, como elementos de seguridad en el hogar, ya sean cámaras, sensores de movimiento o sensores de apertura de puertas, o componentes “vestibles” denominados *wearables*, como relojes, auriculares *true wireless* o pulseras de actividad.

La definición de esta tecnología podría ser la interconexión de elementos cotidianos que generan un servicio agregado, y prueba de su impacto en el mercado actual son los diferentes estudios [1] en los que se ve involucrada, donde se detalla un avance de dispositivos conectados en la década que comprende desde 2015, que registraba una cantidad de 15,41 billones de sistemas, hasta el 2025, con una estimación de 75,44 billones, por lo que la tasa se quintuplicará en tan sólo diez años.

Fruto de las motivaciones personales ligadas a la vida deportiva, se decidió realizar un estudio comparativo entre las diferentes propuestas que se presentan en dicho sector utilizando la tecnología previamente mencionada. Bien es conocida la gran variedad de pulseras de actividad y relojes con capacidades de medición de parámetros de la salud orientados al mundo del deporte. Estos dispositivos son capaces, a día de hoy, de estimar características biomédicas tales como la frecuencia cardíaca o el nivel de oxígeno en sangre, y otras relacionadas con la actividad física, como distancias recorridas en deportes aeróbicos o ritmo medio de desplazamiento. El sistema de detección de estos parámetros en el entorno deportivo es siempre el mismo: el usuario, mediante una interfaz destinada para ello, se comunica con el dispositivo correspondiente para informar del inicio de una nueva sesión de entrenamiento y, una vez finalizado, realiza el mismo procedimiento.

Este mecanismo es válido en la mayoría de deportes comúnmente conocidos, especialmente los aeróbicos, pero existe un tipo de ejercicio que mueve, únicamente en Europa, a más de 60 millones de personas al año: el *fitness* [2]. Para este deporte se puede tomar la variación de pulsaciones que se generan en un entrenamiento, y así poder realizar un análisis de la resistencia a lo largo del tiempo para un mismo tipo de sesión. Además, en determinadas rutinas se pueden aplicar ejercicios de carrera o bicicleta, donde se valora la distancia recorrida. Sin embargo, existen otros parámetros que adquieren una mayor relevancia a la hora de estudiar una sesión de *fitness*: el número de ejercicios que se realizan, cuántas series de cada ejercicio es capaz de aguantar la musculatura y el avance en los pesos que se utilizan. Si el mecanismo de detección de variables que se utiliza convencionalmente se aplica a estos parámetros, el resultado es tedioso y poco efectivo, ya que el usuario debería señalar al *smartwatch* o pulsera de actividad cada serie que va a realizar, con una estimación media de 20 series por sesión.

El objetivo del presente proyecto es resolver dicha problemática mediante un sistema que detecte el ejercicio que se va a realizar, calcule las repeticiones y las agrupe en series, sin que el usuario tenga que informar al dispositivo más que el inicio de un nuevo *workout* (entrenamiento). Además, se busca un sistema lo más simple posible para ajustarse a la comodidad del individuo, acompañándolo de un aplicación nativa que permita la navegación a través de una interfaz donde visualizar los resultados registrados, junto a otras funciones como la comparativa de los entrenamientos realizados para un mismo grupo muscular a través de una base de datos o la corrección de posturas en tiempo real.

Para alcanzar el propósito final de dicho sistema se ha diseñado un *hardware* específico y se ha realizado la programación en el lenguaje C++ adaptado al IDE de Arduino, permitiendo así la detección de ejercicios para la parte superior del cuerpo (espalda, pecho, hombros, bíceps y tríceps) y algunos para la parte inferior. Además, se proporcionan funcionalidades extras como el registro de datos, el envío mediante correo electrónico de los parámetros registrados y la corrección de posturas basada en lógica difusa.

El presente documento recoge todo lo relacionado con el desarrollo del proyecto. En primer lugar se realiza un estado del arte, que se localiza en el capítulo 2, donde se analiza el estado actual del mercado en el entorno de los *wearables* y su aplicación al mundo del *fitness*, para hacer hincapié también en los estudios y artículos de carácter académico aplicados en el sector, con el fin de verificar que el proyecto cuenta con una capacidad innovadora y resolutive ante un problema existente. En el tercer capítulo se detallan los componentes a nivel de *hardware* que se utilizan en el diseño final, profundizando en las características eléctricas y en detalles concretos de cada elemento. Se añaden determinados fundamentos teóricos en el capítulo 4, que permiten una mayor comprensión de la utilización de protocolos y mediciones, para avanzar durante el quinto capítulo en el desarrollo del algoritmo y el funcionamiento global del dispositivo y de la interfaz. Durante el capítulo seis se entra en detalle en aquellas funcionalidades extras que aporta el sistema más allá del propósito básico. En el séptimo capítulo se realiza una validación del mecanismo y se localizan los principales errores, buscando una solución que permita suavizarlos o erradicarlos en un futuro, seguido de las conclusiones del proyecto. Por último, se incorporan en los dos últimos capítulos la bibliografía utilizada, junto a los anexos, entre los que se encuentran las hojas de datos de los componentes utilizados, los esquemáticos y el *layout* del *hardware* implementado, los planos referentes al encapsulado de las PCBs y el código empleado.

1.1. Introduction

In the called technological revolution that is happening nowadays, where the digital sector is growing and being present in the life of millions of people, there is a type of technology that has been expanding exponentially from the beginning of the last decade: the Internet of Things (IoT). Some examples can be found in an average day, like security elements at home (cameras, motion sensors or door sensors), or wearables like smartwatches, true wireless headphones, or activity bracelets.

The definition of this technology could be the interconnection of daily elements that generate an aggregated service. A proof of its impact in the market can be the different studies [1] where it is involved, where an advance of connected devices between the year 2015 and 2025 is detailed, with an estimation of 75.44 billion devices at that year, five times higher than a decade before.

Product of personal ambitions oriented to sport, a comparative study between the different proposals presented in the sector using the mentioned technology was made: is well known the variety of activity bracelets and smartwatches with the capability of measure health parameters oriented to the sports world. These devices are capable of estimating biomedical characteristics such as the heart rate or the blood oxygen level and others related to physical activity like the traveled distance in aerobic sports or an average speed. The detection system of these parameters in the sports environment is always the same: the user, through a customized interface, communicates to the corresponding device to order the start of a new workout session, and when it is finished, the person does the same procedure.

This mechanism is valid for the majority of known sports, especially aerobics. Still, more than 60 million people practice a type of exercise per year only in Europe: fitness. For this sport, the heart rate generated during a session can be taken to analyze the pulmonary resistance over time for the same characteristics of the training. Moreover, in some routines, it can be applied running exercises or bicycle, where the traveled distance can be evaluated. However, two parameters have more relevance when a session of fitness is studied: the quantity of exercises that are done, how many series of each exercise is capable of resisting the muscle group, and the advance of the weights that are used. If the variables detection mechanism that is used conventionally is applied to these parameters, the result is tedious and presents low effectiveness because the user would have to indicate the smartwatch or activity bracelet the series that is going to do, with an estimate of twenty series per session.

The present project aims to resolve that problem through a system capable of detecting the exercise that is going to do, calculating the repetitions, and grouping them in series, without the user's interaction beyond indicating the start of a session. In addition, the project looks for the most straightforward possible system to adjust for every person, with the creation of a native application that allows through an interface the review of the registered results and other functions like the comparative between sessions for the same muscle groups through a database or the posture correction in real-time.

To reach the final goal of the system-specific hardware has been designed, and the programming in C++ language adapted to Arduino IDE has been made for it, allowing the detection of exercises for the high part of the body (back, chest, shoulders, biceps, and triceps) and some for the low part. Moreover, some extra functionalities like the register of date, the sending through an email of the registered parameters, and correcting the posture based on fuzzy logic are created.

The present document recollects all the parts related to the development of the project. First of all, a state-of-art is done located in chapter 2, where the actual state of the market in wearables environment is analyzed, and its application in the fitness world; also focusing on the studies and papers with academic purposes applied to this sector checking that the project has an innovative capability and to resolve an existing problem. In the third chapter, all the components involved in the final hardware are detailed, going deeper into electric characteristics and concrete details of each element. Some theoretical concepts are added in chapter 4 that allow a better comprehension of the use of protocols and measurements to develop the algorithm and the global working of the algorithm through the device and the interface in chapter 5. During the sixth chapter, the extra implemented functionalities are detailed, and chapter seven includes the validation of the mechanism and the location of the main errors for the correction in the future, following the conclusions of the project. The last part is done for the bibliography and attachments, where the datasheets of the used components are located, with the schematics and layout of the implemented hardware, the drawings for the packaging of the PCBs, and the final code.

Estado del arte

2. Estado del arte

Para la creación de un proyecto que cumpla con un objetivo de innovación, y que permita solucionar una problemática existente en el mercado actual, se realiza una investigación acerca del estado de este y de las posibles alternativas que surgen en el mundo del I+D+i.

2.1. Análisis del mercado y sensores asociados

Dentro de la gran variedad que existe en la gama de la denominada “tecnología invisible” aparecen una serie de sensores que se repiten para la mayoría de casos que se presenta. En las pulseras de actividad y relojes inteligentes, que son los que principalmente se ajustan al actual proyecto, se suele encontrar un sensor de frecuencia cardíaca. Es el caso de la *Xiaomi Mi Band 6* [3], la *Honor Band 5* [4] o la *Huawei Band 4 Pro* [5], que son los principales referentes del sector en la gama de entrada de las pulseras de actividad. Además, este tipo de sensor se encuentra en dispositivos de mayor coste económico, como el *Apple Watch Series 6* [6], el *Oppo Watch* [7] o el *Samsung Galaxy Active 2* [8], siendo estos últimos los buques insignia en términos de *wearables* que aportan estas tres de las más importantes marcas tecnológicas del planeta. Estos últimos, además, incluyen otros sensores de mayor envergadura tanto para el ámbito sanitario como para el común, como medidores de presión arterial, electrocardiograma (ECG), sensores de luz y ruido ambiental o la brújula. Esto se aplica para el resto de marcas del sector que orientan sus productos a un mercado generalista, lejos de objetivos poblacionales concretos.

Para este tipo de nicho de mercado se aplican una serie de sensores dedicados que permiten una experiencia deportiva más óptima y segura. Prueba de esto son los medidores de presión atmosférica y temperatura, que permiten la visualización en tiempo real de estos parámetros sin requerir de una conexión a internet como en los dispositivos convencionales. Además, es común encontrar sensores barométricos en este tipo de productos, por ejemplo, en el *Suunto Ambit3 Peak* [9] o el *Casio SGW-1000-2ber* [10], dos *smartwatches* de alto poder adquisitivo que están orientados al uso en senderismo.

El mecanismo de registro de variables en función al deporte que se realiza es similar para todos aquellos dispositivos de ámbito generalista, y las pequeñas diferencias que se encuentran entre aquellos de diferentes rangos de precio no aportan un valor diferencial para el propósito del proyecto que se presenta.

Para la gama de entrada, las pulseras de actividad son capaces de monitorizar hasta 30 tipos de deporte, como es el caso de la *Xiaomi Mi Band 6*. El dispositivo es capaz de diferenciar, en función a estos, los momentos en los que se trabaja de forma intensa o más relajada, utilizando el sensor de frecuencia cardíaca como referencia. Esta última versión de la pulsera incluye un modo “Gimnasio Interior”, que se entiende como *fitness*, exportando de igual manera un estudio de la actividad en función a los latidos del corazón, junto a un resumen de calorías consumidas, por lo que no se tiene constancia de una detección de ejercicios como tal. Este ejemplo se puede extrapolar al resto de *wearables* que se encuentran en esa gama de precio, sin importar el tipo de marca, como es el caso de la *Yamay Fitness Tracker* [11] o la *Honor Band 5*. La más completa es la *Huawei Band 6* [12], aunque también de mayor coste, que incorpora un sensor de oxígeno en sangre y la capacidad de registrar hasta 96 tipos de deporte diferente, aunque el registro para el uso de gimnasio se ve limitado a lo visto anteriormente.

Si se busca en un entorno de mayor poder adquisitivo, se encuentran los dispositivos mencionados anteriormente de la marca *Apple*, *Samsung*, *Oppo* o la propia *Huawei*. El *smartwatch* que presenta Apple es capaz de detectar un entrenamiento de forma automática en función al movimiento del usuario y el aumento de las pulsaciones en un período de 10 minutos, así como de programar los entrenamientos para evitar el inicio manual de forma repetida. El número de ejercicios detectables se reduce a 15, y el mecanismo se resume a lo visto hasta ahora: un análisis del tiempo de entrenamiento, pulsaciones medias y máximas, número de calorías consumidas activas y número de calorías consumidas totales. Para determinados ejercicios aeróbicos se incluye la posibilidad de determinar la distancia recorrida. En el caso del *fitness*, sólo se obtiene lo básico, por lo que no existe ningún sistema de detección de ejercicios concretos. El *Apple Watch Series 6* es uno de los relojes más avanzados del sector, por lo que, tal y como se comprueba, es de esperar que otros modelos como el *Samsung Galaxy Active 2*, el *Garmin Venu* o el *Huawei Watch 3 Series* adopten un registro y exportación similar o inferior a lo que se encuentra en el modelo de la manzana mordida.

Es por ello que, a nivel de usuario medio, no se encuentra un dispositivo, en ninguna gama de precios, que se ajuste al propósito que se desea presentar en el documento actual. Por tanto, se deberá realizar un estudio de aquellos productos dedicados exclusivamente al entorno del *fitness*.

El *Atlas Multitrainer 3* [13] es el sucesor natural de la *Atlas Wristband 2*, un *wearable* que presume de un *tracking* del ejercicio eficaz y que promete facilitar la recuperación post-entreno. Entre sus cualidades, además, está la de detectar repeticiones de los ejercicios del *workout* que se realiza. La manera en la que funciona esto se resume en una comunicación previa, por parte del usuario, de los ejercicios que se van a ejecutar, junto a las repeticiones correspondientes a cada serie, y el número de series de cada uno. El reloj, que cuenta con un acelerómetro, cuenta las repeticiones utilizando los cambios de aceleración y los añade al registro. Sin embargo, no cuenta con un sistema de detección de estos ejercicios, por lo que el individuo debe señalar antes de cada sesión la rutina a realizar.

Otro de los productos que se pueden encontrar es la *PUSH Band* [14], una banda que se sitúa en el antebrazo y que comparte muchas características con el *Atlas Multitrainer*. Incluye la monitorización de la potencia, la velocidad y el trabajo realizado durante la sesión de entrenamiento, y un portal web para acceder a los datos. Además, promete hasta un total de detección de 250 ejercicios. Sin embargo, esta detección de ejercicios no es más que lo visto anteriormente, por lo que se trata de una detección de repeticiones de ejercicios previamente programados por el usuario, no un sistema que detecte de forma autónoma los ejercicios realizados.

El tercero en discordia es el dispositivo denominado *Beast* [15], una banda que se coloca en la muñeca y que se conecta a un elemento magnético que se adhiere a las barras donde se colocan los pesos. Cuenta con un *app* donde se puede consultar los registros y donde se visualiza la monitorización de las repeticiones. El sistema es el mismo que los otros dispositivos mencionados, una detección que depende de una preprogramación por parte del usuario, rompiendo con la fluidez y naturalidad que requiere un entrenamiento.

Por último, está el dispositivo multifuncional *Gymwatch* [16] y *Athos* [17]. El primero es una banda que se puede situar en cualquier extremidad, aportando además una completa aplicación que permite la incorporación de nuevos ejercicios a la hoja de ruta. Cuenta con un botón que habilita un contador hasta el inicio de la rutina. No es un producto orientado a la sesión de entrenamiento como tal, sino al cuidado de la integridad del individuo, y prueba de esto es que realiza un *feedback* con la calidad de los movimientos que se realizan para evitar lesiones y mejorar la ejecución, midiendo a su vez la tensión muscular. La detección de repeticiones repite el esquema que se encontraba hasta ahora. Sin embargo, este producto ha quedado obsoleto a día de hoy y no dispone de ningún sucesor previsto. El segundo son dos prendas deportivas, una malla y una camiseta, que cuentan con 20 sensores capaces de analizar la actividad muscular durante el ejercicio físico. No está orientado a la detección de movimiento o repeticiones, únicamente a la detección de ritmo cardíaco, respiración y capacidades musculares, por lo que su objetivo es el cuidado personal. Durante la sesión de entrenamiento sólo se muestra el esfuerzo realizado por cada grupo muscular sin importar el ejercicio, ya que tampoco cuenta con una programación previa.

2.2. Análisis de artículos académicos

Se demuestra, por tanto, que no se encuentran alternativas en el mercado que realicen una detección similar a lo que se pretende implementar en el presente proyecto, ya sea a nivel general como a productos orientados al sector del *fitness*. Es por ello que se realiza una investigación poniendo el foco en estudios y artículos de carácter académico con una fecha de publicación posterior a 2016.

Es en ese año cuando se crea un sistema de origen estadounidense denominado *StayFit* [18] y cuyos autores son Maram Maheedhar, Aman Gaurav, Vivek Jilla, Vijay N Tiwari y Rangavittal Narayanan. Para la creación del producto, mezclan conceptos de potencia y capacidad cardiorrespiratoria, que dan lugar a la detección de las repeticiones de ocho ejercicios diferentes para los grupos musculares de mayor tamaño, alcanzando una sensibilidad del 96 % y una precisión del 95 %, que dan como resultado un sistema similar a lo que se desea implementar en el presente proyecto mediante la programación de un reloj inteligente (*Samsung Galaxy Gear S2*), que opera a 25 Hz, con la desventaja de la limitación que requiere el utilizar un único punto de análisis. El número de ejercicios es reducido, y por tanto, inaplicable en un entorno real.

En el año 2017, Chaeolhyo Lee presentó en la Novena Conferencia de Redes del Futuro una algoritmo capaz de medir los valores picos de resistencia que genera la musculatura correspondiente en las actividades físicas propuestas [19], aunque sin entrar en términos de detección de ejercicios, ya que se conectan sensores en las diferentes partes del cuerpo y se mide la tensión muscular y la aceleración en los movimientos, detectando picos positivos y negativos, por lo que no se ajusta a lo que se desea alcanzar en el proyecto actual. El test práctico realizado para este sistema se puede visualizar en la figura 1.

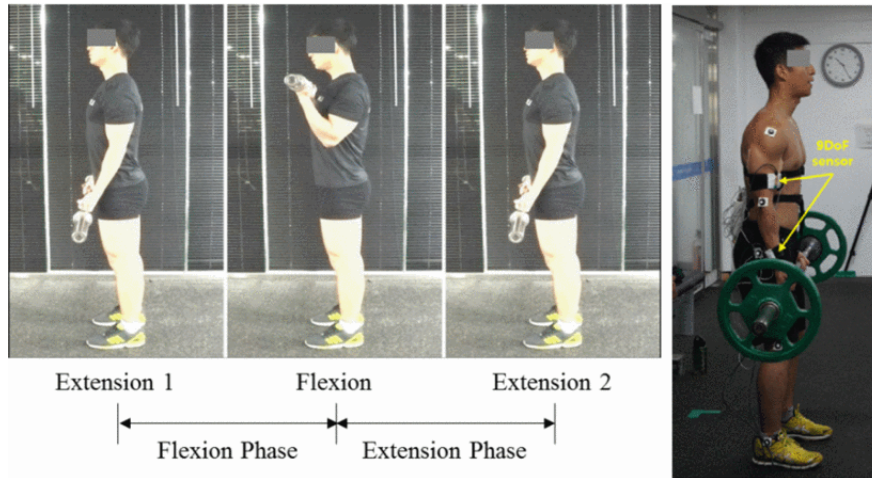


Figura 1: Sistema creado para el registro de picos musculares. Fuente: [19]]

Un año más tarde se presenta un dispositivo denominado *GIFT* [20], un guante destinado al *fitness indoor* que realiza una detección automática del ejercicio en función a la presión que se registra en los diferentes puntos de la mano (figura 2). Sus autores, Elder A. H. Akpa, Masashi Fujiwara, Yutaka Arakawa, Hirohiko Suwa y Keiichi Yasumoto, indican una precisión del 87 % para los diez ejercicios que registraron, conectando el guante a una unidad de muestreo de datos que recoge la presión en cada sensor y realiza una comparación con otros ejercicios. Al igual que en el primer artículo mencionado, al tener un único punto de análisis, se limita la detección de una gran cantidad de ejercicios, a pesar de la futura inclusión de un acelerómetro que se plantea en el artículo.

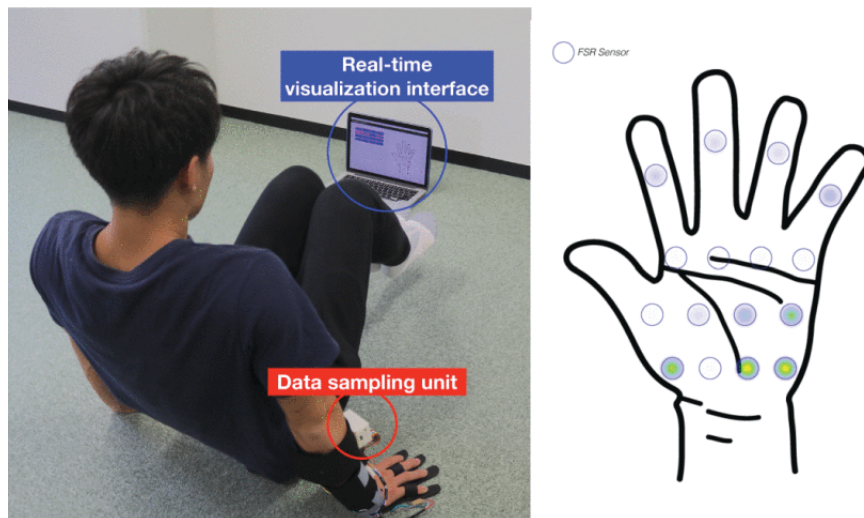


Figura 2: Funcionamiento del dispositivo GIFT. Fuente: [20]

En junio de 2019, se presenta un sistema de análisis en tiempo real de entrenamientos de *fitness* utilizando *machine learning* combinado con visión por ordenador [21]. Sus autores, Amit Nagarkoti, Revan Teotia, Amith K. Mahale y Pankaj K. Das realizan una comparativa del movimiento que realiza un sujeto utilizando una grabación y una serie de vectores que unen las diferentes extremidades con el torso de este. El sistema está orientado a la corrección de posturas de cara a la mejora de la ejecución del ejercicio y a la reducción de lesiones ocasionadas por estos. No existe detección automática, sino una comparación entre los movimientos de un profesional con el usuario. Esto no se ajusta al propósito del presente proyecto y, además, no resulta práctico de cara a un entorno real.

2.3. Oportunidad de innovación

Se finaliza, por tanto, el análisis del mercado, junto a los artículos académicos que se han publicado relacionados con el *fitness*, donde se puede concluir que no existe un sistema como el que se pretende implementar en el presente proyecto. Es cierto que existen dispositivos capaces de realizar una detección de repeticiones o de ejercicios, pero presentan varios problemas. El primero, que requieren de una programación previa, sobre todo en el ámbito comercial, por lo que no resulta cómodo y limita la fluidez que debe tener un entrenamiento de estas características. El segundo, que los dispositivos que se han creado para la detección de ejercicios se han testado con un número muy reducido de estos, utilizando un único punto de análisis, lo que limita en gran medida la exportación al mundo real, donde muchos se deben detectar desde otro punto, con la ayuda de la información que se recoge en otro u otros sensores. A pesar de los altos porcentajes que pueden presentar, no se puede extrapolar a una sesión real en un futuro, mientras sólo se tome un punto de detección. Además, el campo que se estudia se encuentra en una fase muy temprana debida a la escasez de artículos publicados en este sector.

El presente proyecto, por tanto, puede solucionar la problemática existente. Por una parte, cuenta con un sistema autónomo que detecta los ejercicios sin necesidad de una programación previa, únicamente con la orden del inicio del entrenamiento. Por otra, al contar con dos puntos de análisis, se abre el abanico de registro de ejercicios, hasta un total de 36, aportando un valor diferencial respecto a los artículos publicados hasta ahora.

Descripción del hardware

3. Descripción del *hardware*

Previa implementación del *software* necesario para la detección de ejercicios y otros parámetros, se realiza el diseño completo del *hardware* utilizando la plataforma *Altium Designer*. Para el objetivo del proyecto, se debe tener en cuenta que se precisa de un acelerómetro y giroscopio, para determinar la aceleración y orientación de los puntos de estudio en cada instante de tiempo. Además, se requiere de un circuito integrado que permita establecer la comunicación *Bluetooth* entre los diferentes puntos, de tal manera que se estén enviando continuamente mensajes con la posición de estos. Es de utilidad incorporar una pequeña pantalla que sirva de ayuda visual ante problemas cotidianos de comunicación entre nodos o para visualizar datos como el tiempo de entrenamiento. Además, se instala un sensor de frecuencia cardíaca, junto a otros componentes menos visibles en la práctica, como convertidores de voltajes, elementos pasivos o un convertidor de protocolos USB-UART. Por tanto, se cuentan con los siguientes componentes principales:

- **MPU-6050:** este circuito integrado de tipo *smart-sensor* consta de un acelerómetro y un giroscopio, de tres ejes cada uno, por lo que se tienen 6 grados de libertad. La función de este módulo es la de detectar la posición del antebrazo o el brazo de forma discreta en cada instante de tiempo. Cuenta con unas dimensiones en milímetros de $4 \times 4 \times 0,9$ (alto \times ancho \times espesor), perteneciente al fabricante *Invensense*. Cuenta con un amplio abanico de tensiones a las que es capaz de funcionar. Sus principales características se pueden observar en la tabla 1, mientras que en la figura 3 se puede visualizar el encapsulado del componente:

Característica	Valor
Voltaje de alimentación, Vdd	-0.5 V a 6 V
Voltaje de entrada, Vlogic	-0.5 a Vdd + 0.5 V
Aceleración en cualquier eje	10000 g para 0.2 ms
Rango operativo de temperatura	-40°C a +105°C
Rango de temperatura de almacenamiento	-40°C a +125°C

Tabla 1: Características del módulo MPU-6050

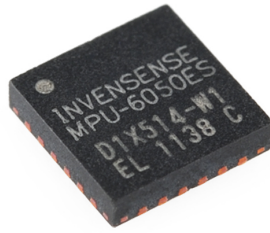


Figura 3: Encapsulado del MPU-6050

- ESP32-WROOM-32D:** módulo *WiFi* + *Bluetooth* que se utilizará para la comunicación entre ambos nodos y el *smartphone* correspondiente. Diseñado y fabricado por *Espressif*, cuenta con los protocolos 802.11 b/g/n para el caso del *WiFi* y la versión 4.2 de *Bluetooth*. Además, incorpora compatibilidad para tarjetas SD, protocolo UART, puerto serie y leds, teniendo unas dimensiones de $18 \pm 0,2 \text{ mm} \times 25,5 \pm 0,2 \text{ mm} \times 3,1 \pm 0,15 \text{ mm}$. En la tabla 2 se observan algunas de las características más importantes del módulo, además de el encapsulado general del módulo que se muestra en la figura 4:

Item	Especificación
Voltaje de operación	2.7 V a 3.6 V
Corriente de operación	Media: 80 mA
Seguridad Wi-Fi	WPA/WPA2/WPA2-Enterprise/WPS
Protocolo Bluetooth	Bluetooth 4.2 BR/EDR y especificación BLE
Rango operativo de temperatura	-40°C a +85°C

Tabla 2: Características del ESP32-WROOM-32



Figura 4: Encapsulado del módulo ESP32-WROOM-32D

- **MAX30102EFD+**: este módulo (Figura 5) hace referencia a un sensor de frecuencia cardíaca, que va a estar destinado al registro de este parámetro durante la sesión de entrenamiento, para posteriormente establecer un análisis de los mínimos, máximos y frecuencia media. Necesita de una tensión mínima de 1,8 V y una máxima de 2,0 V. En el presente proyecto, el sensor de pulso estará integrado en el subsistema de la muñeca, con unas dimensiones de $5,6 \times 3,3 \times 1,55 \text{ mm}^3$, realizándose únicamente la implementación a nivel de *hardware* de dicho módulo, limitándose su programación a futuros proyectos que envuelvan al sistema.

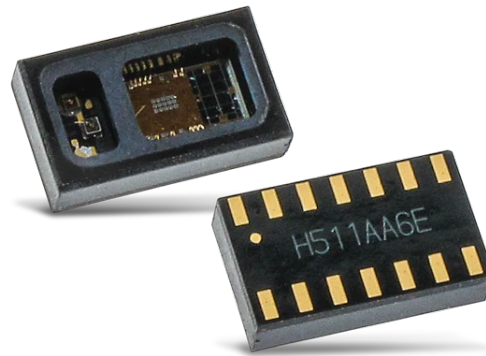


Figura 5: Encapsulado del sensor de frecuencia cardíaca

Además, se integran una serie de componentes que serán necesarios para el correcto funcionamiento de los anteriormente mencionados. Estos son:

- **TP4056**: gestor de baterías que se encarga de recargar la batería de litio-polímero (LiPo) para el uso continuado del sistema de manera inalámbrica. Tiene un rango de funcionamiento de -4 V a 8 V, aunque el uso típico es de 5 V, y un rango operativo de temperatura de -40°C a 85°C .
- **TX0102DCTR**: este circuito integrado realiza la función de traslación de voltaje de forma bidireccional. Conecta los puertos serie del MPU-6050, del ESP32-WROOM y del *display*, que funcionan a 3,3 V, y del MAX30102EFD+, que funciona a 1,8 V.
- **TLV75533PDBVR**: convertidor de tensión que reduce la señal de 4,2 V a 3,3 V, necesarios para el funcionamiento del acelerómetro, de la pantalla y del módulo *WiFi* y *Bluetooth*. Cuenta con un rango de operación de $-0,3 \text{ V}$ a 6 V y un rango operativo de temperatura de -40°C a 150°C .

- **NCP612SQ30T2G**: convertidor de tensión que se encargará de reducir la tensión de 3,3 V a 1,8 V, que es el voltaje de funcionamiento del sensor de frecuencia cardíaca. Su rango de temperatura va desde los -40°C a los 85°C y permite un rango operativo de voltajes de 0 a 6,0 V, aunque su funcionamiento como tal debe estar en un margen de $\pm 0,3V_{IN}$.

En el capítulo referente a los Anexos se adjuntan las hojas de datos de los componentes utilizados para la creación del proyecto. Como se puede observar, se tienen cuatro ramas principales de voltaje. La primera es la que funciona a 5,0 V, necesaria para la conexión USB y el funcionamiento del conversor USB a protocolo UART (CP2102). Tras esto, se convierte el voltaje a 4,2 V, ya que será la máxima tensión de funcionamiento a las que trabajan las baterías de litio-polímero, para posteriormente reducirlo a 3,3 V. Es aquí donde se encuentra todo el eje central del *hardware*, ya que es el voltaje de funcionamiento del acelerómetro y giroscopio (MPU-6050), del módulo *WiFi + Bluetooth* (ESP32-WROOM) y del *display* que se incorpora en el diseño. La última rama es la de 1,8 V, necesaria para el uso del sensor de frecuencia cardíaca (MAX30102EFD+). En la figura 6 se puede visualizar un esquema con los principales elementos que se integran en el sistema.

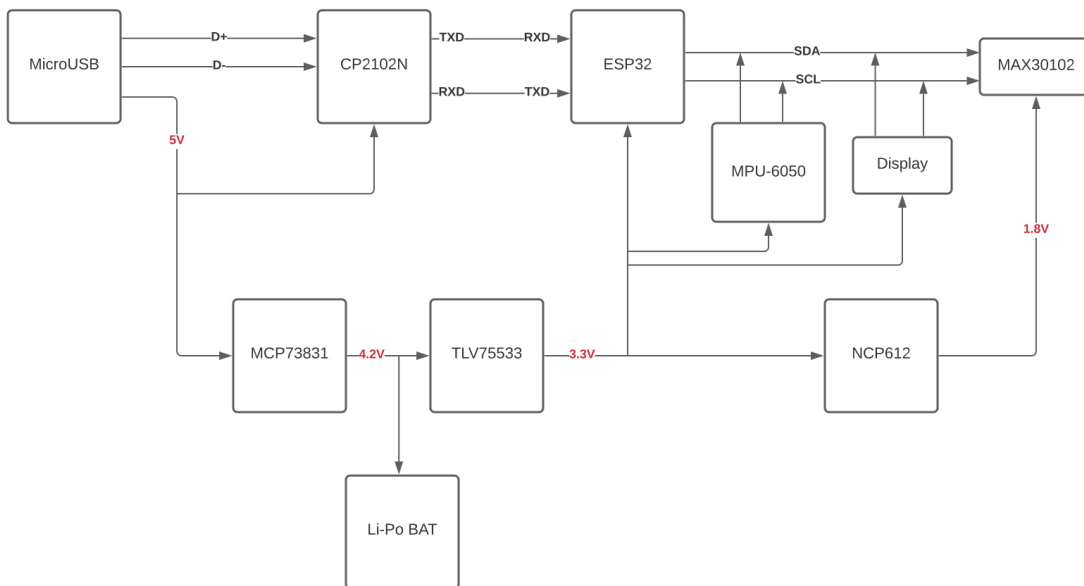


Figura 6: Diagrama de bloques de la PCB diseñada

En la figura 7 se puede observar el diseño *hardware* final con todos los componentes implementados en las PCBs, donde cada una tiene unas dimensiones en milímetros de 49×32 .

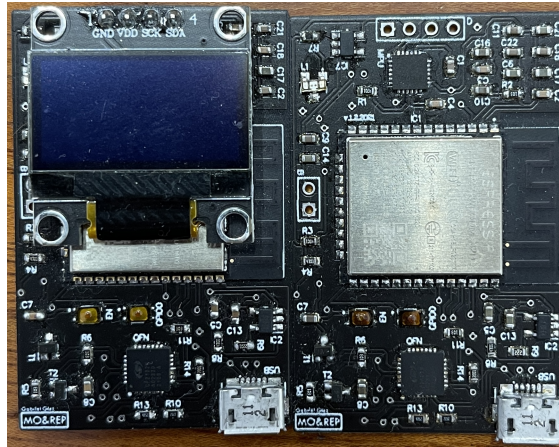


Figura 7: Diseño final del *hardware* implementado

Fundamentos teóricos

4. Fundamentos teóricos

Durante el presente capítulo se realiza una descripción exhaustiva de los principales fundamentos teóricos en los que se basan los elementos del proyecto, entre los que se encuentran los mecanismos del acelerómetro y giroscopio, los esquemas en los que se basa el *Bluetooth* de baja energía (BLE) y el protocolo SMTP utilizado para el envío de correos electrónicos, así como la estructura de un servidor HTTP.

4.1. Funcionamiento del MPU-6050

La aceleración se define como la variación de la velocidad por unidad de tiempo, representada matemáticamente como:

$$a = \frac{dv}{dt} \quad (1)$$

Si se aplica la segunda ley de Newton, que se define como el producto de la masa de un cuerpo por la aceleración a la que se ve sometido, se obtiene el funcionamiento de un acelerómetro.

$$F = m \cdot a \quad (2)$$

Estos contienen en su interior un sistema microelectromecánico (mEMS), que actúa de una manera similar a la de un resorte. El dispositivo es capaz de detectar la aceleración de la gravedad, por lo que nunca se mostrará un valor nulo de movimiento. Además, debido a las capacidades propias del acelerómetro, se pueden calcular de manera indirecta otros parámetros como la velocidad o el desplazamiento.

Por otro lado, la velocidad angular se define de manera analítica como la diferencia de desplazamiento angular en un determinado instante de tiempo, por lo que se puede identificar de forma empírica como la velocidad a la que gira un cuerpo alrededor de su eje.

$$\omega = \frac{d\theta}{dt} \quad (3)$$

El sistema microelectromecánico que se encuentra en componentes como el MPU-6050 utiliza el efecto Coriolis [21] para hallar este parámetro, permitiendo la medición indirecta del desplazamiento angular.

Sumando ambos conceptos se puede visualizar la idea del funcionamiento del IMU implementado, el MPU-6050. En la figura 8 se muestra la distribución de los ejes en los que se calculan las diferentes aceleraciones lineales y angulares y su relación posicional con el módulo.

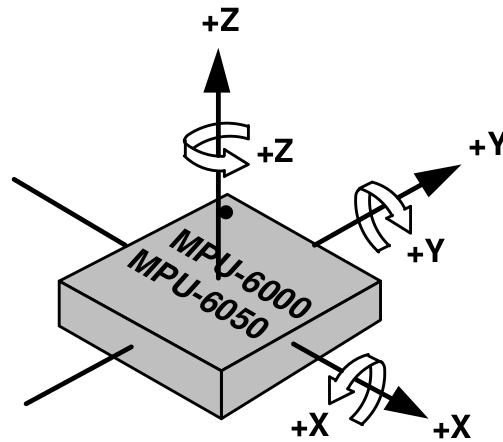


Figura 8: Distribución de los ejes del MPU-6050. *Fuente: Invensense*

Durante el proyecto que se presenta se implementa el módulo mencionado para determinar las posiciones que adoptan los diferentes puntos de análisis para su posterior comunicación vía *Bluetooth*.

4.2. *Bluetooth Low Energy* (BLE)

El *Bluetooth* de baja energía o BLE es un subconjunto del estándar *Bluetooth* v.4.0. Dispone de un grupo de protocolos respecto al modelo OSI orientada a conexiones sencillas para aplicaciones que requieren muy poca potencia, lo cual lo hace perfecto para el entorno del Internet de las Cosas, ya que su mayor uso engloba dispositivos que funcionan a base de pilas o baterías, como el ejemplo que se presenta.

Cuenta con una amplia aceptación y compatibilidad con los diferentes sistemas operativos que dominan el mercado, tanto en dispositivos móviles como en *wearables* u ordenadores. Siguiendo el esquema OSI mencionado anteriormente, se pueden identificar los diferentes protocolos según la capa a la que haga referencia:

- La **capa física** define el cableado y circuitería que conforma el sistema de comunicación. En ella se realizan los procesos de modulación y demodulación de las señales analógicas para convertirlas a señales digitales. La tecnología BLE permite el uso de 40 canales de 2 MHz en la banda ISM de 2,4 GHz. Dicho estándar realiza la técnica conocida como *frequency hopping*, que se traduce en saltos de frecuencia pseudoaleatorios entre los diversos canales que se mencionan, lo que crea un alto nivel de fiabilidad de cara a posibles interferencias.
- En la **capa de enlace** se gestionan determinadas características temporales, como la verificación de mensajes y reenvío de erróneos recibidos, el filtrado de direcciones, etc. Cuenta con una identificación de papeles o roles por dispositivo en el proceso de comunicación, que son el *Advertiser*, el *Scanner*, el *Master* y el *Slave*.
- En la **capa de red** se encuentra la HCI o *Host Controller Interface*, que permite la comunicación entre un servidor o *host* y un controlador mediante una interfaz serie. De esta manera se define como el conjunto de comandos y eventos para llevar a cabo el proceso de interacción entre ambos elementos.
- En la **capa de transporte** se encuentra el *Logic Link Control and Adaptation Protocol* o L2CAP, que tiene como objetivo el proceso de multiplexación (el envío de paquetes provenientes de niveles superiores en el modelo OSI para encapsularlos en paquetes estándar BLE, y viceversa), además de la fragmentación y recombinación. De esta manera, los paquetes que provienen de la capa de aplicación ocupando una cantidad muy alta de bytes, son fragmentados ajustándose a la unidad máxima de transferencia de paquetes que requiere el estándar (27 bytes de carga útil o *payload*). La capa L2CAP, además, se encarga de permitir el acceso y dar soporte al protocolo ATT (*Attribute Protocol*), que permite el intercambio de información utilizando una arquitectura servidor-cliente basada en “atributos”, y el SMP o *Security Manager Protocol*, que proporciona un *framework* para generar y distribuir claves de seguridad entre los diferentes dispositivos.

- Para la **capa de sesión** se encuentran paralelamente las capas GAP (*Generic Access Profile*) y GATT (*Generic Attribute Profile*). La primera permite la visibilización de un dispositivo respecto al resto de estos, determinando cómo pueden interactuar entre ellos. Para la realización de este propósito la capa establece una serie de normas y conceptos para estandarizar las operaciones de niveles inferiores como:
 - Roles de interacción
 - Modos de operación y transición entre dispositivos
 - Procedimientos para el establecimiento de la comunicación
 - Modos de seguridad y procedimientos

Por otro lado, la capa GATT realiza la función de definir cómo se transfiere la información entre dos dispositivos BLE. Esto se realiza una vez se ha determinado el establecimiento de la comunicación. [22]

La principal diferencia entre el BLE y el *Bluetooth* convencional reside en la cantidad de energía que se requiere para la utilización de uno u otro. El *Bluetooth* clásico se diseñó para la transmisión continua de datos, por lo que se precisa de una fuente generosa de batería, careciendo de utilidad en dispositivos de menor tamaño.

Ambos operan en la banda ISM de los 2,4 GHz. Sin embargo, el BLE permanece en modo suspensión de manera constante, salvo cuando se inicia la conexión, lo que tarda unos pocos milisegundos, a diferencia de los más de 100 milisegundos que tardaría el *Bluetooth* clásico. Para el uso de menor energía los dispositivos involucrados pueden ser centrales, como *smartphones*, *tablets* u ordenadores, capaces de ejecutar un número mayor de procesos, encargándose de controlar los periféricos, que suelen identificarse como sensores capaces de registrar datos y enviarlos a los dispositivos centrales, por lo que estos últimos son los encargados de procesarlos convenientemente, reduciendo la energía requerida por los periféricos.

4.2.1. Servicios y características

Las transacciones GATT en BLE están basados en objetos conjuntos denominados perfiles, servicios y características. En la figura 9 se puede observar como está distribuido el funcionamiento del *Bluetooth* de baja energía.

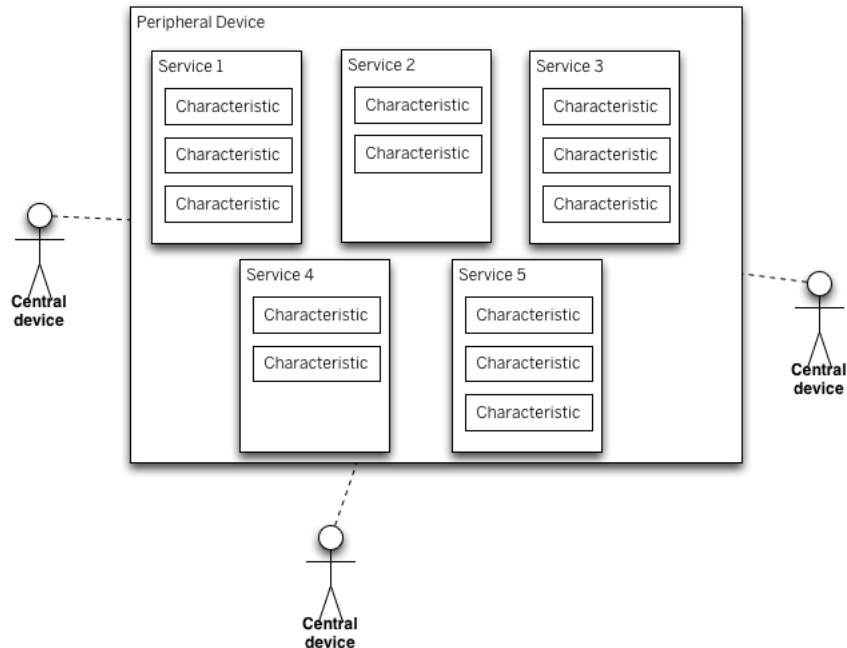


Figura 9: Esquema de funcionamiento del BLE

Un conjunto predefinido de servicios forman un perfil, y cada servicio se utiliza para dividir datos en entidades lógicas, conteniendo porciones específicas de datos llamados características. Un servicio, por tanto, podrá tener varias de dichas características, que se diferenciarán entre sí por un ID numérico denominado UUID, formados por 16 bits en el caso de los servicios BLE que se utilizan oficialmente, o 128 bits para aquellos personalizados. Las características son el concepto más bajo en las transacciones GATT, ya que encapsulan un único tipo de dato, aunque puede contener un vector en él [23].

4.2.2. Seguridad y emparejamiento del BLE

Las dos principales características que presenta el BLE en términos de seguridad son la autenticación y el cifrado de 128 bits, además de los saltos de frecuencia, que permiten la corrección de errores hacia adelante (FEC, *Forward Error Correction*), por lo que el receptor corrige errores de transmisión sin necesidad de reenvíos.

Una vez realizada la verificación en la conexión de dos o más dispositivos, la conexión es realmente segura, aunque, para ello, se precisa de una serie de pasos de cara al emparejamiento.

- La primera etapa consta de un intercambio de información básica en los que cobra importancia las capacidades de los integrantes de la red, para encontrar el procedimiento óptimo de conexión. Esta etapa no conlleva ningún tipo de encriptación.
- La segunda etapa de emparejamiento está orientada a la generación e intercambio de claves, siendo esta la fase de mayor vulnerabilidad del proceso, ya que las conexiones pueden ser manipuladas. Aquí aparecen métodos de seguridad para ejecutar el procedimiento de manera fiable, como el algoritmo *Diffie-Hellman* para la generación de claves, introducido en la versión 4.2 del BLE. Muchos de los dispositivos pertenecientes al IoT no cuentan con este tipo de seguridad, por lo que son susceptibles a escuchas pasivas o al conocido *Man-In-The-Middle*.
- En la última fase del proceso los dispositivos almacenan los datos de autenticación que se intercambiaron previamente, lo que permite el emparejamiento en casos posteriores al quedarse guardados dichos datos.

Los cuatro métodos principales de emparejamiento en la tecnología BLE son los denominados *Just Works*, *Out of Band*, claves de paso y comparación numérica.

En el presente proyecto se utiliza la tecnología *Bluetooth Low Energy* para la comunicación constante de los diferentes nodos que se utilizan durante el ejercicio, enviando y reconociendo las posiciones que ocupa cada uno en cada instante de tiempo, así como la conexión y emparejamiento con el dispositivo móvil correspondiente.

4.3. Protocolo SMTP para el envío de correos electrónicos

Al finalizar cada sesión de entrenamiento se envía un correo electrónico con el análisis de lo realizado. Para ello, se precisa del protocolo SMTP (*Simple Mail Transfer Protocol*), que utiliza los estándares RFC 821, 2821 y 5321 [22].

Dicho protocolo se encuentra directamente relacionado con otros comunes como el POP3, que usa el estándar RFC 1939, o el IMAP, que aplica el RFC 3501. La diferencia entre estos radica en el propósito de cada uno, ya que el SMTP suele utilizarse para correos electrónicos de salida, mientras que POP3 e IMAP se usan para correo entrante.

Para la transmisión de mensajes se definen una serie de normas, a modo de rutina, que conforman el estándar comunicativo. Estas son:

- Se requiere un origen, que se identifica como el cliente del correo emisor.
- El correo navega por internet a través de la conexión ISP.
- Se realiza una autenticación en el servidor SMTP llegando al servidor correspondiente.
- Cuando el servidor procesa el correo lo envía a los receptores de destino definidos.

En un cliente de correo convencional, el servidor de destino (*mail exchanger*) almacena la información, para que el propio cliente la recoja mediante protocolos POP3 o IMAP, enviándolo posteriormente a los destinatarios. En el popular ejemplo del *webmail*, el correo llega al servidor, que se encuentra conectado a internet, para ser visualizado a través del navegador o de la interfaz correspondiente.

El SMTP utiliza el puerto 25 como estándar, aunque el 465 se encuentra en un auge de popularidad de uso, siendo el utilizado para el presente proyecto. Además, otras plataformas orientadas al *marketing* como *Mailrelay* usan los puertos 125 o 2525. La diferencia entre los mencionados radica en la seguridad: los puertos 25 y 587 se encuentran por defecto en el protocolo SMTP como descriptados. En todos se necesita una autenticación con usuario y contraseña. Sin embargo, el 465 añade una conexión cifrada SSL/TLS similar a la que se utiliza en el protocolo HTTPS. Esto no implica una seguridad absoluta e inquebrantable, pero sí que añade un nivel superior de seguridad respecto al resto de puertos.

Como se ha mencionado anteriormente, la principal desventaja que se encuentra en el protocolo SMTP es la falta de seguridad en determinados puertos utilizados, por lo que se emplea comúnmente para correos fraudulentos, que permite enviar un correo cualquiera desde cualquier dirección a cualquier destinatario.

Por otro lado, se debe mencionar la facilidad y lo básico que resulta el protocolo, a modo de ventaja. Los mensajes están basados en codificación ASCII. Las líneas se intercambian entre el cliente y el servidor, y llevan un orden estricto. En la tabla 3 se incluyen los diferentes comandos y respuestas que se plantean durante la conexión entre servidor y cliente:

Cliente/Servidor	Mensaje
Servidor	220 SMTP
Cliente	HELO miequipo.midominio.com
Servidor	250 Hello, please to meet you
Cliente	MAIL FROM: yo@midominio.com
Servidor	250 Ok
Cliente	RCPT TO: destinatario@sudominio.com
Servidor	250 Ok
Cliente	DATA
Servidor	354 End data with "."
Cliente	Subject: Campo de asunto
Cliente	From: yo@midominio.com
Cliente	To: destinatario@sudominio.com
Cliente	Hola,
Cliente	Esto es una prueba.
Cliente	Adiós
Cliente	.
Servidor	250 Ok: queued as 12345
Cliente	QUIT
Servidor	221 Bye

Tabla 3: Estructura de mensajes en el protocolo SMTP

Como se puede observar, los mensajes salientes del servidor se componen de un número y una cadena de texto, donde la mayor relevancia la acoge el número. En determinados casos, como en el 250, se verifica el envío del correo, siendo el cliente el que traduce dicha información. La comunicación comienza con la detección de la conexión por parte del servidor en el puerto correspondiente, devolviendo un 220. El cliente responde con un “HELO”, seguido de la información propia del dispositivo con el que se trabaja. Una vez el servidor confirma que ha recibido dicha información, el cliente envía el correo emisor y el correo destinatario, con confirmaciones de recepción por parte del servidor. Posteriormente se envían todos los datos necesarios para el envío del correo, y el propio cliente da la orden de desconexión.

Para casos en los que existen errores de envío, el servidor emite unos comandos con nomenclatura 5XX, siendo X un número entero del 0 al 9, para que el cliente lo interprete.

4.4. Servidor HTTP

Una de las opciones que se implementan en el proyecto que se ocupa es el acceso a la última sesión realizada, haciendo uso de la memoria EEPROM del sistema. Para ello, se genera un servidor HTTP desde una dirección IP local donde se implementa la información requerida.

Un servidor web o servidor HTTP es una aplicación informática utilizada para la distribución de contenido web en redes internas o en internet, encargándose de proporcionar los datos para la visualización de la información. El funcionamiento reside en la renderización de un código recibido a través de un navegador web utilizando generalmente el protocolo HTTP, basado a su vez en los protocolos de red IP y TCP, para la transmisión de datos durante la comunicación, representando en el modelo OSI la capa de aplicación.

Existen dos tipos de servidor web en función a la estructura y el proceso de envío de los archivos: los estáticos y los dinámicos. En el primero dichos archivos se envían mediante el servidor de la misma forma que se almacenan, directamente hacia el navegador. Por otro lado, los dinámicos cuentan con una aplicación servidor y una base de datos, necesitando más recursos que el servidor estático debido a la complejidad del esquema establecido. La aplicación, por tanto, se encarga de actualizar los archivos almacenados previo al envío que se realiza por el servidor HTTP.

En la práctica, el servidor web se ejecuta en un dispositivo y se mantiene a la espera de recibir peticiones por parte de un cliente a través de un navegador web. Una vez las recibe son respondidas mediante una página web que se reproduce a través del navegador. El ejemplo más básico es la petición HTTP que se realiza al servidor con la URL a la que se desea acceder, mostrando mediante código HTML la página correspondiente, donde el cliente interpreta dicho código y lo muestra por pantalla [23]. Además de la transferencia de un código HTML, estos servidores son capaces de entregar aplicaciones web, las cuales se corresponden a códigos que se ejecutan bajo una petición o respuesta HTTP. Estas aplicaciones pueden ser:

- Aplicaciones en el lado del cliente. Es el cliente el que se encarga de ejecutar las aplicaciones en el dispositivo del usuario, utilizando comúnmente lenguajes como Java y Javascript.
- Aplicaciones en el lado del servidor. El servidor ejecuta las aplicaciones generando un código HTML y enviándolo al cliente mediante el protocolo HTTP. Este último tipo de aplicación es el que se gestiona en el presente proyecto.

Un servidor HTTP requiere de diferentes métodos de petición, los cuales indican la acción que se quiere realizar para un recurso determinado, denominados *HTTP verbs*. Estos se implementan mediante semánticas diferentes a pesar de contar con características similares entre varios de ellos. Los principales *HTTP verbs* son la petición GET y la petición POST.

4.4.1. Petición GET

La petición GET aparece, por ejemplo, al escribirse una dirección URL en el navegador web. Al realizarse, el navegador conecta con el servidor enviándole dicha petición con la forma “GET /index.php”. El archivo “index.php” se representa con la página de inicio del sitio web, lo que el servidor envía como respuesta al navegador. De la misma forma se ejecutan los archivos HTML, emitiendo de la misma forma la petición (“GET /test.html”). Estas peticiones pueden incluir un mayor número de requisitos interpretables por el servidor. Si el navegador plantea una petición “GET /search?platform=Windows&category=office”, el servidor interpreta tres secuencias. La primera será la interrogación (?), que indica el inicio de los parámetros de la petición, donde posteriormente se solicita que el parámetro “platform” tenga un valor igual a “Windows” y (&) “category” sea igual a “office”.

A nivel de infraestructura se le asigna, por norma general, el puerto TCP 80 al protocolo HTTP. El método GET solicita una representación de un recurso específico, por lo que sólo se recuperan datos. Cuando un navegador realiza una o varias peticiones, se produce un *socket* con un servidor existente en una dirección IP mediante TCP. Las direcciones DNS, las cuales son alfanuméricas, se convierten en numéricas, y se solicita al servidor las direcciones IP correspondientes, en caso de que no exista ya una regla de base de datos DNS. De esta manera, se crea una nueva regla y se almacena la IP, junto a su relación con la DNS correspondiente. Tras esto, se realiza una petición a la base de datos para recuperar los valores de la regla y posteriormente se produce un *socket* con la dirección IP mediante TCP. Es entonces cuando se crea la petición GET con la URL, un *flag*, una prioridad y un método, el cual es el propio GET. Se realiza la apertura de caché y se ejecuta la petición, donde se leen las cabeceras HTTP y el cuerpo, denominado *HTTP transaction*. Finalmente se ejecuta una consulta en el caché sobre la existencia de una entrada asociada al recurso solicitado, lo cual tendrá una respuesta booleana donde la variable, denominada “created”, tomará valor *true* si existiera el recurso, y *false* en caso contrario. En caso positivo se muestra la información procesada y se comprueba que sea correcta.

4.4.2. Petición POST

Para el envío al servidor web de grandes paquetes de datos como imágenes o formularios se necesita de un método más potente respecto al GET, ya que no se pueden escribir todos estos datos en la barra de direcciones de un navegador. Es entonces cuando se aplica la petición POST, adjuntándose a la cabecera HTTP. Un ejemplo se puede ver en la figura 10:

```
<html>
<body>
<form action="newsletter.php" method="post">
Name: <input type="text" name="name"><br>
E-mail: <input type="text" name="email"><br>
<input type="submit">
</form>
</body>
</html>
```

Figura 10: Ejemplo de una cabecera HTTP. Fuente: Ionos

En el caso de la petición POST, se requiere el envío de una entidad a un recurso específico, causando frecuentemente una modificación en el estado del servidor, lo que incluye posibles efectos secundarios. Para el funcionamiento de este, los datos que se deben enviar al servidor se adjuntan al cuerpo de la petición con las cabeceras HTTP asignadas, que se corresponden al tipo de petición. En la petición se incluye la cabecera “application/x-www-form-urlencoded”, lo que indica el formato o el tipo de codificación que se envía, separando las variables mediante el símbolo &. La estructura generalizada para la petición POST es la siguiente:

- *Petition Type*. Determina el tipo de petición HTTP.
- *Referer*. Especifica la URL de origen.
- *Content-Length*. Especifica la longitud en bytes de los datos enviados en el cuerpo de la petición.
- *Origin*. Determina la URL principal.
- *User-Agent*. Referencia al identificador del navegador web que realizó la petición.
- *Content-Type*. Marca el formato o MIME (*Multipurpose Internet Mail Extensions* de los datos enviados en el cuerpo de la petición.

- *Accept*. Especifica el MIME que se espera obtener en la respuesta.
- *Accept-Language*. Indica el lenguaje que debe tener el código de la respuesta.
- *Accept-Charset*. Especifica la codificación esperada en la respuesta.
- *Cookie*. Determina el identificador la sesión en la petición, que deriva en una *cookie*.
- *Accept-encoding*. Determina el tipo de codificación o compresión esperada en la respuesta (opcional).

La respuesta, por su parte, tendrá una estructura con los siguientes parámetros.

- *HTTP version & date*.
- *Date*.
- *Server*.
- *Expires*.
- *Cache-control*.
- *Pragma*.
- *Content-length*.
- *Content-type*.
- *Keep-Alive*.
- *Connection*.
- *X-Powered by*.

4.4.3. Otras peticiones de un servidor web

Además de las ya mencionadas peticiones GET y POST, existen otras adicionales que se utilizan a lo largo del funcionamiento de un servidor HTTP, que solicitan acciones específicas para un recurso. Estas son:

- HEAD.
- PUT.
- DELETE.
- CONNECT.
- OPTIONS.
- TRACE.
- PATCH.

Desarrollo del código

5. Desarrollo del código

5.1. Funcionamiento práctico

A la hora de llevar a la práctica el sistema diseñado, el usuario accede a la aplicación *Android/iOS* diseñada específicamente para el proyecto, tal y como se puede ver en la figura 13. Además, el propio dispositivo muestra por pantalla la instrucción correspondiente (figura 12), previa aparición del logo que acompaña al sistema (figura 11).

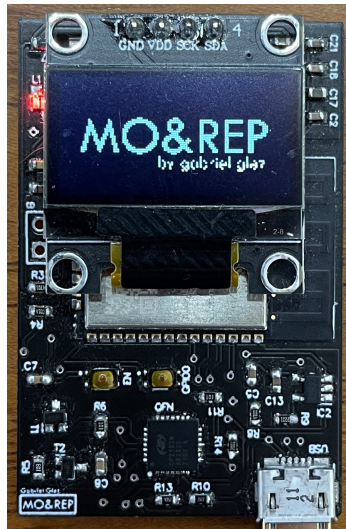


Figura 11: Pantalla de carga del subsistema principal



Figura 12: Pantalla de espera del nodo de la muñeca

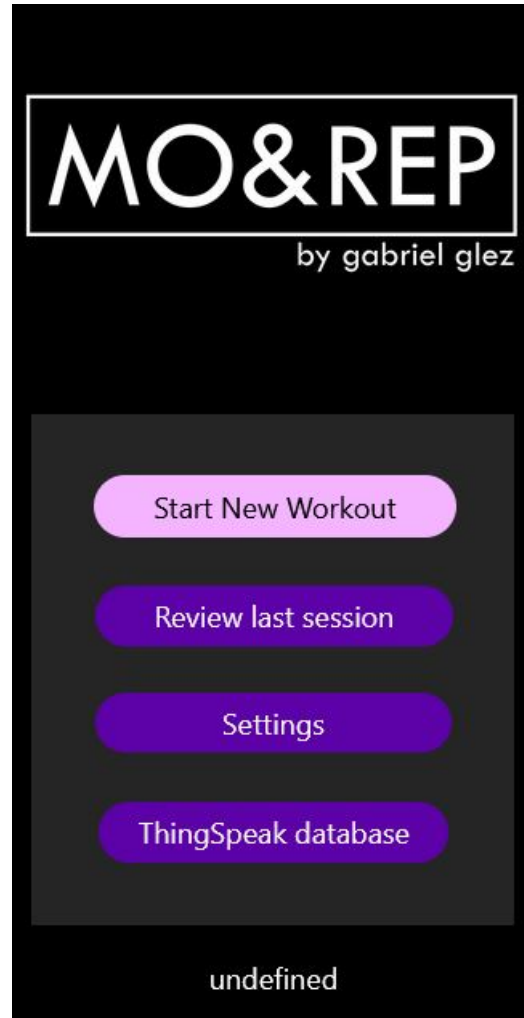


Figura 13: Pantalla principal de la *app*

En la pantalla principal aparecen varias opciones:

- La primera opción ordena el inicio de un nuevo *workout*. Cuando se selecciona dicho botón, el sistema inicia la tarea que se corresponde con el acelerómetro y giroscopio, detectando la posición del brazo y del antebrazo y codificando la sincronización de ambos.
- La segunda alternativa es la revisión del entrenamiento realizado durante la sesión anterior mediante la creación de un servidor HTTP, haciendo uso de la memoria EEPROM integrada en el ESP32.
- La tercera opción permite al usuario configurar parámetros como el envío del correo electrónico al finalizar la rutina.

- El último botón abre una ventana con la que acceder directamente al portal de *ThingSpeak*, lo que permite la visualización de la base de datos en la propia aplicación.

En este punto del proceso el emparejamiento entre ambos subsistemas ya se ha realizado. Por tanto, si el usuario decide seleccionar la primera opción mencionada anteriormente, se sincronizan ambos y comienza el proceso de detección del ejercicio. Durante la sesión de entrenamiento se puede ir observando en la pantalla del nodo inferior las series analizadas hasta el momento, incluyendo las repeticiones realizadas, así como el tiempo transcurrido, tal y como se muestra en las figuras 14 y 15.

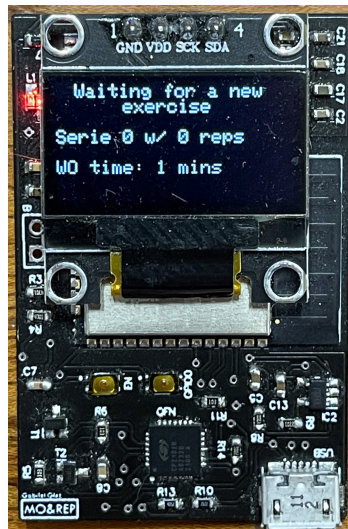


Figura 14: Inicio de la detección de movimientos

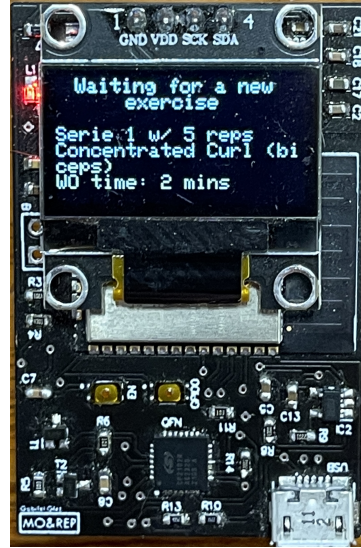


Figura 15: Serie detectada durante la sesión

Durante el transcurso del ejercicio, se podrá leer en la pantalla del nodo inferior la detección que está realizando el sistema en función a los movimientos del usuario, representado en la figura 16.

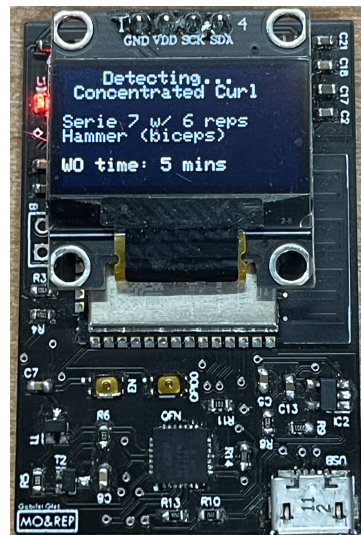


Figura 16: Pantalla de detección de ejercicio

Una vez finalizado el *workout*, se puede observar en la pantalla del sistema las instrucciones de finalización, que se resumen en el acceso al correo electrónico para el análisis del entrenamiento realizado y el acceso a la misma información a través de la aplicación, que tendrá la estructura visible en la figura 17, coincidiendo así con la revisión mencionada en el segundo punto.



Figura 17: Pantalla de finalización de entrenamiento

En la figura 18 se pueden observar los parámetros configurables en el sistema, entre los que se encuentran el envío del correo electrónico bajo el protocolo SMTP al finalizar la sesión, la activación del dispositivo tras el modo *sleep* y la opción de detectar ejercicios del tronco inferior.

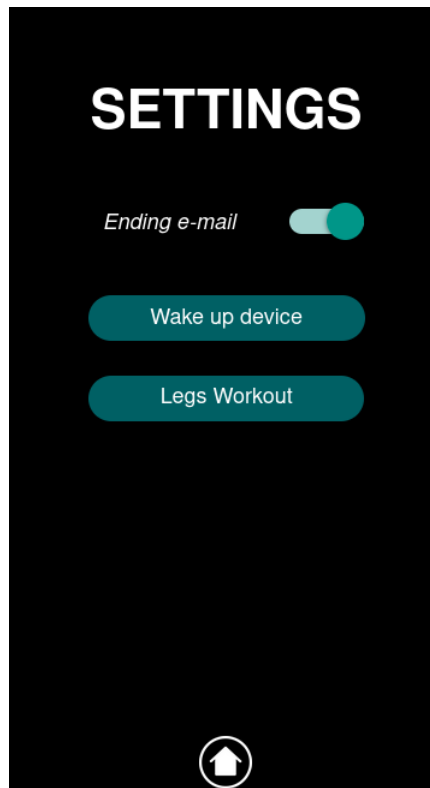


Figura 18: Pantalla de configuración de la aplicación

Además, es posible acceder en tiempo real a la base de datos de *ThingSpeak* para visualizar la evolución del número de series realizadas para cada grupo muscular, junto a la fecha y hora a la que se registraron, tal y como se puede observar en la figura 19.



Figura 19: Pantalla de acceso a la base de datos de ThingSpeak

En las figura 20 y 21 se representan las estructuras correspondientes para el análisis de la sesión previa almacenada en la EEPROM del ESP32 y del correo electrónico enviado al finalizar el entrenamiento.

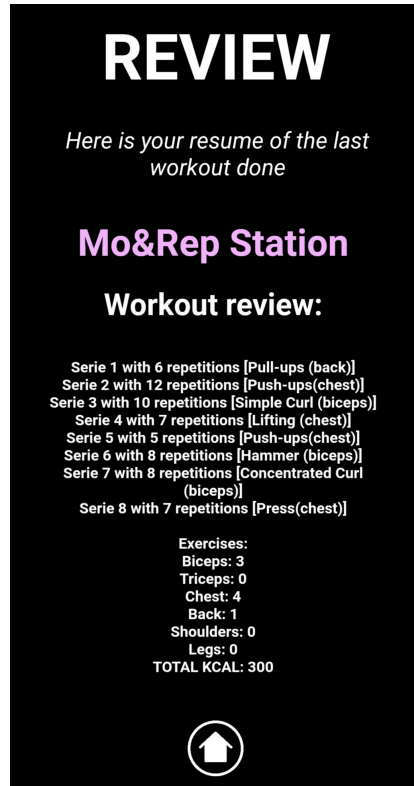


Figura 20: Análisis del entrenamiento previo visto desde la *app*

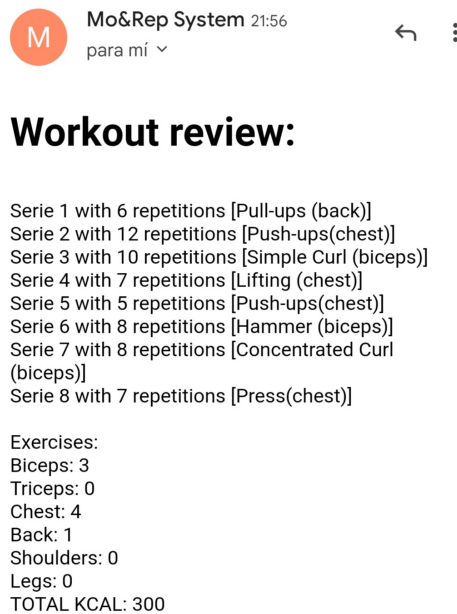


Figura 21: Formato de correo electrónico enviado al finalizar la sesión

5.2. Código embebido para el nodo situado en la muñeca

En primer lugar se desarrollará el entramado del algoritmo correspondiente al subsistema de la muñeca, debido a la cantidad de ejercicios detectables en este nodo, junto con la responsabilidad adicional de ejercer como servidor *Bluetooth* del sistema en su conjunto, ocupando tareas esenciales como el envío del correo electrónico y el registro de datos.

Tal y como se mencionó al principio de la memoria, los códigos se desarrollan en el IDE de Arduino, lo que implica el uso de bibliotecas propias para este software. En el caso que se ocupa se recogen en la tabla 4:

Librería	Descripción
Arduino.h	Libería básica del software implementado
Wire.h	Comunicación con dispositivos que utilizan el puerto serie (I ² C)
Adafruit_GFX.h	Uso de la pantalla conectada en el puerto serie
Adafruit_SSD1306.h	Definición de las funciones que se aplican en la pantalla
I2Cdev.h	Aplicación de funciones para dispositivos conectados en el puerto serie y el ESP32
MPU6050.h	Funciones del circuito tipo <i>smart-sensor</i> que cuenta con un acelerómetro y un giroscopio
String.h	Uso de cadenas de texto
WiFi.h	Uso del módulo WiFi + Bluetooth ESP32
EEPROM.h	Gestión de la EEPROM incorporada en el ESP32
Separador.h	Libería diseñada por el portal "Ioticos" para el tratamiento de cadenas de caracteres con separadores
ESP_Mail_Client.h	Comandos requeridos para el envío del correo electrónico mediante protocolo SMTP
ThingSpeak.h	Funciones de acceso a la base de datos
Secrets.h	Almacenamiento de claves de acceso y datos esenciales
MAX30105.h	Aplicación del algoritmo para el sensor de frecuencia cardíaca
Spo2_algorithm.h	Uso del medidor de oxígeno en sangre que incorpora el MAX30102EFD+
HeartRate.h	Complemento para las medidas biomédicas
NimBLEDevice.h	Comunicación BLE utilizando un 50 % de recursos del ESP32 respecto a la librería original
TaskScheduler.h	Gestión de tareas realizadas en paralelo

Tabla 4: Bibliotecas utilizadas en el sensor de la muñeca

Una vez declaradas las bibliotecas, se procede a la definición de variables que no hacen referencia a información confidencial de cara al acceso de la comunicación, tales como variables del sistema de detección de ejercicios y medición de datos biomédicos o punteros a características BLE. Tras esto, se detallan una serie de funciones propias del *Bluetooth* de baja energía, así como la codificación en lenguaje hexadecimal del logo del sistema.

Es entonces cuando se declara la tarea principal: la detección de ejercicios en el entorno de *fitness*. Utilizando el giroscopio y acelerómetro (MPU-6050), se realiza la función primordial del sistema de forma cíclica cada 200 ms, suficiente para el registro de cambios de posición.

El subsistema de la muñeca, que actúa como *master*, recibe la orden del inicio del entrenamiento, que se ve reflejada en la variable “workoutctrl”. Cuando esta toma el valor entero “1” se activa la sincronización de ambos subsistemas. Para ello, el nodo principal modifica la característica diseñada en la comunicación BLE (“Wrist”). Esta característica siempre tendrá un encabezado con la terminología “WM_”, independientemente del momento en el que se sitúe la sesión de entrenamiento, por lo que, para el inicio de este, está formada por una cadena de texto con valor “WM_1”. Es aquí cuando “workoutctrl” se reinicia para evitar un *bug* crítico donde la característica de la muñeca siempre tiene valor 1. Será en este punto donde el nodo del brazo, que actúa como *slave*, lee el valor obtenido y escribe en su propia característica (“Arm”) el mismo dato con el encabezado “AM_”. Debido a que la función lectura en ambos nodos se produce cada 333 ms, el *delay* obtenido en el proceso es muy pequeño y no afecta al correcto funcionamiento del sistema.

Una vez programado el proceso de sincronización entre ambos nodos, se detallan las particularidades del subsistema de la muñeca. Para definir qué ejercicios se está realizando se aplica un mecanismo de diferenciación de posiciones basados en un dado, donde cada lado de este corresponde a una posición del antebrazo. En la figura 22 se muestra la estructura que se menciona. A su vez, la tabla 5 muestra las posiciones a las que se hace referencia, junto con las aceleraciones que se deben recoger en el eje correspondiente.

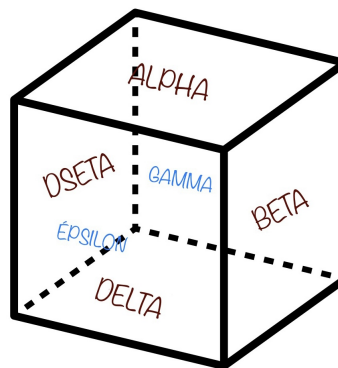


Figura 22: Representación de los lados escogidos para el acelerómetro en el nodo principal

Posición	Aceleración
Alpha	Eje Z >7 m/s ²
Delta	Eje Z <-7 m/s ²
Beta	Eje Y >7 m/s ²
Dseta	Eje Y <-7 m/s ²
Épsilon	Eje X >7 m/s ²
Gamma	Eje X <-7 m/s ²

Tabla 5: Relación entre las posiciones del subsistema de la muñeca y sus aceleraciones

Para el resto de valores comprendidos entre las aceleraciones destacadas se establece una posición trivial bajo el nombre “Half way”, que no produce ninguna modificación en el mecanismo de detección.

El algoritmo parte de dichas posiciones, las cuales se integran en una máquina de ocho estados, donde seis equivalen a “Alpha”, “Delta”, “Beta”, “Dseta”, “Épsilon” y “Gamma”, quedando dos adicionales que serán un estado inicial, necesario para reinicializar determinadas variables, y un estado final donde se determina las repeticiones que se han realizado para una serie concreta, almacenando en el registro el ejercicio realizado para comenzar con el proceso de nuevo.

En el presente proyecto se diferencian dos tipos de registro: el que se realiza mediante el subsistema de la muñeca y el que se realiza con el nodo del brazo. Esto se debe a las variaciones nulas en algunos movimientos para un determinado nodo. Un ejemplo de ejercicios que se detectan desde la muñeca es un *curl* concentrado de bíceps. Tal y como se ve en la figura 23, la parte superior del brazo se mantiene estática durante todo el movimiento correspondiente al ejercicio, mientras que es el antebrazo el que se desplaza. Para este caso, el subsistema de la muñeca parte desde una posición “Épsilon” y finaliza en una posición “Alpha”, mientras que el nodo superior se mantiene estable.

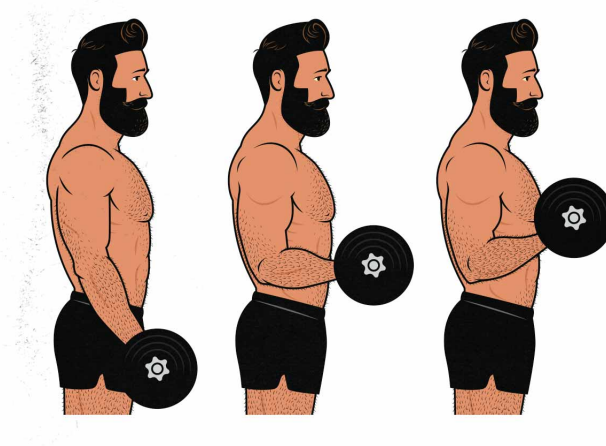


Figura 23: Procedimiento para la realización del *curl* de bíceps. Fuente: *Outlift*

Un total de 17 ejercicios recogidos se registran mediante el subsistema que actúa como *master*, aunque hay otros 13 para los que se requiere del *slave*, como se menciona posteriormente en el punto 5.3. En la tabla 6 se recoge la relación entre las posiciones del nodo inferior, el estado al que pertenecen y la cantidad de ejercicios en los que intervienen para los cinco grupos musculares de la parte superior del cuerpo que se engloban en el presente proyecto: pecho, espalda, bíceps, tríceps y hombros.

Posición	Estado	Pecho	Espalda	Bíceps	Tríceps	Hombros
<i>Alpha</i>	2	1	0	2	2	0
<i>Delta</i>	6	1	2	1	3	2
<i>Beta</i>	5	1	1	1	1	1
<i>Dseta</i>	7	0	0	1	0	0
<i>Épsilon</i>	4	2	1	3	7	3
<i>Gamma</i>	3	2	3	4	5	2

Tabla 6: Estados equivalentes a las posiciones del antebrazo y número de ejercicios para cada grupo muscular

Cabe recordar que las características implementadas en el protocolo *Bluetooth* de baja energía se van modificando a medida que se realizan los movimientos, a modo de mensajes que se codifican entre ambos subsistemas. Durante la ejecución del ejercicio, la característica del nodo inferior detalla el inicio y el final del movimiento de este. En la tabla 7 se determinan los códigos utilizados para la transmisión de información en el caso del subsistema de la muñeca.

Posición inicial	Estado inicial	Posición final	Estado final	Aceleración (m/s ²)	Codificación
Alpha	2	Gamma	3	-	WM_23
Épsilon	4	Épsilon	4	$\Delta ay > 2$	WM_04A
Épsilon	4	Épsilon	4	$\Delta ay \approx 0$	WM_04Q
Gamma	3	Gamma	3	$\Delta ax \approx 0$	WM_03Q
Gamma	3	Gamma	3	$\Delta ax > 2$	WM_03A
Beta	5	Beta	5	-	WM_05
Delta	6	Delta	6	-	WM_06

Tabla 7: Codificación de mensajes del nodo de la muñeca

Una vez finalizado el entrenamiento, se desmarca el botón correspondiente, ordenando así que la sesión ha terminado. Esto se identifica en el algoritmo con la variable mencionada anteriormente “workoutctrl”, que toma el valor entero “2”, lo que provoca la suspensión de la tarea de detección de posición. La característica perteneciente al *master* toma la codificación “WM_96”, que interpretará el nodo superior para detener su proceso equivalente. Es aquí donde se ordena el envío del correo electrónico utilizando el protocolo SMTP, la carga del registro a la base de datos *ThingSpeak* y el guardado automático en la memoria EEPROM del sistema. En la pantalla del nodo inferior se mostrará el mensaje de finalización mostrado anteriormente, con las instrucciones correspondientes.

Más allá de esto se encuentran las funciones *setup()*, donde se inician diferentes componentes como la conexión *Bluetooth*, el puerto serie con la pantalla y el giroscopio más acelerómetro, o la lectura de la EEPROM. La función *FinishWorkout()* corresponde al envío del correo electrónico, al registro y almacenamiento de la información y lo relacionado con la base de datos, mientras que *ReadingEEPROM()* realiza la lectura de la sesión anterior, junto a la creación del servidor HTTP mediante la función *webServer()*.

5.3. Código embebido para el nodo situado en el brazo

El esquema que se sigue para el nodo superior es similar, aunque añade simplicidad respecto al nodo de la muñeca, ya que se rescinde de parámetros como la creación del servidor BLE o el envío del correo electrónico bajo el protocolo SMTP. Además, el número de ejercicios registrados desde este punto es de 13, lo que conforma una reducción significativa en términos de memoria *flash* y operaciones en tiempo real.

De la misma forma que en el apartado anterior, se va a diferenciar dos tipos de tareas que se realizan cíclicamente durante el transcurso del entrenamiento: la modificación de la característica correspondiente a la comunicación *Bluetooth* del subsistema (“Arm”), y la detección de la posición y el movimiento de este.

Como se ha mencionado anteriormente, el encabezado del mensaje que se utiliza en este nodo es “AM_” seguido de un código numérico que indica el recorrido que realiza durante la serie. Sin embargo, se requiere de un segundo encabezado para los ejercicios detectados desde este punto, ya que se debe enviar la información al subsistema *master* para el registro y la agrupación de los datos obtenidos. Este último encabezado será “EX_” seguido del código correspondiente del ejercicio realizado y el número de repeticiones realizadas para dicha serie.

Partiendo de esto, se definen seis posiciones posibles diferenciables en el nodo superior, las mismas que para la muñeca, con la diferencia de la posición “Eta”, que no se aplica en ninguno de los ejercicios programados, por lo que su existencia es meramente simbólica y sujeta a la adición de más movimientos. Las diferentes caras del dado se pueden visualizar en la tabla 8 que se adjunta a continuación:

Posición	Aceleración
Theta	Eje Z <-7 m/s ²
Iota	Eje Z >7 m/s ²
Kappa	Eje X <-7 m/s ²
Eta	Eje X >7 m/s ²
Lambda	Eje Y <-7 m/s ²
Mi	Eje Y >7 m/s ²

Tabla 8: Relación entre las posiciones del subsistema del brazo y sus aceleraciones

De la misma manera que se realiza para el nodo inferior, se incorpora una posición “Half Way” que no aporta nada en el registro, y únicamente se utiliza como puente hacia otra posición.

En este nodo se detecta un total de 13 ejercicios en los que principalmente se localiza una variación en la parte superior del brazo, junto a un período de inmovilidad por parte del antebrazo. Un ejemplo de esto es el conocido *press* de hombros que se puede visualizar en la figura 24.

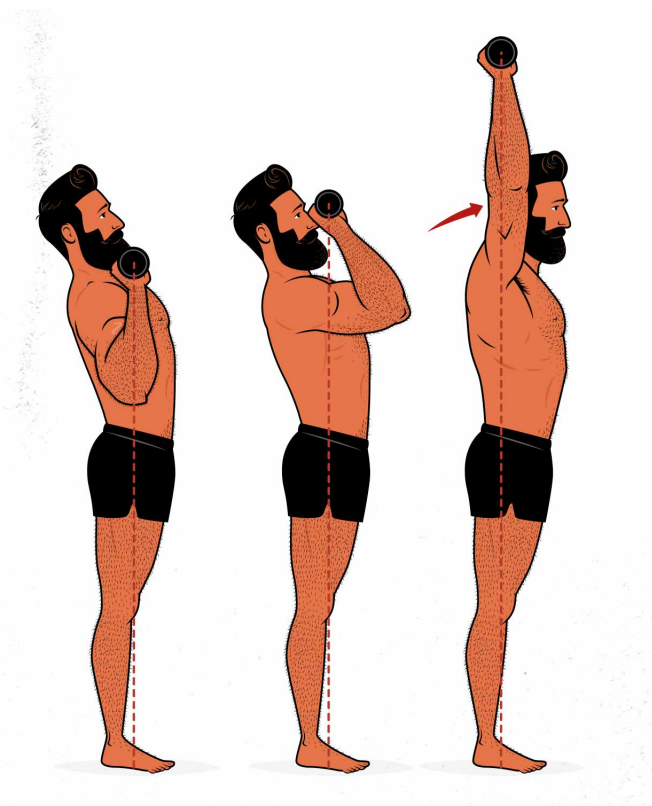


Figura 24: Procedimiento para la realización del *press* de hombros. Fuente: *Outlift*

Conociendo el mecanismo que se ha empleado para ambos subsistemas, se puede observar que la orientación del antebrazo no varía durante el desarrollo completo del ejercicio, mientras que es la parte superior la que sufre un cambio respecto a su posición inicial. Por tanto, el nodo inferior se mantiene en posición “Gamma” durante todo el transcurso de la serie, enviando un código “WM_03A” a la característica del antebrazo (“Wrist”), mientras que el nodo superior partirá desde una posición “Mi” y finalizará en “Kappa”. El sistema está diseñado para que no existan conflictos entre ejercicios, por lo que el subsistema del húmero detecta el ejercicio que se está realizando y, una vez finalizado, codifica su característica (“Arm”) con el valor “EX_24_X”, donde 24 es la posición para *press* de hombros del *array* que incorpora todos los ejercicios programados y X corresponde al número de repeticiones realizadas, añadiendo una serie más en el registro. Esta información es leída por el *master*, que lo añade al resumen e inicia una nueva sincronización.

En la tabla 9 que se adjunta se relaciona, de igual manera que en el apartado anterior, cada posición implementada con el estado al que pertenece en la máquina de estados y el número de ejercicios en los que interviene para cada grupo muscular.

Posición	Estado	Pecho	Espalda	Bíceps	Tríceps	Hombros
<i>Theta</i>	3	2	1	0	0	1
<i>Iota</i>	5	2	2	3	7	4
<i>Kappa</i>	2	3	4	0	0	4
<i>Lambda</i>	6	1	2	0	2	0
<i>Mi</i>	4	4	4	1	6	2

Tabla 9: Estados equivalentes a las posiciones del húmero y número de ejercicios para cada grupo muscular

Cabe destacar que la máquina de estados que se implementa en este nodo cuenta con un total de siete estados, uno menos que el nodo inferior, debido a la posición que no tiene relevancia en el proceso.

Se incorpora en la tabla 10, además, la lista de códigos que pueden aparecer en la característica *Bluetooth* del húmero debidos al comportamiento durante el movimiento general.

Posición inicial	Estado inicial	Posición final	Estado final	Aceleración (m/s ²)	Codificación
Kappa	2	Kappa	2	-	AM_02
Iota	5	Kappa	2	-	AM_52
Iota	5	Theta	3	-	AM_53
Iota	5	Mi	4	-	AM_54
Iota	5	Lambda	6	-	AM_56
Iota	5	Iota	5	-	AM_05
Mi	4	Kappa	2	-	AM_42
Mi	4	Iota	5	-	AM_45
Mi	4	Mi	4	$\Delta az \approx 0$	AM_04Q
Mi	4	Mi	4	$\Delta az > 2,5$	AM_04A
Theta	3	Iota	5	-	AM_35
Theta	3	Theta	3	-	AM_03

Tabla 10: Codificación de mensajes del nodo del húmero

Además, se implementan dos posibles opciones de cara a la finalización de la detección del ejercicio y el inicio de uno nuevo:

- Se crea un variable denominada “a_total” que equivale a la suma de los valores absolutos de las aceleraciones en cada eje al cuadrado. En el análisis experimental se verificó que un ejercicio tiene un margen de aceleraciones de 7 a 20 m/s² para esta variable. Para darle un coeficiente de seguridad fiable, se establece un valor de 40 m/s², identificado como una agitación en el nodo de la muñeca, a modo de reinicio manual. Por tanto, si el subsistema detecta que el valor que toma “a_total” es mayor a 40 m/s², el algoritmo se trasladará directamente al estado 8, donde se registra lo realizado y se reinicia la detección.

- Por otro lado, un momento donde ambos nodos se mantienen estáticos durante más de 12 segundos, sin cambiar de posición en ningún instante. Esto se produce comúnmente en etapas de descanso entre ejercicios, lo que permite un reinicio automático de la detección.

La tabla 11 muestra una serie de códigos genéricos para la comunicación entre ambos nodos, relacionados con lo visto anteriormente, mientras que las tablas 12 y 13 profundizan en detalle las condiciones y los mensajes que se transmiten para cada uno de los ejercicios propuestos.

Orden	Emisor	Receptor	Codificación
Subsistema preparado	Ambos	Ambos	WM_1 AM_1
Fin de la sesión	Antebrazo	Húmero	WM_96
Adición de una serie	Antebrazo	Húmero	WM_97
Inicio manual	Antebrazo	Húmero	WM_98
Tiempo >12 segs	Ambos	Ambos	WM_99 AM_99

Tabla 11: Códigos de comunicación entre nodos

Ejercicio	Número	Grupo muscular	Nodo inferior	Nodo superior	Condición N.I.	Condición N.S.	Código N.I.	Código N.S.
Curl simple	Exercise[1]	Bíceps	Alpha-Gamma	Mi-Mi	Estado inicial: 2	Estado fijo: 4	Ninguno	AM_04Q
					Cambio de estado (2-3)			
Hammer	Exercise[2]	Bíceps	Épsilon-Beta	Iota-Iota	Estado inicial: 4	Estado fijo: 5	Ninguno	AM_05
					Cambio de estado (4-5)			
Curl concentrado	Exercise[3]	Bíceps	Épsilon-Alpha	Iota-Iota	Estado inicial: 4	Estado fijo: 5	Ninguno	AM_05
					Cambio de estado (4-2)			
Curl inverso	Exercise[4]	Bíceps	Épsilon-Delta	Iota-Iota	Estado inicial: 4	Estado fijo: 5	Ninguno	AM_05
					Cambio de estado (4-6)			
Extensión c/cuerda	Exercise[5]	Tríceps	Gamma-Épsilon	Mi-Iota	Estado inicial: 3	Cambio de estado (4-5)	Ninguno	AM_45
					Cambio de estado (3-4)			
Extensión c/barra	Exercise[6]	Tríceps	Gamma-Épsilon	Iota-Iota	Estado inicial: 3	Cambio de estado (4-5)	Ninguno	AM_05
					Cambio de estado (3-4)			
					Estado intermedio: 6			
Extensión inversa	Exercise[7]	Tríceps	Gamma-Épsilon	Iota-Iota	Estado inicial: 3	Cambio de estado (4-5)	Ninguno	AM_05
					Cambio de estado (3-4)			
					Estado intermedio: 2			
Fondos	Exercise[10]	Tríceps	Épsilon-Épsilon	Lambda-Iota	Estado fijo: 4	Cambio de estado (6-5)	WM_04Q	Ninguno
					Tríceps >Pecho			
					$\Delta ay \approx 0 \text{ m/s}^2$	Estado inicial: 6		
Flexiones diamante	Exercise[30]	Tríceps	Épsilon-Delta	Iota-Lambda	Estado inicial: 4	Cambio de estado (5-6)	Ninguno	AM_56
					Cambio de estado (4-6)			
Press	Exercise[24]	Hombros	Gamma-Gamma	Mi-Kappa	Estado fijo: 3	Cambio de estado (4-2)	WM_03A	Ninguno
						Pecho >Hombros		
						Estado inicial: 4		
Apertura (acostado)	Exercise[12]	Pecho	Alpha-Gamma	Mi-Kappa	Estado inicial: 2	Cambio de estado (4-2)	Ninguno	AM_42
					Cambio de estado (2-3)			
Apertura(erguido)	Exercise[13]	Pecho	Beta-Beta	Theta-Theta	Estado fijo: 5	Estado fijo: 3	Ninguno	AM_03
					Estado inicial: 5			
					$\Delta az > 2.5 \text{ m/s}^2$			
Empuje	Exercise[14]	Pecho	Delta-Delta	Theta-Theta	Estado fijo: 6	Estado fijo: 3	Ninguno	AM_03
					Estado inicial: 6			
					$\Delta ay > 2.5 \text{ m/s}^2$			
Flexiones	Exercise[15]	Pecho	Épsilon-Épsilon	Iota-Lambda	Estado fijo: 4	Cambio de estado (5-6)	WM_04Q	Ninguno
					Tríceps <Pecho			
					$\Delta ay \approx 0 \text{ m/s}^2$	Estado inicial: 5		
Levantamiento	Exercise[16]	Pecho	Épsilon-Alpha	Iota-Mi	Estado inicial: 4	Cambio de estado (5-4)	Ninguno	AM_54 AM_45
					Cambio de estado (4-2)			
Dominadas	Exercise[18]	Espalda	Gamma-Gamma	Kappa-Mi	Estado fijo: 3	Cambio de estado (2-4)	WM_03Q	Ninguno
					$\Delta ay \approx 0 \text{ m/s}^2$	Estado inicial: 2		
Jalón al pecho (abierto)	Exercise[19]	Espalda	Gamma-Gamma	Kappa-Mi	Estado fijo: 3	Cambio de estado (2-4)	WM_03A	Ninguno
					$\Delta ay < -2.5 \text{ m/s}^2$	Estado inicial: 2		
Press hombros	Exercise[24]	Hombros	Gamma-Gamma	Mi-Kappa	Estado fijo: 3	Cambio de estado (4-2)	WM_03A	Ninguno
						Hombros >Pecho		
						Estado inicial: 4		

Tabla 12: Condiciones de ambos nodos para la detección de los ejercicios (I)

Ejercicio	Número	Grupo muscular	Nodo inferior	Nodo superior	Condición N.I.	Condición N.S.	Código N.I.	Código N.S.
Apertura	Exercise[25]	Hombros	Delta-Delta	Theta-Theta	Estado inicial: 3	Estado fijo: 3	Ninguno	AM_03
					Estado fijo: 3			
					$\Delta az < -2.5 \text{ m/s}^2$			
Elevación lateral	Exercise[27]	Hombros	Épsilon-Beta	Iota-Mi	Cambio de estado (4-5)	Cambio de estado (5-4)	Ninguno	AM_54
Vuelo	Exercise[28]	Hombros	Épsilon-Delta	Iota-Kappa	Estado inicial: 4	Cambio de estado (5-2)	Ninguno	AM_52
					Cambio de estado (4-6)			
Jalón al pecho (cerrado)	Exercise[20]	Espalda	Gamma-Gamma	Kappa-Iota	Estado fijo: 3	Cambio de estado (2-5)	WM_03A	Ninguno
					$\Delta ay < -2.5 \text{ m/s}^2$	Estado inicial: 2		
Atracción c/cuerda	Exercise[21]	Hombros	Delta-Delta	Theta-Mi	Estado fijo: 6	Cambio de estado (3-4)	WM_06	Ninguno
						Estado inicial: 3		
Remo c/polea (V)	Exercise[22]	Espalda	Beta-Beta	Mi-Mi	Estado inicial: 5	Estado fijo: 4	Ninguno	AM_04Q
					Estado fijo: 5			
					$\Delta ay < -2.5 \text{ m/s}^2$			
Remo c/polea (H)	Exercise[23]	Espalda	Delta-Delta	Theta-Theta	Estado inicial: 6	Estado fijo: 2	Ninguno	AM_03
					Estado fijo: 6			
					$\Delta ay > 2.5 \text{ m/s}^2$			
Remo al cuello	Exercise[17]	Hombros	Épsilon-Delta	Iota-Theta	Estado inicial: 4	Cambio de estado (5-3)	Ninguno	AM_53
					Cambio de estado (4-6)			
Pull-over	Exercise[32]	Espalda	Delta-Épsilon	Theta-Iota	Cambio de estado (6-4)	Cambio de estado (3-5)	Ninguno	AM_35
					Estado inicial: 6	Espalda > Pecho		
Apertura inferior	Exercise[33]	Pecho	Delta-Épsilon	Theta-Iota	Cambio de estado (6-4)	Cambio de estado (3-5)	Ninguno	AM_35
					Estado inicial: 6	Pecho > Espalda		
Remo horizontal	Exercise[31]	Espalda	Épsilon-Épsilon	Lambda-Iota	Estado fijo: 4	Estado inicial: 6	WM_04A	Ninguno
						$\Delta ay > 2.5 \text{ m/s}^2$		
Extensión vertical	Exercise[29]	Tríceps	Dseta-Gamma	Theta-Theta	Estado inicial: 7	Ninguno	Ninguno	Ninguno
					Cambio de estado (7-3)			

Tabla 13: Condiciones de ambos nodos para la detección de los ejercicios (II)

Funcionalidades adicionales

6. Funcionalidades adicionales

En el presente capítulo se detallan las funcionalidades que se añaden de forma adicional al cómputo general del sistema, orientadas a una mayor integración de cara al usuario y al registro de componentes que complementan al análisis de una sesión de gimnasio.

6.1. Biblioteca NimBLE para Arduino

El módulo ESP32 que se integra en el dispositivo cuenta con unas bibliotecas oficiales para el IDE de Arduino. Estas permiten la programación de los módulos para el uso de comunicación *Bluetooth* y, más específicamente, *Bluetooth* de baja energía, lo que facilita la interacción con el microcontrolador desde un inicio, ya que se adjuntan códigos de ejemplo de fácil sustitución, explicaciones de la sistemática a seguir por parte del fabricante y tutoriales oficiales para el buen uso del algoritmo.

Sin embargo, se ha demostrado a lo largo del tiempo que estas bibliotecas ocupan un porcentaje mayoritario de la memoria *flash* con las que cuentan los ESP32, alcanzando cantidades del 80 % para códigos simples y ejemplos clásicos. Esto produce un ínfimo margen de maniobra de cara a desarrollar otras tareas que se ejecuten en paralelo con la comunicación entre módulos, como es el proyecto que se presenta. Es por ello que se decide aplicar la librería NimBLE diseñada por el autor H2Zero [21].

La biblioteca NimBLE se caracteriza por la reducción en un 50 % de espacio para la memoria *flash* para la misma funcionalidad, y el uso de 100 kb menos de memoria RAM. Además, es 100 % compatible con todos los controladores para los que se puede desarrollar la biblioteca original de Arduino. En la tabla 14 se puede observar una comparación de la ocupación de memoria para ambas bibliotecas, demostrando la reducción a la mitad de los recursos requeridos:

Ejemplo	Librería Arduino BLE	Librería NimBLE-Arduino
BLE_client	58 % (<i>Heap</i> libre = 171548)	29 % (<i>Heap</i> libre = 270336)
BLE_notify	57 % (<i>Heap</i> libre = 173300)	28 % (<i>Heap</i> libre = 269792)

Tabla 14: Comparación de ocupación del almacenamiento del programa para las librerías Arduino BLE y NimBLE-Arduino

En el presente proyecto se utiliza un único servicio denominado “ActionsService”, que contiene tres características:

- La primera muestra la posición del nodo inferior (“Wrist”), con UUID “d6597e78-c992-4f43-9861-719b78932fa6”, teniendo propiedades de lectura encriptada, escritura y notificación.
- La segunda detalla el movimiento del nodo del húmero (“Arm”), con UUID “84d8a625-08f9-49b3-82fb-d85daffc3c39” y las mismas propiedades que la primera.
- La tercera y última es una característica de control de la aplicación (“InfoBLE”), lo que permitirá enlazar los comandos de la *app* con sus variables en el código del sistema. Tendrá UUID “beb5483e-36e1-4688-b7f5-ea07361b26a8” y propiedades básicas de lectura, escritura y notificación.

Tal y como se menciona en el apartado 5 del presente proyecto, las características de la muñeca y el nodo superior envían constantemente mensajes con el encabezado “WM_”, “AM_” y “EX_”, siendo el primer código para el subsistema principal, mientras que los otros dos pertenecen al *slave*. Sin embargo, la característica informativa cuenta con diferentes mensajes que se interpretan en el sistema provenientes de la aplicación móvil. Esta codificación se ve representada en la tabla 15:

Código	Interpretación
Reminder	Acceso a los datos almacenados en la EEPROM con la última sesión guardada
Ready	Emparejamiento exitoso entre la aplicación y el dispositivo
Email	Activación o desactivación del correo electrónico enviado al final del entrenamiento
WorkoutOn	Inicio de la detección de ejercicios
WorkoutOff	Finalización de la sesión de entrenamiento
LegsOn	Activación de la detección de ejercicios pertenecientes al tronco inferior
LegsOff	Desactivación de la detección de ejercicios de piernas
WakeUp	Activación del dispositivo tras el modo <i>sleep</i>
Sleep	Entrada al modo hibernación del dispositivo

Tabla 15: Códigos informativos enviados por la aplicación e interpretados por el sistema

6.2. Aplicación Android/iOS

Para el desarrollo de la aplicación funcional en los sistemas operativos móviles *Android* e *iOS* se utiliza la plataforma *web* denominada *Thunkable*, que permite la creación de *apps* nativas en un sólo *framework* de una manera intuitiva y práctica, con funciones *live* orientadas a la puesta en práctica constante mediante sincronización entre el servidor de la plataforma y su *app* correspondiente. Además, cuenta con sistemas avanzados de lectura de características *Bluetooth*, además de componentes básicos como botones, *switches*, etiquetas, *timers* o controles.

Tal y como se ha visto en el punto 5.1, se programan cuatro pantallas con sus respectivas opciones, lo que permite al usuario un manejo cómodo y rápido del sistema de cara al control del dispositivo, así como la visualización de los parámetros detectados a lo largo de las sesiones. En la figura 25 se puede observar el panel de edición de los bloques correspondientes a cada elemento de la pantalla.

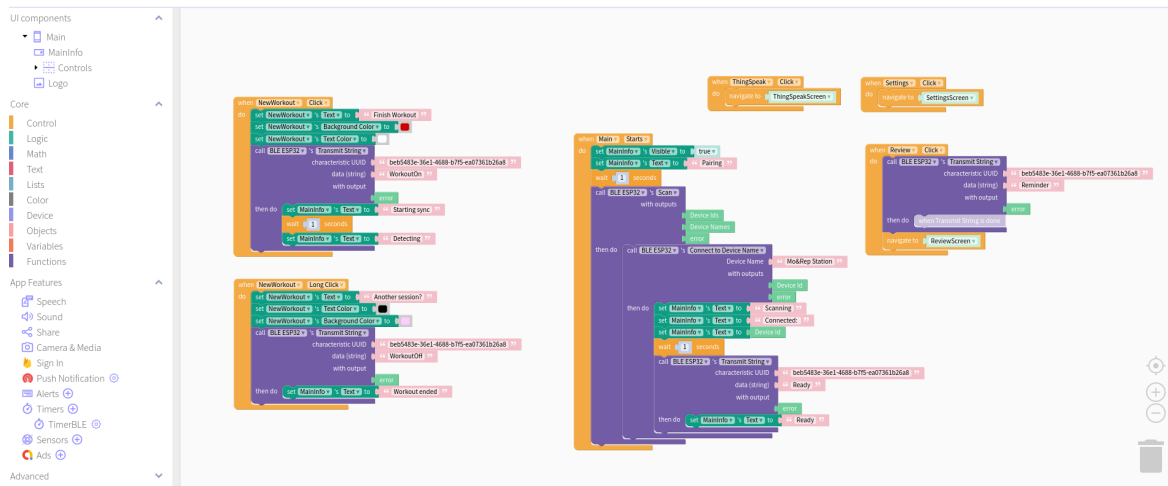


Figura 25: Pantalla de edición de bloques para la creación de una app

6.3. Sleep Mode

De cara a mejorar la autonomía de los dispositivos, se programa una función dedicada a la reducción de la frecuencia de reloj del microcontrolador. Este funciona de forma activa a 240 MHz, pudiendo reducirse hasta los 10 MHz. Sin embargo, para despertarlo de nuevo se necesita de la aplicación, que trabaja a través de *Bluetooth*, y este protocolo está limitado a los 80 MHz.

Es por ello que, una vez detecta que no se está realizando ningún entrenamiento, mediante las variables “workoutctrl” y un tiempo estimado de 30 minutos, el sistema limita su frecuencia a 80 MHz, y se desactivan las tareas correspondientes al MPU-6050 (acelerómetro). De esta manera, sólo se ejecuta de forma cíclica la lectura del servicio de BLE, reduciendo la carga de trabajo del microcontrolador y aumentando la autonomía de la batería.

6.4. Corrección de posturas

A modo de testeo y programación en versión *alpha*, se implementa un sistema que compara las aceleraciones y orientaciones medias durante el desarrollo de un ejercicio con los valores ideales que deberían tener estas. Se hace una estimación y se determina que la inclinación de los movimientos no debe sobrepasar un el 50 % de las ideales. Matemáticamente, se puede considerar como límite 1.5 veces el valor de la orientación ideal para el nodo inferior, que corresponde con la muñeca. Este sistema está diseñado para la futura implementación de un nodo central colocado en el torso, que permitirá corregir posturas de la espalda a la hora de realizar una sesión de entrenamiento, ya que es la parte del cuerpo más susceptible a lesiones y con mayor índice de gravedad.

La comparación se realiza una vez finalizada la serie, indicándose un mensaje en el *display* del nodo de la muñeca con el texto “Corrige tu postura”.

6.5. Ejercicios del tronco inferior

Se estudia el desarrollo del sistema diseñado en ejercicios del tronco inferior, siendo un total de 6, entre los que destacan sentadillas, *curl* de cuádriceps o peso muerto.

El funcionamiento es el mismo que para el tronco superior, ya que se coloca uno de los nodos en el cuádriceps y otro por debajo de la rodilla, ambos por la cara interna de la pierna, para evitar presiones y golpes con las máquinas propias de un gimnasio. Cabe destacar que, para el nodo *slave*, la máquina de estados tendrá 8 estados, al igual que el *master*, ya que se hace uso de la posición “Eta”, que ocupa el estado 7. En la tabla 16 se refleja, tal y como se hizo con el tronco superior, las condiciones a las que están sometidos los nodos durante el transcurso de cada ejercicio.

Ejercicio	Número	Grupo muscular	Nodo inferior	Nodo superior	Condición N.I.	Condición N.S.	Código N.I.	Código N.S.
Sentadillas	Exercise[1]	Piernas	Eta-Eta	Épsilon-Beta	Estado fijo: 7	Cambio de estado(4-5) Estado inicial: 4	AM_07	Ninguno
Curl de cuádriceps	Exercise[2]	Piernas	Eta-Mi	Beta-Beta	Cambio de estado(7-4) Estado inicial: 7	Estado fijo: 5	Ninguno	WM_05
Peso muerto	Exercise[3]	Piernas	Eta-Eta	Beta-Épsilon	Estado fijo: 7	Cambio de estado(5-4) Estado inicial: 5	AM_07	Ninguno
Prensa	Exercise[4]	Piernas	Kappa-Kappa	Gamma-Dseta	Estado fijo: 2	Cambio de estado(3-7) Estado inicial: 3	AM_02	Ninguno
Curl de femoral	Exercise[5]	Piernas	Mi-Eta	Beta-Beta	Cambio de estado(4-7) Estado inicial: 4	Estado fijo: 4	Ninguno	WM_05
Curl de femoral 2	Exercise[6]	Piernas	Lambda-Kappa	Dseta-Dseta	Cambio de estado(6-2) Estado inicial: 6	Estado fijo: 7	Ninguno	WM_07

Tabla 16: Condiciones de ambos nodos para la detección de los ejercicios de tronco inferior

Validación y verificación

7. Validación y verificación

Se realizan una serie de pruebas en entornos controlados. Se colocan las respectivas PCBs en la prenda personalizada y se ejecuta el proceso para la detección de ejercicios como se ha mencionado en el capítulo 5. Tras esto, se ejecutan una serie de ejercicios y series para comprobar la eficacia del sistema. El resultado de estas pruebas se adjuntan en las tablas 17, 18, 19, 20, 21 y 22:

Entreno	Ejercicios	Series reales	Reps reales	Series detectadas	Reps detectadas	% acierto	
1	Curl concentrado	4	12	4	12	100 %	
			10		10		
			8		8		
			6		6		
	Martillo	4	4	12	4	12	100 %
				10		10	
				8		8	
				6		6	
	Curl inverso	4	4	12	4	12	97,22 %
				10		10	
				8		8	
				6		5	
	Curl simple	4	4	12	4	12	100 %
				10		10	
				8		8	
				6		6	

Tabla 17: Pruebas realizadas para el entrenamiento de bíceps

Entreno	Ejercicios	Series reales	Reps reales	Series detectadas	Reps detectadas	% acierto	
2	Extensión inversa	4	12	4	11	94,44 %	
			10		11		
			8		8		
			6		6		
	Extensión con barra	4	4	12	4	12	100 %
				10		10	
				8		8	
				6		6	
	Extensión vertical	4	4	12	4	12	100 %
				10		10	
				8		8	
				6		6	
	Fondos	4	4	12	4	12	100 %
				10		10	
				8		8	
				6		6	

Tabla 18: Pruebas realizadas para el entrenamiento de tríceps

Entreno	Ejercicios	Series reales	Reps reales	Series detectadas	Reps detectadas	% acierto	
3	Dominadas	4	12	4	12	100 %	
			10		10		
			8		8		
			6		6		
	Jalón al pecho	4	4	12	4	10	91,67 %
				10		10	
				8		7	
				6		6	
	Remo horizontal	4	4	12	4	10	94,44 %
				10		10	
				8		7	
				6		6	
	Pull-over	4	4	12	4	11	91,67 %
				10		10	
				8		7	
				6		5	

Tabla 19: Pruebas realizadas para el entrenamiento de espalda

Entreno	Ejercicios	Series reales	Reps reales	Series detectadas	Reps detectadas	% acierto	
4	Press	4	12	4	11	88,89 %	
			10		9		
			8		6		
			6		6		
	Levantamiento	4	4	12	4	12	100 %
				10		10	
				8		8	
				6		5	
	Apertura	4	4	12	4	12	100 %
				10		10	
				8		8	
				6		6	
	Flexiones	4	4	12	4	12	100 %
				10		10	
				8		8	
				6		6	

Tabla 20: Pruebas realizadas para el entrenamiento de pecho

Entreno	Ejercicios	Series reales	Reps reales	Series detectadas	Reps detectadas	% acierto	
5	Vuelo	4	12	4	11	91,67 %	
			10		10		
			8		8		
			6		4		
	Press	4	4	12	4	12	94,44 %
				10		10	
				8		7	
				6		5	
	Remo al cuello	4	4	12	4	12	100 %
				10		10	
				8		8	
				6		6	
	Elevación lateral	4	4	12	4	12	91,67 %
				10		9	
				8		6	
				6		6	

Tabla 21: Pruebas realizadas para el entrenamiento de hombros

Entreno	Ejercicios	Series reales	Reps reales	Series detectadas	Reps detectadas	% acierto	
6	Sentadilla	4	12	4	12	100 %	
			10		10		
			8		8		
			6		6		
	Curl de cuádriceps	4	4	12	4	11	94,44 %
				10		10	
				8		8	
				6		5	
	Curl de femoral	4	4	12	4	11	91,67 %
				10		8	
				8		8	
				6		6	

Tabla 22: Pruebas realizadas para el entrenamiento de piernas

Haciendo un porcentaje de acierto total del 96,62 %. Cabe destacar que el uso de tecnología BLE produce una pequeña latencia a la hora de leer las características y escribirlas al mismo tiempo, lo que perjudica en algunos casos la detección de la primera repetición. Se realizaron pruebas utilizando una *mesh WiFi* con la misma metodología, y al tener mayor capacidad se producía un funcionamiento en tiempo real más eficaz que el que se produce con *Bluetooth Low Energy*. Además, el sistema tiene dificultades con aquellos ejercicios que dependen del movimiento en un único eje donde no se modifica las posiciones iniciales y finales. Sin embargo, es muy eficaz en aquellos ejercicios articulados, tales como *curl* de bíceps, dominadas o extensión vertical. Igualmente, el sistema implementado supera a alternativas similares, tanto en el mercado, como en el ámbito de la investigación, ya que se comporta de manera autónoma registrando una amplia variedad de ejercicios con un porcentaje de acierto muy elevado.

Conclusiones y potenciales aplicaciones

8. Conclusiones y potenciales aplicaciones

En el presente documento se ha desarrollado la creación de un sistema de detección de movimientos y parámetros biomédicos orientados al sector deportivo, y en concreto, el *fitness*, resumido en la aplicación de un sensor capaz de hallar las aceleraciones y orientación de un nodo colocado en la parte inferior del brazo, y la comunicación de estos valores con un homónimo situado a la zona alta de la misma extremidad. Mediante la creación de una interfaz integrada en una aplicación para dispositivos móviles, se recogen las repeticiones realizadas para un conjunto de 36 ejercicios preprogramados, agrupándose en series que se registran y se almacenan para el análisis posterior de la sesión de entrenamiento.

En primer lugar se ha realizado un estudio de mercado, así como del ámbito de la investigación, para buscar el punto de innovación que requiere el proyecto que se presenta, tras lo cual se alcanza la conclusión de haber desarrollado un sistema diferenciador en términos de amplitud de ejercicios y practicidad de uso respecto a lo visto hasta el momento. Una vez finalizado este apartado, se destacan los componentes en términos de *hardware* en los que se basa el dispositivo, haciendo hincapié en sus principales circuitos integrados (MPU-6050 y ESP32-WROOM-32D), dando el salto posteriormente a los fundamentos teóricos escondidos tras el funcionamiento de cada apartado relevante, entre los que se destacan el protocolo *Bluetooth Low Energy*, SMTP para el envío de correos electrónicos, el servidor HTTP y el funcionamiento del IMU incorporado. Se continúa con la explicación en detalle del procedimiento que realiza el algoritmo, profundizando en la codificación de los mensajes y en la distribución de la detección de los ejercicios programados en los nodos correspondientes, adjuntando tablas y figuras que los ejemplifican y que sintetizan la información redactada. La validación de los datos obtenidos en entornos controlados, con un porcentaje de acierto del 96,62 % y la descripción de las posibles mejoras a implementar vienen precedidas por las funcionalidades adicionales que se incorporan, donde se mencionan las plataformas, bibliotecas y funciones que complementan al código principal.

De cara a una línea futura de desarrollo, se considera la implementación de mecanismos de *machine learning* para una detección más precisa de ejercicios y rutinas, y la posibilidad de incrementar el número de estos mediante ejemplos personalizados contrastados con una base de datos. Esto se puede representar con el estudio por parte del algoritmo de los grupos musculares que se trabajan en función al día de la semana, algo que es muy popular entre los practicantes del *fitness*. A partir de esto, se podrían implementar probabilidades en la realización de otros ejercicios o en el trabajo de otros músculos, afinando la detección de las sesiones. De cara a la corrección de posturas, un sistema de mayor eficacia tendría que tener en cuenta cada ejercicio de forma individual y detallar cómo se debe corregir la postura para los tres nodos propuestos (antebrazo, brazo y espalda) basándose en el sistema que se implementa de forma experimental en el presente proyecto.

Más allá del sector deportivo, el uso de un circuito integrado como el MPU-6050, capaz de medir aceleración y orientación podría ser útil para determinados colectivos en el ámbito sanitario. Un ejemplo es la detección de ataques repentinos en personas que sufran enfermedades como el Parkinson. Utilizándolo con el sistema de frecuencia cardíaca, que podría comprobar un aumento de esta de forma instantánea, podría evaluar el riesgo de la situación y conectarse de forma remota al servidor del centro médico más cercano, o incluso podría tener la capacidad de ir administrando, junto a la ayuda de un profesional, las dosis correspondientes a la medicación que regula estos ataques, ya que se detallaría de una forma exacta la frecuencia a la que surgen estos.

8.1. Conclusions and potential applications

In the present document, the creation of a movements detection system and biomedical parameters oriented to the sports sector, specifically, fitness, is developed, summarized in the application of a sensor capable of detecting the accelerations and orientation of a node situated in the low part of the arm, and the communication of these values with the same structure located in the high part of it. Through the creation of an integrated interface inside a smartphone app, the repetitions for 36 different preprogrammed exercises are recollected and grouped in series that are recorded and stored for the consequent analysis of the workout session.

First of all, it has been done a study for the global market, in addition to the research sector, to look for the point of innovation that practices the project that is presented. After this, the conclusion to do a different system in terms of variety of exercises and practicality is reached, and once finished this part, all the components related to the hardware are highlighted, focusing on the main integrated circuits of the device (MPU-6050 and ESP32-WROOM-32D), taking the leap to the theoretical fundamentals that are below each protocol that is used, like Bluetooth Low Energy or SMTP for the sending of an email at the end of the session. Also, the physical concepts of the used IMU are established. Next to it, the code is explained with details, including the practical process of the algorithm, the codification of the messages, and the distribution of the detection of the exercises in both nodes, attaching tables and figures that work as examples and help to comprehend the written information. The validation of the obtained values in controlled environments, with a success rate of 96,62 % and the description of the possible improvements, is preceded by the additional functions that are implemented, where the platforms, libraries, and complementary functions of the main code are mentioned.

Facing a future development line, the implementation of mechanisms based on deep learning are considered for more accurate detection of exercises and routines and the possibility of increasing the quantity of these through customized examples contrasted with a database. This can be represented with the study of the algorithm of the muscle groups that are worked depending on the day of the week, something that is so popular among practitioners of fitness. From this, it could be implemented probabilities doing other exercises or the work of other muscles, increasing the accuracy of the detections. Regarding fixing the postures, a more efficient system would have to consider each exercise and detail how the posture can be fixed for the two (or three) different nodes, based on the system implemented in the present project.

Beyond the sports sector, the use of an integrated circuit such as the MPU-6050, capable of measuring acceleration and orientation, could be helpful for determining collectives in the health field. An example is the detection of sudden attacks in people that suffer from diseases like Parkinson's. Using it with the heart-rate sensor, that could check an increase of this instantly; it could be evaluated the risk of the situation and connect remotely to the server of the closest medical center, or even could have the capability of manage, with the help of a professional, the corresponding doses to the medication that controls these attacks, because the frequency of these could be detailed.

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Anexos

Código correspondiente al nodo inferior

```
1  #include <ESP_Mail_Client.h>
2  #include <Arduino.h>
3  #include <Wire.h>
4  #include <Adafruit_GFX.h>
5  #include <Adafruit_SSD1306.h>
6  #include "I2Cdev.h"
7  #include "MPU6050.h"
8  #include "string.h"
9  #include <EEPROM.h>
10 #include <Separador.h>
11 #include "ThingSpeak.h"
12 #include "secrets.h"
13 #include "MAX30105.h"
14 #include "spo2_algorithm.h"
15 #include "heartRate.h"
16 #include <WiFi.h>
17 #include <WebServer.h>
18 #include <NimBLEDevice.h>
19 #include <TaskScheduler.h>
20
21 Separador s;
22
23 //MAX30102EFD+
24 MAX30105 particleSensor;
25
26 const byte RATE_SIZE = 4;
27 byte rates[RATE_SIZE];
28 byte rateSpot = 0;
29 long lastBeat = 0;
30
31 float beatsPerMinute;
32 int beatAvg;
33
34 Scheduler                               MoRepScheduler;
```

```
35
36 //WebServer
37 WiFiServer server(80);
38 unsigned long currentTime = millis();
39 unsigned long previousTime = 0;
40 const long timeoutTime = 2000;
41 String head;
42 bool localip = false;
43
44 //BLE
45 static NimBLEServer* pServer;
46 #define CHARACTERISTIC_UUID_WRIST "d6597e78-c992-4f43-9861-719
    b78932fa6"
47 #define CHARACTERISTIC_UUID_ARM "84d8a625-08f9-49b3-82fb-d85daffc3c39
    "
48 #define CHARACTERISTIC_UUID_INFO "beb5483e-36e1-4688-b7f5-
    ea07361b26a8"
49 NimBLEService* pSvc;
50 std::string valueW = "WM_0";
51 std::string valueA = "AM_0";
52 std::string header;
53
54 //SMTP
55 SMTPSession smtp;
56 void smtpCallback(SMTP_Status status);
57
58 //ThingSpeak
59 unsigned long myChannelNumber = SECRET_CH_ID;
60 const char * myWriteAPIKey = SECRET_WRITE_APIKEY;
61 int keyIndex = 0;
62 WiFiClient client;
63 int httpCode;
64
65 //I2C Chain
66 void scan_i2c();
67 byte i2c_address[5];
68 unsigned int nDevices = 0;
69
```

```
70 Adafruit_SSD1306 display(SCREEN_WIDTH, SCREEN_HEIGHT, &Wire,
    OLED_RESET);
71
72 MPU6050 mpu(0x68);
73 int16_t ax, ay, az;
74 int16_t gx, gy, gz;
75 float ang_x, ang_y, ang_z;
76 float ang_x_prev[20], ang_y_prev[20], ang_z_prev[20];
77 float accel_ang_x;
78 float accel_ang_y;
79 float accel_ang_z;
80
81 unsigned long t_prev;
82 float dt;
83 int j = 1;
84 int k = 0;
85 unsigned long tmove;
86 unsigned long tmove_prev;
87 unsigned long t_control;
88 int mins = 0;
89 unsigned long StartTime, FinishedTime, ElapsedTime, Over;
90
91 struct myStruct {
92     int Series [30] = {0};
93     int Exercise [35] = {0};
94     String Ex[100];
95     int MuscGroup[5] = {0};
96     int CountSeries[10] = {0};
97     int kcal = 0;
98 };
99
100 myStruct WORKOUT;
101
102 String WristPosition;
103 int WristPos;
104 int IniState = 1;
105 int state = 1;
106 int state_prev = 1;
```

```
107 bool Push = 0;
108 bool Pull = 0;
109 int IniMove = 0;
110 float ax_m_s2_prev[10];
111 float ay_m_s2_prev[10];
112 float az_m_s2_prev[10];
113 float angx_av = 0;
114 float angy_av = 0;
115 float angz_av = 0;
116 float ax_av, ay_av, az_av = 0;
117 float accel_av[2] = {0};
118 float accel_id[5] = {0};
119 int it = 0;
120 bool order = false;
121 int workoutctrl = 0;
122 std::string Review = "";
123 String Reminder = "";
124 std::string Analysis = "";
125
126 int eeaddress = 0;
127 bool mail = true;
128 int journey;
129 std::string WristMove = "";
130 std::string ArmMove;
131 int ArmEx;
132 int ArmRep;
133 int ExDisp;
134 bool env;
135
136 //Functions
137 void Postures();
138 void FinishWorkout();
139 void ReadingEEPROM();
140 void webServer();
141
142 class ServerCallbacks: public NimBLEServerCallbacks {
143     void onConnect(NimBLEServer* pServer) {
144         Serial.println("Client connected");
```

```
145     Serial.println("Multi-connect support: start advertising");
146     NimBLEDevice::startAdvertising();
147 };
148 void onConnect(NimBLEServer* pServer, ble_gap_conn_desc* desc) {
149     Serial.print("Client address: ");
150     Serial.println(NimBLEAddress(desc->peer_ota_addr).toString().
151         c_str());
152     pServer->updateConnParams(desc->conn_handle, 24, 48, 0, 60);
153 };
154 void onDisconnect(NimBLEServer* pServer) {
155     Serial.println("Client disconnected - start advertising");
156     NimBLEDevice::startAdvertising();
157 };
158 void onMTUChange(uint16_t MTU, ble_gap_conn_desc* desc) {
159     Serial.printf("MTU updated: %u for connection ID: %u\n", MTU,
160         desc->conn_handle);
161 };
162 uint32_t onPassKeyRequest(){
163     Serial.println("Server Passkey Request");
164     return 123456;
165 };
166
167 bool onConfirmPIN(uint32_t pass_key){
168     Serial.print("The passkey YES/NO number: ");Serial.println(
169         pass_key);
170     return true;
171 };
172
173 void onAuthenticationComplete(ble_gap_conn_desc* desc){
174     if(!desc->sec_state.encrypted) {
175         NimBLEDevice::getServer()->disconnect(desc->conn_handle);
176         Serial.println("Encrypt connection failed - disconnecting
177             client");
178         return;
179     }
180     Serial.println("Starting BLE work!");
```



```
179     };
180 };
181
182 class CharacteristicCallbacks: public NimBLECharacteristicCallbacks {
183     void onRead(NimBLECharacteristic* pCharacteristic){
184     };
185     void onWrite(NimBLECharacteristic* pCharacteristic) {
186     };
187     void onNotify(NimBLECharacteristic* pCharacteristic) {
188     };
189
190     void onStatus(NimBLECharacteristic* pCharacteristic, Status
191         status, int code) {
192         String str = ("Notification/Indication status code: ");
193         str += status;
194         str += ", return code: ";
195         str += code;
196         str += ", ";
197         str += NimBLEUtils::returnCodeToString(code);
198         Serial.println(str);
199     };
200
201     void onSubscribe(NimBLECharacteristic* pCharacteristic,
202         ble_gap_conn_desc* desc, uint16_t subValue) {
203         String str = "Client ID: ";
204         str += desc->conn_handle;
205         str += " Address: ";
206         str += std::string(NimBLEAddress(desc->peer_ota_addr)).c_str
207             ();
208         if(subValue == 0) {
209             str += " Unsubscribed to ";
210         }else if(subValue == 1) {
211             str += " Subscribed to notfications for ";
212         } else if(subValue == 2) {
213             str += " Subscribed to indications for ";
214         } else if(subValue == 3) {
215             str += " Subscribed to notifications and indications for
216                 ";
```

```
213     }
214     str += std::string(pCharacteristic->getUUID()).c_str();
215
216     Serial.println(str);
217 };
218 };
219
220 class DescriptorCallbacks : public NimBLEDescriptorCallbacks {
221     void onWrite(NimBLEDescriptor* pDescriptor) {
222         std::string dscVal((char*)pDescriptor->getValue(),
223             pDescriptor->getLength());
224
225     };
226
227     void onRead(NimBLEDescriptor* pDescriptor) {
228     };
229 };
230
231 static DescriptorCallbacks dscCallbacks;
232 static CharacteristicCallbacks chrCallbacks;
233
234 NimBLECharacteristic* pWristCharacteristic;
235 NimBLECharacteristic* pArmCharacteristic;
236 NimBLECharacteristic* pInfoCharacteristic;
237
238 const unsigned char LogoMoRep [] PROGMEM = {
239     0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0
240     x00, 0x00, 0x00, 0x00, 0x00,
241     0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0
242     x00, 0x00, 0x00, 0x00, 0x00,
243     0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0
244     x00, 0x00, 0x00, 0x00, 0x00,
245     0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0
246     x00, 0x00, 0x00, 0x00, 0x00,
247     0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0
248     x00, 0x00, 0x00, 0x00, 0x00,
249     0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0
250     x00, 0x00, 0x00, 0x00, 0x00,
```

243 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0
x00, 0x00, 0x00, 0x00, 0x00,

244 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0
x00, 0x00, 0x00, 0x00, 0x00,

245 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0
x00, 0x00, 0x00, 0x00, 0x00,

246 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0
x00, 0x00, 0x00, 0x00, 0x00,

247 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0
x00, 0x00, 0x00, 0x00, 0x00,

248 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0
x00, 0x00, 0x00, 0x00, 0x00,

249 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0
x00, 0x00, 0x00, 0x00, 0x00,

250 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0
x00, 0x00, 0x00, 0x00, 0x00,

251 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0
x00, 0x00, 0x00, 0x00, 0x00,

252 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0
x00, 0x00, 0x00, 0x00, 0x00,

253 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0
x00, 0x00, 0x00, 0x00, 0x00,

254 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0
x00, 0x00, 0x00, 0x00, 0x00,

255 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0
x00, 0x00, 0x00, 0x00, 0x00,

256 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0
x00, 0x00, 0x00, 0x00, 0x00,

257 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0
x00, 0x00, 0x00, 0x00, 0x00,

258 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0
x00, 0x00, 0x00, 0x00, 0x00,

259 0x00, 0x00, 0x00, 0x00, 0x00, 0x1c, 0x00, 0x01, 0xc0, 0x00, 0x00, 0
x00, 0x00, 0x00, 0x00, 0x00,

260 0x00, 0x00, 0x80, 0x10, 0x00, 0xff, 0x80, 0x07, 0xe0, 0x03, 0xf8, 0
x0f, 0xfc, 0x7f, 0x00, 0x00,

261 0x00, 0x00, 0xc0, 0x18, 0x03, 0xff, 0xe0, 0x0f, 0xf0, 0x03, 0xfe, 0
x0f, 0xfc, 0x7f, 0xc0, 0x00,

262 0x00, 0x00, 0xc0, 0x18, 0x07, 0xc0, 0xf0, 0x0c, 0x38, 0x03, 0x0f, 0
x0c, 0x00, 0x71, 0xe0, 0x00,
263 0x00, 0x00, 0xe0, 0x38, 0x0f, 0x00, 0x78, 0x0c, 0x38, 0x03, 0x07, 0
x0c, 0x00, 0x70, 0x70, 0x00,
264 0x00, 0x01, 0xe0, 0x38, 0x0e, 0x00, 0x3c, 0x0c, 0x38, 0x03, 0x03, 0
x0c, 0x00, 0x70, 0x70, 0x00,
265 0x00, 0x01, 0xe0, 0x7c, 0x1c, 0x00, 0x1c, 0x0e, 0x70, 0x03, 0x03, 0
x0c, 0x00, 0x70, 0x70, 0x00,
266 0x00, 0x01, 0xf0, 0x7c, 0x1c, 0x00, 0x0c, 0x07, 0xe0, 0x03, 0x03, 0
x0c, 0x00, 0x70, 0x70, 0x00,
267 0x00, 0x01, 0xb0, 0x6c, 0x18, 0x00, 0x0e, 0x03, 0xc0, 0x03, 0x07, 0
x0f, 0xfc, 0x70, 0xe0, 0x00,
268 0x00, 0x03, 0xb8, 0xec, 0x18, 0x00, 0x0e, 0x07, 0xc0, 0x03, 0xfe, 0
x0f, 0xfc, 0x7f, 0xe0, 0x00,
269 0x00, 0x03, 0x18, 0xce, 0x18, 0x00, 0x0e, 0x1f, 0xe0, 0x03, 0xfc, 0
x0c, 0x00, 0x7f, 0x80, 0x00,
270 0x00, 0x03, 0x19, 0xc6, 0x18, 0x00, 0x0e, 0x3c, 0xf1, 0x03, 0xf0, 0
x0c, 0x00, 0x7c, 0x00, 0x00,
271 0x00, 0x03, 0x1d, 0x86, 0x1c, 0x00, 0x0c, 0x38, 0x7b, 0x83, 0x70, 0
x0c, 0x00, 0x70, 0x00, 0x00,
272 0x00, 0x07, 0x0f, 0x86, 0x1c, 0x00, 0x1c, 0x70, 0x3f, 0x03, 0x38, 0
x0c, 0x00, 0x70, 0x00, 0x00,
273 0x00, 0x06, 0x0f, 0x87, 0x0e, 0x00, 0x3c, 0x70, 0x1e, 0x03, 0x1c, 0
x0c, 0x00, 0x70, 0x00, 0x00,
274 0x00, 0x06, 0x07, 0x03, 0x07, 0x00, 0x78, 0x70, 0x1e, 0x03, 0x1c, 0
x0c, 0x00, 0x70, 0x00, 0x00,
275 0x00, 0x0e, 0x07, 0x03, 0x07, 0xc0, 0xf0, 0x38, 0x3f, 0x03, 0x0e, 0
x0c, 0x00, 0x70, 0x00, 0x00,
276 0x00, 0x0e, 0x06, 0x03, 0x83, 0xff, 0xe0, 0x3f, 0xf3, 0x83, 0x07, 0
x0f, 0xfc, 0x70, 0x00, 0x00,
277 0x00, 0x0c, 0x02, 0x03, 0x80, 0xff, 0x80, 0x0f, 0xe1, 0xc3, 0x07, 0
x0f, 0xfc, 0x70, 0x00, 0x00,
278 0x00, 0x00, 0x00, 0x00, 0x00, 0x1c, 0x00, 0x03, 0x80, 0x00, 0x00, 0
x00, 0x00, 0x00, 0x00, 0x00,
279 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0
x00, 0x00, 0x00, 0x00, 0x00,
280 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x01, 0x00, 0x00, 0x02, 0x00, 0
x02, 0x00, 0x80, 0x00, 0x00,

281 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x01, 0x00, 0x00, 0x02, 0x01, 0
x02, 0x00, 0x80, 0x00, 0x00,
282 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x01, 0x40, 0x04, 0x22, 0x84, 0
x22, 0x08, 0x89, 0xc0, 0x00,
283 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x01, 0x2a, 0x0b, 0x4a, 0x49, 0
x4a, 0x12, 0x84, 0x40, 0x00,
284 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x01, 0x26, 0x11, 0x4a, 0x01, 0
x7a, 0x02, 0xbc, 0x80, 0x00,
285 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x01, 0x24, 0x0b, 0x4a, 0x41, 0
x42, 0x12, 0xa4, 0x80, 0x00,
286 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x44, 0x05, 0x20, 0x80, 0
x20, 0x0a, 0x08, 0x00, 0x00,
287 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x0a, 0x00, 0x00, 0
x00, 0x1c, 0x00, 0x00, 0x00,
288 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0
x00, 0x00, 0x00, 0x00, 0x00,
289 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0
x00, 0x00, 0x00, 0x00, 0x00,
290 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0
x00, 0x00, 0x00, 0x00, 0x00,
291 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0
x00, 0x00, 0x00, 0x00, 0x00,
292 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0
x00, 0x00, 0x00, 0x00, 0x00,
293 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0
x00, 0x00, 0x00, 0x00, 0x00,
294 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0
x00, 0x00, 0x00, 0x00, 0x00,
295 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0
x00, 0x00, 0x00, 0x00, 0x00,
296 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0
x00, 0x00, 0x00, 0x00, 0x00,
297 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0
x00, 0x00, 0x00, 0x00, 0x00,
298 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0
x00, 0x00, 0x00, 0x00, 0x00,
299 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0
x00, 0x00, 0x00, 0x00, 0x00,

```
300     0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0x00, 0
301     x00, 0x00, 0x00, 0x00, 0x00
302 };
303
304 Task taskMPULegs(TASK_SECOND / 5, TASK_FOREVER, []() {
305     if (workoutctrl == 1){
306         order = true;
307         WristMove = "1";
308         workoutctrl = 0;
309     }
310     if (order == true) {
311         if (tmove - t_prev > 1500){
312             t_prev = tmove;
313         }
314
315         float ax_m_s2, ay_m_s2, az_m_s2;
316         mpu.getAcceleration(&ax, &ay, &az); //raw values of accelerations
317         mpu.getRotation(&gx, &gy, &gz); //raw values of orientations
318         dt = (tmove - t_prev) / 1000.0;
319         tmove = millis();
320         ax_m_s2 = ax * (9.81 / 16384.0);
321         ay_m_s2 = ay * (9.81 / 16384.0);
322         az_m_s2 = az * (9.81 / 16384.0);
323         accel_ang_x = atan(ax / sqrt(pow(ay, 2) + pow(az, 2))) * (180.0 /
324             3.14);
325         accel_ang_y = atan(ay / sqrt(pow(ax, 2) + pow(az, 2))) * (180.0 /
326             3.14);
327         accel_ang_z = atan(az / sqrt(pow(ax, 2) + pow(ay, 2))) * (180.0 /
328             3.14);
329         ang_x = 0.98 * (gx / 131) * dt + 0.02 * accel_ang_x;
330         ang_y = 0.98 * (gy / 131) * dt + 0.02 * accel_ang_y;
331         ang_z = 0.98 * (gz / 131) * dt + 0.02 * accel_ang_z;
332         double a_total = abs(ax_m_s2) + abs(ay_m_s2) + abs(az_m_s2);
333         mins = tmove/60000;
334         accel_av[0] = ax_av; accel_av[1] = ay_av; accel_av[2] = az_av;
```

```
334   if (0.6 > dt > 0.5){
335       ang_x_prev[it] = ang_x;
336       ang_y_prev[it] = ang_y;
337       ang_z_prev[it] = ang_z;
338       angx_av = (angx_av + ang_x_prev[it])/(it+1);
339       angy_av = (angy_av + ang_y_prev[it])/(it+1);
340       angz_av = (angz_av + ang_z_prev[it])/(it+1);
341       ax_m_s2_prev[it] = ax_m_s2;
342       ay_m_s2_prev[it] = ay_m_s2;
343       az_m_s2_prev[it] = az_m_s2;
344       ax_av = (ax_av + ax_m_s2_prev[it])/(it+1);
345       ay_av = (ay_av + ay_m_s2_prev[it])/(it+1);
346       az_av = (az_av + az_m_s2_prev[it])/(it+1);
347       it++;
348   }
349
350   else if (it > 5){
351       it = 0;
352   }
353
354   if (az_m_s2 > 7) {
355       WristPosition = "Alpha";
356       WristPos = 1;
357   }
358   else if (az_m_s2 < -7) {
359       WristPosition = "Delta";
360       WristPos = 2;
361   }
362   else if (ax_m_s2 > 7) {
363       WristPosition = "Beta";
364       WristPos = 4;
365   }
366   else if (ax_m_s2 < -7) {
367       WristPosition = "Dseta";
368       WristPos = 3;
369   }
370   else if (ay_m_s2 < -7) {
371       WristPosition = "Epsilon";
```

```
372     WristPos = 5;
373 }
374 else if (ay_m_s2 > 7) {
375     WristPosition = "Gamma";
376     WristPos = 6;
377 }
378 else {
379     WristPosition = "Half way";
380     WristPos = 0;
381 }
382
383 switch (state) {
384     case (1): //State detection
385         if (ArmMove == "1" || header == "EX"){
386             IniMove = 0;
387             Push = 0;
388             Pull = 0;
389             WristMove = "1";
390             if (WristMove == "1" && ArmMove == "1"){
391                 display.clearDisplay();
392                 display.setTextSize(1.5);
393                 display.setTextColor(WHITE);
394                 display.setCursor(10, 1);
395                 display.println("Waiting for a new           exercise");
396                 display.display();
397             }
398             if (WristPosition == "Alpha") {
399                 state = 2;
400                 IniState = 2;
401                 state_prev = 1;
402                 tmove_prev = tmove;
403             }
404             if (WristPosition == "Gamma") {
405                 IniState = 3;
406                 state = 3;
407                 state_prev = 1;
408                 tmove_prev = tmove;
409             }

```



```
410     if (WristPosition == "Epsilon") {
411         state = 4;
412         IniState = 4;
413         state_prev = 1;
414         tmove_prev = tmove;
415     }
416     if (WristPosition == "Beta") {
417         state = 5;
418         IniState = 5;
419         state_prev = 1;
420         tmove_prev = tmove;
421     }
422     if (WristPosition == "Delta") {
423         state = 6;
424         IniState = 6;
425         state_prev = 1;
426         tmove_prev = tmove;
427     }
428     if (WristPosition == "Dseta") {
429         state = 7;
430         IniState = 7;
431         state_prev = 1;
432         tmove_prev = tmove;
433     }
434     else if (WORKOUT.Series[j] > 3) {
435         j++;
436         WristMove = "97";
437     }
438     else if (ArmMove == "97" && env == true) {
439         if (ArmEx == 2){
440             WORKOUT.Ex[j] = "Curl quadriceps(Legs)";
441             WORKOUT.MuscGroup[5]++;
442         }
443         if (ArmEx == 5 || ArmEx == 6){
444             WORKOUT.Ex[j] = "Curl femoral (Legs)";
445             WORKOUT.MuscGroup[5]++;
446         }
447         WORKOUT.Series[j] = ArmRep;
```

```
448     j++;
449     env = false;
450 }
451 }
452     break;
453
454 case (2): //Alpha
455     if (WristPos == 2){
456         state = 6;
457         state_prev = 2;
458         tmove_prev = tmove;
459     }
460     if (WristPos == 3){
461         state = 7;
462         state_prev = 2;
463         tmove_prev = tmove;
464     }
465     if (WristPos == 4){
466         state = 5;
467         state_prev = 2;
468         tmove_prev = tmove;
469     }
470     if (WristPos == 5){
471         state = 4;
472         state_prev = 2;
473         tmove_prev = tmove;
474     }
475     if (WristPos == 6){
476         state = 3;
477         state_prev = 2;
478         tmove_prev = tmove;
479     }
480     if (tmove - tmove_prev > 12000){
481         WristMove = "99";
482         if (ArmMove == "99"){
483             state = 1;
484             t_control = tmove;
485         }

```

```
486     }
487     if (a_total > 40) {
488         state = 8;
489         WristMove = "98";
490         tmove_prev = tmove;
491     }
492
493     break;
494
495     case (3): //Gamma
496         if (WristPos == 2){
497             state = 6;
498             state_prev = 3;
499             tmove_prev = tmove;
500         }
501         if (WristPos == 3){
502             if ((ArmMove == "02" || ArmMove == "99") && IniState == 3){
503                 WORKOUT.Exercise[4]++;
504                 display.clearDisplay();
505                 display.setTextSize(1.5);
506                 display.setTextColor(WHITE);
507                 display.setCursor(10, 1);
508                 display.print(" Detecting... \n Push\n");
509                 display.display();
510             }
511             state = 7;
512             state_prev = 3;
513             tmove_prev = tmove;
514         }
515         if (WristPos == 4){
516             state = 5;
517             state_prev = 3;
518             tmove_prev = tmove;
519         }
520         if (WristPos == 5){
521             state = 4;
522             state_prev = 2;
523             tmove_prev = tmove;
```

```
524     }
525     if (WristPos == 1){
526         state = 2;
527         state_prev = 3;
528         tmove_prev = tmove;
529     }
530     if (tmove - tmove_prev > 12000){
531         WristMove = "99";
532         if (ArmMove == "99"){
533             state = 8;
534             t_control = tmove;
535         }
536     }
537     if (a_total > 40) {
538         state = 8;
539         WristMove = "98";
540         tmove_prev = tmove;
541     }
542     break;
543
544     case (4): // psilon
545         if (WristPos == 2){
546             state = 6;
547             state_prev = 4;
548             tmove_prev = tmove;
549         }
550         if (WristPos == 3){
551             state = 7;
552             state_prev = 4;
553             tmove_prev = tmove;
554         }
555         if (WristPos == 4){
556             if ((ArmMove == "07" || ArmMove == "99") && IniState == 4){
557                 WORKOUT.Exercise[1]++;
558                 display.clearDisplay();
559                 display.setTextSize(1.5);
560                 display.setTextColor(WHITE);
561                 display.setCursor(10, 1);
```

```
562     display.print("  Detecting... \n Squats\n");
563     display.display();
564 }
565     state = 5;
566     state_prev = 4;
567     tmove_prev = tmove;
568 }
569     if (WristPos == 1){
570         state = 2;
571         state_prev = 4;
572         tmove_prev = tmove;
573     }
574     if (WristPos == 6){
575         state = 3;
576         state_prev = 4;
577         tmove_prev = tmove;
578     }
579     if (tmove - tmove_prev > 12000){
580         WristMove = "99";
581         if (ArmMove == "99"){
582             state = 8;
583         }
584     }
585     if (a_total > 40) {
586         state = 8;
587         WristMove = "98";
588         tmove_prev = tmove;
589     }
590         break;
591
592     case (5): //Beta
593         if (WristPos == 2){
594             state = 6;
595             state_prev = 5;
596             tmove_prev = tmove;
597         }
598         if (WristPos == 3){
599             state = 7;
```

```
600     state_prev = 5;
601     tmove_prev = tmove;
602 }
603 if (WristPos == 1){
604     state = 2;
605     state_prev = 5;
606     tmove_prev = tmove;
607 }
608 if (WristPos == 5){
609     if ((ArmMove == "07" || ArmMove == "99") && IniState == 5){
610         WORKOUT.Exercise[3]++;
611         display.clearDisplay();
612         display.setTextSize(1.5);
613         display.setTextColor(WHITE);
614         display.setCursor(10, 1);
615         display.print("  Detecting... \n Deadlift\n");
616         display.display();
617
618     }
619     state = 4;
620     state_prev = 5;
621     tmove_prev = tmove;
622 }
623 if (WristPos == 6){
624     state = 3;
625     state_prev = 5;
626     tmove_prev = tmove;
627 }
628 if (tmove - tmove_prev > 2000 && tmove - tmove_prev < 12000) {
629     WristMove = "05";
630     if (ExDisp == 1){
631         if (ArmMove == "74"){
632             display.clearDisplay();
633             display.setTextSize(1.5);
634             display.setTextColor(WHITE);
635             display.setCursor(10, 1);
636             display.print("  Detecting... \n Legs extension\n");
637             display.display();
```

```
638     }
639     if (ArmMove == "47"){
640         display.clearDisplay();
641         display.setTextSize(1.5);
642         display.setTextColor(WHITE);
643         display.setCursor(10, 1);
644         display.print("  Detecting... \n Curl Femoral\n");
645         display.display();
646     }
647 }
648 }
649 if (tmove - tmove_prev > 12000){
650     WristMove = "99";
651     if (ArmMove == "99"){
652         state = 8;
653     }
654 }
655 if (a_total > 40) {
656     state = 8;
657     WristMove = "98";
658     tmove_prev = tmove;
659 }
660     break;
661
662 case (6): //Delta
663     if (WristPos == 1){
664         state = 2;
665         state_prev = 6;
666         tmove_prev = tmove;
667     }
668     if (WristPos == 3){
669         state = 7;
670         state_prev = 6;
671         tmove_prev = tmove;
672     }
673     if (WristPos == 4){
674         state = 5;
675         state_prev = 6;
```

```
676     tmove_prev = tmove;
677 }
678 if (WristPos == 5){
679     state = 4;
680     state_prev = 6;
681     tmove_prev = tmove;
682 }
683 if (WristPos == 6){
684     state = 3;
685     state_prev = 6;
686     tmove_prev = tmove;
687 }
688 if (tmove - tmove_prev > 12000){
689     WristMove = "99";
690     if (ArmMove == "99"){
691         state = 8;
692     }
693 }
694 if (a_total > 40) {
695     state = 8;
696     WristMove = "98";
697     tmove_prev = tmove;
698 }
699     break;
700
701 case (7): //Dseta
702     if (WristPos == 2){
703         state = 6;
704         state_prev = 7;
705         tmove_prev = tmove;
706     }
707     if (WristPos == 1){
708         state = 2;
709         state_prev = 7;
710         tmove_prev = tmove;
711     }
712     if (WristPos == 4){
713         state = 5;
```



```
714     state_prev = 7;
715     tmove_prev = tmove;
716 }
717 if (WristPos == 5){
718     state = 4;
719     state_prev = 7;
720     tmove_prev = tmove;
721 }
722 if (WristPos == 6){
723     state = 3;
724     state_prev = 7;
725     tmove_prev = tmove;
726 }
727 if (tmove - tmove_prev > 2000 && tmove - tmove_prev < 12000) {
728     WristMove = "07";
729     if (ExDisp == 1){
730         display.clearDisplay();
731         display.setTextSize(1.5);
732         display.setTextColor(WHITE);
733         display.setCursor(10, 1);
734         display.print("  Detecting... \n Curl Femoral\n");
735         display.display();
736     }
737 }
738 if (tmove - tmove_prev > 12000){
739     WristMove = "99";
740     if (ArmMove == "99"){
741         state = 8;
742     }
743 }
744 if (a_total > 40) {
745     state = 8;
746     WristMove = "98";
747     tmove_prev = tmove;
748 }
749     break;
750
751 case (8): // Definition of moves
```

```
752     if (WORKOUT.Exercise[1] < 3) {
753         WORKOUT.Exercise[1] = 0;
754     }
755     if (WORKOUT.Exercise[3] < 3) {
756         WORKOUT.Exercise[1] = 0;
757     }
758     if (WORKOUT.Exercise[4] < 3) {
759         WORKOUT.Exercise[1] = 0;
760     }
761     if (WORKOUT.Exercise[1] > 3) {
762         WORKOUT.Series[j] = WORKOUT.Exercise[1];
763         WORKOUT.Ex[j] = "Squats (Legs)";
764         WORKOUT.Exercise[1] = 0;
765         WORKOUT.MuscGroup[5]++;
766     }
767     if (WORKOUT.Exercise[3] > 3) {
768         WORKOUT.Series[j] = WORKOUT.Exercise[3];
769         WORKOUT.Ex[j] = "Deadlift (Legs)";
770         WORKOUT.Exercise[3] = 0;
771         WORKOUT.MuscGroup[5]++;
772     }
773     if (WORKOUT.Exercise[4] > 3) {
774         WORKOUT.Series[j] = WORKOUT.Exercise[4];
775         WORKOUT.Ex[j] = "Push (Legs)";
776         WORKOUT.Exercise[4] = 0;
777         WORKOUT.MuscGroup[5]++;
778     }
779     env = true;
780     t_control = tmove;
781     state = 1;
782     break;
783 }
784
785 display.setTextSize(1.9);
786 display.setTextColor(WHITE);
787 display.print ("\nSerie ");
788 display.print (j-1);
789 display.print (" w/ ");
```

```
790     display.print (WORKOUT.Series[j-1]);
791     display.print (" reps\n");
792     display.println (WORKOUT.Ex[j-1]);
793     display.print ("WO time: ");
794     display.print (mins);
795     display.print (" mins");
796     display.print ("\n\n");
797     display.display();
798
799     Serial.print("valueW: ");
800     Serial.print(valueW.c_str());
801     Serial.print("\n");
802     Serial.print("valueA: ");
803     Serial.print(valueA.c_str());
804     Serial.print("\n");
805 }
806
807 if (workoutctrl == 2){
808     order = false;
809     WristMove = "96";
810     display.clearDisplay();
811     display.setTextSize(1.95);
812     display.setTextColor(WHITE);
813     display.setCursor(10, 1);
814     display.println ("  WORKOUT DONE!");
815     display.setTextSize(1.7);
816     display.println ("");
817     display.println ("Check your email, \nreview your workout  in the
      app, \nor start a new      workout");
818     display.display();
819     float tm = tmove;
820     WORKOUT.kcal = (tm / 3600000) * 450;
821     FinishWorkout();
822     WORKOUT.Series [30] = {0};
823     WORKOUT.MuscGroup[5] = {0};
824     WORKOUT.kcal = 0;
825     tmove = 0;
826     tmove_prev = 0;
```

```
827     t_control = 0;
828 }
829 });
830
831 Task taskMPU(TASK_SECOND / 5, TASK_FOREVER, []() {
832     if (workoutctrl == 1){
833         order = true;
834         WristMove = "1";
835         workoutctrl = 0;
836     }
837     if (order == true) {
838         if (tmove - t_prev > 1500){
839             t_prev = tmove;
840         }
841
842         float ax_m_s2, ay_m_s2, az_m_s2;
843         mpu.getAcceleration(&ax, &ay, &az);
844         mpu.getRotation(&gx, &gy, &gz);
845         dt = (tmove - t_prev) / 1000.0;
846         tmove = millis();
847         ax_m_s2 = ax * (9.81 / 16384.0);
848         ay_m_s2 = ay * (9.81 / 16384.0);
849         az_m_s2 = az * (9.81 / 16384.0);
850         accel_ang_x = atan(ax / sqrt(pow(ay, 2) + pow(az, 2))) * (180.0 /
851             3.14);
852         accel_ang_y = atan(ay / sqrt(pow(ax, 2) + pow(az, 2))) * (180.0 /
853             3.14);
854         accel_ang_z = atan(az / sqrt(pow(ax, 2) + pow(ay, 2))) * (180.0 /
855             3.14);
856         ang_x = 0.98 * (gx / 131) * dt + 0.02 * accel_ang_x;
857         ang_y = 0.98 * (gy / 131) * dt + 0.02 * accel_ang_y;
858         ang_z = 0.98 * (gz / 131) * dt + 0.02 * accel_ang_z;
859         double a_total = abs(ax_m_s2) + abs(ay_m_s2) + abs(az_m_s2);
860         mins = tmove/60000;
861         accel_av[0] = ax_av; accel_av[1] = ay_av; accel_av[2] = az_av;
862
863         if (0.6 > dt > 0.5){
```

```
862     ang_x_prev[it] = ang_x;
863     ang_y_prev[it] = ang_y;
864     ang_z_prev[it] = ang_z;
865     angx_av = (angx_av + ang_x_prev[it])/(it+1);
866     angy_av = (angy_av + ang_y_prev[it])/(it+1);
867     angz_av = (angz_av + ang_z_prev[it])/(it+1);
868     ax_m_s2_prev[it] = ax_m_s2;
869     ay_m_s2_prev[it] = ay_m_s2;
870     az_m_s2_prev[it] = az_m_s2;
871     ax_av = (ax_av + ax_m_s2_prev[it])/(it+1);
872     ay_av = (ay_av + ay_m_s2_prev[it])/(it+1);
873     az_av = (az_av + az_m_s2_prev[it])/(it+1);
874     it++;
875 }
876
877 else if (it > 10){
878     it = 0;
879 }
880
881 if (az_m_s2 > 7) {
882     WristPosition = "Alpha";
883     WristPos = 1;
884 }
885 else if (az_m_s2 < -7) {
886     WristPosition = "Delta";
887     WristPos = 2;
888 }
889 else if (ax_m_s2 > 7) {
890     WristPosition = "Beta";
891     WristPos = 4;
892 }
893 else if (ax_m_s2 < -7) {
894     WristPosition = "Dseta";
895     WristPos = 3;
896 }
897 else if (ay_m_s2 < -7) {
898     WristPosition = "Epsilon";
899     WristPos = 5;
```

```
900     }
901     else if (ay_m_s2 > 7) {
902         WristPosition = "Gamma";
903         WristPos = 6;
904     }
905     else {
906         WristPosition = "Half way";
907         WristPos = 0;
908     }
909
910     switch (state) {
911         case (1): //State detection
912             if (ArmMove == "1" || header == "EX"){
913                 IniMove = 0;
914                 Push = 0;
915                 Pull = 0;
916                 WristMove = "1";
917                 if (WristMove == "1" && ArmMove == "1"){
918                     display.clearDisplay();
919                     display.setTextSize(1.5);
920                     display.setTextColor(WHITE);
921                     display.setCursor(10, 1);
922                     display.println("Waiting for a new           exercise");
923                     display.display();
924                 }
925                 if (WristPosition == "Alpha") {
926                     state = 2;
927                     IniState = 2;
928                     state_prev = 1;
929                     tmove_prev = tmove;
930                 }
931                 if (WristPosition == "Gamma") {
932                     IniState = 3;
933                     state = 3;
934                     state_prev = 1;
935                     tmove_prev = tmove;
936                 }
937                 if (WristPosition == "Epsilon") {
```

```
938     state = 4;
939     IniState = 4;
940     state_prev = 1;
941     tmove_prev = tmove;
942 }
943 if (WristPosition == "Beta") {
944     state = 5;
945     IniState = 5;
946     state_prev = 1;
947     tmove_prev = tmove;
948 }
949 if (WristPosition == "Delta") {
950     state = 6;
951     IniState = 6;
952     state_prev = 1;
953     tmove_prev = tmove;
954 }
955 if (WristPosition == "Dseta") {
956     state = 7;
957     IniState = 7;
958     state_prev = 1;
959     tmove_prev = tmove;
960 }
961 else if (WORKOUT.Series[j] > 3) {
962     j++;
963     WristMove = "97";
964     Postures();
965 }
966 else if (header == "EX" && env == true) {
967     if (ArmEx == 10){
968         WORKOUT.Ex[j] = "Push-ups(triceps)";
969         WORKOUT.MuscGroup[1]++;
970     }
971     if (ArmEx == 11){
972         WORKOUT.Ex[j] = "Press(chest)";
973         WORKOUT.MuscGroup[2]++;
974     }
975     if (ArmEx == 15){
```

```
976     WORKOUT.Ex[j] = "Push-ups (chest)";
977     WORKOUT.MuscGroup[2]++;
978 }
979 if (ArmEx == 18){
980     WORKOUT.Ex[j] = "Pull-ups (back)";
981     WORKOUT.MuscGroup[3]++;
982 }
983 if (ArmEx == 19){
984     WORKOUT.Ex[j] = "Open pull (back)";
985     WORKOUT.MuscGroup[3]++;
986 }
987 if (ArmEx == 20){
988     WORKOUT.Ex[j] = "Close pull (back)";
989     WORKOUT.MuscGroup[3]++;
990 }
991 if (ArmEx == 21){
992     WORKOUT.Ex[j] = "Pull w/rope (shoulders)";
993     WORKOUT.MuscGroup[4]++;
994 }
995 if (ArmEx == 24){
996     WORKOUT.Ex[j] = "Press (shoulders)";
997     WORKOUT.MuscGroup[4]++;
998 }
999 if (ArmEx == 31){
1000     WORKOUT.Ex[j] = "Horizontal Scull (back)";
1001     WORKOUT.MuscGroup[3]++;
1002 }
1003 WORKOUT.Series[j] = ArmRep;
1004 j++;
1005 env = false;
1006 }
1007 }
1008     break;
1009
1010 case (2): //Alpha
1011     if (WristPos == 6) {
1012         if (IniState == 4 && state_prev == 3 && (ArmMove == "05" ||
            ArmMove == "99")) {
```



```
1013     WORKOUT.Exercise[3]++;
1014     display.clearDisplay();
1015     display.setTextSize(1.5);
1016     display.setTextColor(WHITE);
1017     display.setCursor(10, 1);
1018     display.print("  Detecting... \n Concentrated Curl\n");
1019     display.display();
1020 }
1021 if (IniState == 2 && (ArmMove == "04Q" || ArmMove == "99")) {
1022     WORKOUT.Exercise[1]++;
1023     display.clearDisplay();
1024     display.setTextSize(1.5);
1025     display.setTextColor(WHITE);
1026     display.setCursor(10, 1);
1027     display.print("  Detecting... \n      Simple curl\n");
1028     display.display();
1029 }
1030 if (IniState == 2 && (state_prev == 1 || state_prev == 3) &&
1031     ArmMove == "42") {
1032     WORKOUT.Exercise[12]++;
1033     display.clearDisplay();
1034     display.setTextSize(1.5);
1035     display.setTextColor(WHITE);
1036     display.setCursor(10, 1);
1037     display.print("  Detecting... \n Opening on bench\n");
1038     display.display();
1039 }
1040     tmove_prev = tmove;
1041     state_prev = 2;
1042     WristMove = "23";
1043     state = 3;
1044 }
1045 if (WristPos == 5) {
1046     if (IniState == 3 && state_prev == 4 && (ArmMove == "05" ||
1047         ArmMove == "99")) {
1048         WORKOUT.Exercise[7]++;
1049         display.clearDisplay();
1050         display.setTextSize(1.5);
```

```
1049     display.setTextColor(WHITE);
1050     display.setCursor(10, 1);
1051     display.print("  Detecting... \n Inverse Extension\n");
1052     display.display();
1053   }
1054   tmove_prev = tmove;
1055   state_prev = 2;
1056   state = 4;
1057 }
1058 if (WristPos == 4 || WristPos == 3 || WristPos == 2 || a_total >
1059     30) {
1060     tmove_prev = tmove;
1061     state = 8;
1062     WristMove = "98";
1063 }
1064 if (tmove - tmove_prev > 12000){
1065     WristMove = "99";
1066     if (ArmMove == "99"){
1067         state = 1;
1068         t_control = tmove;
1069     }
1070 }
1071 break;
1072
1073 case (3): //Gamma
1074     if ((ay_m_s2_prev[it] - ay_av < -2) && ay_m_s2_prev[it] != 0 &&
1075         az_av > -2 && IniState == 3) {
1076         Push = 1;
1077         tmove_prev = tmove;
1078         if (IniMove == 0) {
1079             IniMove = 1;
1080         }
1081     }
1082     if ((ay_m_s2_prev[it] - ay_av > 2) && ay_m_s2_prev[it] != 0 &&
1083         az_av > -2 && IniState == 3) {
1084         Pull = 1;
1085         tmove_prev = tmove;
1086         if (IniMove == 0) {
```

```
1084     IniMove = 2;
1085     }
1086 }
1087 if (Push == 1 && Pull == 1 && IniMove == 1) {
1088     Push = 0;
1089     Pull = 0;
1090 }
1091 if (Push == 1 && Pull == 1 && IniMove == 2) {
1092     Push = 0;
1093     Pull = 0;
1094 }
1095
1096 if (WristPos == 1) {
1097     if (IniState == 3 && (ArmMove == "05" || ArmMove == "99")) {
1098         WORKOUT.Exercise[7]++;
1099         display.clearDisplay();
1100         display.setTextSize(1.5);
1101         display.setTextColor(WHITE);
1102         display.setCursor(10, 1);
1103         display.print("  Detecting... \n Inverse Extension\n");
1104         display.display();
1105     }
1106     state = 2;
1107     state_prev = 3;
1108     tmove_prev = tmove;
1109 }
1110 if (WristPos == 2) {
1111     tmove_prev = tmove;
1112     state_prev = 3;
1113     state = 6;
1114 }
1115 if (WristPos == 3) {
1116     tmove_prev = tmove;
1117     state_prev = 3;
1118     state = 7;
1119 }
1120 if (WristPos == 4) {
1121     tmove_prev = tmove;
```

```
1122     state_prev = 3;
1123     state = 5;
1124 }
1125 if (WristPos == 5) {
1126     if (IniState == 3) {
1127         if ((state_prev == 1 || state_prev == 6) && (ArmMove == "05
1128             " || ArmMove == "99")) {
1129             WORKOUT.Exercise[6]++;
1130             display.clearDisplay();
1131             display.setTextSize(1.5);
1132             display.setTextColor(WHITE);
1133             display.setCursor(10, 1);
1134             display.print(" Detecting... \n Extension w/bar\n");
1135             display.display();
1136         }
1137         if ((state_prev == 1 || state_prev == 2) && (ArmMove == "05
1138             " || ArmMove == "99")) {
1139             WORKOUT.Exercise[7]++;
1140             display.clearDisplay();
1141             display.setTextSize(1.5);
1142             display.setTextColor(WHITE);
1143             display.setCursor(10, 1);
1144             display.print(" Detecting... \n Inverse Extension\n");
1145             display.display();
1146         }
1147     }
1148     tmove_prev = tmove;
1149     state_prev = 3;
1150     state = 4;
1151 }
1152 if (tmove - tmove_prev > 2000 && tmove - tmove_prev < 12000) {
1153     if (abs(ax_m_s2_prev[it]) < 5 && ax_m_s2_prev[it] != 0 && az_av
1154         > -2) {
1155         WristMove = "03Q";
1156         if (ExDisp == 1){
1157             display.clearDisplay();
1158             display.setTextSize(1.5);
1159             display.setTextColor(WHITE);
```

```
1157     display.setCursor(10, 1);
1158     display.print("  Detecting... \n Pull-ups\n");
1159     display.display();
1160   }
1161 }
1162 if (abs(ax_m_s2_prev[it]) > 5 && az_av > -2) {
1163   WristMove = "03A";
1164   if (ExDisp == 1){
1165     if (ArmMove == "42"){
1166       if(WORKOUT.MuscGroup[2] > WORKOUT.MuscGroup[3] && WORKOUT
1167         .MuscGroup[2] > WORKOUT.MuscGroup[4]){
1168         display.clearDisplay();
1169         display.setTextSize(1.5);
1170         display.setTextColor(WHITE);
1171         display.setCursor(10, 1);
1172         display.print("  Detecting... \n Press bench\n");
1173         display.display();
1174       }
1175       if (WORKOUT.MuscGroup[3] > WORKOUT.MuscGroup[2] &&
1176         WORKOUT.MuscGroup[3] > WORKOUT.MuscGroup[4]){
1177         display.clearDisplay();
1178         display.setTextSize(1.5);
1179         display.setTextColor(WHITE);
1180         display.setCursor(10, 1);
1181         display.print("  Detecting... \n Open pull\n");
1182         display.display();
1183       }
1184     }
1185     if (ArmMove == "52"){
1186       display.clearDisplay();
1187       display.setTextSize(1.5);
1188       display.setTextColor(WHITE);
1189       display.setCursor(10, 1);
1190       display.print("  Detecting... \n Close pull\n");
1191       display.display();
1192     }
1193   }
1194 }
```

```
1193     }
1194
1195     if (tmove - tmove_prev > 12000){
1196         WristMove = "99";
1197         if (ArmMove == "99"){
1198             state = 8;
1199             t_control = tmove;
1200         }
1201     }
1202     if (a_total > 40) {
1203         state = 8;
1204         WristMove = "98";
1205         tmove_prev = tmove;
1206     }
1207     break;
1208
1209     case (4): // psilon
1210         if (WristPos == 4) {
1211             if (IniState == 4 && (ArmMove == "05" || ArmMove == "99")) {
1212                 WORKOUT.Exercise[2]++;
1213                 display.clearDisplay();
1214                 display.setTextSize(1.5);
1215                 display.setTextColor(WHITE);
1216                 display.setCursor(10, 1);
1217                 display.print(" Detecting... \n Hammer\n");
1218                 display.display();
1219             }
1220             if (IniState == 4 && (ArmMove == "54" || ArmMove == "45")) {
1221                 WORKOUT.Exercise[27]++;
1222                 display.clearDisplay();
1223                 display.setTextSize(1.5);
1224                 display.setTextColor(WHITE);
1225                 display.setCursor(10, 1);
1226                 display.print(" Detecting... \n Vertical lifting\n");
1227                 display.display();
1228             }
1229             tmove_prev = tmove;
1230             state_prev = 4;
```

```
1231     state = 5;
1232 }
1233 if (WristPos == 2) {
1234     if (IniState == 4 && ArmMove == "52") {
1235         WORKOUT.Exercise[17]++;
1236         display.clearDisplay();
1237         display.setTextSize(1.5);
1238         display.setTextColor(WHITE);
1239         display.setCursor(10, 1);
1240         display.print("  Detecting... \n Scull to neck\n");
1241         display.display();
1242     }
1243     if (IniState == 4 && ArmMove == "53") {
1244         WORKOUT.Exercise[28]++;
1245         display.clearDisplay();
1246         display.setTextSize(1.5);
1247         display.setTextColor(WHITE);
1248         display.setCursor(10, 1);
1249         display.print("  Detecting... \n Flight\n");
1250         display.display();
1251     }
1252     if (IniState == 4 && (ArmMove == "05" || ArmMove == "99")) {
1253         WORKOUT.Exercise[4]++;
1254         display.clearDisplay();
1255         display.setTextSize(1.5);
1256         display.setTextColor(WHITE);
1257         display.setCursor(10, 1);
1258         display.print("  Detecting... \n Inverse Curl\n");
1259         display.display();
1260     }
1261     if (IniState == 4 && ArmMove == "56") {
1262         WORKOUT.Exercise[30]++;
1263         display.clearDisplay();
1264         display.setTextSize(1.5);
1265         display.setTextColor(WHITE);
1266         display.setCursor(10, 1);
1267         display.print("  Detecting... \n Diamond Push-ups\n");
1268         display.display();
```

```
1269     }
1270     tmove_prev = tmove;
1271     state_prev = 4;
1272     state = 6;
1273 }
1274 if (WristPos == 1) {
1275     if (IniState == 4 && (state_prev == 1 || state_prev == 3 ||
1276         state_prev == 2) && (ArmMove == "05" || ArmMove == "99"))
1277     {
1278         WORKOUT.Exercise[3]++;
1279         display.clearDisplay();
1280         display.setTextSize(1.5);
1281         display.setTextColor(WHITE);
1282         display.setCursor(10, 1);
1283         display.print(" Detecting... \n Concentrated Curl\n");
1284         display.display();
1285     }
1286     if (IniState == 4 && (state_prev == 1 || state_prev == 2) &&
1287         (ArmMove == "54" || ArmMove == "45")) {
1288         WORKOUT.Exercise[16]++;
1289         display.clearDisplay();
1290         display.setTextSize(1.5);
1291         display.setTextColor(WHITE);
1292         display.setCursor(10, 1);
1293         display.print(" Detecting... \n          Lifting");
1294         display.display();
1295     }
1296     tmove_prev = tmove;
1297     state_prev = 4;
1298     state = 2;
1299 }
1300 if (WristPos == 6) {
1301     if (WORKOUT.Exercise[3] > 1) {
1302         WORKOUT.Exercise[3]++;
1303         display.clearDisplay();
1304         display.setTextSize(1.5);
1305         display.setTextColor(WHITE);
1306         display.setCursor(10, 1);
```



```
1304     display.print("  Detecting... \n Concentrated Curl\n");
1305     display.display();
1306   }
1307   if (WORKOUT.Exercise[4] > 1) {
1308     WORKOUT.Exercise[4]++;
1309     display.clearDisplay();
1310     display.setTextSize(1.5);
1311     display.setTextColor(WHITE);
1312     display.setCursor(10, 1);
1313     display.print("  Detecting... \n Inverse Curl\n");
1314     display.display();
1315   }
1316   tmove_prev = tmove;
1317   state_prev = 4;
1318   state = 3;
1319 }
1320 if (tmove - tmove_prev > 2000 && tmove - tmove_prev < 12000) {
1321   if ((ay_m_s2_prev[it] > 2.5) && ay_m_s2_prev[it] != 0 &&
1322       az_av > -2){
1323     WristMove = "04A";
1324     if (ExDisp == 1){
1325       display.clearDisplay();
1326       display.setTextSize(1.5);
1327       display.setTextColor(WHITE);
1328       display.setCursor(10, 1);
1329       display.print("  Detecting... \n Horizontal Scull\n");
1330       display.display();
1331     }
1332   }
1333   if ((ay_m_s2_prev[it] < 2.5) && ay_m_s2_prev[it] != 0 &&
1334       az_av > -2){
1335     WristMove = "04Q";
1336     if (ExDisp == 1){
1337       display.clearDisplay();
1338       display.setTextSize(1.5);
1339       display.setTextColor(WHITE);
1340       display.setCursor(10, 1);
1341       display.print("  Detecting... \n Push-ups\n");
```

```
1340         display.display();
1341     }
1342 }
1343 }
1344 if (WristPos == 3 || a_total > 40) {
1345     tmove_prev = tmove;
1346     WristMove = "98";
1347     state = 8;
1348 }
1349 if (tmove - tmove_prev > 12000){
1350     WristMove = "99";
1351     if (ArmMove == "99"){
1352         state = 8;
1353         t_control = tmove;
1354     }
1355 }
1356     break;
1357
1358 case (5): //Beta
1359     if (WristPos == 5) {
1360         if (IniState == 3 && (ArmMove == "45" || ArmMove == "54")) {
1361             WORKOUT.Exercise[5]++;
1362             display.clearDisplay();
1363             display.setTextSize(1.5);
1364             display.setTextColor(WHITE);
1365             display.setCursor(10, 1);
1366             display.print(" Detecting... \n Rope Extension\n");
1367             display.display();
1368         }
1369         tmove_prev = tmove;
1370         state_prev = 5;
1371         state = 4;
1372     }
1373     if (WristPos == 6) {
1374         tmove_prev = tmove;
1375         state_prev = 5;
1376         state = 3;
1377     }
```

```
1378     if (((ay_m_s2_prev[it] - ay_av) > 1.5) && ay_m_s2_prev[it] != 0
1379         && ax_av > -1 && az_av > -1 && IniState == 5) {
1380         Push = 1;
1381         tmove_prev = tmove;
1382         if (IniMove == 0) {
1383             IniMove = 1;
1384         }
1385     }
1386     if (((ay_m_s2_prev[it] - ay_av) < -1.5) && ay_m_s2_prev[it] != 0
1387         && ax_av > -1 && az_av > -1 && IniState == 5) {
1388         Pull = 1;
1389         tmove_prev = tmove;
1390         if (IniMove == 0) {
1391             IniMove = 2;
1392         }
1393     }
1394     if (((az_m_s2_prev[it] - az_av) > 1.5) && az_m_s2_prev[it] != 0
1395         && ay_av > 5 && ax_av > -1 && IniState == 5) {
1396         Push = 1;
1397         tmove_prev = tmove;
1398         if (IniMove == 0) {
1399             IniMove = 1;
1400         }
1401     }
1402     if (((az_m_s2_prev[it] - az_av) < -1.5) && az_m_s2_prev[it] != 0
1403         && ay_av > 5 && ax_av > -1 && IniState == 5) {
1404         Pull = 1;
1405         tmove_prev = tmove;
1406         if (IniMove == 0) {
1407             IniMove = 2;
1408         }
1409     }
1410     if (Push == 1 && Pull == 1 && IniMove == 1) {
1411         if (ArmMove == "03" || (ArmMove == "99" && WORKOUT.Exercise[13]
1412             > 1)) {
1413             WORKOUT.Exercise[13]++;
1414             display.clearDisplay();
1415             display.setTextSize(1.5);
```

```
1411     display.setTextColor(WHITE);
1412     display.setCursor(10, 1);
1413     display.print("  Detecting... \n Opening on chair\n");
1414     display.display();
1415 }
1416 if (ArmMove == "410"  || (ArmMove == "99" && WORKOUT.Exercise
1417     [22] > 1)) {
1418     WORKOUT.Exercise[22]++;
1419     display.clearDisplay();
1420     display.setTextSize(1.5);
1421     display.setTextColor(WHITE);
1422     display.setCursor(10, 1);
1423     display.print("  Detecting... \n Scull\n");
1424     display.display();
1425 }
1426 Push = 0;
1427 Pull = 0;
1428 state_prev = 5;
1429 state = 5;
1430 }
1431 if (WristPos == 1 || WristPos == 3 || WristPos == 2 || a_total >
1432     40) {
1433     tmove_prev = tmove;
1434     WristMove = "98";
1435     state = 8;
1436 }
1437 else if (tmove - tmove_prev > 2000 && tmove - tmove_prev <
1438     12000) {
1439     WristMove = "05";
1440 }
1441 if (tmove - tmove_prev > 12000){
1442     WristMove = "99";
1443     if (ArmMove == "99"){
1444         state = 8;
1445     }
1446 }
1447 }
1448 break;
```

```
1446     case (6): //Delta
1447         if (WristPos == 5) {
1448             if (IniState == 3 && state_prev == 3 && (ArmMove == "05" ||
1449                 ArmMove == "99")) {
1450                 WORKOUT.Exercise[6]++;
1451                 display.clearDisplay();
1452                 display.setTextSize(1.5);
1453                 display.setTextColor(WHITE);
1454                 display.setCursor(10, 1);
1455                 display.print("  Detecting... \n Extension w/bar\n");
1456                 display.display();
1457             }
1458             if (IniState == 6 && (ArmMove == "35" || ArmMove == "53")) {
1459                 if (WORKOUT.MuscGroup[3] > WORKOUT.MuscGroup[2]){
1460                     WORKOUT.Exercise[32]++;
1461                     display.clearDisplay();
1462                     display.setTextSize(1.5);
1463                     display.setTextColor(WHITE);
1464                     display.setCursor(10, 1);
1465                     display.print("  Detecting... \n Pull-over\n");
1466                     display.display();
1467                 }
1468                 else{
1469                     WORKOUT.Exercise[33]++;
1470                     display.clearDisplay();
1471                     display.setTextSize(1.5);
1472                     display.setTextColor(WHITE);
1473                     display.setCursor(10, 1);
1474                     display.print("  Detecting... \n Opening Down\n");
1475                     display.display();
1476                 }
1477             }
1478             tmove_prev = tmove;
1479             state_prev = 6;
1480             state = 4;
1481         }
1482         if (WristPos == 6) {
1483             if (IniState == 4 && (ArmMove == "05" || ArmMove == "99")) {
```

```
1483     WORKOUT.Exercise[4]++;
1484     display.clearDisplay();
1485     display.setTextSize(1.5);
1486     display.setTextColor(WHITE);
1487     display.setCursor(10, 1);
1488     display.print("  Detecting... \n Inverse Curl\n");
1489     display.display();
1490   }
1491   tmove_prev = tmove;
1492   state_prev = 6;
1493   state = 3;
1494 }
1495 if (WristPos == 1 || WristPos == 3 || WristPos == 4 || a_total >
1496     30){
1497   tmove_prev = tmove;
1498   WristMove = "98";
1499   state = 8;
1500 }
1501 if (tmove - tmove_prev > 12000){
1502   WristMove == "99";
1503   if (ArmMove == "99"){
1504     state = 1;
1505   }
1506 }
1507 if ((ax_m_s2_prev[it] - ax_av < -1.5) && az_av > 0 && IniState
1508     == 6) {
1509   Push = 1;
1510   if (IniMove == 0) {
1511     IniMove = 1;
1512   }
1513   tmove_prev = tmove;
1514 }
1515 if ((ax_m_s2_prev[it] - ax_av > 1.5) && az_av > 0 && IniState ==
1516     6) {
1517   Pull = 1;
1518   if (IniMove == 0) {
1519     IniMove = 2;
1520   }
1521 }
```

```
1518     tmove_prev = tmove;
1519 }
1520 if ((az_m_s2_prev[it] - az_av > 1.5) && ax_av > 0 && IniState ==
1521     6) {
1522     Pull = 1;
1523     if (IniMove == 0) {
1524         IniMove = 3;
1525     }
1526     tmove_prev = tmove;
1527 }
1528 if ((az_m_s2_prev[it] - az_av < -1.5) && ax_av > 0 && IniState
1529     == 6) {
1530     Push = 1;
1531     if (IniMove == 0) {
1532         IniMove = 4;
1533     }
1534     tmove_prev = tmove;
1535 }
1536 if (Push == 1 && Pull == 1){
1537     if (ArmMove == "03" || ArmMove == "99"){
1538         if (IniMove == 1 || WORKOUT.Exercise[14] > 2) {
1539             WORKOUT.Exercise[14]++;
1540             display.clearDisplay();
1541             display.setTextSize(1.5);
1542             display.setTextColor(WHITE);
1543             display.setCursor(10, 1);
1544             display.print(" Detecting... \n Push\n");
1545             display.display();
1546             state = 3;
1547         }
1548         if (IniMove == 3 || WORKOUT.Exercise[25] > 2) {
1549             WORKOUT.Exercise[25]++;
1550             display.clearDisplay();
1551             display.setTextSize(1.5);
1552             display.setTextColor(WHITE);
1553             display.setCursor(10, 1);
1554             display.print(" Detecting... \n Opening\n");
1555             display.display();
```

```
1554     state = 3;
1555     }
1556   }
1557   state = 3;
1558 }
1559 else if (tmove - tmove_prev > 2000 && tmove - tmove_prev <
1560         12000) {
1561   WristMove = "06";
1562   if (ExDisp == 1){
1563     display.clearDisplay();
1564     display.setTextSize(1.5);
1565     display.setTextColor(WHITE);
1566     display.setCursor(10, 1);
1567     display.print("  Detecting... \n Pull w/rope\n");
1568     display.display();
1569   }
1570   break;
1571
1572 case (7): //Dseta
1573   if (WristPos == 6) {
1574     if (IniState == 7 && (ArmMove == "02" || ArmMove == "99")) {
1575       WORKOUT.Exercise[29]++;
1576       display.clearDisplay();
1577       display.setTextSize(1.5);
1578       display.setTextColor(WHITE);
1579       display.setCursor(10, 1);
1580       display.print("  Detecting... \n Vertical Extension\n");
1581       display.display();
1582     }
1583     tmove_prev = tmove;
1584     state_prev = 7;
1585     state = 3;
1586   }
1587   if (WristPos == 4 || WristPos == 1 || WristPos == 5 || WristPos
1588       == 2 || a_total > 40) {
1589     tmove_prev = tmove;
1590     WristMove = "98";
```



```
1590     state = 8;
1591 }
1592 if (tmove - tmove_prev > 12000){
1593     WristMove = "99";
1594     if (ArmMove == "99"){
1595         state = 1;
1596     }
1597 }
1598     break;
1599
1600 case (8): // Definition of moves
1601     if (WORKOUT.Exercise[1] < 3) {
1602         WORKOUT.Exercise[1] = 0;
1603     }
1604     if (WORKOUT.Exercise[2] < 3) {
1605         WORKOUT.Exercise[2] = 0;
1606     }
1607     if (WORKOUT.Exercise[3] < 3) {
1608         WORKOUT.Exercise[3] = 0;
1609     }
1610     if (WORKOUT.Exercise[4] < 3) {
1611         WORKOUT.Exercise[4] = 0;
1612     }
1613     if (WORKOUT.Exercise[5] < 3) {
1614         WORKOUT.Exercise[5] = 0;
1615     }
1616     if (WORKOUT.Exercise[6] < 3) {
1617         WORKOUT.Exercise[6] = 0;
1618     }
1619     if (WORKOUT.Exercise[7] < 3) {
1620         WORKOUT.Exercise[7] = 0;
1621     }
1622     if (WORKOUT.Exercise[12] < 3) {
1623         WORKOUT.Exercise[12] = 0;
1624     }
1625     if (WORKOUT.Exercise[13] < 3) {
1626         WORKOUT.Exercise[13] = 0;
1627     }
```

```
1628     if (WORKOUT.Exercise[14] < 3) {
1629         WORKOUT.Exercise[14] = 0;
1630     }
1631     if (WORKOUT.Exercise[16] < 3) {
1632         WORKOUT.Exercise[16] = 0;
1633     }
1634     if (WORKOUT.Exercise[17] < 3) {
1635         WORKOUT.Exercise[17] = 0;
1636     }
1637     if (WORKOUT.Exercise[19] < 3) {
1638         WORKOUT.Exercise[19] = 0;
1639     }
1640     if (WORKOUT.Exercise[22] < 3) {
1641         WORKOUT.Exercise[22] = 0;
1642     }
1643     if (WORKOUT.Exercise[23] < 3) {
1644         WORKOUT.Exercise[23] = 0;
1645     }
1646     if (WORKOUT.Exercise[25] < 3) {
1647         WORKOUT.Exercise[25] = 0;
1648     }
1649     if (WORKOUT.Exercise[28] < 3) {
1650         WORKOUT.Exercise[28] = 0;
1651     }
1652     if (WORKOUT.Exercise[27] < 3) {
1653         WORKOUT.Exercise[27] = 0;
1654     }
1655     if (WORKOUT.Exercise[29] < 3) {
1656         WORKOUT.Exercise[29] = 0;
1657     }
1658     if (WORKOUT.Exercise[30] < 3) {
1659         WORKOUT.Exercise[30] = 0;
1660     }
1661     if (WORKOUT.Exercise[32] < 3) {
1662         WORKOUT.Exercise[32] = 0;
1663     }
1664     if (WORKOUT.Exercise[33] < 3) {
1665         WORKOUT.Exercise[33] = 0;
```

```
1666     }
1667     if (WORKOUT.Exercise[1] > 3) {
1668         WORKOUT.Series [j] = WORKOUT.Exercise[1];
1669         WORKOUT.Ex[j] = "Simple Curl (biceps)";
1670         WORKOUT.Exercise[1] = 0;
1671         WORKOUT.MuscGroup[0]++;
1672         accel_id[0] = 0;
1673         accel_id[1] = 0;
1674         accel_id[2] = 9;
1675         accel_id[3] = 0;
1676         accel_id[4] = 9;
1677         accel_id[5] = 0;
1678     }
1679     if (WORKOUT.Exercise[2] > 3) {
1680         WORKOUT.Series[j] = WORKOUT.Exercise[2];
1681         WORKOUT.Exercise[2] = 0;
1682         WORKOUT.Ex[j] = "Hammer (biceps)";
1683         WORKOUT.MuscGroup[0]++;
1684         accel_id[0] = 0;
1685         accel_id[1] = -9;
1686         accel_id[2] = 0;
1687         accel_id[3] = 9;
1688         accel_id[4] = 0;
1689         accel_id[5] = 0;
1690     }
1691     if (WORKOUT.Exercise[3] > 3) {
1692         WORKOUT.Series [j] = WORKOUT.Exercise[3];
1693         WORKOUT.Ex[j] = "Concentrated Curl (biceps)";
1694         WORKOUT.Exercise[3] = 0;
1695         WORKOUT.MuscGroup[0]++;
1696         accel_id[0] = 0;
1697         accel_id[1] = -9;
1698         accel_id[2] = 0;
1699         accel_id[3] = 0;
1700         accel_id[4] = 0;
1701         accel_id[5] = 9;
1702     }
1703     if (WORKOUT.Exercise[4] > 3) {
```

```
1704     WORKOUT.Series[j] = WORKOUT.Exercise[4];
1705     WORKOUT.Exercise[4] = 0;
1706     WORKOUT.Ex[j] = "Inverse Curl (biceps)";
1707     WORKOUT.MuscGroup[0]++;
1708     accel_id[0] = 0;
1709     accel_id[1] = -9;
1710     accel_id[2] = 0;
1711     accel_id[3] = 0;
1712     accel_id[4] = 9;
1713     accel_id[5] = 0;
1714 }
1715 if (WORKOUT.Exercise[5] > 3) {
1716     WORKOUT.Series[j] = WORKOUT.Exercise[5];
1717     WORKOUT.Exercise[5] = 0;
1718     WORKOUT.Ex[j] = "Rope Extension (triceps)";
1719     WORKOUT.MuscGroup[1]++;
1720     accel_id[0] = 0;
1721     accel_id[1] = 9;
1722     accel_id[2] = 0;
1723     accel_id[3] = 0;
1724     accel_id[4] = -9;
1725     accel_id[5] = 0;
1726 }
1727 if (WORKOUT.Exercise[6] > 3) {
1728     WORKOUT.Series[j] = WORKOUT.Exercise[6];
1729     WORKOUT.Exercise[6] = 0;
1730     WORKOUT.Ex[j] = "Extension w/bar (triceps)";
1731     WORKOUT.MuscGroup[1]++;
1732     accel_id[0] = 0;
1733     accel_id[1] = 9;
1734     accel_id[2] = 0;
1735     accel_id[3] = 0;
1736     accel_id[4] = -9;
1737     accel_id[5] = 0;
1738 }
1739 if (WORKOUT.Exercise[7] > 3) {
1740     WORKOUT.Series[j] = WORKOUT.Exercise[7];
1741     WORKOUT.Exercise[7] = 0;
```

```
1742     WORKOUT.Ex[j] = "Inverse Extension (triceps)";
1743     WORKOUT.MuscGroup[1]++;
1744     accel_id[0] = 0;
1745     accel_id[1] = 9;
1746     accel_id[2] = 0;
1747     accel_id[3] = 0;
1748     accel_id[4] = -9;
1749     accel_id[5] = 0;
1750 }
1751 if (WORKOUT.Exercise[12] > 3) {
1752     WORKOUT.Series[j] = WORKOUT.Exercise[12];
1753     WORKOUT.Exercise[12] = 0;
1754     WORKOUT.Ex[j] = "Opening on bench (chest)";
1755     WORKOUT.MuscGroup[2]++;
1756     accel_id[0] = 0;
1757     accel_id[1] = 0;
1758     accel_id[2] = 9;
1759     accel_id[3] = 0;
1760     accel_id[4] = 9;
1761     accel_id[5] = 0;
1762 }
1763 if (WORKOUT.Exercise[13] > 3) {
1764     WORKOUT.Series[j] = WORKOUT.Exercise[13];
1765     WORKOUT.Exercise[13] = 0;
1766     WORKOUT.Ex[j] = "Opening on chair (chest)";
1767     WORKOUT.MuscGroup[2]++;
1768     accel_id[0] = 9;
1769     accel_id[1] = 0;
1770     accel_id[2] = 0;
1771     accel_id[3] = 9;
1772     accel_id[4] = 0;
1773     accel_id[5] = 0;
1774 }
1775 if (WORKOUT.Exercise[14] > 3) {
1776     WORKOUT.Series[j] = WORKOUT.Exercise[14];
1777     WORKOUT.Exercise[14] = 0;
1778     WORKOUT.Ex[j] = "Push (chest)";
1779     WORKOUT.MuscGroup[2]++;
```

```
1780     accel_id[0] = 0;
1781     accel_id[1] = 0;
1782     accel_id[2] = -9;
1783     accel_id[3] = 0;
1784     accel_id[4] = 0;
1785     accel_id[5] = -9;
1786 }
1787 if (WORKOUT.Exercise[16] > 3) {
1788     WORKOUT.Series[j] = WORKOUT.Exercise[16];
1789     WORKOUT.Exercise[16] = 0;
1790     WORKOUT.Ex[j] = "Lifting (chest)";
1791     WORKOUT.MuscGroup[2]++;
1792     accel_id[0] = 0;
1793     accel_id[1] = -9;
1794     accel_id[2] = 0;
1795     accel_id[3] = 0;
1796     accel_id[4] = 0;
1797     accel_id[5] = 9;
1798 }
1799 if (WORKOUT.Exercise[17] > 3) {
1800     WORKOUT.Series[j] = WORKOUT.Exercise[17];
1801     WORKOUT.Exercise[17] = 0;
1802     WORKOUT.Ex[j] = "Scull to neck (chest)";
1803     WORKOUT.MuscGroup[2]++;
1804     accel_id[0] = 0;
1805     accel_id[1] = -9;
1806     accel_id[2] = 0;
1807     accel_id[3] = 0;
1808     accel_id[4] = 0;
1809     accel_id[5] = -9;
1810 }
1811 if (WORKOUT.Exercise[19] > 3) {
1812     WORKOUT.Series[j] = WORKOUT.Exercise[19];
1813     WORKOUT.Exercise[18] = 0;
1814     WORKOUT.Ex[j] = "Pull (back)";
1815     WORKOUT.MuscGroup[3]++;
1816     accel_id[0] = 0;
1817     accel_id[1] = 9;
```

```
1818     accel_id[2] = 0;
1819     accel_id[3] = 0;
1820     accel_id[4] = 9;
1821     accel_id[5] = 0;
1822 }
1823 if (WORKOUT.Exercise[22] > 3) {
1824     WORKOUT.Series[j] = WORKOUT.Exercise[22];
1825     WORKOUT.Exercise[22] = 0;
1826     WORKOUT.Ex[j] = "Scull (back)";
1827     WORKOUT.MuscGroup[3]++;
1828     accel_id[0] = 9;
1829     accel_id[1] = 0;
1830     accel_id[2] = 0;
1831     accel_id[3] = 9;
1832     accel_id[4] = 0;
1833     accel_id[5] = 0;
1834 }
1835 if (WORKOUT.Exercise[23] > 3) {
1836     WORKOUT.Series[j] = WORKOUT.Exercise[23];
1837     WORKOUT.Exercise[23] = 0;
1838     WORKOUT.Ex[j] = "Horizontal Low Scull (back)";
1839     WORKOUT.MuscGroup[3]++;
1840     accel_id[0] = 0;
1841     accel_id[1] = 0;
1842     accel_id[2] = 9;
1843     accel_id[3] = 0;
1844     accel_id[4] = 9;
1845     accel_id[5] = 0;
1846 }
1847 if (WORKOUT.Exercise[25] > 3) {
1848     WORKOUT.Series[j] = WORKOUT.Exercise[25];
1849     WORKOUT.Exercise[25] = 0;
1850     WORKOUT.Ex[j] = "Opening (shoulders)";
1851     WORKOUT.MuscGroup[3]++;
1852     accel_id[0] = 0;
1853     accel_id[1] = 0;
1854     accel_id[2] = -9;
1855     accel_id[3] = 0;
```

```
1856     accel_id[4] = 0;
1857     accel_id[5] = -9;
1858 }
1859 if (WORKOUT.Exercise[28] > 3) {
1860     WORKOUT.Series[j] = WORKOUT.Exercise[28];
1861     WORKOUT.Exercise[28] = 0;
1862     WORKOUT.Ex[j] = "Flight (shoulders)";
1863     WORKOUT.MuscGroup[4]++;
1864     accel_id[0] = 0;
1865     accel_id[1] = -9;
1866     accel_id[2] = 0;
1867     accel_id[3] = 0;
1868     accel_id[4] = 0;
1869     accel_id[5] = -9;
1870 }
1871 if (WORKOUT.Exercise[27] > 3) {
1872     WORKOUT.Series[j] = WORKOUT.Exercise[27];
1873     WORKOUT.Exercise[27] = 0;
1874     WORKOUT.Ex[j] = "Vertical Lifting (shoulders)";
1875     WORKOUT.MuscGroup[4]++;
1876     accel_id[0] = 0;
1877     accel_id[1] = -9;
1878     accel_id[2] = 0;
1879     accel_id[3] = 9;
1880     accel_id[4] = 0;
1881     accel_id[5] = 0;
1882 }
1883 if (WORKOUT.Exercise[29] > 3) {
1884     WORKOUT.Series[j] = WORKOUT.Exercise[29];
1885     WORKOUT.Exercise[29] = 0;
1886     WORKOUT.Ex[j] = "Vertical Extensions (triceps)";
1887     WORKOUT.MuscGroup[1]++;
1888     accel_id[0] = -9;
1889     accel_id[1] = 0;
1890     accel_id[2] = 0;
1891     accel_id[3] = 0;
1892     accel_id[4] = 9;
1893     accel_id[5] = 0;
```



```
1894     }
1895     if (WORKOUT.Exercise[30] > 3) {
1896         WORKOUT.Series[j] = WORKOUT.Exercise[30];
1897         WORKOUT.Exercise[30] = 0;
1898         WORKOUT.Ex[j] = "Diamond Push-ups (triceps)";
1899         WORKOUT.MuscGroup[1]++;
1900         accel_id[0] = 0;
1901         accel_id[1] = -9;
1902         accel_id[2] = 0;
1903         accel_id[3] = 0;
1904         accel_id[4] = 0;
1905         accel_id[5] = -9;
1906     }
1907     if (WORKOUT.Exercise[32] > 3) {
1908         WORKOUT.Series[j] = WORKOUT.Exercise[32];
1909         WORKOUT.Exercise[32] = 0;
1910         WORKOUT.Ex[j] = "Pull-over (back)";
1911         WORKOUT.MuscGroup[3]++;
1912         accel_id[0] = 0;
1913         accel_id[1] = 0;
1914         accel_id[2] = -9;
1915         accel_id[3] = 0;
1916         accel_id[4] = -9;
1917         accel_id[5] = 0;
1918     }
1919     if (WORKOUT.Exercise[33] > 3) {
1920         WORKOUT.Series[j] = WORKOUT.Exercise[33];
1921         WORKOUT.Exercise[33] = 0;
1922         WORKOUT.Ex[j] = "Opening down (back)";
1923         WORKOUT.MuscGroup[3]++;
1924         accel_id[0] = 0;
1925         accel_id[1] = 0;
1926         accel_id[2] = -9;
1927         accel_id[3] = 0;
1928         accel_id[4] = -9;
1929         accel_id[5] = 0;
1930     }
1931     display.clearDisplay();
```

```
1932     display.setTextSize(1.5);
1933     display.setTextColor(WHITE);
1934     display.setCursor(10, 1);
1935     display.println("    Registering reps");
1936     display.display();
1937     env = true;
1938     t_control = tmove;
1939     state = 1;
1940         break;
1941     }
1942
1943     display.setTextSize(1.9);
1944     display.setTextColor(WHITE);
1945     display.print ("\nSerie ");
1946     display.print (j-1);
1947     display.print (" w/ ");
1948     display.print (WORKOUT.Series[j-1]);
1949     display.print (" reps\n");
1950     display.println (WORKOUT.Ex[j-1]);
1951     display.print("\n");
1952     display.print ("WO time: ");
1953     display.print (mins);
1954     display.print (" mins");
1955     display.print("\n");
1956     display.display();
1957
1958     Serial.print("valueW: ");
1959     Serial.print(valueW.c_str());
1960     Serial.print("\n");
1961     Serial.print("valueA: ");
1962     Serial.print(valueA.c_str());
1963     Serial.print("\n");
1964     }
1965
1966     if (workoutctrl == 2){
1967         order = false;
1968         WristMove = "96";
1969         float tm = tmove;
```

```

1970     WORKOUT.kcal = round((tm / 3600000) * 450);
1971     Serial.print("tmove: ");
1972     Serial.print(tmove);
1973     Serial.print("\n");
1974     Serial.print("KCAL: ");
1975     Serial.print(WORKOUT.kcal);
1976     Serial.print("\n");
1977
1978     display.clearDisplay();
1979     display.setTextSize(1.95);
1980     display.setTextColor(WHITE);
1981     display.setCursor(10, 1);
1982     display.println ("  WORKOUT DONE!");
1983     display.setTextSize(1.7);
1984     display.println ("");
1985     display.println ("Check your email, \nreview your workout  in the
           app, \nor start a new          workout");
1986     display.display();
1987     FinishWorkout();
1988     FinishedTime = millis()-tmove;
1989     tmove = 0;
1990     tmove_prev = 0;
1991     t_control = 0;
1992     WORKOUT.Series [30] = {0};
1993     WORKOUT.MuscGroup[5] = {0};
1994     WORKOUT.kcal = 0;
1995     workoutctrl = 0;
1996 }
1997 });
1998
1999 Task taskBLE(TASK_SECOND / 3, TASK_FOREVER, []() {
2000     if(pServer->getConnectionCount()) {
2001         NimBLEService* pSvc = pServer->getServiceByUUID((uint16_t)0x1826)
                ;
2002         NimBLECharacteristic* pArm = pSvc->getCharacteristic(
                CHARACTERISTIC_UUID_ARM);
2003         valueW = "WM_" + WristMove;
2004         pWristCharacteristic->setValue(valueW);

```

```
2005     valueA = pArmCharacteristic->getValue();
2006     header = valueA.substr(0, 2); //Decoding of messages
2007         if (header == "AM"){
2008             ArmMove = s.separa(valueA.c_str(), '_', 1).c_str();
2009             ExDisp = s.separa(valueA.c_str(), '_', 2).toInt();
2010         }
2011         if (header == "EX"){
2012             ArmEx = s.separa(valueA.c_str(), '_', 1).toInt();
2013             ArmRep = s.separa(valueA.c_str(), '_', 2).toInt();
2014         }
2015     }
2016     std::string infoBLE = pInfoCharacteristic->getValue();
2017     if (infoBLE == "Reminder"){
2018         Serial.println(Reminder);
2019         webServer();
2020         if (localip == true){
2021             pInfoCharacteristic->setValue(WiFi.localIP());
2022         }
2023     }
2024     if (infoBLE == "Ready"){
2025         Serial.println(infoBLE.c_str());
2026         pInfoCharacteristic->setValue("Start");
2027         display.clearDisplay();
2028         display.setTextSize(1.95);
2029         display.setTextColor(WHITE);
2030         display.setCursor(10, 1);
2031         display.println("WELCOME TO MO&REP");
2032         display.setTextSize(1.7);
2033         display.println("    by Gabriel Glez\n\n");
2034         display.println("Waiting instructions");
2035         display.display();
2036     }
2037     if (infoBLE == "Email"){
2038         mail = not(mail);
2039         pInfoCharacteristic->setValue("Settings");
2040     }
2041     if (infoBLE == "WorkoutOn"){
2042         workoutctrl = 1;
```

```
2043     pInfoCharacteristic->setValue("SessionOn");
2044     Serial.println(infoBLE.c_str());
2045 }
2046 if (infoBLE == "WorkoutOff"){
2047     workoutctrl = 2;
2048     pInfoCharacteristic->setValue("SessionOff");
2049 }
2050 if (infoBLE == "SessionOff"){
2051     FinishedTime = millis()-tmove;
2052 }
2053 if (infoBLE == "LegsOn"){
2054     Serial.println("LegsOn");
2055     pInfoCharacteristic->setValue("Ready");
2056     taskMPU.disable();
2057     taskMPULegs.enable();
2058 }
2059 if (infoBLE == "LegsOff"){
2060     pInfoCharacteristic->setValue("Ready");
2061     taskMPU.enable();
2062     taskMPULegs.disable();
2063 }
2064 if ((workoutctrl == 0 && (FinishedTime/1000) > 10) || infoBLE == "
    Sleep"){
2065     pInfoCharacteristic->setValue("Sleep");
2066     taskMPU.disable();
2067     taskMPULegs.disable();
2068     taskBLE.setInterval(TASK_SECOND*2);
2069     setCpuFrequencyMhz(80);
2070     display.clearDisplay();
2071     display.drawBitmap(0, 0, LogoMoRep, 128, 64, WHITE);
2072     display.display();
2073     FinishedTime = millis()-tmove;
2074     if (FinishedTime/1000 > 30 && infoBLE == "Sleep"){
2075         taskMPU.disable();
2076         taskMPULegs.disable();
2077         taskBLE.setInterval(10*TASK_SECOND);
2078         setCpuFrequencyMhz(80);
2079         display.clearDisplay();
```

```
2080     }
2081 }
2082
2083 else if (infoBLE == "WakeUp"){
2084     setCpuFrequencyMhz(240);
2085     taskMPU.enable();
2086     taskBLE.setInterval(TASK_SECOND/3);
2087     pInfoCharacteristic->setValue("Awaken");
2088     FinishedTime = 0;
2089     display.clearDisplay();
2090     display.setTextSize(1.95);
2091     display.setTextColor(WHITE);
2092     display.setCursor(10, 1);
2093     display.println("WELCOME TO MO&REP");
2094     display.setTextSize(1.7);
2095     display.println("    by Gabriel Glez\n\n");
2096     display.println("Waiting instructions");
2097     display.display();
2098 }
2099 });
2100
2101 Task taskwebServer(TASK_SECOND*5, TASK_FOREVER, []() {
2102     WiFiClient client = server.available();
2103     if (client) {
2104         currentTime = millis();
2105         previousTime = currentTime;
2106         String currentLine = "";
2107         while (client.connected()) {
2108             currentTime = millis();
2109             if (client.available()) {
2110                 char c = client.read();
2111                 Serial.write(c);
2112                 head += c;
2113                 if (c == '\n') {
2114                     if (currentLine.length() == 0) {
2115                         client.println("HTTP/1.1 200 OK");
2116                         client.println("Content-type:text/html");
2117                         client.println("Connection: close");
```

```
2118     client.println();
2119
2120     client.println("<head><meta name=\"viewport\" content=\"
           width=device-width, initial-scale=1\">");
2121     client.println("<body bgcolor = black><h1><font color = #
           F5B4FF><center>Mo&Rep Station</center></font></h1>");
2122     client.println("<h1><font size = 2 color = white><center>
           ");
2123     client.println("<meta name=\"viewport\" content=\"width=
           device-width, initial-scale=1\">");
2124     client.print(Reminder.c_str());
2125     client.print("</center></font></body>");
2126     break;
2127 } else {
2128     currentLine = "";
2129 }
2130 } else if (c != '\r') {
2131     currentLine += c;
2132 }
2133 }
2134 }
2135 head = "";
2136 client.stop();
2137 Serial.println("Client disconnected.");
2138 Serial.println("");
2139 }
2140 });
2141
2142 void Postures(){
2143     for (int i = 0; i < sizeof(accel_av)/sizeof(accel_av[0]); i++){
2144         if (accel_av[i] >= abs(1+3*(accel_id[i]+accel_id[i+2])/4)){
2145             display.clearDisplay();
2146             display.setTextSize(1.95);
2147             display.setTextColor(WHITE);
2148             display.setCursor(10, 1);
2149             display.print ("Fix your posture in ");
2150             display.print(WORKOUT.Ex[j-1]);
2151             display.display();
```

```
2152     }
2153   }
2154 }
2155
2156
2157 void setup() {
2158   Serial.begin(115200);
2159   EEPROM.begin(4096);
2160   Wire.begin();
2161   scan_i2c();
2162
2163   NimBLEDevice::init("Mo&Rep Station");
2164   NimBLEDevice::setSecurityAuth(/*BLE_M_PAIR_AUTHREQ_BOND |
2165     BLE_SM_PAIR_AUTHREQ_MITM */ BLE_SM_PAIR_AUTHREQ_SC);
2166   pServer = NimBLEDevice::createServer();
2167   pServer->setCallbacks(new ServerCallbacks());
2168   NimBLEService* pActionsService = pServer->createService((uint16_t)0
2169     x1826);
2170   pWristCharacteristic = pActionsService->createCharacteristic(
2171     CHARACTERISTIC_UUID_WRIST,
2172     NIMBLE_PROPERTY::READ |
2173     NIMBLE_PROPERTY::WRITE |
2174     NIMBLE_PROPERTY::NOTIFY |
2175     NIMBLE_PROPERTY::READ_ENC
2176   );
2177   pArmCharacteristic = pActionsService->createCharacteristic(
2178     CHARACTERISTIC_UUID_ARM,
2179     NIMBLE_PROPERTY::READ |
2180     NIMBLE_PROPERTY::WRITE |
2181     NIMBLE_PROPERTY::NOTIFY |
2182     NIMBLE_PROPERTY::READ_ENC
2183   );
2184   pInfoCharacteristic = pActionsService->createCharacteristic(
2185     CHARACTERISTIC_UUID_INFO,
2186     NIMBLE_PROPERTY::READ |
2187     NIMBLE_PROPERTY::WRITE |
2188     NIMBLE_PROPERTY::NOTIFY
2189   );
```



```
2188 pWristCharacteristic->setValue("WM_");
2189 pWristCharacteristic->setCallbacks(&chrCallbacks);
2190 pArmCharacteristic->setValue("AM_");
2191 pArmCharacteristic->setCallbacks(&chrCallbacks);
2192 pInfoCharacteristic->setValue("NONE");
2193 pInfoCharacteristic->setCallbacks(&chrCallbacks);
2194 pActionsService->start();
2195 NimBLEAdvertising* pAdvertising = NimBLEDevice::getAdvertising();
2196 pAdvertising->addServiceUUID(pActionsService->getUUID());
2197
2198 pAdvertising->setScanResponse(false);
2199 pAdvertising->start();
2200
2201 ReadingEEPROM();
2202 display.begin(SSD1306_SWITCHCAPVCC, 0x3C);
2203 mpu.initialize();
2204 if (mpu.testConnection()){
2205     Serial.println("Accelerometer Detected");
2206 }
2207 else{
2208     Serial.println("Error in Accelerometer");
2209 }
2210
2211 display.clearDisplay();
2212 display.drawBitmap(0, 0, LogoMoRep, 128, 64, WHITE);
2213 display.display();
2214
2215 MoRepScheduler.addTask(taskMPU);
2216 taskMPU.enable();
2217 MoRepScheduler.addTask(taskBLE);
2218 taskBLE.enable();
2219 MoRepScheduler.addTask(taskMPULegs);
2220 MoRepScheduler.addTask(taskwebServer);
2221 }
2222
2223 void loop() {
2224     MoRepScheduler.execute();
2225 }
```

```

2226
2227 void FinishWorkout() {
2228     int n = 0;
2229
2230     Review += "<html>";
2231     Review += "<body>";
2232     Review += "<h1>Workout review:</h1>";
2233     Review += "<br>";
2234     for (k = 1; k <= j-1; k++){
2235         Analysis += std::string("Serie ") + String(k,DEC).c_str() + std::
                string(" with ") + String(WORKOUT.Series[k],DEC).c_str() + std
                ::string(" repetitions ") + WORKOUT.Ex[k].c_str()
2236         + std::string("<br>");
2237     }
2238
2239     Review += Analysis + std::string(" <br>") + std::string ("Exercises
                : <br>Biceps: ") + String(WORKOUT.MuscGroup[0],DEC).c_str()
2240         + std::string ("<br>Triceps: ") + String(WORKOUT.MuscGroup
                [1],DEC).c_str() + std::string ("<br>Chest: ") + String(
                WORKOUT.MuscGroup[2],DEC).c_str() + std::string ("<br>
                Back: ")
2241         + String(WORKOUT.MuscGroup[3],DEC).c_str() + std::string ("<
                br>Shoulders: ") + String(WORKOUT.MuscGroup[4],DEC).c_str
                () + std::string ("<br>Legs: ") + String(WORKOUT.
                MuscGroup[5],DEC).c_str()
2242         + std::string ("<br>TOTAL KCAL: "); + String(WORKOUT.kcal,
                DEC).c_str();
2243     Review += "</p>";
2244     Review += "</body>";
2245     Review += "</html>";
2246
2247     for (int m = 0; m <= int(Review.length()); m++){
2248         EEPROM.write(m, Review[m]);
2249     }
2250
2251     EEPROM.commit();
2252
2253     WiFi.begin(SECRET_SSID, SECRET_PASS);

```

```
2254     while (WiFi.status() != WL_CONNECTED){
2255         Serial.print(".");
2256         delay(200);
2257     }
2258
2259     WiFi.mode(WIFI_STA);
2260
2261     if (mail == true){
2262         smtp.debug(1);
2263         smtp.callback(smtpCallback);
2264         ESP_Mail_Session session;
2265         session.server.host_name = SMTP_HOST;
2266         session.server.port = SMTP_PORT;
2267         session.login.email = AUTHOR_EMAIL;
2268         session.login.password = AUTHOR_PASSWORD;
2269         session.login.user_domain = "moandrepsystem.net";
2270
2271         SMTP_Message message;
2272
2273         message.sender.name = "Mo&Rep System";
2274         message.sender.email = AUTHOR_EMAIL;
2275         message.subject = "Workout Session Review";
2276         message.addRecipient("Gabriel", "gabriel.glez.rial@gmail.com");
2277
2278         message.html.content = Review.c_str();
2279         message.html.charset = "utf-8";
2280         message.html.transfer_encoding = Content_Transfer_Encoding::
            enc_7bit;
2281         message.priority = esp_mail_smtp_priority::
            esp_mail_smtp_priority_low;
2282         message.response.notify = esp_mail_smtp_notify_success |
            esp_mail_smtp_notify_failure | esp_mail_smtp_notify_delay;
2283         message.addHeader("Message-ID: <abcde.fghij@gmail.com>");
2284
2285         if (!smtp.connect(&session))
2286             return;
2287
2288         if (!MailClient.sendMail(&smtp, &message))
```

```
2289     Serial.println("Error sending Email, " + smtp.errorReason());
2290
2291     ESP_MAIL_PRINTF("Free Heap: %d\n", MailClient.getFreeHeap());
2292 }
2293
2294 ThingSpeak.begin(client);
2295 for (int i = 0; i < 5; i++){
2296     ThingSpeak.setField(i+1, WORKOUT.MuscGroup[i]);
2297 }
2298
2299 httpCode = ThingSpeak.writeFields(myChannelNumber, myWriteAPIKey);
2300
2301 Serial.print(httpCode);
2302 if (httpCode == 200) {
2303     Serial.println("Channel write successful.");
2304 }
2305 else {
2306     Serial.println("Problem writing to channel. HTTP error code " +
2307         String(httpCode));
2308 }
2309
2310 void scan_i2c() {
2311     byte error, address;
2312     Serial.println("Scanning...");
2313     nDevices = 0;
2314     for (address = 1; address < 127; address++)
2315     {
2316         Wire.beginTransmission(address);
2317         error = Wire.endTransmission();
2318         if (error == 0)
2319         {
2320             Serial.print("I2C Device in ADDRESS 0x");
2321             if (address < 16)
2322                 Serial.print("0");
2323             i2c_address[nDevices] = address;
2324             Serial.print(address, HEX);
2325             Serial.println("  !");
```

```
2326     nDevices++;
2327 }
2328 else if (error == 4)
2329 {
2330     Serial.print("Unknown error in ADDRESS 0x");
2331     if (address < 16)
2332         Serial.print("0");
2333     Serial.println(address, HEX);
2334 }
2335 }
2336 if (nDevices == 0)
2337     Serial.println("No I2C Device connected\n");
2338 else
2339     Serial.println("Done\n");
2340 delay(1000);
2341 }
2342
2343 void ReadingEEPROM(){
2344     for (int addr = 0; addr <= EEPROM_SIZE; addr++){
2345         Reminder += char(EEPROM.read(addr));
2346     }
2347     Reminder = Reminder.c_str();
2348 }
2349
2350 void smtpCallback(SMTP_Status status){
2351     /* Print the current status */
2352     Serial.println(status.info());
2353
2354     /* Print the sending result */
2355     if (status.success())
2356     {
2357         Serial.println("-----");
2358         ESP_MAIL_PRINTF("Message sent success: %d\n", status.
                completedCount());
2359         ESP_MAIL_PRINTF("Message sent failed: %d\n", status.failedCount
                ());
2360         Serial.println("-----\n");
2361         struct tm dt;
```

```
2362
2363     for (size_t i = 0; i < smtp.sendingResult.size(); i++)
2364     {
2365         /* Get the result item */
2366         SMTP_Result result = smtp.sendingResult.getItem(i);
2367         time_t ts = (time_t)result.timestamp;
2368         localtime_r(&ts, &dt);
2369
2370         ESP_MAIL_PRINTF("Message No: %d\n", i + 1);
2371         ESP_MAIL_PRINTF("Status: %s\n", result.completed ? "success" :
2372             "failed");
2373         ESP_MAIL_PRINTF("Date/Time: %d/%d/%d %d:%d:%d\n", dt.tm_year +
2374             1900, dt.tm_mon + 1, dt.tm_mday, dt.tm_hour, dt.tm_min, dt.
2375             tm_sec);
2373         ESP_MAIL_PRINTF("Recipient: %s\n", result.recipients);
2374         ESP_MAIL_PRINTF("Subject: %s\n", result.subject);
2375     }
2376     Serial.println("-----\n");
2377 }
2378 }
2379
2380 void webServer(){
2381     Serial.print("Connecting to ");
2382     Serial.println(SECRET_SSID);
2383     WiFi.begin(SECRET_SSID, SECRET_PASS);
2384     while (WiFi.status() != WL_CONNECTED) {
2385         delay(500);
2386         Serial.print(".");
2387     }
2388     // Print local IP address and start web server
2389     Serial.println("");
2390     Serial.println("WiFi connected.");
2391     Serial.println("IP address: ");
2392     Serial.println(WiFi.localIP());
2393     localip = true;
2394     server.begin();
2395     taskwebServer.enable();
2396 }
```

Código correspondiente al nodo superior

```
1  #include <Arduino.h>
2  #include <Wire.h>
3  #include <Adafruit_GFX.h>
4  #include <Adafruit_SSD1306.h>
5  #include "I2Cdev.h"
6  #include "MPU6050.h"
7  #include "string.h"
8  #include "Separador.h"
9  #include <NimBLEDevice.h>
10 #include <TaskScheduler.h>
11
12 Scheduler MoRepScheduler;
13
14 //I2C Chain
15 void scan_i2c();
16 byte i2c_address[5];
17 unsigned int nDevices = 0;
18
19 Separador s;
20
21 //MPU-6050
22 MPU6050 mpu(0x68);
23 int16_t ax, ay, az;
24 int16_t gx, gy, gz;
25 float ang_x, ang_y, ang_z, ang_disp;
26 float ang_x_prev[20], ang_y_prev[20], ang_z_prev[20];
27 String ArmPosition;
28 int ArmPos = 0;//Standing Arm Position
29 unsigned long tiempo_prev;
30 float dt;//Integration Step
31 int j = 1;
32 unsigned long tmove;
33 unsigned long tmove_prev;
34 int IniState = 1;
35 int state = 1;
36 int state_prev = 1;
```

```
37 int accel_ang_x;
38 int accel_ang_y;
39 int accel_ang_z;
40 float ax_m_s2_prev[5];
41 float ay_m_s2_prev[5];
42 float az_m_s2_prev[5];
43 float axv = 0;
44 float ayv = 0;
45 float azv = 0;
46 float angx_av = 0;
47 float angy_av = 0;
48 float angz_av = 0;
49 float ax_av, ay_av, az_av = 0;
50 float accel_av[2] = {0};
51 float accel_id[5] = {0};
52 int it = 0;
53 int n = 0;
54 bool order = false;
55
56 std::string valueW = "";
57 std::string valueA = "AM_1";
58 std::string WristMove = "";
59
60 struct myStruct {
61     int Series [30] = {0};
62     int Exercise [35] = {0};
63     int Ex[35];
64     int MuscGroup[5] = {0};
65 };
66
67 myStruct WORKOUT;
68
69 //BLE
70 static BLEUUID serviceUUID((uint16_t)0x1826);
71 static BLEUUID CHARACTERISTIC_UUID_WRIST ("d6597e78-c992-4f43
72     -9861-719b78932fa6");
73 static BLEUUID CHARACTERISTIC_UUID_ARM ("84d8a625-08f9-49b3-82fb-
74     d85daffc3c39");
```



```
73 static BLEUUID CHARACTERISTIC_UUID_INFO ("beb5483e-36e1-4688-b7f5-  
    ea07361b26a8");  
74  
75 static boolean doConnect = false;  
76 static boolean connected = false;  
77 static boolean doScan = false;  
78 static BLERemoteCharacteristic* pWristChar;  
79 static BLERemoteCharacteristic* pArmChar;  
80 static BLERemoteCharacteristic* pInfoChar;  
81 static BLEAdvertisedDevice* myDevice;  
82  
83 static void notifyCallback(  
84     BLERemoteCharacteristic* pBLERemoteCharacteristic,  
85     uint8_t* pData,  
86     size_t length,  
87     bool isNotify) {  
88     Serial.print("Notify callback for characteristic ");  
89     Serial.print(pBLERemoteCharacteristic->getUUID().toString().c_str  
    ());  
90     Serial.print(" of data length ");  
91     Serial.println(length);  
92     Serial.print("data: ");  
93     Serial.println((char*)pData);  
94 }  
95  
96 class MyClientCallback : public BLEClientCallbacks {  
97     void onConnect(BLEClient* pclient) {  
98     }  
99  
100    void onDisconnect(BLEClient* pclient) {  
101        connected = false;  
102        Serial.println("onDisconnect");  
103    }  
104  
105    uint32_t onPassKeyRequest(){  
106        Serial.println("Client PassKeyRequest");  
107        return 123456;  
108    }
```

```
109     bool onConfirmPIN(uint32_t pass_key){
110         Serial.print("The passkey YES/NO number: ");Serial.println(
            pass_key);
111         return true;
112     }
113
114     void onAuthenticationComplete(ble_gap_conn_desc desc){
115         Serial.println("Starting BLE work!");
116     }
117 };
118
119 bool connectToServer() {
120     Serial.print("Forming a connection to ");
121     Serial.println(myDevice->getAddress().toString().c_str());
122
123     BLEClient* pClient = BLEDevice::createClient();
124     Serial.println(" - Created client");
125
126     pClient->setClientCallbacks(new MyClientCallback());
127
128     pClient->connect(myDevice);
129     Serial.println(" - Connected to server");
130
131     BLERemoteService* pRemoteService = pClient->getService(
        serviceUUID);
132     if (pRemoteService == nullptr) {
133         Serial.print("Failed to find our service UUID: ");
134         Serial.println(serviceUUID.toString().c_str());
135         pClient->disconnect();
136         return false;
137     }
138     Serial.println(" - Found our service");
139
140     pWristChar = pRemoteService->getCharacteristic(
        CHARACTERISTIC_UUID_WRIST);
141     pArmChar = pRemoteService->getCharacteristic(
        CHARACTERISTIC_UUID_ARM);
```

```
142 pInfoChar = pRemoteService->getCharacteristic(  
    CHARACTERISTIC_UUID_INFO);  
143 if (pWristChar == nullptr) {  
144     Serial.print("Failed to find our characteristic UUID: ");  
145     Serial.println(CHARACTERISTIC_UUID_WRIST.toString().c_str());  
146     pClient->disconnect();  
147     return false;  
148 }  
149 Serial.println(" - Found our characteristic");  
150  
151 if(pWristChar->canRead()) {  
152     std::string valueW = pWristChar->readValue();  
153     Serial.print("The characteristic value was: ");  
154     Serial.println(valueW.c_str());  
155 }  
156  
157 if(pWristChar->canNotify())  
158     pWristChar->registerForNotify(notifyCallback);  
159  
160 if (pArmChar == nullptr) {  
161     Serial.print("Failed to find our characteristic UUID: ");  
162     Serial.println(CHARACTERISTIC_UUID_ARM.toString().c_str());  
163     pClient->disconnect();  
164     return false;  
165 }  
166 Serial.println(" - Found our characteristic");  
167  
168 if(pArmChar->canRead()) {  
169     std::string valueA = pArmChar->readValue();  
170     Serial.print("The characteristic value was: ");  
171     Serial.println(valueA.c_str());  
172 }  
173  
174 if(pArmChar->canNotify())  
175     pArmChar->registerForNotify(notifyCallback);  
176  
177 if (pInfoChar == nullptr) {  
178     Serial.print("Failed to find our characteristic UUID: ");
```

```
179     Serial.println(CHARACTERISTIC_UUID_INFO.toString().c_str());
180     pClient->disconnect();
181     return false;
182 }
183 Serial.println(" - Found our characteristic");
184
185 if(pInfoChar->canRead()) {
186     std::string infoBLE = pInfoChar->readValue();
187     Serial.print("The characteristic value was: ");
188     Serial.println(infoBLE.c_str());
189 }
190
191 if(pInfoChar->canNotify())
192     pInfoChar->registerForNotify(notifyCallback);
193
194     connected = true;
195     return true;
196 }
197
198 class MyAdvertisedDeviceCallbacks: public
199     BLEAdvertisedDeviceCallbacks {
200     void onResult(BLEAdvertisedDevice* advertisedDevice) {
201         Serial.print("BLE Advertised Device found: ");
202         Serial.println(advertisedDevice->toString().c_str());
203
204         if (advertisedDevice->haveServiceUUID() && advertisedDevice->
205             isAdvertisingService(serviceUUID)) {
206             BLEDevice::getScan()->stop();
207             myDevice = advertisedDevice;
208             doConnect = true;
209             doScan = true;
210         }
211     }
212 };
213
214 Task taskMPULegs(TASK_SECOND / 5, TASK_FOREVER, []() {
215     if (WristMove == "1") {
216         order = true;
217     }
218 });
```

```
215     }
216
217     if (order == true){
218         float ax_m_s2;
219         float ay_m_s2;
220         float az_m_s2;
221         mpu.getAcceleration(&ax, &ay, &az);
222         mpu.getRotation(&gx, &gy, &gz);
223         dt = (millis() - tiempo_prev) / 1000.0;
224         tiempo_prev = millis();
225         tmove = millis();
226         ax_m_s2 = ax * (9.81 / 16384.0);
227         ay_m_s2 = ay * (9.81 / 16384.0);
228         az_m_s2 = az * (9.81 / 16384.0);
229         ang_x = 0.98 * (gx / 131) * dt + 0.02 * accel_ang_x;
230         ang_y = 0.98 * (gy / 131) * dt + 0.02 * accel_ang_y;
231         ang_z = 0.98 * (gz / 131) * dt + 0.02 * accel_ang_z;
232         accel_ang_x = atan(ax / sqrt(pow(ay, 2) + pow(az, 2))) * (180.0 /
233             3.14);
234         accel_ang_y = atan(ay / sqrt(pow(ax, 2) + pow(az, 2))) * (180.0 /
235             3.14);
236         accel_ang_z = atan(az / sqrt(pow(ax, 2) + pow(ay, 2))) * (180.0 /
237             3.14);
238
239         if (0.6 > dt > 0.5){
240             ax_m_s2_prev[n] = ax_m_s2;
241             ay_m_s2_prev[n] = ay_m_s2;
242             az_m_s2_prev[n] = az_m_s2;
243             axv = axv + ax_m_s2_prev[n];
244             ayv = ayv + ay_m_s2_prev[n];
245             azv = azv + az_m_s2_prev[n];
246             n++;
247         }
248         if (n == 5){
249             n = 0;
250         }
251
252         axv = axv/(n+1);
```

```
250     ayv = ayv/(n+1);
251     azv = azv/(n+1);
252
253     if (az_m_s2 > 7) {
254         ArmPosition = "Eta";
255         ArmPos = 1;
256     }
257     else if (az_m_s2 < -7) {
258         ArmPosition = "Theta";
259         ArmPos = 3;
260     }
261     else if (ax_m_s2 > 7) {
262         ArmPosition = "Mi";
263         ArmPos = 4;
264     }
265     else if (ax_m_s2 < -7) {
266         ArmPosition = "Lambda";
267         ArmPos = 6;
268     }
269     else if (ay_m_s2 < -7) {
270         ArmPosition = "Iota";
271         ArmPos = 5;
272     }
273     else if (ay_m_s2 > 7) {
274         ArmPosition = "Kappa";
275         ArmPos = 2;
276     }
277     else {
278         ArmPosition = "Half way";
279         ArmPos = 0;
280     }
281
282     switch (state) {
283         case (1): //State detection
284             if (WristMove == "1") {
285                 valueA = "AM_1";
286                 if (ArmPosition == "Kappa") {
287                     IniState = 2;
```

```
288     state = 2;
289     tmove_prev = tmove;
290 }
291 if (ArmPosition == "Iota") {
292     state = 5;
293     IniState = 5;
294     tmove_prev = tmove;
295 }
296 if (ArmPosition == "Mi") {
297     state = 4;
298     IniState = 4;
299     tmove_prev = tmove;
300 }
301 if (ArmPosition == "Theta") {
302     state = 3;
303     IniState = 3;
304     tmove_prev = tmove;
305 }
306 if (ArmPosition == "Lambda") {
307     state = 6;
308     IniState = 6;
309     tmove_prev = tmove;
310 }
311 if (ArmPosition == "Eta"){
312     state = 7;
313     IniState = 7;
314     tmove_prev = tmove;
315 }
316 else if (WristMove == "97") {
317     j++;
318 }
319 }
320 break;
321
322 case (2): //Kappa
323     if (ArmPos == 3) {
324         state = 3;
325         tmove_prev = tmove;
```

```
326     state_prev = 2;
327 }
328 if (ArmPos == 4) {
329     state = 4;
330     tmove_prev = tmove;
331     state_prev = 2;
332 }
333 if (ArmPos == 5) {
334     state = 5;
335     tmove_prev = tmove;
336     state_prev = 2;
337 }
338 if (ArmPos == 6) {
339     state = 6;
340     tmove_prev = tmove;
341     state_prev = 2;
342 }
343 if (ArmPos == 1) {
344     state = 7;
345     tmove_prev = tmove;
346     state_prev = 2;
347 }
348 if (tmove - tmove_prev > 2000 && tmove - tmove_prev < 12000) {
349     valueA = "AM_02";
350 }
351 if (tmove - tmove_prev > 12000) {
352     valueA = "AM_99";
353 }
354 if ((WristMove == "99" && valueA == "AM_99") || WristMove == "
355     98") {
356     state = 8;
357     tmove_prev = tmove;
358 }
359 break;
360 case (3): //Theta
361     if (ArmPos == 4) {
362         state = 4;
```



```
363     tmove_prev = tmove;
364     state_prev = 3;
365 }
366 if (ArmPos == 5) {
367     state = 5;
368     tmove_prev = tmove;
369     state_prev = 3;
370 }
371 if (ArmPos == 6) {
372     state = 6;
373     tmove_prev = tmove;
374     state_prev = 3;
375 }
376 if (ArmPos == 2) {
377     tmove_prev = tmove;
378     state = 2;
379     state_prev = 3;
380 }
381 if (ArmPos == 1) {
382     state = 7;
383     tmove_prev = tmove;
384     state_prev = 3;
385 }
386 if (tmove - tmove_prev > 12000) {
387     valueA = "AM_99";
388 }
389 if ((WristMove == "99" && valueA == "AM_99") || WristMove == "
390     98") {
391     state = 8;
392     tmove_prev = tmove;
393 }
394 break;
395 case (4): //Mi
396     if (ArmPos == 2) {
397         state = 2;
398         tmove_prev = tmove;
399         state_prev = 4;
400     }
```

```
400     if (ArmPos == 3) {
401         state = 3;
402         tmove_prev = tmove;
403         state_prev = 4;
404     }
405     if (ArmPos == 1) {
406         state = 7;
407         tmove_prev = tmove;
408         state_prev = 4;
409         if (WristMove == "05" && IniState == 4){
410             valueA = "AM_47_1";
411             WORKOUT.Exercise[5]++;
412         }
413     }
414     if (ArmPos == 5) {
415         state = 5;
416         tmove_prev = tmove;
417         state_prev = 4;
418     }
419     if (ArmPos == 6) {
420         state = 6;
421         tmove_prev = tmove;
422         state_prev = 4;
423     }
424     if (tmove - tmove_prev > 12000) {
425         valueA = "AM_99";
426     }
427     if ((WristMove == "99" && valueA == "AM_99") || WristMove == "
428         98") {
429         state = 8;
430         tmove_prev = tmove;
431     }
432     break;
433 case (5): //Iota
434     if (ArmPos == 3) {
435         state = 3;
436         tmove_prev = tmove;
```

```
437     state_prev = 5;
438 }
439 if (ArmPos == 4) {
440     state = 4;
441     tmove_prev = tmove;
442     state_prev = 5;
443 }
444 if (ArmPos == 2) {
445     state = 2;
446     tmove_prev = tmove;
447     state_prev = 5;
448 }
449 if (ArmPos == 1) {
450     state = 7;
451     tmove_prev = tmove;
452     state_prev = 5;
453 }
454 if (ArmPos == 6) {
455     state = 6;
456     tmove_prev = tmove;
457     state_prev = 5;
458 }
459 if (tmove - tmove_prev > 12000) {
460     valueA = "AM_99";
461 }
462 if ((WristMove == "99" && valueA == "AM_99") || WristMove == "
463     98") {
464     state = 8;
465     tmove_prev = tmove;
466 }
467 break;
468
469 case (6): //Lambda
470 if (ArmPos == 2) {
471     state = 2;
472     tmove_prev = tmove;
473     state_prev = 6;
474     if (WristMove == "07" && IniState == 6){
```

```
474     WORKOUT.Exercise[6]++;
475     valueA = valueA + "_1";
476 }
477 }
478 if (ArmPos == 3) {
479     state = 3;
480     tmove_prev = tmove;
481     state_prev = 6;
482 }
483 if (ArmPos == 4) {
484     state = 4;
485     tmove_prev = tmove;
486     state_prev = 6;
487 }
488 if (ArmPos == 5) {
489     state = 5;
490     tmove_prev = tmove;
491     state_prev = 6;
492 }
493 if (ArmPos == 6) {
494     state = 6;
495     tmove_prev = tmove;
496     state_prev = 6;
497 }
498 if (ArmPos == 1) {
499     state = 7;
500     tmove_prev = tmove;
501     state_prev = 6;
502 }
503 if (tmove - tmove_prev > 12000) {
504     valueA = "AM_99";
505 }
506 if ((WristMove == "99" && valueA == "AM_99") || WristMove == "
507     98") {
508     state = 8;
509     tmove_prev = tmove;
510 }
511 break;
```

```
511
512     case (7): //Eta
513         if (ArmPos == 3) {
514             state = 3;
515             tmove_prev = tmove;
516             state_prev = 7;
517         }
518         if (ArmPos == 4) {
519             state = 4;
520             tmove_prev = tmove;
521             if (WristMove == "05" && IniState == 7){
522                 valueA = "AM_74_1";
523                 WORKOUT.Exercise[2]++;
524             }
525         }
526         if (ArmPos == 5) {
527             state = 5;
528             tmove_prev = tmove;
529             state_prev = 7;
530         }
531         if (ArmPos == 6) {
532             state = 6;
533             tmove_prev = tmove;
534             state_prev = 7;
535         }
536         if (tmove - tmove_prev > 2000 && tmove - tmove_prev < 12000) {
537             valueA = "AM_07";
538         }
539         if (tmove - tmove_prev > 12000) {
540             valueA = "AM_99";
541         }
542         if ((WristMove == "99" && valueA == "AM_99") || WristMove == "
543             98") {
544             state = 8;
545             tmove_prev = tmove;
546         }
547         break;
```

```
548     case (8): //Exercise detection
549         if (WORKOUT.Exercise[2] < 3) {
550             WORKOUT.Exercise[2] = 0;
551         }
552         if (WORKOUT.Exercise[5] < 3) {
553             WORKOUT.Exercise[11] = 0;
554         }
555         if (WORKOUT.Exercise[6] < 3) {
556             WORKOUT.Exercise[6] = 0;
557         }
558         if (WORKOUT.Exercise[2] > 3) {
559             WORKOUT.Series [j] = WORKOUT.Exercise [2];
560             WORKOUT.Ex[j] = 2;
561             WORKOUT.Exercise [2] = 0;
562             WORKOUT.MuscGroup [5]++;
563         }
564         if (WORKOUT.Exercise[5] > 3) {
565             WORKOUT.Series [j] = WORKOUT.Exercise [5];
566             WORKOUT.Ex[j] = 5;
567             WORKOUT.Exercise [5] = 0;
568             WORKOUT.MuscGroup [5]++;
569         }
570         if (WORKOUT.Exercise[6] > 3) {
571             WORKOUT.Series [j] = WORKOUT.Exercise [6];
572             WORKOUT.Ex[j] = 6;
573             WORKOUT.Exercise [6] = 0;
574             WORKOUT.MuscGroup [5]++;
575         }
576         if (WORKOUT.Series[j] > 3) {
577             valueA = std::string ("EX_") + String(WORKOUT.Ex[j]).c_str()
                    + std::string ("_") + String(WORKOUT.Series[j]).c_str();
578             j++;
579         }
580         else{
581             valueA = "AM_1";
582         }
583         state = 1;
584         break;
```

```
585     }
586
587     if (WristMove == "96") {
588         order = false;
589     }
590 }
591 });
592
593 Task taskMPU(TASK_SECOND / 5, TASK_FOREVER, []() {
594     if (WristMove == "1") {
595         order = true;
596     }
597
598     if (order == true){
599         float ax_m_s2;
600         float ay_m_s2;
601         float az_m_s2;
602         mpu.getAcceleration(&ax, &ay, &az);
603         mpu.getRotation(&gx, &gy, &gz);
604         dt = (millis() - tiempo_prev) / 1000.0;
605         tiempo_prev = millis();
606         tmove = millis();
607         ax_m_s2 = ax * (9.81 / 16384.0);
608         ay_m_s2 = ay * (9.81 / 16384.0);
609         az_m_s2 = az * (9.81 / 16384.0);
610         ang_x = 0.98 * (gx / 131) * dt + 0.02 * accel_ang_x;
611         ang_y = 0.98 * (gy / 131) * dt + 0.02 * accel_ang_y;
612         ang_z = 0.98 * (gz / 131) * dt + 0.02 * accel_ang_z;
613         accel_ang_x = atan(ax / sqrt(pow(ay, 2) + pow(az, 2))) * (180.0 /
614             3.14);
615         accel_ang_y = atan(ay / sqrt(pow(ax, 2) + pow(az, 2))) * (180.0 /
616             3.14);
617         accel_ang_z = atan(az / sqrt(pow(ax, 2) + pow(ay, 2))) * (180.0 /
618             3.14);
619
620         if (0.6 > dt > 0.5){
621             ax_m_s2_prev[n] = ax_m_s2;
622             ay_m_s2_prev[n] = ay_m_s2;
```

```
620     az_m_s2_prev[n] = az_m_s2;
621     axv = axv + ax_m_s2_prev[n];
622     ayv = ayv + ay_m_s2_prev[n];
623     azv = azv + az_m_s2_prev[n];
624     n++;
625 }
626 if (n == 5){
627     n = 0;
628 }
629
630 axv = axv/(n+1);
631 ayv = ayv/(n+1);
632 azv = azv/(n+1);
633
634 if (az_m_s2 > 7) {
635     ArmPosition = "Eta";
636     ArmPos = 1;
637 }
638 else if (az_m_s2 < -7) {
639     ArmPosition = "Theta";
640     ArmPos = 3;
641 }
642 else if (ax_m_s2 > 7) {
643     ArmPosition = "Mi";
644     ArmPos = 4;
645 }
646 else if (ax_m_s2 < -7) {
647     ArmPosition = "Lambda";
648     ArmPos = 6;
649 }
650 else if (ay_m_s2 < -7) {
651     ArmPosition = "Iota";
652     ArmPos = 5;
653 }
654 else if (ay_m_s2 > 7) {
655     ArmPosition = "Kappa";
656     ArmPos = 2;
657 }
```



```
658     else {
659         ArmPosition = "Half way";
660         ArmPos = 0;
661     }
662
663     switch (state) {
664         case (1): //State detection
665             if (WristMove == "1") {
666                 valueA = "AM_1";
667                 if (ArmPosition == "Kappa") {
668                     IniState = 2;
669                     state = 2;
670                     tmove_prev = tmove;
671                 }
672                 if (ArmPosition == "Iota") {
673                     state = 5;
674                     IniState = 5;
675                     tmove_prev = tmove;
676                 }
677                 if (ArmPosition == "Mi") {
678                     state = 4;
679                     IniState = 4;
680                     tmove_prev = tmove;
681                 }
682                 if (ArmPosition == "Theta") {
683                     state = 3;
684                     IniState = 3;
685                     tmove_prev = tmove;
686                 }
687                 if (ArmPosition == "Lambda") {
688                     state = 6;
689                     IniState = 6;
690                     tmove_prev = tmove;
691                 }
692             else if (WristMove == "97") {
693                 j++;
694             }
695     }
```

```
696         break;
697
698     case (2): //Kappa
699         if (ArmPos == 3) {
700             state = 3;
701             tmove_prev = tmove;
702         }
703         if (ArmPos == 4) {
704             if (IniState == 2 && (WristMove == "03Q" || (WristMove == "99
705                 " && WORKOUT.Exercise[18] > 1)) && WORKOUT.Exercise[19] ==
706                 0) {
707                 WORKOUT.Exercise[18]++;
708                 valueA = valueA + "_1";
709             }
710             if (IniState == 4 && (WristMove == "03A" || (WristMove == "99
711                 " && WORKOUT.Exercise[19] > 1)) && WORKOUT.Exercise[18] ==
712                 0) {
713                 WORKOUT.Exercise[19]++;
714                 valueA = valueA + "_1";
715             }
716             state = 4;
717             tmove_prev = tmove;
718         }
719         if (ArmPos == 5) {
720             state = 5;
721             tmove_prev = tmove;
722         }
723         if (ArmPos == 6) {
724             state = 6;
725             tmove_prev = tmove;
726         }
727         if (ArmPos == 1) {
728             tmove_prev = tmove;
729         }
730         if (tmove - tmove_prev > 2000 && tmove - tmove_prev < 12000) {
731             valueA = "AM_02";
732         }
733         if (tmove - tmove_prev > 12000) {
```

```
730     valueA = "AM_99";
731 }
732 if ((WristMove == "99" && valueA == "AM_99") || WristMove == "
733     98") {
734     state = 7;
735     tmove_prev = tmove;
736 }
737 break;
738
739 case (3): //Theta
740     if (ArmPos == 4) {
741         state = 4;
742         tmove_prev = tmove;
743         if (WristMove == "06" && IniState == 3){
744             WORKOUT.Exercise[21]++;
745             valueA = valueA + "_1";
746         }
747     }
748     if (ArmPos == 5) {
749         state = 5;
750         tmove_prev = tmove;
751         valueA = "AM_35";
752     }
753     if (ArmPos == 6) {
754         state = 6;
755         tmove_prev = tmove;
756     }
757     if (ArmPos == 2) {
758         valueA = "AM_32";
759         tmove_prev = tmove;
760         state = 2;
761     }
762     if (ArmPos == 1) {
763         tmove_prev = tmove;
764     }
765     if (tmove - tmove_prev > 2000 && tmove - tmove_prev < 12000) {
766         valueA = "AM_03";
767     }
```

```
767     if (tmove - tmove_prev > 12000) {
768         valueA = "AM_99";
769     }
770     if ((WristMove == "99" && valueA == "AM_99") || WristMove == "
771         98") {
772         state = 7;
773         tmove_prev = tmove;
774     }
775     break;
776 case (4): //Mi
777     if (ArmPos == 2) {
778         valueA = "AM_42";
779         if (IniState == 4){
780             if (WristMove == "23") {
781                 WORKOUT.Exercise[12]++;
782                 valueA = valueA + "_1";
783             }
784             if (WristMove == "03A" || (WristMove == "99" || WristMove
785                 == "03Q" && (WORKOUT.Exercise[24] > 1 || WORKOUT.
786                 Exercise[11] > 1))){
787                 if (WORKOUT.MuscGroup[4] > WORKOUT.MuscGroup[2]){
788                     WORKOUT.Exercise[24]++;
789                     valueA = valueA + "_1";
790                 }
791                 if (WORKOUT.MuscGroup[4] < WORKOUT.MuscGroup[2]){
792                     WORKOUT.Exercise[11]++;
793                     valueA = valueA + "_1";
794                 }
795             }
796         }
797         state = 2;
798         tmove_prev = tmove;
799     }
800     if (ArmPos == 3) {
801         state = 3;
802         tmove_prev = tmove;
803     }
804     if (ArmPos == 1) {
```

```
802     tmove_prev = tmove;
803 }
804 if (ArmPos == 5) {
805     valueA = "AM_45";
806     if (IniState == 4 && WristMove == "05") {
807         WORKOUT.Exercise[13]++;
808         valueA = valueA + "_1";
809     }
810     state = 5;
811     tmove_prev = tmove;
812 }
813 if (ArmPos == 6) {
814     state = 6;
815     valueA = "AM_46";
816     tmove_prev = tmove;
817 }
818 if (tmove - tmove_prev > 2000 && tmove - tmove_prev < 12000) {
819     if ((az_m_s2_prev[n] - azv < 2.5) && az_m_s2_prev[n] != 0)
820     {
821         valueA = "AM_04Q";
822         tmove_prev = tmove;
823     }
824     if ((az_m_s2_prev[n] - azv > 2.5) && az_m_s2_prev != 0 &&
825         ax_m_s2 > -2) {
826         valueA = "AM_04A";
827         tmove_prev = tmove;
828     }
829 }
830 if (tmove - tmove_prev > 12000) {
831     valueA = "AM_99";
832 }
833 if ((WristMove == "99" && valueA == "AM_99") || WristMove == "
834     98") {
835     state = 7;
836     tmove_prev = tmove;
837 }
838 break;
```

```
837     case (5): //Iota
838         if (ArmPos == 3) {
839             state = 3;
840             tmove_prev = tmove;
841             valueA = "AM_53";
842         }
843         if (ArmPos == 4) {
844             state = 4;
845             valueA = "AM_54";
846             tmove_prev = tmove;
847         }
848         if (ArmPos == 2) {
849             valueA = "AM_52";
850             if (WristMove == "03A" || (WristMove == "99" && WORKOUT.
851                 Exercise[20] > 1)){
852                 WORKOUT.Exercise[20]++;
853                 valueA = valueA + "_1";
854             }
855             state = 2;
856             tmove_prev = tmove;
857         }
858         if (ArmPos == 1) {
859             tmove_prev = tmove;
860         }
861         if (tmove - tmove_prev > 2000 && tmove - tmove_prev < 12000) {
862             valueA = "AM_05";
863         }
864         if (tmove - tmove_prev > 12000) {
865             valueA = "AM_99";
866         }
867         if (ArmPos == 6) {
868             if (IniState == 5){
869                 valueA = "AM_56";
870                 if ((WristMove == "04Q" || (WristMove == "99" && (WORKOUT.
871                     Exercise[10] > 1 || WORKOUT.Exercise[15] > 1))) &&
872                     WORKOUT.Exercise[31] == 0) {
873                     if (WORKOUT.MuscGroup[1] > WORKOUT.MuscGroup[2]) {
874                         WORKOUT.Exercise[10]++;
```

```
872         valueA = valueA + "_1";
873     }
874     else {
875         WORKOUT.Exercise[15]++;
876         valueA = valueA + "_1";
877     }
878     if ((WristMove == "04A" || ((WristMove == "04Q" ||
879         WristMove == "99") && WORKOUT.Exercise[31] > 1)) &&
880         WORKOUT.Exercise[10] == 0 && WORKOUT.Exercise[15] == 0){
881         WORKOUT.Exercise[31]++;
882         valueA = valueA + "_1";
883     }
884     }
885     }
886     state = 6;
887     tmove_prev = tmove;
888 }
889 if ((WristMove == "99" && valueA == "AM_99") || WristMove == "
890     98") {
891     state = 7;
892     tmove_prev = tmove;
893 }
894 break;
895
896 case (6): //Lambda
897     if (ArmPos == 3) {
898         state = 3;
899         tmove_prev = tmove;
900     }
901     if (ArmPos == 4) {
902         state = 4;
903         tmove_prev = tmove;
904     }
905     if (ArmPos == 5) {
906         state = 5;
907         tmove_prev = tmove;
908     }
909     if (ArmPos == 6) {
```

```
907     state = 6;
908     tmove_prev = tmove;
909 }
910 if (ArmPos == 1) {
911     tmove_prev = tmove;
912 }
913 if (tmove - tmove_prev > 2000 && tmove - tmove_prev < 12000) {
914     valueA = "AM_06";
915 }
916 if (tmove - tmove_prev > 12000) {
917     valueA = "AM_99";
918 }
919 if ((WristMove == "99" && valueA == "AM_99") || WristMove == "
920     98") {
921     state = 7;
922     tmove_prev = tmove;
923 }
924 break;
925
926 case (7): //Exercise detection
927     if (WORKOUT.Exercise[10] < 3) {
928         WORKOUT.Exercise[10] = 0;
929     }
930     if (WORKOUT.Exercise[11] < 3) {
931         WORKOUT.Exercise[11] = 0;
932     }
933     if (WORKOUT.Exercise[15] < 3) {
934         WORKOUT.Exercise[15] = 0;
935     }
936     if (WORKOUT.Exercise[18] < 3) {
937         WORKOUT.Exercise[18] = 0;
938     }
939     if (WORKOUT.Exercise[19] < 3) {
940         WORKOUT.Exercise[19] = 0;
941     }
942     if (WORKOUT.Exercise[20] < 3) {
943         WORKOUT.Exercise[20] = 0;
944     }
```



```
944     if (WORKOUT.Exercise[21] < 3) {
945         WORKOUT.Exercise[21] = 0;
946     }
947     if (WORKOUT.Exercise[24] < 3) {
948         WORKOUT.Exercise[24] = 0;
949     }
950     if (WORKOUT.Exercise[31] < 3) {
951         WORKOUT.Exercise[31] = 0;
952     }
953     if (WORKOUT.Exercise[10] > 3) {
954         WORKOUT.Series [j] = WORKOUT.Exercise[10];
955         WORKOUT.Ex[j] = 10;
956         WORKOUT.Exercise[10] = 0;
957         WORKOUT.MuscGroup[1]++;
958     }
959     if (WORKOUT.Exercise[11] > 3) {
960         WORKOUT.Series [j] = WORKOUT.Exercise[11];
961         WORKOUT.Ex[j] = 11;
962         WORKOUT.Exercise[11] = 0;
963         WORKOUT.MuscGroup[2]++;
964     }
965     if (WORKOUT.Exercise[15] > 3) {
966         WORKOUT.Series [j] = WORKOUT.Exercise[15];
967         WORKOUT.Ex[j] = 15;
968         WORKOUT.Exercise[15] = 0;
969         WORKOUT.MuscGroup[2]++;
970     }
971     if (WORKOUT.Exercise[18] > 3) {
972         WORKOUT.Series[j] = WORKOUT.Exercise[18];
973         WORKOUT.Exercise[18] = 0;
974         WORKOUT.Ex[j] = 18;
975         WORKOUT.MuscGroup[3]++;
976     }
977     if (WORKOUT.Exercise[19] > 3) {
978         WORKOUT.Series[j] = WORKOUT.Exercise[19];
979         WORKOUT.Exercise[19] = 0;
980         WORKOUT.Ex[j] = 19;
981         WORKOUT.MuscGroup[3]++;
```

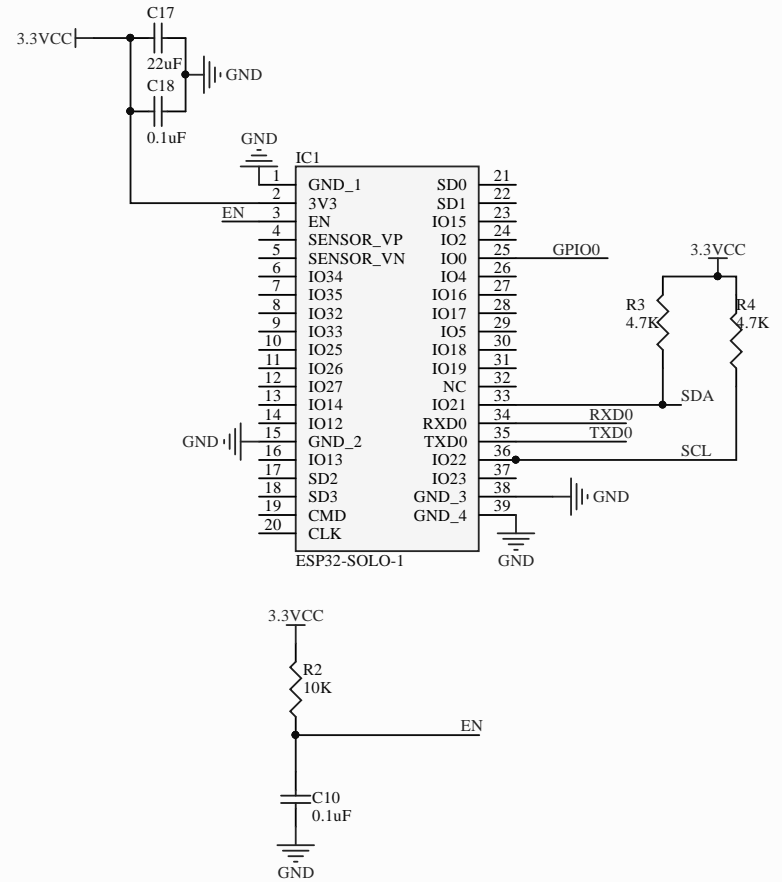
```
982     }
983     if (WORKOUT.Exercise[20] > 3) {
984         WORKOUT.Series[j] = WORKOUT.Exercise[19];
985         WORKOUT.Exercise[20] = 0;
986         WORKOUT.Ex[j] = 20;
987         WORKOUT.MuscGroup[3]++;
988     }
989     if (WORKOUT.Exercise[21] > 3) {
990         WORKOUT.Series[j] = WORKOUT.Exercise[21];
991         WORKOUT.Exercise[21] = 0;
992         WORKOUT.Ex[j] = 21;
993         WORKOUT.MuscGroup[4]++;
994     }
995     if (WORKOUT.Exercise[24] > 3) {
996         WORKOUT.Series[j] = WORKOUT.Exercise[24];
997         WORKOUT.Ex[j] = 24;
998         WORKOUT.Exercise[24] = 0;
999         WORKOUT.MuscGroup[4]++;
1000    }
1001    if (WORKOUT.Exercise[31] > 3) {
1002        WORKOUT.Series[j] = WORKOUT.Exercise[31];
1003        WORKOUT.Exercise[31] = 0;
1004        WORKOUT.Ex[j] = 31;
1005        WORKOUT.MuscGroup[3]++;
1006    }
1007    if (WORKOUT.Series[j] > 3) {
1008        valueA = std::string("EX_") + String(WORKOUT.Ex[j]).c_str()
1009                + std::string("_") + String(WORKOUT.Series[j]).c_str();
1010        j++;
1011    }
1012    else{
1013        valueA = "AM_1";
1014    }
1015    state = 1;
1016    break;
1017 }
1018 if (WristMove == "96") {
```

```
1019     order = false;
1020     }
1021 }
1022
1023 });
1024
1025 Task taskBLE(TASK_SECOND / 3.5, TASK_FOREVER, []() {
1026     if (doConnect == true){
1027         if (connectToServer()){
1028             Serial.println("Connected");
1029         }
1030         else{
1031             Serial.println("Not connected");
1032         }
1033         doConnect = false;
1034     }
1035
1036     if (connected){
1037         /* Set the value */
1038         pArmChar->writeValue(valueA);
1039         valueW = pWristChar->readValue();
1040         std::string infoBLE = pInfoChar->readValue();
1041         std::string header = valueW.substr(0, 2); //Decoding of messages
1042         if (header == "WM"){
1043             WristMove = s.separa(valueW.c_str(), '_', 1).c_str();
1044         }
1045         if (infoBLE == "LegsOn"){
1046             taskMPU.disable();
1047             taskMPULegs.enable();
1048         }
1049         if (infoBLE == "Sleep"){
1050             taskMPU.disable();
1051             taskMPULegs.disable();
1052             taskBLE.setInterval(10*TASK_SECOND);
1053             setCpuFrequencyMhz(80);
1054         }
1055         if (infoBLE == "WakeUp"){
1056             setCpuFrequencyMhz(240);
```

```
1057     taskMPU.enable();
1058     taskBLE.setInterval(TASK_SECOND/3);
1059 }
1060 if (infoBLE == "LegsOff"){
1061     taskMPU.enable();
1062     taskMPULegs.disable();
1063 }
1064 }
1065 });
1066
1067 void setup() {
1068     Serial.begin(115200);
1069     Wire.begin();
1070     BLEDevice::init("");
1071     MoRepScheduler.addTask(taskMPU);
1072     MoRepScheduler.addTask(taskBLE);
1073     MoRepScheduler.addTask(taskMPULegs);
1074     taskMPU.enable();
1075     taskBLE.enable();
1076     scan_i2c();
1077     mpu.initialize();
1078
1079     if (mpu.testConnection()){
1080         Serial.println("Accelerometer Detected");
1081     }
1082     else{
1083         Serial.println("Error in Accelerometer");
1084     }
1085
1086     BLEScan* pBLEScan = BLEDevice::getScan();
1087     pBLEScan->setAdvertisedDeviceCallbacks(new
1088         MyAdvertisedDeviceCallbacks());
1089     pBLEScan->setInterval(1349);
1090     pBLEScan->setWindow(449);
1091     pBLEScan->setActiveScan(true);
1092     pBLEScan->start(5, false);
1093 }
```

```
1094 void loop() {
1095     MoRepScheduler.execute();
1096 }
1097
1098 void scan_i2c() {
1099     byte error, address;
1100     Serial.println("Scanning...");
1101     nDevices = 0;
1102     for (address = 1; address < 127; address++)
1103     {
1104         Wire.beginTransmission(address);
1105         error = Wire.endTransmission();
1106         if (error == 0)
1107         {
1108             Serial.print("I2C Device in ADDRESS 0x");
1109             if (address < 16)
1110                 Serial.print("0");
1111             i2c_address[nDevices] = address;
1112             Serial.print(address, HEX);
1113             Serial.println(" !");
1114             nDevices++;
1115         }
1116         else if (error == 4)
1117         {
1118             Serial.print("Unknown error in ADDRESS 0x");
1119             if (address < 16)
1120                 Serial.print("0");
1121             Serial.println(address, HEX);
1122         }
1123     }
1124     if (nDevices == 0)
1125         Serial.println("No I2C Device connected\n");
1126     else
1127         Serial.println("Done\n");
1128     delay(1000);
1129 }
```

Esquemáticos y *layout* del sistema



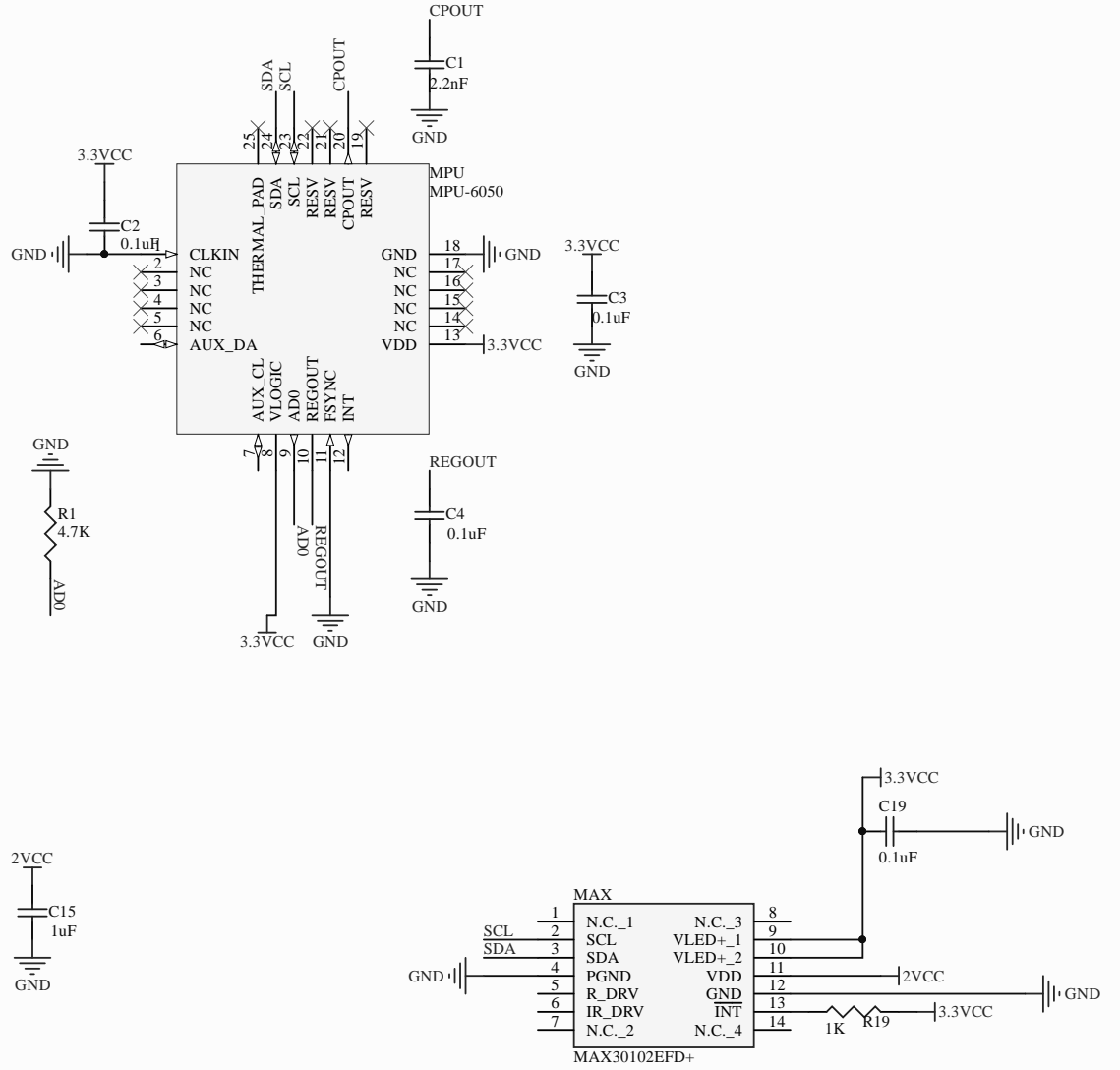
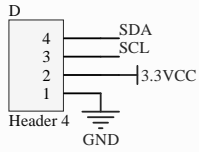
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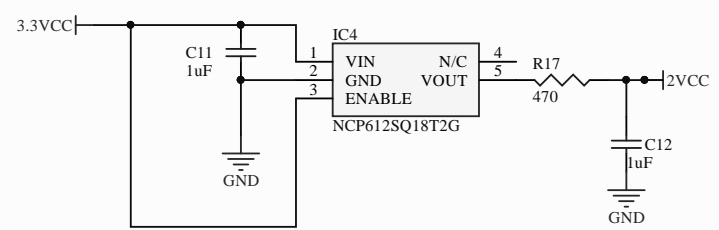
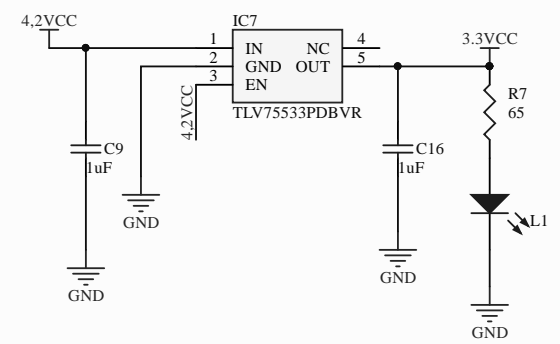
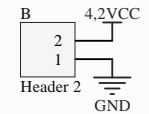
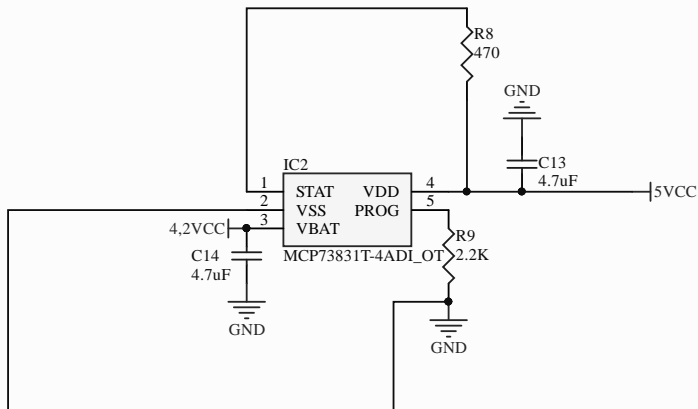
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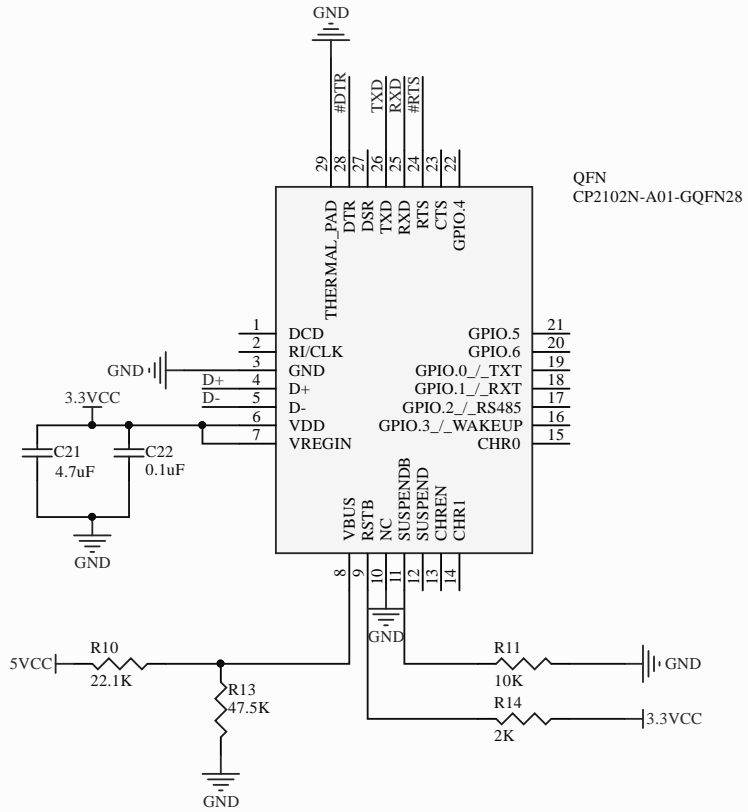
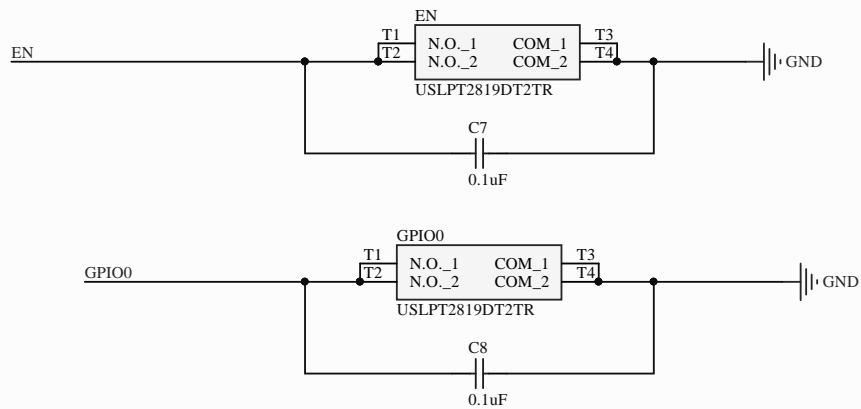
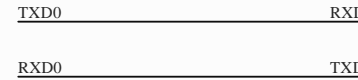
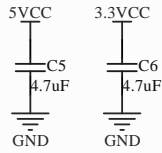
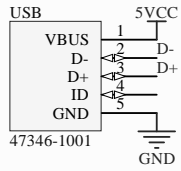
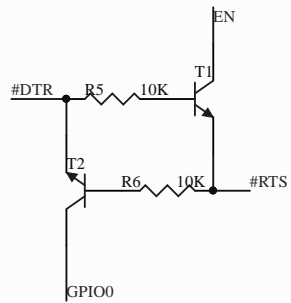
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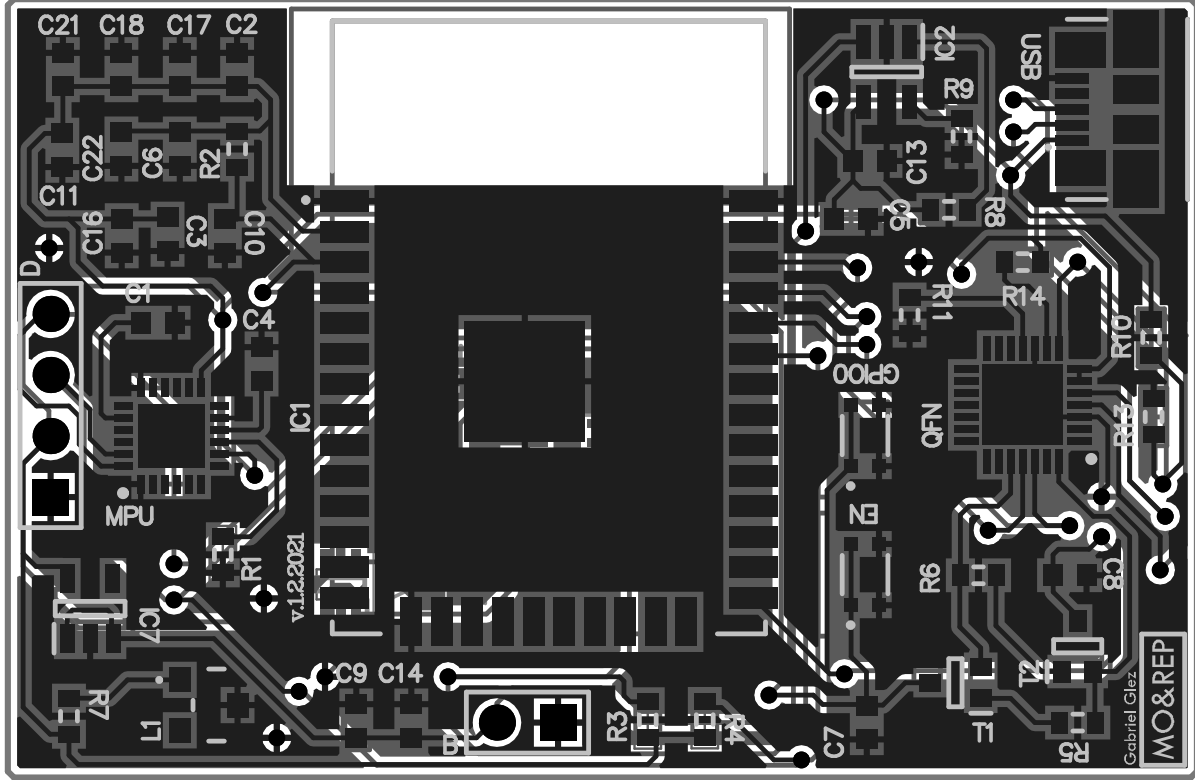
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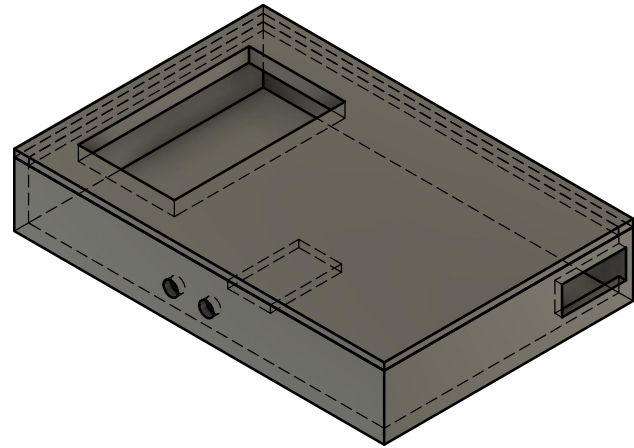
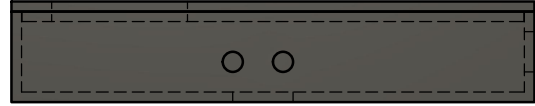
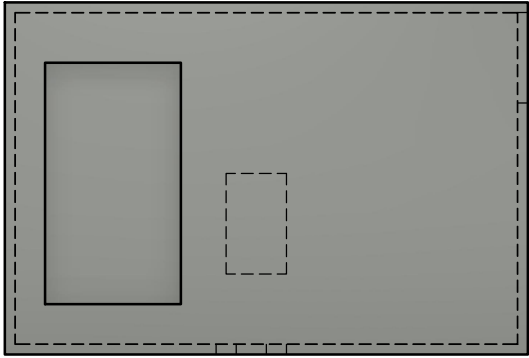


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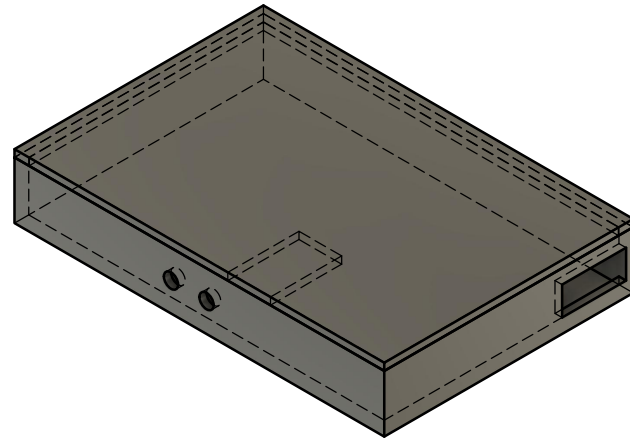
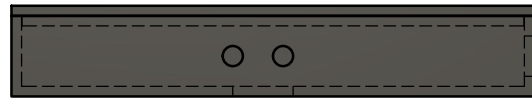
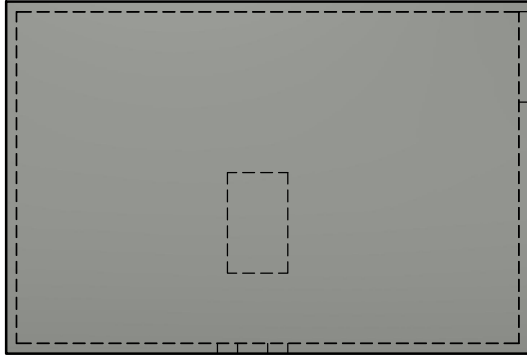


Vistas del encapsulado del sistema


Encapsulado del nodo inferior



Encapsulado del nodo superior



Datasheets de los componentes




ESP32-WROOM-32

Datasheet



Version 2.9
Espressif Systems
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About This Document

This document provides the specifications for the ESP32-WROOM-32 module.

Revision History

For revision history of this document, please refer to the [last page](#).

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1. Overview

ESP32-WROOM-32 is a powerful, generic Wi-Fi+BT+BLE MCU module that targets a wide variety of applications, ranging from low-power sensor networks to the most demanding tasks, such as voice encoding, music streaming and MP3 decoding.

At the core of this module is the ESP32-D0WDQ6 chip*. The chip embedded is designed to be scalable and adaptive. There are two CPU cores that can be individually controlled, and the CPU clock frequency is adjustable from 80 MHz to 240 MHz. The user may also power off the CPU and make use of the low-power co-processor to constantly monitor the peripherals for changes or crossing of thresholds. ESP32 integrates a rich set of peripherals, ranging from capacitive touch sensors, Hall sensors, SD card interface, Ethernet, high-speed SPI, UART, I²S and I²C.

Note:

* For details on the part numbers of the ESP32 family of chips, please refer to the document [ESP32 Datasheet](#).

The integration of Bluetooth, Bluetooth LE and Wi-Fi ensures that a wide range of applications can be targeted, and that the module is all-around: using Wi-Fi allows a large physical range and direct connection to the Internet through a Wi-Fi router, while using Bluetooth allows the user to conveniently connect to the phone or broadcast low energy beacons for its detection. The sleep current of the ESP32 chip is less than 5 μ A, making it suitable for battery powered and wearable electronics applications. The module supports a data rate of up to 150 Mbps, and 20 dBm output power at the antenna to ensure the widest physical range. As such the module does offer industry-leading specifications and the best performance for electronic integration, range, power consumption, and connectivity.

The operating system chosen for ESP32 is freeRTOS with LwIP; TLS 1.2 with hardware acceleration is built in as well. Secure (encrypted) over the air (OTA) upgrade is also supported, so that users can upgrade their products even after their release, at minimum cost and effort.

Table 1 provides the specifications of ESP32-WROOM-32.

Table 1: ESP32-WROOM-32 Specifications

Categories	Items	Specifications
Certification	RF certification	FCC/CE-RED/IC/TELEC/KCC/SRRC/NCC
	Wi-Fi certification	Wi-Fi Alliance
	Bluetooth certification	BQB
	Green certification	RoHS/REACH
Test	Reliability	HTOL/HTSL/uHAST/TCT/ESD
Wi-Fi	Protocols	802.11 b/g/n (802.11n up to 150 Mbps) A-MPDU and A-MSDU aggregation and 0.4 μ s guard interval support
	Frequency range	2.4 GHz ~ 2.5 GHz
Bluetooth	Protocols	Bluetooth v4.2 BR/EDR and BLE specification
	Radio	NZIF receiver with -97 dBm sensitivity
		Class-1, class-2 and class-3 transmitter
		AFH

Categories	Items	Specifications
	Audio	CVSD and SBC
Hardware	Module interfaces	SD card, UART, SPI, SDIO, I ² C, LED PWM, Motor PWM, I ² S, IR, pulse counter, GPIO, capacitive touch sensor, ADC, DAC
	On-chip sensor	Hall sensor
	Integrated crystal	40 MHz crystal
	Integrated SPI flash	4 MB
	Operating voltage/Power supply	3.0 V ~ 3.6 V
	Operating current	Average: 80 mA
	Minimum current delivered by power supply	500 mA
	Recommended operating temperature range	-40 °C ~ +85 °C
	Package size	(18.00±0.10) mm × (25.50±0.10) mm × (3.10±0.10) mm
	Moisture sensitivity level (MSL)	Level 3

2. Pin Definitions

2.1 Pin Layout

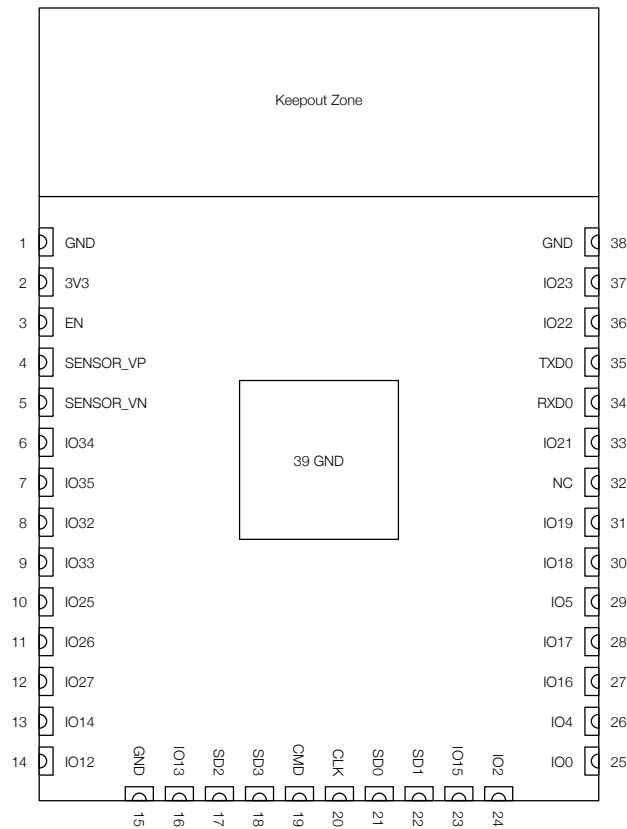


Figure 1: ESP32-WROOM-32 Pin Layout (Top View)

2.2 Pin Description

ESP32-WROOM-32 has 38 pins. See pin definitions in Table 2.

Table 2: Pin Definitions

Name	No.	Type	Function
GND	1	P	Ground
3V3	2	P	Power supply
EN	3	I	Module-enable signal. Active high.
SENSOR_VP	4	I	GPIO36, ADC1_CH0, RTC_GPIO0
SENSOR_VN	5	I	GPIO39, ADC1_CH3, RTC_GPIO3
IO34	6	I	GPIO34, ADC1_CH6, RTC_GPIO4
IO35	7	I	GPIO35, ADC1_CH7, RTC_GPIO5
IO32	8	I/O	GPIO32, XTAL_32K_P (32.768 kHz crystal oscillator input), ADC1_CH4, TOUCH9, RTC_GPIO9
IO33	9	I/O	GPIO33, XTAL_32K_N (32.768 kHz crystal oscillator output), ADC1_CH5, TOUCH8, RTC_GPIO8

Name	No.	Type	Function
IO25	10	I/O	GPIO25, DAC_1, ADC2_CH8, RTC_GPIO6, EMAC_RXD0
IO26	11	I/O	GPIO26, DAC_2, ADC2_CH9, RTC_GPIO7, EMAC_RXD1
IO27	12	I/O	GPIO27, ADC2_CH7, TOUCH7, RTC_GPIO17, EMAC_RX_DV
IO14	13	I/O	GPIO14, ADC2_CH6, TOUCH6, RTC_GPIO16, MTMS, HSPICLK, HS2_CLK, SD_CLK, EMAC_TXD2
IO12	14	I/O	GPIO12, ADC2_CH5, TOUCH5, RTC_GPIO15, MTDI, HSPIQ, HS2_DATA2, SD_DATA2, EMAC_TXD3
GND	15	P	Ground
IO13	16	I/O	GPIO13, ADC2_CH4, TOUCH4, RTC_GPIO14, MTCK, HSPID, HS2_DATA3, SD_DATA3, EMAC_RX_ER
SHD/SD2*	17	I/O	GPIO9, SD_DATA2, SPIHD, HS1_DATA2, U1RXD
SWP/SD3*	18	I/O	GPIO10, SD_DATA3, SPIWP, HS1_DATA3, U1TXD
SCS/CMD*	19	I/O	GPIO11, SD_CMD, SPICS0, HS1_CMD, U1RTS
SCK/CLK*	20	I/O	GPIO6, SD_CLK, SPICLK, HS1_CLK, U1CTS
SDO/SD0*	21	I/O	GPIO7, SD_DATA0, SPIQ, HS1_DATA0, U2RTS
SDI/SD1*	22	I/O	GPIO8, SD_DATA1, SPID, HS1_DATA1, U2CTS
IO15	23	I/O	GPIO15, ADC2_CH3, TOUCH3, MTDO, HSPICS0, RTC_GPIO13, HS2_CMD, SD_CMD, EMAC_RXD3
IO2	24	I/O	GPIO2, ADC2_CH2, TOUCH2, RTC_GPIO12, HSPIWP, HS2_DATA0, SD_DATA0
IO0	25	I/O	GPIO0, ADC2_CH1, TOUCH1, RTC_GPIO11, CLK_OUT1, EMAC_TX_CLK
IO4	26	I/O	GPIO4, ADC2_CH0, TOUCH0, RTC_GPIO10, HSPIHD, HS2_DATA1, SD_DATA1, EMAC_TX_ER
IO16	27	I/O	GPIO16, HS1_DATA4, U2RXD, EMAC_CLK_OUT
IO17	28	I/O	GPIO17, HS1_DATA5, U2TXD, EMAC_CLK_OUT_180
IO5	29	I/O	GPIO5, VSPICS0, HS1_DATA6, EMAC_RX_CLK
IO18	30	I/O	GPIO18, VSPICLK, HS1_DATA7
IO19	31	I/O	GPIO19, VSPIQ, U0CTS, EMAC_TXD0
NC	32	-	-
IO21	33	I/O	GPIO21, VSPIHD, EMAC_TX_EN
RXD0	34	I/O	GPIO3, U0RXD, CLK_OUT2
TXD0	35	I/O	GPIO1, U0TXD, CLK_OUT3, EMAC_RXD2
IO22	36	I/O	GPIO22, VSPIWP, U0RTS, EMAC_TXD1
IO23	37	I/O	GPIO23, VSPID, HS1_STROBE
GND	38	P	Ground

Notice:

* Pins SCK/CLK, SDO/SD0, SDI/SD1, SHD/SD2, SWP/SD3 and SCS/CMD, namely, GPIO6 to GPIO11 are connected to the integrated SPI flash integrated on the module and are not recommended for other uses.

2.3 Strapping Pins

ESP32 has five strapping pins, which can be seen in Chapter 6 Schematics:

- MTDI
- GPIO0
- GPIO2
- MTDO
- GPIO5

Software can read the values of these five bits from register "GPIO_STRAPPING".

During the chip's system reset release (power-on-reset, RTC watchdog reset and brownout reset), the latches of the strapping pins sample the voltage level as strapping bits of "0" or "1", and hold these bits until the chip is powered down or shut down. The strapping bits configure the device's boot mode, the operating voltage of VDD_SDIO and other initial system settings.

Each strapping pin is connected to its internal pull-up/pull-down during the chip reset. Consequently, if a strapping pin is unconnected or the connected external circuit is high-impedance, the internal weak pull-up/pull-down will determine the default input level of the strapping pins.

To change the strapping bit values, users can apply the external pull-down/pull-up resistances, or use the host MCU's GPIOs to control the voltage level of these pins when powering on ESP32.

After reset release, the strapping pins work as normal-function pins.

Refer to Table 3 for a detailed boot-mode configuration by strapping pins.

Table 3: Strapping Pins

Voltage of Internal LDO (VDD_SDIO)					
Pin	Default	3.3 V		1.8 V	
MTDI	Pull-down	0		1	
Bootling Mode					
Pin	Default	SPI Boot		Download Boot	
GPIO0	Pull-up	1		0	
GPIO2	Pull-down	Don't-care		0	
Enabling/Disabling Debugging Log Print over U0TXD During Bootling					
Pin	Default	U0TXD Active		U0TXD Silent	
MTDO	Pull-up	1		0	
Timing of SDIO Slave					
Pin	Default	Falling-edge Sampling Falling-edge Output	Falling-edge Sampling Rising-edge Output	Rising-edge Sampling Falling-edge Output	Rising-edge Sampling Rising-edge Output
MTDO	Pull-up	0	0	1	1
GPIO5	Pull-up	0	1	0	1

Note:

- Firmware can configure register bits to change the settings of "Voltage of Internal LDO (VDD_SDIO)" and "Timing of SDIO Slave" after bootling.
- The module integrates a 3.3 V SPI flash, so the pin MTDI cannot be set to 1 when the module is powered up.

The strapping pins need a setup and hold time before and after the EN signal goes high. For details please refer to Section Strapping Pins in [ESP32 Datasheet](#).

3. Functional Description

This chapter describes the modules and functions integrated in ESP32-WROOM-32.

3.1 CPU and Internal Memory

ESP32-D0WDQ6 contains two low-power Xtensa® 32-bit LX6 microprocessors. The internal memory includes:

- 448 KB of ROM for booting and core functions.
- 520 KB of on-chip SRAM for data and instructions.
- 8 KB of SRAM in RTC, which is called RTC FAST Memory and can be used for data storage; it is accessed by the main CPU during RTC Boot from the Deep-sleep mode.
- 8 KB of SRAM in RTC, which is called RTC SLOW Memory and can be accessed by the co-processor during the Deep-sleep mode.
- 1 Kbit of eFuse: 256 bits are used for the system (MAC address and chip configuration) and the remaining 768 bits are reserved for customer applications, including flash-encryption and chip-ID.

3.2 External Flash and SRAM

ESP32 supports multiple external QSPI flash and SRAM chips. More details can be found in Chapter SPI in the [ESP32 Technical Reference Manual](#). ESP32 also supports hardware encryption/decryption based on AES to protect developers' programs and data in flash.

ESP32 can access the external QSPI flash and SRAM through high-speed caches.

- The external flash can be mapped into CPU instruction memory space and read-only memory space simultaneously.
 - When external flash is mapped into CPU instruction memory space, up to 11 MB + 248 KB can be mapped at a time. Note that if more than 3 MB + 248 KB are mapped, cache performance will be reduced due to speculative reads by the CPU.
 - When external flash is mapped into read-only data memory space, up to 4 MB can be mapped at a time. 8-bit, 16-bit and 32-bit reads are supported.
- External SRAM can be mapped into CPU data memory space. Up to 4 MB can be mapped at a time. 8-bit, 16-bit and 32-bit reads and writes are supported.

ESP32-WROOM-32 integrates a 4 MB SPI flash, which is connected to GPIO6, GPIO7, GPIO8, GPIO9, GPIO10 and GPIO11. These six pins cannot be used as regular GPIOs.

3.3 Crystal Oscillators

The module uses a 40-MHz crystal oscillator.

3.4 RTC and Low-Power Management

With the use of advanced power-management technologies, ESP32 can switch between different power modes.

For details on ESP32's power consumption in different power modes, please refer to section "RTC and Low-Power Management" in [ESP32 Datasheet](#).

4. Peripherals and Sensors

Please refer to Section Peripherals and Sensors in [ESP32 Datasheet](#).

Note:

External connections can be made to any GPIO except for GPIOs in the range 6-11. These six GPIOs are connected to the module's integrated SPI flash. For details, please see Section 6 Schematics.

5. Electrical Characteristics

5.1 Absolute Maximum Ratings

Stresses beyond the absolute maximum ratings listed in Table 4 below may cause permanent damage to the device. These are stress ratings only, and do not refer to the functional operation of the device that should follow the [recommended operating conditions](#).

Table 4: Absolute Maximum Ratings

Symbol	Parameter	Min	Max	Unit
VDD33	Power supply voltage	-0.3	3.6	V
I_{output}^1	Cumulative IO output current	-	1,100	mA
T_{store}	Storage temperature	-40	150	°C

1. The module worked properly after a 24-hour test in ambient temperature at 25 °C, and the IOs in three domains (VDD3P3_RTC, VDD3P3_CPU, VDD_SDIO) output high logic level to ground. Please note that pins occupied by flash and/or PSRAM in the VDD_SDIO power domain were excluded from the test.
2. Please see Appendix IO_MUX of [ESP32 Datasheet](#) for IO's power domain.

5.2 Recommended Operating Conditions

Table 5: Recommended Operating Conditions

Symbol	Parameter	Min	Typical	Max	Unit
VDD33	Power supply voltage	3.0	3.3	3.6	V
I_{VDD}	Current delivered by external power supply	0.5	-	-	A
T	Operating temperature	-40	-	85	°C

5.3 DC Characteristics (3.3 V, 25 °C)

Table 6: DC Characteristics (3.3 V, 25 °C)

Symbol	Parameter		Min	Typ	Max	Unit
C_{IN}	Pin capacitance		-	2	-	pF
V_{IH}	High-level input voltage		$0.75 \times VDD^1$	-	$VDD^1 + 0.3$	V
V_{IL}	Low-level input voltage		-0.3	-	$0.25 \times VDD^1$	V
I_{IH}	High-level input current		-	-	50	nA
I_{IL}	Low-level input current		-	-	50	nA
V_{OH}	High-level output voltage		$0.8 \times VDD^1$	-	-	V
V_{OL}	Low-level output voltage		-	-	$0.1 \times VDD^1$	V
I_{OH}	High-level source current ($VDD^1 = 3.3\text{ V}$, $V_{OH} \geq 2.64\text{ V}$, output drive strength set to the maximum)	VDD3P3_CPU power domain ^{1, 2}	-	40	-	mA
		VDD3P3_RTC power domain ^{1, 2}	-	40	-	mA
		VDD_SDIO power domain ^{1, 3}	-	20	-	mA

Symbol	Parameter	Min	Typ	Max	Unit
I_{OL}	Low-level sink current ($V_{DD}^1 = 3.3\text{ V}$, $V_{OL} = 0.495\text{ V}$, output drive strength set to the maximum)	-	28	-	mA
R_{PU}	Resistance of internal pull-up resistor	-	45	-	$k\Omega$
R_{PD}	Resistance of internal pull-down resistor	-	45	-	$k\Omega$
V_{IL_nRST}	Low-level input voltage of CHIP_PU to power off the chip	-	-	0.6	V

Notes:

1. Please see Appendix IO_MUX of [ESP32 Datasheet](#) for IO's power domain. VDD is the I/O voltage for a particular power domain of pins.
2. For VDD3P3_CPU and VDD3P3_RTC power domain, per-pin current sourced in the same domain is gradually reduced from around 40 mA to around 29 mA, $V_{OH} \geq 2.64\text{ V}$, as the number of current-source pins increases.
3. Pins occupied by flash and/or PSRAM in the VDD_SDIO power domain were excluded from the test.

5.4 Wi-Fi Radio

Table 7: Wi-Fi Radio Characteristics

Parameter	Condition	Min	Typical	Max	Unit
Operating frequency range <i>note1</i>	-	2412	-	2484	MHz
Output impedance <i>note2</i>	-	-	<i>note 2</i>	-	Ω
TX power <i>note3</i>	11n, MCS7	12	13	14	dBm
	11b mode	17.5	18.5	20	dBm
Sensitivity	11b, 1 Mbps	-	-98	-	dBm
	11b, 11 Mbps	-	-89	-	dBm
	11g, 6 Mbps	-	-92	-	dBm
	11g, 54 Mbps	-	-74	-	dBm
	11n, HT20, MCS0	-	-91	-	dBm
	11n, HT20, MCS7	-	-71	-	dBm
	11n, HT40, MCS0	-	-89	-	dBm
	11n, HT40, MCS7	-	-69	-	dBm
Adjacent channel rejection	11g, 6 Mbps	-	31	-	dB
	11g, 54 Mbps	-	14	-	dB
	11n, HT20, MCS0	-	31	-	dB
	11n, HT20, MCS7	-	13	-	dB

1. Device should operate in the frequency range allocated by regional regulatory authorities. Target operating frequency range is configurable by software.
2. For the modules that use IPEX antennas, the output impedance is 50 Ω . For other modules without IPEX antennas, users do not need to concern about the output impedance.
3. Target TX power is configurable based on device or certification requirements.

5.5 BLE Radio

5.5.1 Receiver

Table 8: Receiver Characteristics – BLE

Parameter	Conditions	Min	Typ	Max	Unit
Sensitivity @30.8% PER	-	-	-97	-	dBm
Maximum received signal @30.8% PER	-	0	-	-	dBm
Co-channel C/I	-	-	+10	-	dB
Adjacent channel selectivity C/I	$F = F_0 + 1 \text{ MHz}$	-	-5	-	dB
	$F = F_0 - 1 \text{ MHz}$	-	-5	-	dB
	$F = F_0 + 2 \text{ MHz}$	-	-25	-	dB
	$F = F_0 - 2 \text{ MHz}$	-	-35	-	dB
	$F = F_0 + 3 \text{ MHz}$	-	-25	-	dB
	$F = F_0 - 3 \text{ MHz}$	-	-45	-	dB
Out-of-band blocking performance	30 MHz ~ 2000 MHz	-10	-	-	dBm
	2000 MHz ~ 2400 MHz	-27	-	-	dBm
	2500 MHz ~ 3000 MHz	-27	-	-	dBm
	3000 MHz ~ 12.5 GHz	-10	-	-	dBm
Intermodulation	-	-36	-	-	dBm

5.5.2 Transmitter

Table 9: Transmitter Characteristics – BLE

Parameter	Conditions	Min	Typ	Max	Unit
RF transmit power	-	-	0	-	dBm
Gain control step	-	-	3	-	dBm
RF power control range	-	-12	-	+9	dBm
Adjacent channel transmit power	$F = F_0 \pm 2 \text{ MHz}$	-	-52	-	dBm
	$F = F_0 \pm 3 \text{ MHz}$	-	-58	-	dBm
	$F = F_0 \pm > 3 \text{ MHz}$	-	-60	-	dBm
$\Delta f_{1\text{avg}}$	-	-	-	265	kHz
$\Delta f_{2\text{max}}$	-	247	-	-	kHz
$\Delta f_{2\text{avg}}/\Delta f_{1\text{avg}}$	-	-	-0.92	-	-
ICFT	-	-	-10	-	kHz
Drift rate	-	-	0.7	-	kHz/50 μ s
Drift	-	-	2	-	kHz

5.6 Reflow Profile

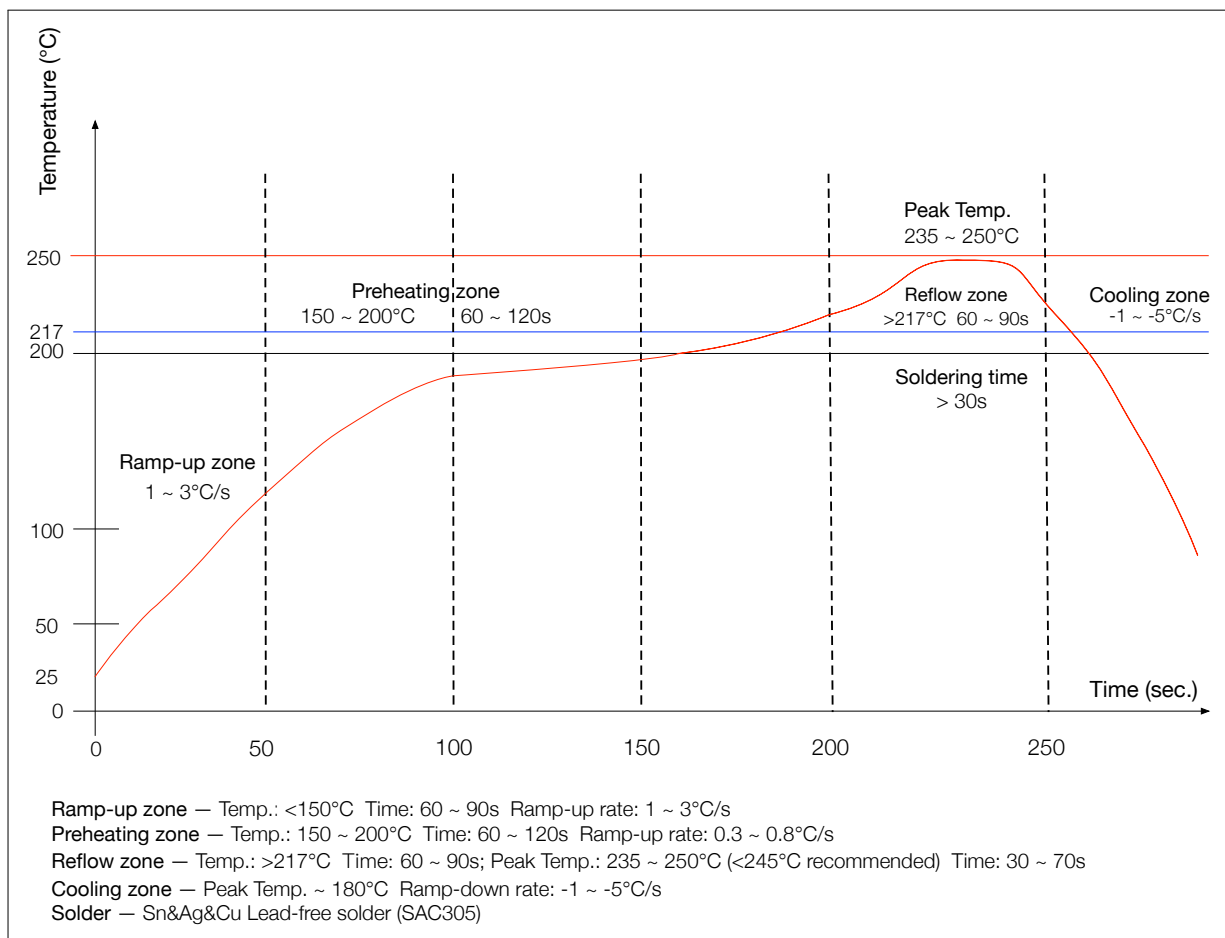


Figure 2: Reflow Profile

6. Schematics

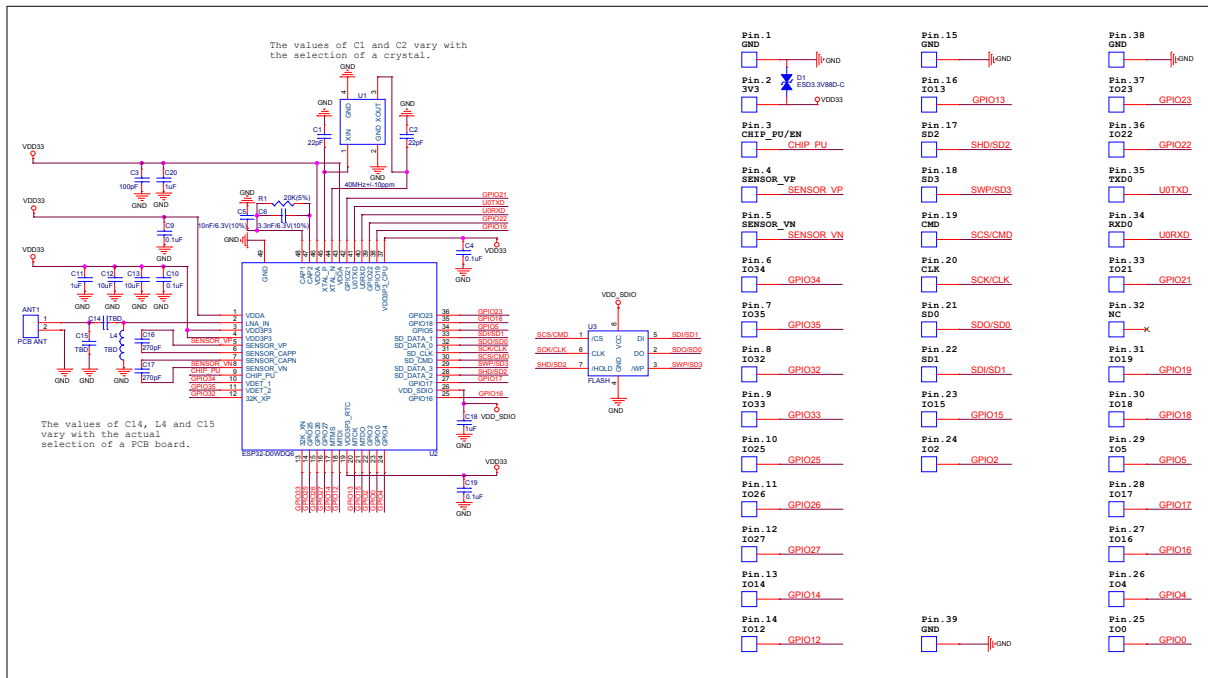


Figure 3: ESP32-WROOM-32 Schematics

7. Peripheral Schematics

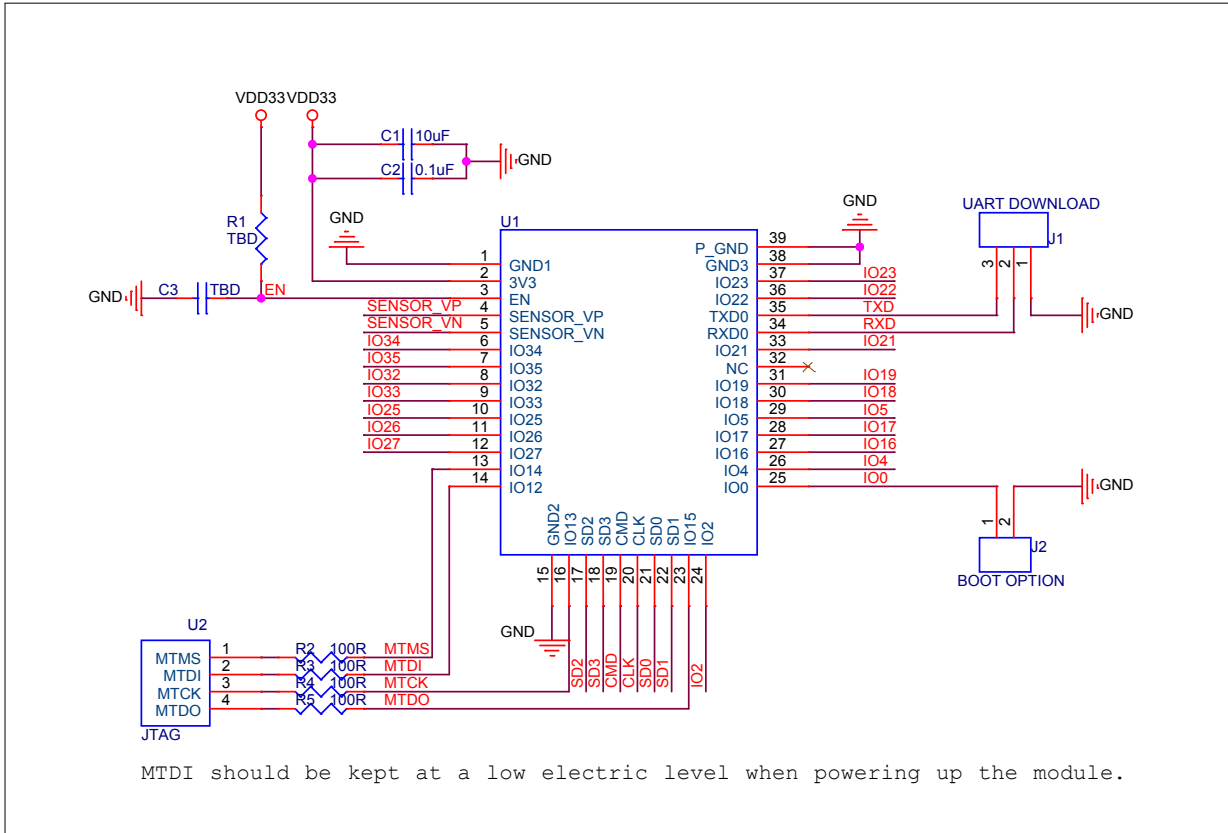


Figure 4: ESP32-WROOM-32 Peripheral Schematics

Note:

- Soldering Pad 39 to the Ground of the base board is not necessary for a satisfactory thermal performance. If users do want to solder it, they need to ensure that the correct quantity of soldering paste is applied.
- To ensure the power supply to the ESP32 chip during power-up, it is advised to add an RC delay circuit at the EN pin. The recommended setting for the RC delay circuit is usually $R = 10\text{ k}\Omega$ and $C = 0.1\ \mu\text{F}$. However, specific parameters should be adjusted based on the power-up timing of the module and the power-up and reset sequence timing of the chip. For ESP32's power-up and reset sequence timing diagram, please refer to Section *Power Scheme* in [ESP32 Datasheet](#).

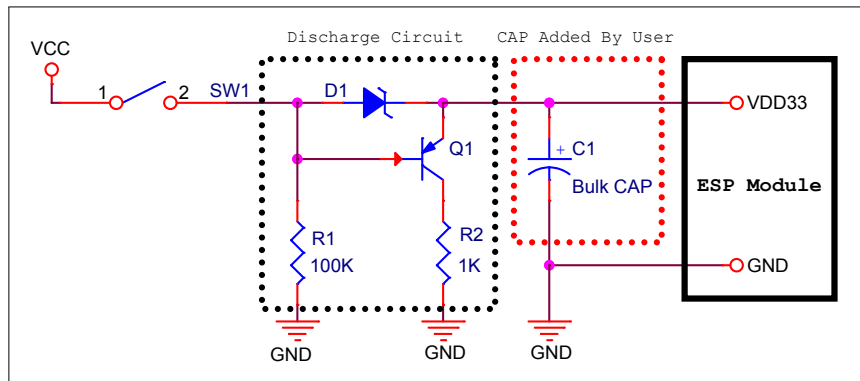


Figure 5: Discharge Circuit for VDD33 Rail

Note:

The discharge circuit can be applied in scenarios where ESP32 is powered on and off repeatedly by switching the power rails, and there is a large capacitor on the VDD33 rail. For details, please refer to Section *Power Scheme* in [ESP32 Datasheet](#).

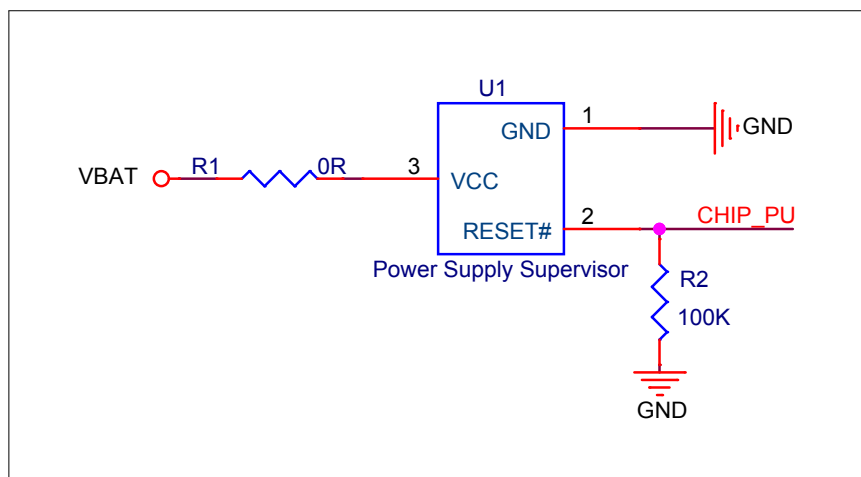


Figure 6: Reset Circuit

Note:

When battery is used as the power supply for ESP32 series of chips and modules, a supply voltage supervisor is recommended to avoid boot failure due to low voltage. Users are recommended to pull CHIP_PU low if the power supply for ESP32 is below 2.3 V.

8. Physical Dimensions

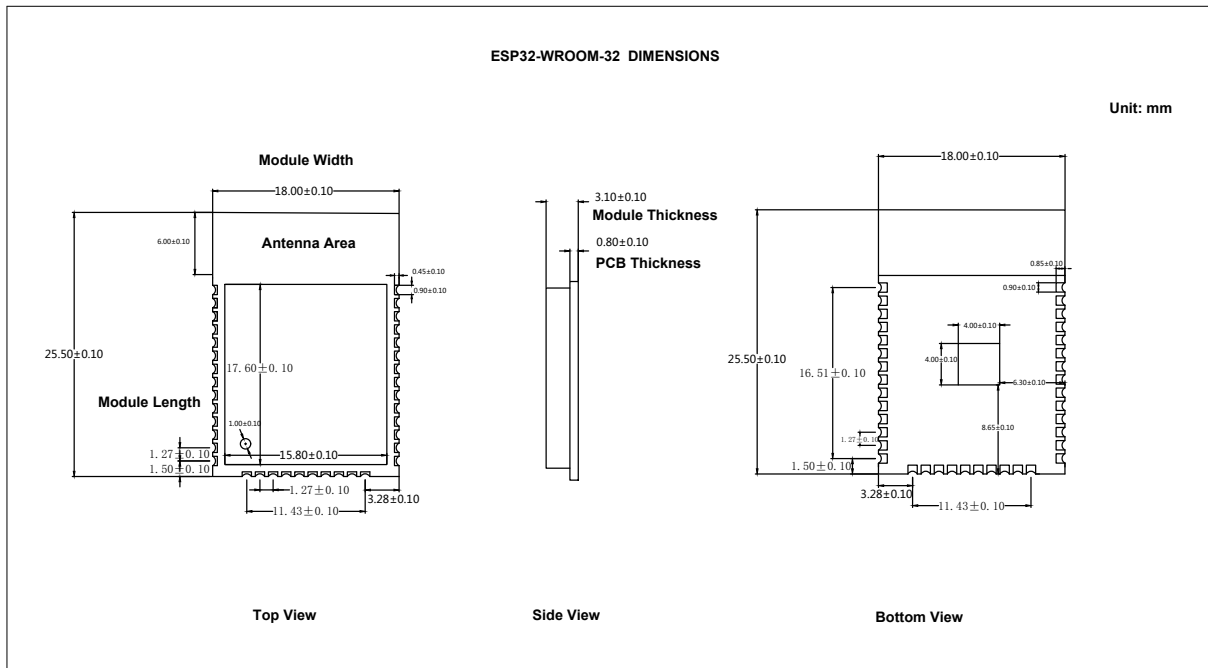


Figure 7: Physical Dimensions of ESP32-WROOM-32

9. Recommended PCB Land Pattern

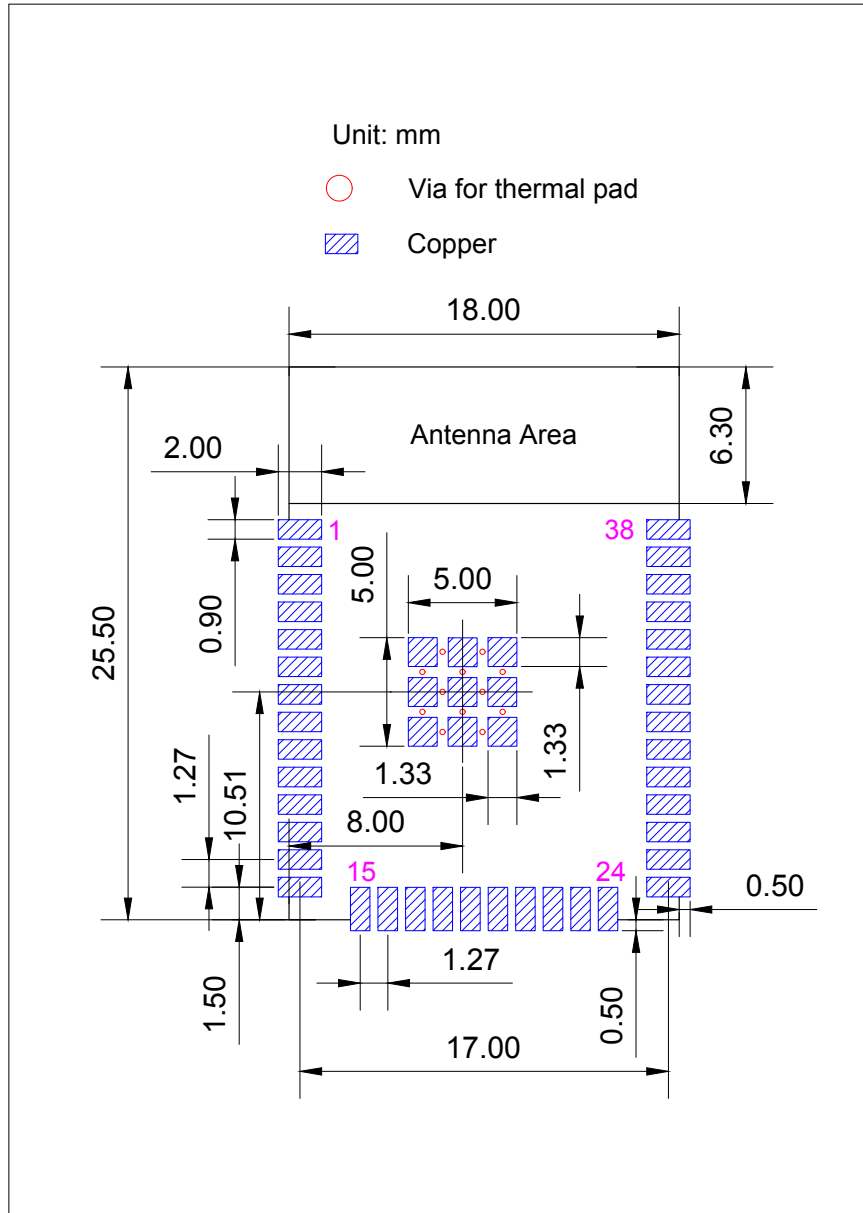


Figure 8: Recommended PCB Land Pattern

10. Learning Resources

10.1 Must-Read Documents

The following link provides documents related to ESP32.

- [ESP32 Datasheet](#)
This document provides an introduction to the specifications of the ESP32 hardware, including overview, pin definitions, functional description, peripheral interface, electrical characteristics, etc.
- [ESP-IDF Programming Guide](#)
It hosts extensive documentation for ESP-IDF ranging from hardware guides to API reference.
- [ESP32 Technical Reference Manual](#)
The manual provides detailed information on how to use the ESP32 memory and peripherals.
- [ESP32 Hardware Resources](#)
The zip files include the schematics, PCB layout, Gerber and BOM list of ESP32 modules and development boards.
- [ESP32 Hardware Design Guidelines](#)
The guidelines outline recommended design practices when developing standalone or add-on systems based on the ESP32 series of products, including the ESP32 chip, the ESP32 modules and development boards.
- [ESP32 AT Instruction Set and Examples](#)
This document introduces the ESP32 AT commands, explains how to use them, and provides examples of several common AT commands.
- [Espressif Products Ordering Information](#)

10.2 Must-Have Resources

Here are the ESP32-related must-have resources.

- [ESP32 BBS](#)
This is an Engineer-to-Engineer (E2E) Community for ESP32 where you can post questions, share knowledge, explore ideas, and help solve problems with fellow engineers.
- [ESP32 GitHub](#)
ESP32 development projects are freely distributed under Espressif's MIT license on GitHub. It is established to help developers get started with ESP32 and foster innovation and the growth of general knowledge about the hardware and software surrounding ESP32 devices.
- [ESP32 Tools](#)
This is a webpage where users can download ESP32 Flash Download Tools and the zip file "ESP32 Certification and Test".
- [ESP-IDF](#)
This webpage links users to the official IoT development framework for ESP32.
- [ESP32 Resources](#)
This webpage provides the links to all available ESP32 documents, SDK and tools.

Revision History

Date	Version	Release notes
2019.09	V2.9	<ul style="list-style-type: none"> • Changed the supply voltage range from 2.7 V ~ 3.6 V to 3.0 V ~ 3.6 V; • Added Moisture sensitivity level (MSL) 3 in Table 1 <i>ESP32-WROOM-32 Specifications</i>; • Added notes about "Operating frequency range" and "TX power" under Table 7 <i>Wi-Fi Radio Characteristics</i>; • Updated Section 7 <i>Peripheral Schematics</i> and added a note about RC delay circuit under it; • Updated Figure 8 <i>Recommended PCB Land Pattern</i>.
2019.01	V2.8	Changed the RF power control range in Table 9 from -12 ~ +12 to -12 ~ +9 dBm.
2018.10	V2.7	Added "Cumulative IO output current" entry to Table 4: Absolute Maximum Ratings; Added more parameters to Table 6: DC Characteristics.
2018.08	V2.6	<ul style="list-style-type: none"> • Added reliability test items the module has passed in Table 1: ESP32-WROOM-32 Specifications, and removed software-specific information; • Updated section 3.4: RTC and Low-Power Management; • Changed the module's dimensions from (18±0.2) mm x (25.5 ±0.2) mm x (3.1±0.15) mm to (18.00±0.10) mm x (25.50±0.10) mm x (3.10±0.10) mm; • Updated Figure 8: Physical Dimensions; • Updated Table 7: Wi-Fi Radio.
2018.06	V2.5	<ul style="list-style-type: none"> • Changed the module name to ESP32-WROOM-32; • Deleted Temperature Sensor in Table 1: ESP32-WROOM-32 Specifications; • Updated Chapter 3: Functional Description; • Added Chapter 8: Recommended PCB Land Pattern; <p>Changes to electrical characteristics:</p> <ul style="list-style-type: none"> • Updated Table 4: Absolute Maximum Ratings; • Added Table 5: Recommended Operating Conditions; • Added Table 6: DC Characteristics; • Updated the values of "Gain control step", "Adjacent channel transmit power" in Table 9: Transmitter Characteristics - BLE.
2018.03	V2.4	Updated Table 1 in Chapter 1.
2018.01	V2.3	Deleted information on LNA pre-amplifier; Updated section 3.4 RTC and Low-Power Management; Added reset circuit in Chapter 7 and a note to it.
2017.10	V2.2	Updated the description of the chip's system reset in Section 2.3 Strapping Pins; Deleted "Association sleep pattern" in Table "Power Consumption by Power Modes" and added notes to Active sleep and Modem-sleep; Updated the note to Figure 4 Peripheral Schematics; Added discharge circuit for VDD33 rail in Chapter 7 and a note to it.
2017.09	V2.1	Updated operating voltage/power supply range updated to 2.7 ~ 3.6V; Updated Chapter 7.
2017.08	V2.0	Changed the sensitivity of NZIF receiver to -97 dBm in Table 1; Updated the dimensions of the module; Updated Table "Power Consumption by Power Modes" Power Consumption by Power Modes, and added two notes to it;

Date	Version	Release notes
		Updated Table 4, 7, 8, 9; Added Chapter 8; Added the link to certification download .
2017.06	V1.9	Added a note to Section 2.1 Pin Layout; Updated Section 3.3 Crystal Oscillators; Updated Figure 3 ESP-WROOM-32 Schematics; Added Documentation Change Notification.
2017.05	V1.8	Updated Figure 1 Top and Side View of ESP32-WROOM-32 (ESP-WROOM-32).
2017.04	V1.7	Added the module's dimensional tolerance; Changed the input impedance value of 50Ω in Table 7 Wi-Fi Radio Characteristics to output impedance value of $30+j10\Omega$.
2017.04	V1.6	Added Figure 2 Reflow Profile.
2017.03	V1.5	Updated Section 2.2 Pin Description; Updated Section 3.2 External Flash and SRAM; Updated Section 4 Peripherals and Sensors Description.
2017.03	V1.4	Updated Chapter 1 Preface; Updated Chapter 2 Pin Definitions; Updated Chapter 3 Functional Description; Updated Table Recommended Operating Conditions; Updated Table 7 Wi-Fi Radio Characteristics; Updated Section 5.6 Reflow Profile; Added Chapter 10 Learning Resources.
2016.12	V1.3	Updated Section 2.1 Pin Layout.
2016.11	V1.2	Added Figure 7 Peripheral Schematics.
2016.11	V1.1	Updated Chapter 6 Schematics.
2016.08	V1.0	First release.



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MPU-6000 and MPU-6050 Product Specification Revision 3.4



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1 Revision History

Revision Date	Revision	Description
11/24/2010	1.0	Initial Release
05/19/2011	2.0	For Rev C parts. Clarified wording in sections (3.2, 5.1, 5.2, 6.1-6.4, 6.6, 6.9, 7, 7.1-7.6, 7.11, 7.12, 7.14, 8, 8.2-8.4, 10.3, 10.4, 11, 12.2)
07/28/2011	2.1	Edited supply current numbers for different modes (section 6.4)
08/05/2011	2.2	Unit of measure for accelerometer sensitivity changed from LSB/mg to LSB/g
10/12/2011	2.3	Updated accelerometer self test specifications in Table 6.2. Updated package dimensions (section 11.2). Updated PCB design guidelines (section 11.3)
10/18/2011	3.0	For Rev D parts. Updated accelerometer specifications in Table 6.2. Updated accelerometer specification note (sections 8.2, 8.3, & 8.4). Updated qualification test plan (section 12.2).
10/24/2011	3.1	Edits for clarity Changed operating voltage range to 2.375V-3.46V Added accelerometer Intelligence Function increment value of 1mg/LSB (Section 6.2) Updated absolute maximum rating for acceleration (any axis, unpowered) from 0.3ms to 0.2ms (Section 6.9) Modified absolute maximum rating for Latch-up to Level A and ± 100 mA (Section 6.9, 12.2)
11/16/2011	3.2	Updated self-test response specifications for Revision D parts dated with date code 1147 (YYWW) or later. Edits for clarity Added Gyro self-test (sections 5.1, 6.1, 7.6, 7.12) Added Min/Max limits to Accel self-test response (section 6.2) Updated Accelerometer low power mode operating currents (Section 6.3) Added gyro self test to block diagram (section 7.5) Updated packaging labels and descriptions (sections 11.8 & 11.9)
5/16/2012	3.3	Updated Gyro and Accelerometer self test information (sections 6.1, 6.2, 7.12) Updated latch-up information (Section 6.9) Updated programmable interrupts information (Section 8) Changed shipment information from maximum of 3 reels (15K units) per shipper box to 5 reels (25K units) per shipper box (Section 11.7) Updated packing shipping and label information (Sections 11.8, 11.9) Updated reliability references (Section 12.2)
8/19/2013	3.4	Updates section 4

	MPU-6000/MPU-6050 Product Specification	Document Number: PS-MPU-6000A-00 Revision: 3.4 Release Date: 08/19/2013
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2 Purpose and Scope

This product specification provides advanced information regarding the electrical specification and design related information for the MPU-6000™ and MPU-6050™ MotionTracking™ devices, collectively called the MPU-60X0™ or MPU™.

Electrical characteristics are based upon design analysis and simulation results only. Specifications are subject to change without notice. Final specifications will be updated based upon characterization of production silicon. For references to register map and descriptions of individual registers, please refer to the MPU-6000/MPU-6050 Register Map and Register Descriptions document.

The self-test response specifications provided in this document pertain to Revision D parts with date codes of 1147 (YYWW) or later. Please see Section 11.6 for package marking description details.



3 Product Overview

3.1 MPU-60X0 Overview

MotionInterface™ is becoming a “must-have” function being adopted by smartphone and tablet manufacturers due to the enormous value it adds to the end user experience. In smartphones, it finds use in applications such as gesture commands for applications and phone control, enhanced gaming, augmented reality, panoramic photo capture and viewing, and pedestrian and vehicle navigation. With its ability to precisely and accurately track user motions, MotionTracking technology can convert handsets and tablets into powerful 3D intelligent devices that can be used in applications ranging from health and fitness monitoring to location-based services. Key requirements for MotionInterface enabled devices are small package size, low power consumption, high accuracy and repeatability, high shock tolerance, and application specific performance programmability – all at a low consumer price point.

The MPU-60X0 is the world’s first integrated 6-axis MotionTracking device that combines a 3-axis gyroscope, 3-axis accelerometer, and a Digital Motion Processor™ (DMP) all in a small 4x4x0.9mm package. With its dedicated I²C sensor bus, it directly accepts inputs from an external 3-axis compass to provide a complete 9-axis MotionFusion™ output. The MPU-60X0 MotionTracking device, with its 6-axis integration, on-board MotionFusion™, and run-time calibration firmware, enables manufacturers to eliminate the costly and complex selection, qualification, and system level integration of discrete devices, guaranteeing optimal motion performance for consumers. The MPU-60X0 is also designed to interface with multiple non-inertial digital sensors, such as pressure sensors, on its auxiliary I²C port. The MPU-60X0 is footprint compatible with the MPU-30X0 family.

The MPU-60X0 features three 16-bit analog-to-digital converters (ADCs) for digitizing the gyroscope outputs and three 16-bit ADCs for digitizing the accelerometer outputs. For precision tracking of both fast and slow motions, the parts feature a user-programmable gyroscope full-scale range of ± 250 , ± 500 , ± 1000 , and $\pm 2000^\circ/\text{sec}$ (dps) and a user-programmable accelerometer full-scale range of $\pm 2g$, $\pm 4g$, $\pm 8g$, and $\pm 16g$.

An on-chip 1024 Byte FIFO buffer helps lower system power consumption by allowing the system processor to read the sensor data in bursts and then enter a low-power mode as the MPU collects more data. With all the necessary on-chip processing and sensor components required to support many motion-based use cases, the MPU-60X0 uniquely enables low-power MotionInterface applications in portable applications with reduced processing requirements for the system processor. By providing an integrated MotionFusion output, the DMP in the MPU-60X0 offloads the intensive MotionProcessing computation requirements from the system processor, minimizing the need for frequent polling of the motion sensor output.

Communication with all registers of the device is performed using either I²C at 400kHz or SPI at 1MHz (MPU-6000 only). For applications requiring faster communications, the sensor and interrupt registers may be read using SPI at 20MHz (MPU-6000 only). Additional features include an embedded temperature sensor and an on-chip oscillator with $\pm 1\%$ variation over the operating temperature range.

By leveraging its patented and volume-proven Nasiri-Fabrication platform, which integrates MEMS wafers with companion CMOS electronics through wafer-level bonding, InvenSense has driven the MPU-60X0 package size down to a revolutionary footprint of 4x4x0.9mm (QFN), while providing the highest performance, lowest noise, and the lowest cost semiconductor packaging required for handheld consumer electronic devices. The part features a robust 10,000g shock tolerance, and has programmable low-pass filters for the gyroscopes, accelerometers, and the on-chip temperature sensor.

For power supply flexibility, the MPU-60X0 operates from VDD power supply voltage range of 2.375V-3.46V. Additionally, the MPU-6050 provides a VLOGIC reference pin (in addition to its analog supply pin: VDD), which sets the logic levels of its I²C interface. The VLOGIC voltage may be $1.8V \pm 5\%$ or VDD.

The MPU-6000 and MPU-6050 are identical, except that the MPU-6050 supports the I²C serial interface only, and has a separate VLOGIC reference pin. The MPU-6000 supports both I²C and SPI interfaces and has a single supply pin, VDD, which is both the device’s logic reference supply and the analog supply for the part. The table below outlines these differences:

**MPU-6000/MPU-6050 Product Specification**Document Number: PS-MPU-6000A-00
Revision: 3.4
Release Date: 08/19/2013**Primary Differences between MPU-6000 and MPU-6050**

Part / Item	MPU-6000	MPU-6050
VDD	2.375V-3.46V	2.375V-3.46V
VLOGIC	n/a	1.71V to VDD
Serial Interfaces Supported	I ² C, SPI	I ² C
Pin 8	/CS	VLOGIC
Pin 9	AD0/SDO	AD0
Pin 23	SCL/SCLK	SCL
Pin 24	SDA/SDI	SDA



4 Applications

- *BlurFree™* technology (for Video/Still Image Stabilization)
- *AirSign™* technology (for Security/Authentication)
- *TouchAnywhere™* technology (for “no touch” UI Application Control/Navigation)
- *MotionCommand™* technology (for Gesture Short-cuts)
- Motion-enabled game and application framework
- InstantGesture™ iG™ gesture recognition
- Location based services, points of interest, and dead reckoning
- Handset and portable gaming
- Motion-based game controllers
- 3D remote controls for Internet connected DTVs and set top boxes, 3D mice
- Wearable sensors for health, fitness and sports
- Toys



5 Features

5.1 Gyroscope Features

The triple-axis MEMS gyroscope in the MPU-60X0 includes a wide range of features:

- Digital-output X-, Y-, and Z-Axis angular rate sensors (gyroscopes) with a user-programmable full-scale range of ± 250 , ± 500 , ± 1000 , and $\pm 2000^\circ/\text{sec}$
- External sync signal connected to the FSYNC pin supports image, video and GPS synchronization
- Integrated 16-bit ADCs enable simultaneous sampling of gyros
- Enhanced bias and sensitivity temperature stability reduces the need for user calibration
- Improved low-frequency noise performance
- Digitally-programmable low-pass filter
- Gyroscope operating current: 3.6mA
- Standby current: 5 μ A
- Factory calibrated sensitivity scale factor
- User self-test

5.2 Accelerometer Features

The triple-axis MEMS accelerometer in MPU-60X0 includes a wide range of features:

- Digital-output triple-axis accelerometer with a programmable full scale range of $\pm 2g$, $\pm 4g$, $\pm 8g$ and $\pm 16g$
- Integrated 16-bit ADCs enable simultaneous sampling of accelerometers while requiring no external multiplexer
- Accelerometer normal operating current: 500 μ A
- Low power accelerometer mode current: 10 μ A at 1.25Hz, 20 μ A at 5Hz, 60 μ A at 20Hz, 110 μ A at 40Hz
- Orientation detection and signaling
- Tap detection
- User-programmable interrupts
- High-G interrupt
- User self-test

5.3 Additional Features

The MPU-60X0 includes the following additional features:

- 9-Axis MotionFusion by the on-chip Digital Motion Processor (DMP)
- Auxiliary master I²C bus for reading data from external sensors (e.g., magnetometer)
- 3.9mA operating current when all 6 motion sensing axes and the DMP are enabled
- VDD supply voltage range of 2.375V-3.46V
- Flexible VLOGIC reference voltage supports multiple I²C interface voltages (MPU-6050 only)
- Smallest and thinnest QFN package for portable devices: 4x4x0.9mm
- Minimal cross-axis sensitivity between the accelerometer and gyroscope axes
- 1024 byte FIFO buffer reduces power consumption by allowing host processor to read the data in bursts and then go into a low-power mode as the MPU collects more data
- Digital-output temperature sensor
- User-programmable digital filters for gyroscope, accelerometer, and temp sensor
- 10,000 g shock tolerant
- 400kHz Fast Mode I²C for communicating with all registers
- 1MHz SPI serial interface for communicating with all registers (MPU-6000 only)
- 20MHz SPI serial interface for reading sensor and interrupt registers (MPU-6000 only)



- MEMS structure hermetically sealed and bonded at wafer level
- RoHS and Green compliant

5.4 MotionProcessing

- Internal Digital Motion Processing™ (DMP™) engine supports 3D MotionProcessing and gesture recognition algorithms
- The MPU-60X0 collects gyroscope and accelerometer data while synchronizing data sampling at a user defined rate. The total dataset obtained by the MPU-60X0 includes 3-Axis gyroscope data, 3-Axis accelerometer data, and temperature data. The MPU's calculated output to the system processor can also include heading data from a digital 3-axis third party magnetometer.
- The FIFO buffers the complete data set, reducing timing requirements on the system processor by allowing the processor burst read the FIFO data. After burst reading the FIFO data, the system processor can save power by entering a low-power sleep mode while the MPU collects more data.
- Programmable interrupt supports features such as gesture recognition, panning, zooming, scrolling, tap detection, and shake detection
- Digitally-programmable low-pass filters
- Low-power pedometer functionality allows the host processor to sleep while the DMP maintains the step count.

5.5 Clocking

- On-chip timing generator $\pm 1\%$ frequency variation over full temperature range
- Optional external clock inputs of 32.768kHz or 19.2MHz



6 Electrical Characteristics

6.1 Gyroscope Specifications

VDD = 2.375V-3.46V, VLOGIC (MPU-6050 only) = 1.8V±5% or VDD, T_A = 25°C

PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS	NOTES
GYROSCOPE SENSITIVITY						
Full-Scale Range	FS_SEL=0		±250		°/s	
	FS_SEL=1		±500		°/s	
	FS_SEL=2		±1000		°/s	
	FS_SEL=3		±2000		°/s	
Gyroscope ADC Word Length			16		bits	
Sensitivity Scale Factor	FS_SEL=0		131		LSB/(°/s)	
	FS_SEL=1		65.5		LSB/(°/s)	
	FS_SEL=2		32.8		LSB/(°/s)	
	FS_SEL=3		16.4		LSB/(°/s)	
Sensitivity Scale Factor Tolerance	25°C	-3		+3	%	
Sensitivity Scale Factor Variation Over Temperature			±2		%	
Nonlinearity	Best fit straight line; 25°C		0.2		%	
Cross-Axis Sensitivity			±2		%	
GYROSCOPE ZERO-RATE OUTPUT (ZRO)						
Initial ZRO Tolerance	25°C		±20		°/s	
ZRO Variation Over Temperature	-40°C to +85°C		±20		°/s	
Power-Supply Sensitivity (1-10Hz)	Sine wave, 100mVpp; VDD=2.5V		0.2		°/s	
Power-Supply Sensitivity (10 - 250Hz)	Sine wave, 100mVpp; VDD=2.5V		0.2		°/s	
Power-Supply Sensitivity (250Hz - 100kHz)	Sine wave, 100mVpp; VDD=2.5V		4		°/s	
Linear Acceleration Sensitivity	Static		0.1		°/s/g	
SELF-TEST RESPONSE						
Relative	Change from factory trim	-14		14	%	1
GYROSCOPE NOISE PERFORMANCE	FS_SEL=0					
Total RMS Noise	DLPFCFG=2 (100Hz)		0.05		°/s-rms	
Low-frequency RMS noise	Bandwidth 1Hz to10Hz		0.033		°/s-rms	
Rate Noise Spectral Density	At 10Hz		0.005		°/s/√Hz	
GYROSCOPE MECHANICAL FREQUENCIES						
X-Axis		30	33	36	kHz	
Y-Axis		27	30	33	kHz	
Z-Axis		24	27	30	kHz	
LOW PASS FILTER RESPONSE						
	Programmable Range	5		256	Hz	
OUTPUT DATA RATE						
	Programmable	4		8,000	Hz	
GYROSCOPE START-UP TIME						
ZRO Settling (from power-on)	DLPFCFG=0 to ±1°/s of Final		30		ms	

1. Please refer to the following document for further information on Self-Test: *MPU-6000/MPU-6050 Register Map and Descriptions*



MPU-6000/MPU-6050 Product Specification

Document Number: PS-MPU-6000A-00
 Revision: 3.4
 Release Date: 08/19/2013

6.2 Accelerometer Specifications

VDD = 2.375V-3.46V, VLOGIC (MPU-6050 only) = 1.8V±5% or VDD, T_A = 25°C

PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS	NOTES
ACCELEROMETER SENSITIVITY						
Full-Scale Range	AFS_SEL=0		±2		g	
	AFS_SEL=1		±4		g	
	AFS_SEL=2		±8		g	
	AFS_SEL=3		±16		g	
ADC Word Length	Output in two's complement format		16		bits	
Sensitivity Scale Factor	AFS_SEL=0		16,384		LSB/g	
	AFS_SEL=1		8,192		LSB/g	
	AFS_SEL=2		4,096		LSB/g	
	AFS_SEL=3		2,048		LSB/g	
Initial Calibration Tolerance			±3		%	
Sensitivity Change vs. Temperature	AFS_SEL=0, -40°C to +85°C		±0.02		%/°C	
Nonlinearity	Best Fit Straight Line		0.5		%	
Cross-Axis Sensitivity			±2		%	
ZERO-G OUTPUT						
Initial Calibration Tolerance	X and Y axes		±50		mg	1
	Z axis		±80		mg	
Zero-G Level Change vs. Temperature	X and Y axes, 0°C to +70°C		±35		mg	
	Z axis, 0°C to +70°C		±60		mg	
SELF TEST RESPONSE						
Relative	Change from factory trim	-14		14	%	2
NOISE PERFORMANCE						
Power Spectral Density	@10Hz, AFS_SEL=0 & ODR=1kHz		400		μg/√Hz	
LOW PASS FILTER RESPONSE						
	Programmable Range	5		260	Hz	
OUTPUT DATA RATE						
	Programmable Range	4		1,000	Hz	
INTELLIGENCE FUNCTION INCREMENT						
			32		mg/LSB	

1. Typical zero-g initial calibration tolerance value after MSL3 preconditioning
2. Please refer to the following document for further information on Self-Test: *MPU-6000/MPU-6050 Register Map and Descriptions*



MPU-6000/MPU-6050 Product Specification

Document Number: PS-MPU-6000A-00
 Revision: 3.4
 Release Date: 08/19/2013

6.3 Electrical and Other Common Specifications

VDD = 2.375V-3.46V, VLOGIC (MPU-6050 only) = 1.8V±5% or VDD, T_A = 25°C

PARAMETER	CONDITIONS	MIN	TYP	MAX	Units	Notes
TEMPERATURE SENSOR						
Range			-40 to +85		°C	
Sensitivity	Untrimmed		340		LSB/°C	
Temperature Offset	35°C		-521		LSB	
Linearity	Best fit straight line (-40°C to +85°C)		±1		°C	
VDD POWER SUPPLY						
Operating Voltages		2.375		3.46	V	
Normal Operating Current	Gyroscope + Accelerometer + DMP		3.9		mA	
	Gyroscope + Accelerometer (DMP disabled)		3.8		mA	
	Gyroscope + DMP (Accelerometer disabled)		3.7		mA	
	Gyroscope only (DMP & Accelerometer disabled)		3.6		mA	
	Accelerometer only (DMP & Gyroscope disabled)		500		µA	
Accelerometer Low Power Mode Current	1.25 Hz update rate		10		µA	
	5 Hz update rate		20		µA	
	20 Hz update rate		70		µA	
	40 Hz update rate		140		µA	
Full-Chip Idle Mode Supply Current			5		µA	
Power Supply Ramp Rate	Monotonic ramp. Ramp rate is 10% to 90% of the final value			100	ms	
VLOGIC REFERENCE VOLTAGE						
Voltage Range	MPU-6050 only VLOGIC must be ≤VDD at all times	1.71		VDD	V	
Power Supply Ramp Rate	Monotonic ramp. Ramp rate is 10% to 90% of the final value			3	ms	
Normal Operating Current			100		µA	
TEMPERATURE RANGE						
Specified Temperature Range	Performance parameters are not applicable beyond Specified Temperature Range	-40		+85	°C	



MPU-6000/MPU-6050 Product Specification

Document Number: PS-MPU-6000A-00
 Revision: 3.4
 Release Date: 08/19/2013

6.4 Electrical Specifications, Continued

VDD = 2.375V-3.46V, VLOGIC (MPU-6050 only) = 1.8V±5% or VDD, T_A = 25°C

PARAMETER	CONDITIONS	MIN	TYP	MAX	Units	Notes
SERIAL INTERFACE						
SPI Operating Frequency, All Registers Read/Write	MPU-6000 only, Low Speed Characterization		100 ±10%		kHz	
	MPU-6000 only, High Speed Characterization		1 ±10%		MHz	
SPI Operating Frequency, Sensor and Interrupt Registers Read Only	MPU-6000 only		20 ±10%		MHz	
	All registers, Fast-mode			400	kHz	
I ² C Operating Frequency	All registers, Standard-mode			100	kHz	
I²C ADDRESS						
	AD0 = 0		1101000			
	AD0 = 1		1101001			
DIGITAL INPUTS (SDI/SDA, AD0, SCLK/SCL, FSYNC, /CS, CLKIN)						
V _{IH} , High Level Input Voltage	MPU-6000	0.7*VDD			V	
	MPU-6050	0.7*VLOGIC			V	
V _{IL} , Low Level Input Voltage	MPU-6000			0.3*VDD	V	
	MPU-6050			0.3*VLOGIC	V	
C _I , Input Capacitance			< 5		pF	
DIGITAL OUTPUT (SDO, INT)						
V _{OH} , High Level Output Voltage	R _{LOAD} =1MΩ; MPU-6000	0.9*VDD			V	
	R _{LOAD} =1MΩ; MPU-6050	0.9*VLOGIC			V	
V _{OL1} , LOW-Level Output Voltage	R _{LOAD} =1MΩ; MPU-6000			0.1*VDD	V	
	R _{LOAD} =1MΩ; MPU-6050			0.1*VLOGIC	V	
V _{OLINT1} , INT Low-Level Output Voltage	OPEN=1, 0.3mA sink Current			0.1	V	
Output Leakage Current	OPEN=1		100		nA	
t _{INT} , INT Pulse Width	LATCH_INT_EN=0		50		μs	



MPU-6000/MPU-6050 Product Specification

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6.5 Electrical Specifications, Continued

Typical Operating Circuit of Section 7.2, VDD = 2.375V-3.46V, VLOGIC (MPU-6050 only) = 1.8V±5% or VDD, TA = 25°C

Parameters	Conditions	Typical	Units	Notes	
Primary I²C I/O (SCL, SDA)					
V _{IL} , LOW-Level Input Voltage	MPU-6000	-0.5 to 0.3*VDD	V		
V _{IH} , HIGH-Level Input Voltage	MPU-6000	0.7*VDD to VDD + 0.5V	V		
V _{hys} , Hysteresis	MPU-6000	0.1*VDD	V		
V _{IL} , LOW Level Input Voltage	MPU-6050	-0.5V to 0.3*VLOGIC	V		
V _{IH} , HIGH-Level Input Voltage	MPU-6050	0.7*VLOGIC to VLOGIC + 0.5V	V		
V _{hys} , Hysteresis	MPU-6050	0.1*VLOGIC	V		
V _{OL1} , LOW-Level Output Voltage	3mA sink current	0 to 0.4	V		
I _{OL} , LOW-Level Output Current	V _{OL} = 0.4V	3	mA		
	V _{OL} = 0.6V	5	mA		
Output Leakage Current		100	nA		
t _{of} , Output Fall Time from V _{IHmax} to V _{ILmax}	C _b bus capacitance in pF	20+0.1C _b to 250	ns		
C _i , Capacitance for Each I/O pin		< 10	pF		
Auxiliary I²C I/O (AUX_CL, AUX_DA)					
V _{IL} , LOW-Level Input Voltage	MPU-6050: <i>AUX_VDDIO=0</i>	-0.5V to 0.3*VLOGIC	V		
V _{IH} , HIGH-Level Input Voltage		0.7*VLOGIC to VLOGIC + 0.5V	V		
V _{hys} , Hysteresis		0.1*VLOGIC	V		
V _{OL1} , LOW-Level Output Voltage		VLOGIC > 2V; 1mA sink current	0 to 0.4	V	
V _{OL3} , LOW-Level Output Voltage		VLOGIC < 2V; 1mA sink current	0 to 0.2*VLOGIC	V	
I _{OL} , LOW-Level Output Current		V _{OL} = 0.4V	1	mA	
		V _{OL} = 0.6V	1	mA	
Output Leakage Current			100	nA	
t _{of} , Output Fall Time from V _{IHmax} to V _{ILmax}		C _b bus capacitance in pF	20+0.1C _b to 250	ns	
C _i , Capacitance for Each I/O pin			< 10	pF	



MPU-6000/MPU-6050 Product Specification

Document Number: PS-MPU-6000A-00
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6.6 Electrical Specifications, Continued

Typical Operating Circuit of Section 7.2, VDD = 2.375V-3.46V, VLOGIC (MPU-6050 only) = 1.8V±5% or VDD, T_A = 25°C

Parameters	Conditions	Min	Typical	Max	Units	Notes
INTERNAL CLOCK SOURCE						
Gyroscope Sample Rate, Fast	CLK_SEL=0,1,2,3 DLPFCFG=0 SAMPLERATEDIV = 0		8		kHz	
Gyroscope Sample Rate, Slow	DLPFCFG=1,2,3,4,5, or 6 SAMPLERATEDIV = 0		1		kHz	
Accelerometer Sample Rate			1		kHz	
Clock Frequency Initial Tolerance	CLK_SEL=0, 25°C	-5		+5	%	
Frequency Variation over Temperature	CLK_SEL=1,2,3; 25°C	-1		+1	%	
	CLK_SEL=0		-15 to +10		%	
PLL Settling Time	CLK_SEL=1,2,3		±1		%	
	CLK_SEL=1,2,3		1	10	ms	
EXTERNAL 32.768kHz CLOCK						
External Clock Frequency	CLK_SEL=4		32.768		kHz	
External Clock Allowable Jitter	Cycle-to-cycle rms		1 to 2		µs	
Gyroscope Sample Rate, Fast	DLPFCFG=0 SAMPLERATEDIV = 0		8.192		kHz	
Gyroscope Sample Rate, Slow	DLPFCFG=1,2,3,4,5, or 6 SAMPLERATEDIV = 0		1.024		kHz	
Accelerometer Sample Rate			1.024		kHz	
PLL Settling Time			1	10	ms	
EXTERNAL 19.2MHz CLOCK						
External Clock Frequency	CLK_SEL=5		19.2		MHz	
Gyroscope Sample Rate	Full programmable range	3.9		8000	Hz	
Gyroscope Sample Rate, Fast Mode	DLPFCFG=0 SAMPLERATEDIV = 0		8		kHz	
Gyroscope Sample Rate, Slow Mode	DLPFCFG=1,2,3,4,5, or 6 SAMPLERATEDIV = 0		1		kHz	
Accelerometer Sample Rate			1		kHz	
PLL Settling Time			1	10	ms	

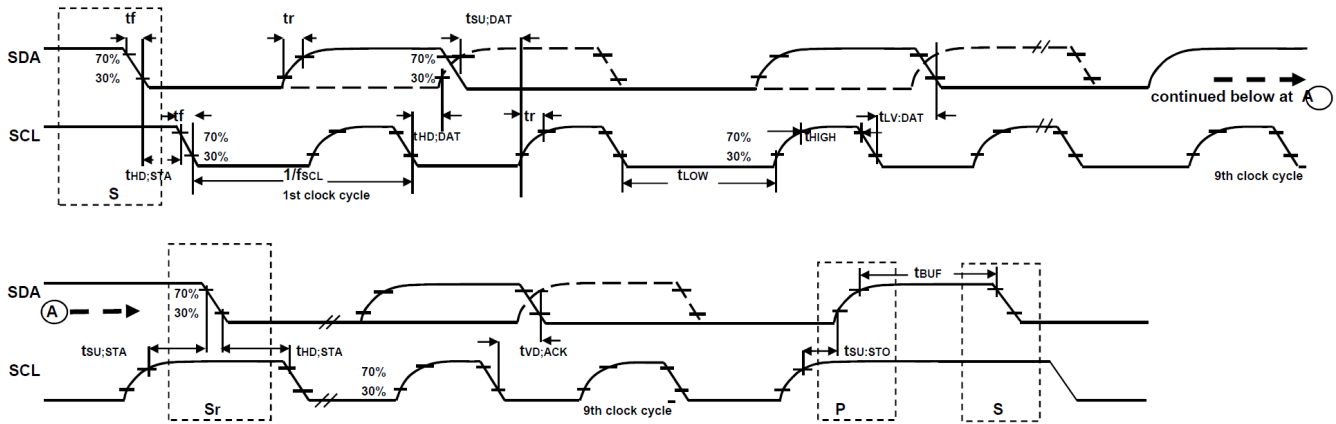


6.7 I²C Timing Characterization

Typical Operating Circuit of Section 7.2, VDD = 2.375V-3.46V, VLOGIC (MPU-6050 only) = 1.8V±5% or VDD, T_A = 25°C

Parameters	Conditions	Min	Typical	Max	Units	Notes
I²C TIMING						
f _{SCL} , SCL Clock Frequency	I ² C FAST-MODE			400	kHz	
t _{HD,STA} , (Repeated) START Condition Hold Time		0.6			µs	
t _{LOW} , SCL Low Period		1.3			µs	
t _{HIGH} , SCL High Period		0.6			µs	
t _{SU,STA} , Repeated START Condition Setup Time		0.6			µs	
t _{HD,DAT} , SDA Data Hold Time		0			µs	
t _{SU,DAT} , SDA Data Setup Time		100			ns	
t _r , SDA and SCL Rise Time	C _b bus cap. from 10 to 400pF	20+0.1C _b		300	ns	
t _f , SDA and SCL Fall Time	C _b bus cap. from 10 to 400pF	20+0.1C _b		300	ns	
t _{SU,STO} , STOP Condition Setup Time		0.6			µs	
t _{BUF} , Bus Free Time Between STOP and START Condition		1.3			µs	
C _b , Capacitive Load for each Bus Line			< 400		pF	
t _{VD,DAT} , Data Valid Time				0.9	µs	
t _{VD,ACK} , Data Valid Acknowledge Time				0.9	µs	

Note: Timing Characteristics apply to both Primary and Auxiliary I²C Bus



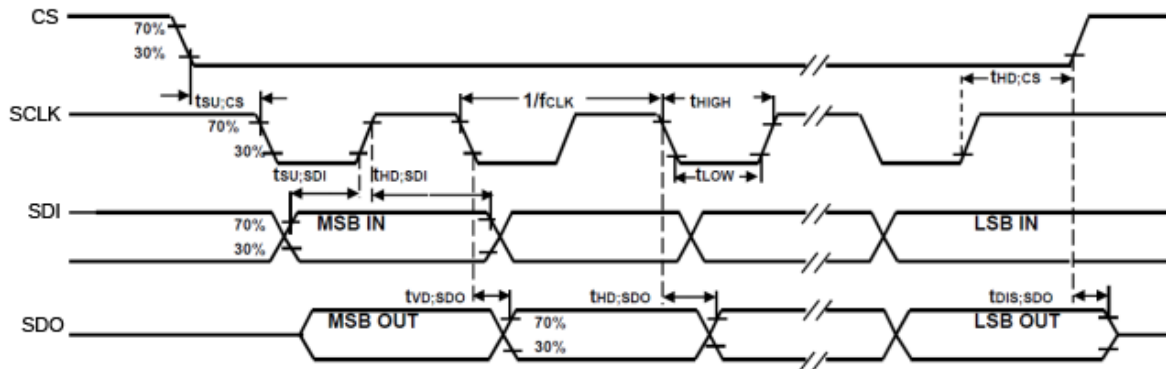
I²C Bus Timing Diagram



6.8 SPI Timing Characterization (MPU-6000 only)

Typical Operating Circuit of Section 7.2, VDD = 2.375V-3.46V, VLOGIC (MPU-6050 only) = 1.8V±5% or VDD, T_A = 25°C, unless otherwise noted.

Parameters	Conditions	Min	Typical	Max	Units	Notes
SPI TIMING						
f _{SCLK} , SCLK Clock Frequency				1	MHz	
t _{LOW} , SCLK Low Period		400			ns	
t _{HIGH} , SCLK High Period		400			ns	
t _{SU,CS} , CS Setup Time		8			ns	
t _{HD,CS} , CS Hold Time		500			ns	
t _{SU,SDI} , SDI Setup Time		11			ns	
t _{HD,SDI} , SDI Hold Time		7			ns	
t _{VD,SDO} , SDO Valid Time	C _{load} = 20pF			100	ns	
t _{HD,SDO} , SDO Hold Time	C _{load} = 20pF	4			ns	
t _{DIS,SDO} , SDO Output Disable Time				10	ns	



SPI Bus Timing Diagram



6.9 Absolute Maximum Ratings

Stress above those listed as “Absolute Maximum Ratings” may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these conditions is not implied. Exposure to the absolute maximum ratings conditions for extended periods may affect device reliability.

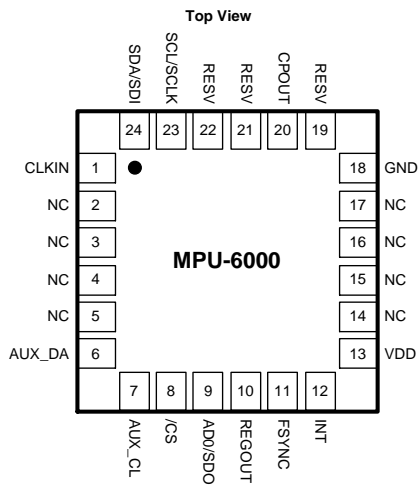
Parameter	Rating
Supply Voltage, VDD	-0.5V to +6V
VLOGIC Input Voltage Level (MPU-6050)	-0.5V to VDD + 0.5V
REGOUT	-0.5V to 2V
Input Voltage Level (CLKIN, AUX_DA, AD0, FSYNC, INT, SCL, SDA)	-0.5V to VDD + 0.5V
CPOUT (2.5V ≤ VDD ≤ 3.6V)	-0.5V to 30V
Acceleration (Any Axis, unpowered)	10,000g for 0.2ms
Operating Temperature Range	-40°C to +105°C
Storage Temperature Range	-40°C to +125°C
Electrostatic Discharge (ESD) Protection	2kV (HBM); 250V (MM)
Latch-up	JEDEC Class II (2), 125°C ±100mA



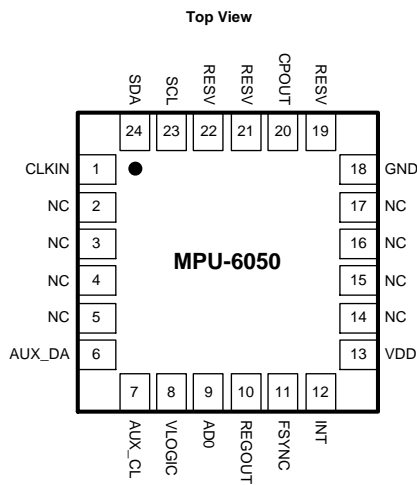
7 Applications Information

7.1 Pin Out and Signal Description

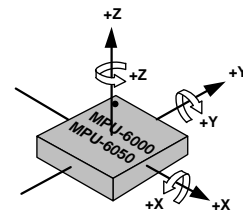
Pin Number	MPU-6000	MPU-6050	Pin Name	Pin Description
1	Y	Y	CLKIN	Optional external reference clock input. Connect to GND if unused.
6	Y	Y	AUX_DA	I ² C master serial data, for connecting to external sensors
7	Y	Y	AUX_CL	I ² C Master serial clock, for connecting to external sensors
8	Y		/CS	SPI chip select (0=SPI mode)
8		Y	VLOGIC	Digital I/O supply voltage
9	Y		AD0 / SDO	I ² C Slave Address LSB (AD0); SPI serial data output (SDO)
9		Y	AD0	I ² C Slave Address LSB (AD0)
10	Y	Y	REGOUT	Regulator filter capacitor connection
11	Y	Y	FSYNC	Frame synchronization digital input. Connect to GND if unused.
12	Y	Y	INT	Interrupt digital output (totem pole or open-drain)
13	Y	Y	VDD	Power supply voltage and Digital I/O supply voltage
18	Y	Y	GND	Power supply ground
19, 21	Y	Y	RESV	Reserved. Do not connect.
20	Y	Y	CPOUT	Charge pump capacitor connection
22	Y	Y	RESV	Reserved. Do not connect.
23	Y		SCL / SCLK	I ² C serial clock (SCL); SPI serial clock (SCLK)
23		Y	SCL	I ² C serial clock (SCL)
24	Y		SDA / SDI	I ² C serial data (SDA); SPI serial data input (SDI)
24		Y	SDA	I ² C serial data (SDA)
2, 3, 4, 5, 14, 15, 16, 17	Y	Y	NC	Not internally connected. May be used for PCB trace routing.



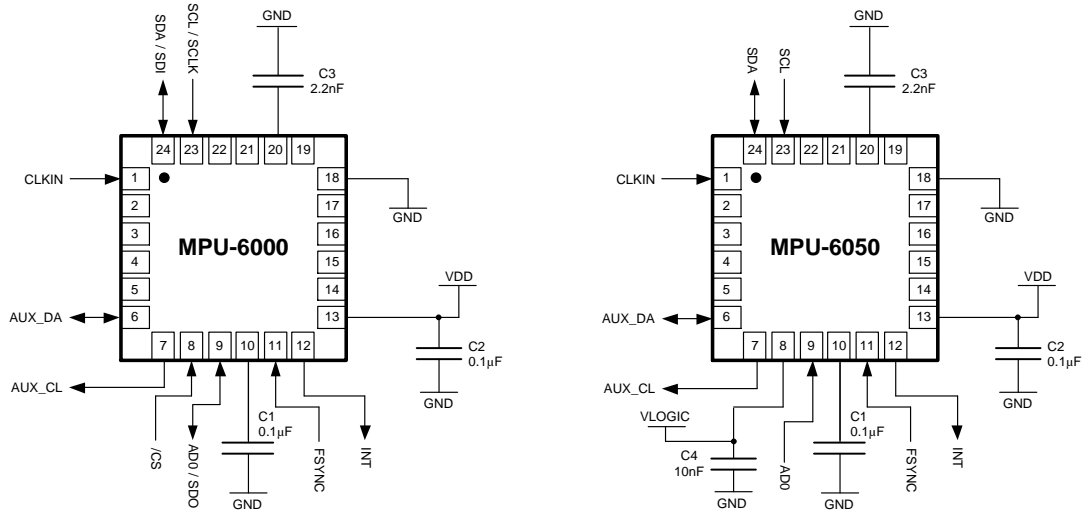
QFN Package
24-pin, 4mm x 4mm x 0.9mm



QFN Package
24-pin, 4mm x 4mm x 0.9mm

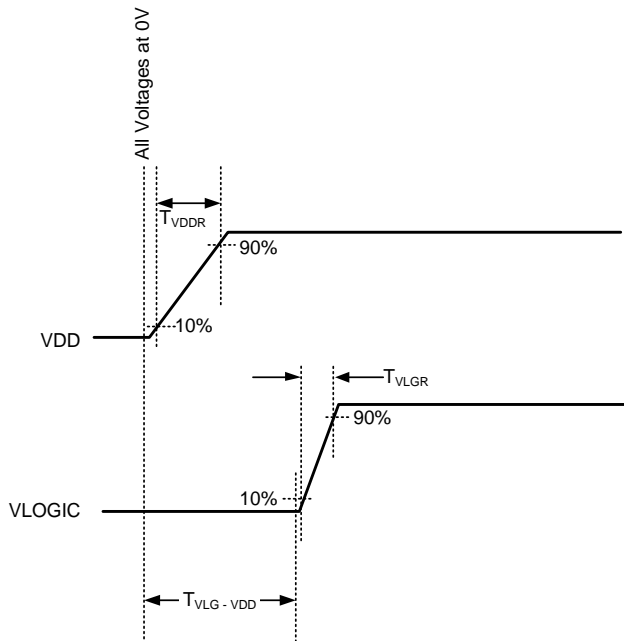


Orientation of Axes of Sensitivity and
Polarity of Rotation

7.2 Typical Operating Circuit

Typical Operating Circuits
7.3 Bill of Materials for External Components

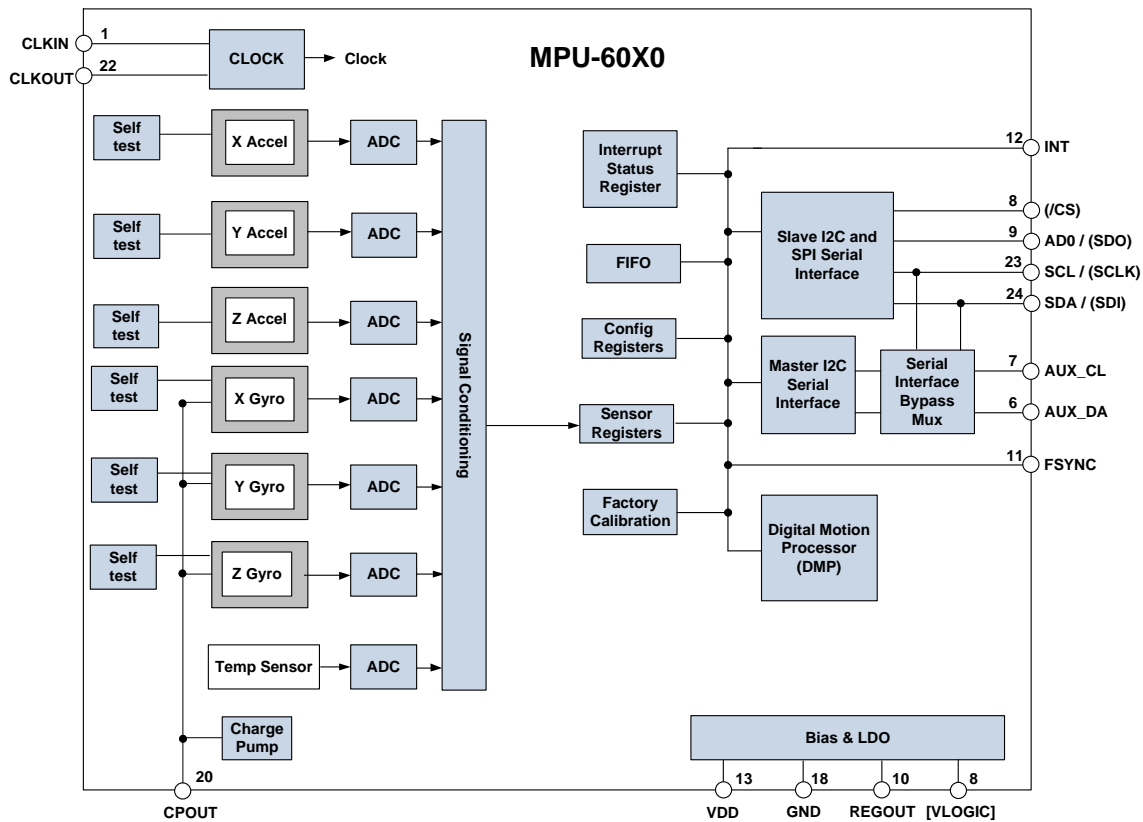
Component	Label	Specification	Quantity
Regulator Filter Capacitor (Pin 10)	C1	Ceramic, X7R, 0.1µF ±10%, 2V	1
VDD Bypass Capacitor (Pin 13)	C2	Ceramic, X7R, 0.1µF ±10%, 4V	1
Charge Pump Capacitor (Pin 20)	C3	Ceramic, X7R, 2.2nF ±10%, 50V	1
VLOGIC Bypass Capacitor (Pin 8)	C4*	Ceramic, X7R, 10nF ±10%, 4V	1

* MPU-6050 Only.

7.4 Recommended Power-on Procedure

Power-Up Sequencing

1. VLOGIC amplitude must always be $\leq VDD$ amplitude
2. T_{VDDR} is VDD rise time: Time for VDD to rise from 10% to 90% of its final value
3. T_{VDDR} is $\leq 100\text{ms}$
4. T_{VLGR} is VLOGIC rise time: Time for VLOGIC to rise from 10% to 90% of its final value
5. T_{VLGR} is $\leq 3\text{ms}$
6. $T_{VLG-VDD}$ is the delay from the start of VDD ramp to the start of VLOGIC rise
7. $T_{VLG-VDD}$ is ≥ 0
8. VDD and VLOGIC must be monotonic ramps

7.5 Block Diagram



Note: Pin names in round brackets () apply only to MPU-6000
 Pin names in square brackets [] apply only to MPU-6050

7.6 Overview

The MPU-60X0 is comprised of the following key blocks and functions:

- Three-axis MEMS rate gyroscope sensor with 16-bit ADCs and signal conditioning
- Three-axis MEMS accelerometer sensor with 16-bit ADCs and signal conditioning
- Digital Motion Processor (DMP) engine
- Primary I²C and SPI (MPU-6000 only) serial communications interfaces
- Auxiliary I²C serial interface for 3rd party magnetometer & other sensors
- Clocking
- Sensor Data Registers
- FIFO
- Interrupts
- Digital-Output Temperature Sensor
- Gyroscope & Accelerometer Self-test
- Bias and LDO
- Charge Pump



7.7 Three-Axis MEMS Gyroscope with 16-bit ADCs and Signal Conditioning

The MPU-60X0 consists of three independent vibratory MEMS rate gyroscopes, which detect rotation about the X-, Y-, and Z- Axes. When the gyros are rotated about any of the sense axes, the Coriolis Effect causes a vibration that is detected by a capacitive pickoff. The resulting signal is amplified, demodulated, and filtered to produce a voltage that is proportional to the angular rate. This voltage is digitized using individual on-chip 16-bit Analog-to-Digital Converters (ADCs) to sample each axis. The full-scale range of the gyro sensors may be digitally programmed to ± 250 , ± 500 , ± 1000 , or ± 2000 degrees per second (dps). The ADC sample rate is programmable from 8,000 samples per second, down to 3.9 samples per second, and user-selectable low-pass filters enable a wide range of cut-off frequencies.

7.8 Three-Axis MEMS Accelerometer with 16-bit ADCs and Signal Conditioning

The MPU-60X0's 3-Axis accelerometer uses separate proof masses for each axis. Acceleration along a particular axis induces displacement on the corresponding proof mass, and capacitive sensors detect the displacement differentially. The MPU-60X0's architecture reduces the accelerometers' susceptibility to fabrication variations as well as to thermal drift. When the device is placed on a flat surface, it will measure 0g on the X- and Y-axes and +1g on the Z-axis. The accelerometers' scale factor is calibrated at the factory and is nominally independent of supply voltage. Each sensor has a dedicated sigma-delta ADC for providing digital outputs. The full scale range of the digital output can be adjusted to $\pm 2g$, $\pm 4g$, $\pm 8g$, or $\pm 16g$.

7.9 Digital Motion Processor

The embedded Digital Motion Processor (DMP) is located within the MPU-60X0 and offloads computation of motion processing algorithms from the host processor. The DMP acquires data from accelerometers, gyroscopes, and additional 3rd party sensors such as magnetometers, and processes the data. The resulting data can be read from the DMP's registers, or can be buffered in a FIFO. The DMP has access to one of the MPU's external pins, which can be used for generating interrupts.

The purpose of the DMP is to offload both timing requirements and processing power from the host processor. Typically, motion processing algorithms should be run at a high rate, often around 200Hz, in order to provide accurate results with low latency. This is required even if the application updates at a much lower rate; for example, a low power user interface may update as slowly as 5Hz, but the motion processing should still run at 200Hz. The DMP can be used as a tool in order to minimize power, simplify timing, simplify the software architecture, and save valuable MIPS on the host processor for use in the application.

7.10 Primary I²C and SPI Serial Communications Interfaces

The MPU-60X0 communicates to a system processor using either a SPI (MPU-6000 only) or an I²C serial interface. The MPU-60X0 always acts as a slave when communicating to the system processor. The LSB of the of the I²C slave address is set by pin 9 (AD0).

The logic levels for communications between the MPU-60X0 and its master are as follows:

- MPU-6000: The logic level for communications with the master is set by the voltage on VDD
- MPU-6050: The logic level for communications with the master is set by the voltage on VLOGIC

For further information regarding the logic levels of the MPU-6050, please refer to Section 10.



7.11 Auxiliary I²C Serial Interface

The MPU-60X0 has an auxiliary I²C bus for communicating to an off-chip 3-Axis digital output magnetometer or other sensors. This bus has two operating modes:

- I²C Master Mode: The MPU-60X0 acts as a master to any external sensors connected to the auxiliary I²C bus
- Pass-Through Mode: The MPU-60X0 directly connects the primary and auxiliary I²C buses together, allowing the system processor to directly communicate with any external sensors.

Auxiliary I²C Bus Modes of Operation:

- I²C Master Mode: Allows the MPU-60X0 to directly access the data registers of external digital sensors, such as a magnetometer. In this mode, the MPU-60X0 directly obtains data from auxiliary sensors, allowing the on-chip DMP to generate sensor fusion data without intervention from the system applications processor.

For example, In I²C Master mode, the MPU-60X0 can be configured to perform burst reads, returning the following data from a magnetometer:

- X magnetometer data (2 bytes)
- Y magnetometer data (2 bytes)
- Z magnetometer data (2 bytes)

The I²C Master can be configured to read up to 24 bytes from up to 4 auxiliary sensors. A fifth sensor can be configured to work single byte read/write mode.

- Pass-Through Mode: Allows an external system processor to act as master and directly communicate to the external sensors connected to the auxiliary I²C bus pins (AUX_DA and AUX_CL). In this mode, the auxiliary I²C bus control logic (3rd party sensor interface block) of the MPU-60X0 is disabled, and the auxiliary I²C pins AUX_DA and AUX_CL (Pins 6 and 7) are connected to the main I²C bus (Pins 23 and 24) through analog switches.

Pass-Through Mode is useful for configuring the external sensors, or for keeping the MPU-60X0 in a low-power mode when only the external sensors are used.

In Pass-Through Mode the system processor can still access MPU-60X0 data through the I²C interface.

Auxiliary I²C Bus IO Logic Levels

- MPU-6000: The logic level of the auxiliary I²C bus is VDD
- MPU-6050: The logic level of the auxiliary I²C bus can be programmed to be either VDD or VLOGIC

For further information regarding the MPU-6050's logic levels, please refer to Section 10.2.



7.12 Self-Test

Please refer to the MPU-6000/MPU-6050 Register Map and Register Descriptions document for more details on self test.

Self-test allows for the testing of the mechanical and electrical portions of the sensors. The self-test for each measurement axis can be activated by means of the gyroscope and accelerometer self-test registers (registers 13 to 16).

When self-test is activated, the electronics cause the sensors to be actuated and produce an output signal. The output signal is used to observe the self-test response.

The self-test response is defined as follows:

$$\text{Self-test response} = \text{Sensor output with self-test enabled} - \text{Sensor output without self-test enabled}$$

The self-test response for each accelerometer axis is defined in the accelerometer specification table (Section 6.2), while that for each gyroscope axis is defined in the gyroscope specification table (Section 6.1).

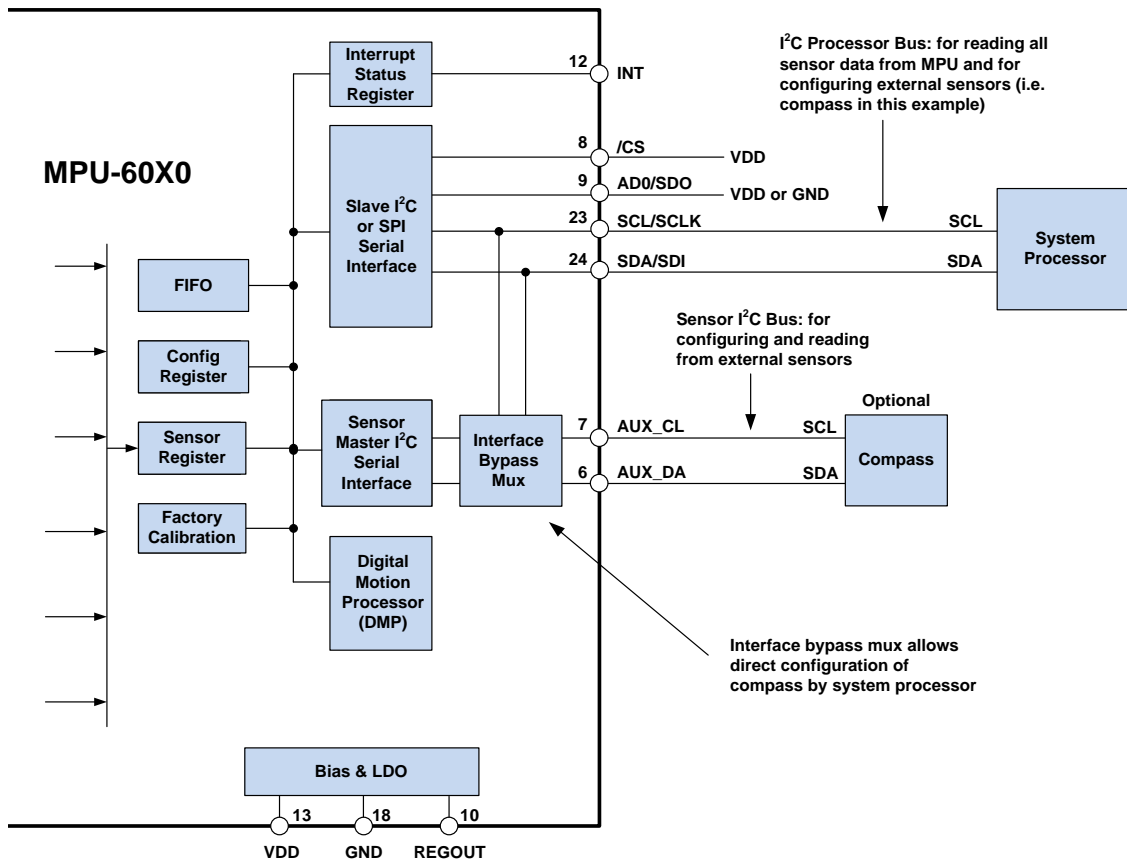
When the value of the self-test response is within the min/max limits of the product specification, the part has passed self test. When the self-test response exceeds the min/max values, the part is deemed to have failed self-test. Code for operating self test code is included within the MotionApps software provided by InvenSense.

7.13 MPU-60X0 Solution for 9-axis Sensor Fusion Using I²C Interface

In the figure below, the system processor is an I²C master to the MPU-60X0. In addition, the MPU-60X0 is an I²C master to the optional external compass sensor. The MPU-60X0 has limited capabilities as an I²C Master, and depends on the system processor to manage the initial configuration of any auxiliary sensors. The MPU-60X0 has an interface bypass multiplexer, which connects the system processor I²C bus pins 23 and 24 (SCL and SDA) directly to the auxiliary sensor I²C bus pins 6 and 7 (AUX_DA and AUX_CL).

Once the auxiliary sensors have been configured by the system processor, the interface bypass multiplexer should be disabled so that the MPU-60X0 auxiliary I²C master can take control of the sensor I²C bus and gather data from the auxiliary sensors.

For further information regarding I²C master control, please refer to Section 10.



7.14 MPU-6000 Using SPI Interface

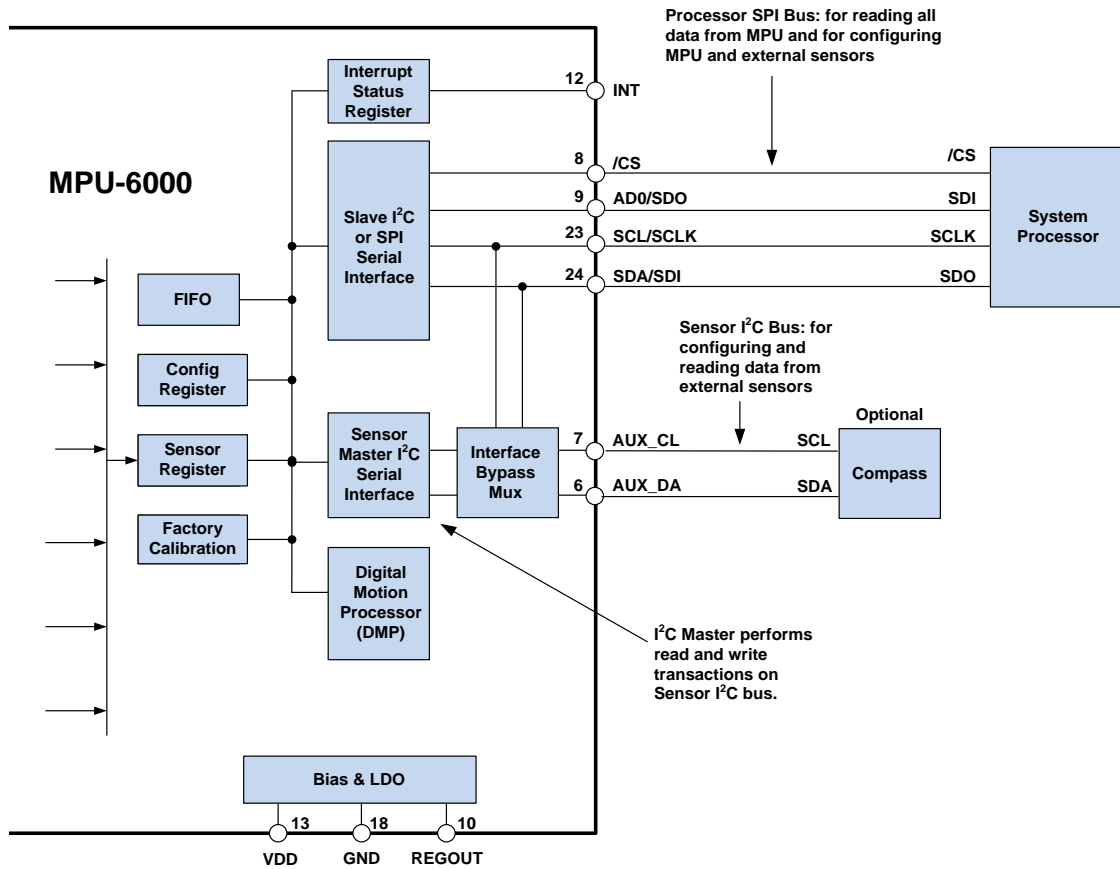
In the figure below, the system processor is an SPI master to the MPU-6000. Pins 8, 9, 23, and 24 are used to support the /CS, SDO, SCLK, and SDI signals for SPI communications. Because these SPI pins are shared with the I²C slave pins (9, 23 and 24), the system processor cannot access the auxiliary I²C bus through the interface bypass multiplexer, which connects the processor I²C interface pins to the sensor I²C interface pins.

Since the MPU-6000 has limited capabilities as an I²C Master, and depends on the system processor to manage the initial configuration of any auxiliary sensors, another method must be used for programming the sensors on the auxiliary sensor I²C bus pins 6 and 7 (AUX_DA and AUX_CL).

When using SPI communications between the MPU-6000 and the system processor, configuration of devices on the auxiliary I²C sensor bus can be achieved by using I²C Slaves 0-4 to perform read and write transactions on any device and register on the auxiliary I²C bus. The I²C Slave 4 interface can be used to perform only single byte read and write transactions.

Once the external sensors have been configured, the MPU-6000 can perform single or multi-byte reads using the sensor I²C bus. The read results from the Slave 0-3 controllers can be written to the FIFO buffer as well as to the external sensor registers.

For further information regarding the control of the MPU-60X0's auxiliary I²C interface, please refer to the MPU-6000/MPU-6050 Register Map and Register Descriptions document.





7.15 Internal Clock Generation

The MPU-60X0 has a flexible clocking scheme, allowing a variety of internal or external clock sources to be used for the internal synchronous circuitry. This synchronous circuitry includes the signal conditioning and ADCs, the DMP, and various control circuits and registers. An on-chip PLL provides flexibility in the allowable inputs for generating this clock.

Allowable internal sources for generating the internal clock are:

- An internal relaxation oscillator
- Any of the X, Y, or Z gyros (MEMS oscillators with a variation of $\pm 1\%$ over temperature)

Allowable external clocking sources are:

- 32.768kHz square wave
- 19.2MHz square wave

Selection of the source for generating the internal synchronous clock depends on the availability of external sources and the requirements for power consumption and clock accuracy. These requirements will most likely vary by mode of operation. For example, in one mode, where the biggest concern is power consumption, the user may wish to operate the Digital Motion Processor of the MPU-60X0 to process accelerometer data, while keeping the gyros off. In this case, the internal relaxation oscillator is a good clock choice. However, in another mode, where the gyros are active, selecting the gyros as the clock source provides for a more accurate clock source.

Clock accuracy is important, since timing errors directly affect the distance and angle calculations performed by the Digital Motion Processor (and by extension, by any processor).

There are also start-up conditions to consider. When the MPU-60X0 first starts up, the device uses its internal clock until programmed to operate from another source. This allows the user, for example, to wait for the MEMS oscillators to stabilize before they are selected as the clock source.

7.16 Sensor Data Registers

The sensor data registers contain the latest gyro, accelerometer, auxiliary sensor, and temperature measurement data. They are read-only registers, and are accessed via the serial interface. Data from these registers may be read anytime. However, the interrupt function may be used to determine when new data is available.

For a table of interrupt sources please refer to Section 8.

7.17 FIFO

The MPU-60X0 contains a 1024-byte FIFO register that is accessible via the Serial Interface. The FIFO configuration register determines which data is written into the FIFO. Possible choices include gyro data, accelerometer data, temperature readings, auxiliary sensor readings, and FSYNC input. A FIFO counter keeps track of how many bytes of valid data are contained in the FIFO. The FIFO register supports burst reads. The interrupt function may be used to determine when new data is available.

For further information regarding the FIFO, please refer to the MPU-6000/MPU-6050 Register Map and Register Descriptions document.

7.18 Interrupts

Interrupt functionality is configured via the Interrupt Configuration register. Items that are configurable include the INT pin configuration, the interrupt latching and clearing method, and triggers for the interrupt. Items that can trigger an interrupt are (1) Clock generator locked to new reference oscillator (used when switching clock



sources); (2) new data is available to be read (from the FIFO and Data registers); (3) accelerometer event interrupts; and (4) the MPU-60X0 did not receive an acknowledge from an auxiliary sensor on the secondary I²C bus. The interrupt status can be read from the Interrupt Status register.

For further information regarding interrupts, please refer to the MPU-60X0 Register Map and Register Descriptions document.

For information regarding the MPU-60X0's accelerometer event interrupts, please refer to Section 8.

7.19 Digital-Output Temperature Sensor

An on-chip temperature sensor and ADC are used to measure the MPU-60X0 die temperature. The readings from the ADC can be read from the FIFO or the Sensor Data registers.

7.20 Bias and LDO

The bias and LDO section generates the internal supply and the reference voltages and currents required by the MPU-60X0. Its two inputs are an unregulated VDD of 2.375 to 3.46V and a VLOGIC logic reference supply voltage of 1.71V to VDD (MPU-6050 only). The LDO output is bypassed by a capacitor at REGOUT. For further details on the capacitor, please refer to the Bill of Materials for External Components (Section 7.3).

7.21 Charge Pump

An on-board charge pump generates the high voltage required for the MEMS oscillators. Its output is bypassed by a capacitor at CPOUT. For further details on the capacitor, please refer to the Bill of Materials for External Components (Section 7.3).



8 Programmable Interrupts

The MPU-60X0 has a programmable interrupt system which can generate an interrupt signal on the INT pin. Status flags indicate the source of an interrupt. Interrupt sources may be enabled and disabled individually.

Table of Interrupt Sources

Interrupt Name	Module
FIFO Overflow	FIFO
Data Ready	Sensor Registers
I ² C Master errors: Lost Arbitration, NACKs	I ² C Master
I ² C Slave 4	I ² C Master

For information regarding the interrupt enable/disable registers and flag registers, please refer to the MPU-6000/MPU-6050 Register Map and Register Descriptions document. Some interrupt sources are explained below.



9 Digital Interface

9.1 I²C and SPI (MPU-6000 only) Serial Interfaces

The internal registers and memory of the MPU-6000/MPU-6050 can be accessed using either I²C at 400 kHz or SPI at 1MHz (MPU-6000 only). SPI operates in four-wire mode.

Serial Interface

Pin Number	MPU-6000	MPU-6050	Pin Name	Pin Description
8	Y		/CS	SPI chip select (0=SPI enable)
8		Y	VLOGIC	Digital I/O supply voltage. VLOGIC must be \leq VDD at all times.
9	Y		AD0 / SDO	I ² C Slave Address LSB (AD0); SPI serial data output (SDO)
9		Y	AD0	I ² C Slave Address LSB
23	Y		SCL / SCLK	I ² C serial clock (SCL); SPI serial clock (SCLK)
23		Y	SCL	I ² C serial clock
24	Y		SDA / SDI	I ² C serial data (SDA); SPI serial data input (SDI)
24		Y	SDA	I ² C serial data

Note:

To prevent switching into I²C mode when using SPI (MPU-6000), the I²C interface should be disabled by setting the *I2C_IF_DIS* configuration bit. Setting this bit should be performed immediately after waiting for the time specified by the "Start-Up Time for Register Read/Write" in Section 6.3.

For further information regarding the *I2C_IF_DIS* bit, please refer to the MPU-6000/MPU-6050 Register Map and Register Descriptions document.

9.2 I²C Interface

I²C is a two-wire interface comprised of the signals serial data (SDA) and serial clock (SCL). In general, the lines are open-drain and bi-directional. In a generalized I²C interface implementation, attached devices can be a master or a slave. The master device puts the slave address on the bus, and the slave device with the matching address acknowledges the master.

The MPU-60X0 always operates as a slave device when communicating to the system processor, which thus acts as the master. SDA and SCL lines typically need pull-up resistors to VDD. The maximum bus speed is 400 kHz.

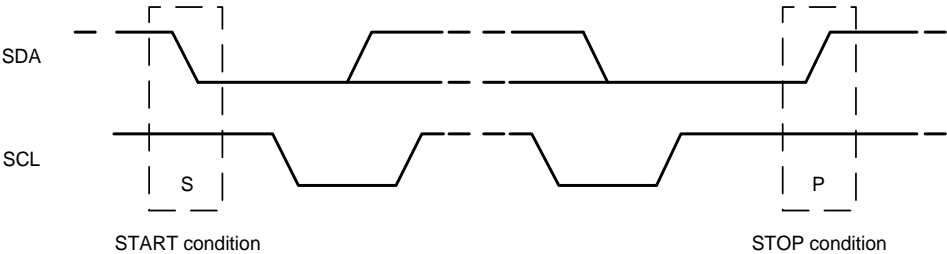
The slave address of the MPU-60X0 is b110100X which is 7 bits long. The LSB bit of the 7 bit address is determined by the logic level on pin AD0. This allows two MPU-60X0s to be connected to the same I²C bus. When used in this configuration, the address of the one of the devices should be b1101000 (pin AD0 is logic low) and the address of the other should be b1101001 (pin AD0 is logic high).

9.3 I²C Communications Protocol

START (S) and STOP (P) Conditions

Communication on the I²C bus starts when the master puts the START condition (S) on the bus, which is defined as a HIGH-to-LOW transition of the SDA line while SCL line is HIGH (see figure below). The bus is considered to be busy until the master puts a STOP condition (P) on the bus, which is defined as a LOW to HIGH transition on the SDA line while SCL is HIGH (see figure below).

Additionally, the bus remains busy if a repeated START (Sr) is generated instead of a STOP condition.

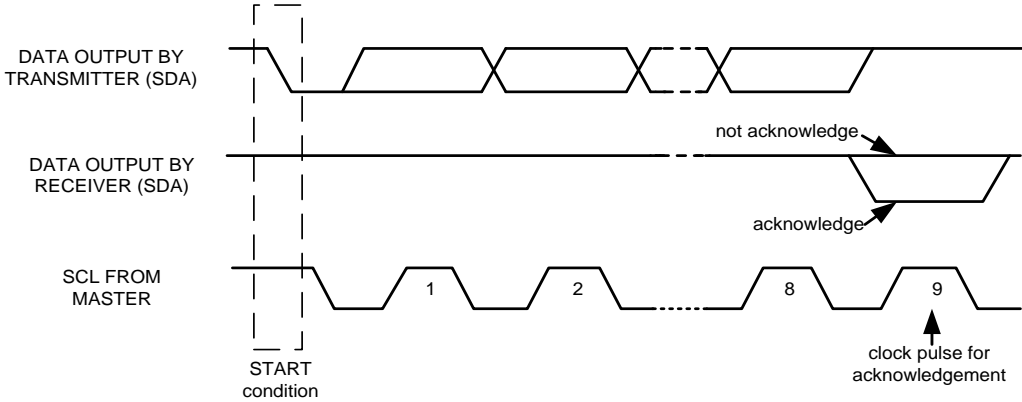


START and STOP Conditions

Data Format / Acknowledge

I²C data bytes are defined to be 8-bits long. There is no restriction to the number of bytes transmitted per data transfer. Each byte transferred must be followed by an acknowledge (ACK) signal. The clock for the acknowledge signal is generated by the master, while the receiver generates the actual acknowledge signal by pulling down SDA and holding it low during the HIGH portion of the acknowledge clock pulse.

If a slave is busy and cannot transmit or receive another byte of data until some other task has been performed, it can hold SCL LOW, thus forcing the master into a wait state. Normal data transfer resumes when the slave is ready, and releases the clock line (refer to the following figure).

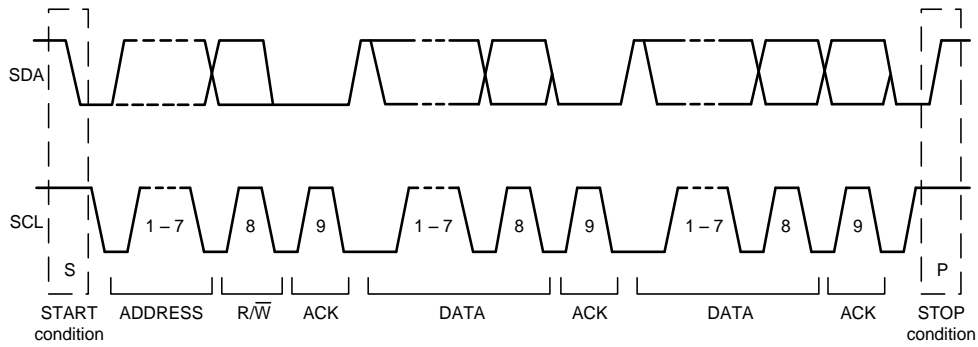


Acknowledge on the I²C Bus



Communications

After beginning communications with the START condition (S), the master sends a 7-bit slave address followed by an 8th bit, the read/write bit. The read/write bit indicates whether the master is receiving data from or is writing to the slave device. Then, the master releases the SDA line and waits for the acknowledge signal (ACK) from the slave device. Each byte transferred must be followed by an acknowledge bit. To acknowledge, the slave device pulls the SDA line LOW and keeps it LOW for the high period of the SCL line. Data transmission is always terminated by the master with a STOP condition (P), thus freeing the communications line. However, the master can generate a repeated START condition (Sr), and address another slave without first generating a STOP condition (P). A LOW to HIGH transition on the SDA line while SCL is HIGH defines the stop condition. All SDA changes should take place when SCL is low, with the exception of start and stop conditions.



Complete I²C Data Transfer

To write the internal MPU-60X0 registers, the master transmits the start condition (S), followed by the I²C address and the write bit (0). At the 9th clock cycle (when the clock is high), the MPU-60X0 acknowledges the transfer. Then the master puts the register address (RA) on the bus. After the MPU-60X0 acknowledges the reception of the register address, the master puts the register data onto the bus. This is followed by the ACK signal, and data transfer may be concluded by the stop condition (P). To write multiple bytes after the last ACK signal, the master can continue outputting data rather than transmitting a stop signal. In this case, the MPU-60X0 automatically increments the register address and loads the data to the appropriate register. The following figures show single and two-byte write sequences.

Single-Byte Write Sequence

Master	S	AD+W		RA		DATA		P
Slave			ACK		ACK		ACK	

Burst Write Sequence

Master	S	AD+W		RA		DATA		DATA		P
Slave			ACK		ACK		ACK		ACK	



To read the internal MPU-60X0 registers, the master sends a start condition, followed by the I²C address and a write bit, and then the register address that is going to be read. Upon receiving the ACK signal from the MPU-60X0, the master transmits a start signal followed by the slave address and read bit. As a result, the MPU-60X0 sends an ACK signal and the data. The communication ends with a not acknowledge (NACK) signal and a stop bit from master. The NACK condition is defined such that the SDA line remains high at the 9th clock cycle. The following figures show single and two-byte read sequences.

Single-Byte Read Sequence

Master	S	AD+W		RA		S	AD+R			NACK	P
Slave			ACK		ACK			ACK	DATA		

Burst Read Sequence

Master	S	AD+W		RA		S	AD+R			ACK		NACK	P
Slave			ACK		ACK			ACK	DATA		DATA		

9.4 I²C Terms

Signal	Description
S	Start Condition: SDA goes from high to low while SCL is high
AD	Slave I ² C address
W	Write bit (0)
R	Read bit (1)
ACK	Acknowledge: SDA line is low while the SCL line is high at the 9 th clock cycle
NACK	Not-Acknowledge: SDA line stays high at the 9 th clock cycle
RA	MPU-60X0 internal register address
DATA	Transmit or received data
P	Stop condition: SDA going from low to high while SCL is high

9.5 SPI Interface (MPU-6000 only)

SPI is a 4-wire synchronous serial interface that uses two control lines and two data lines. The MPU-6000 always operates as a Slave device during standard Master-Slave SPI operation.

With respect to the Master, the Serial Clock output (SCLK), the Serial Data Output (SDO) and the Serial Data Input (SDI) are shared among the Slave devices. Each SPI slave device requires its own Chip Select (/CS) line from the master.

/CS goes low (active) at the start of transmission and goes back high (inactive) at the end. Only one /CS line is active at a time, ensuring that only one slave is selected at any given time. The /CS lines of the non-selected slave devices are held high, causing their SDO lines to remain in a high-impedance (high-z) state so that they do not interfere with any active devices.

SPI Operational Features

1. Data is delivered MSB first and LSB last
2. Data is latched on the rising edge of SCLK
3. Data should be transitioned on the falling edge of SCLK
4. The maximum frequency of SCLK is 1MHz
5. SPI read and write operations are completed in 16 or more clock cycles (two or more bytes). The first byte contains the SPI Address, and the following byte(s) contain(s) the SPI data. The first bit of the first byte contains the Read/Write bit and indicates the Read (1) or Write (0) operation. The following 7 bits contain the Register Address. In cases of multiple-byte Read/Writes, data is two or more bytes:

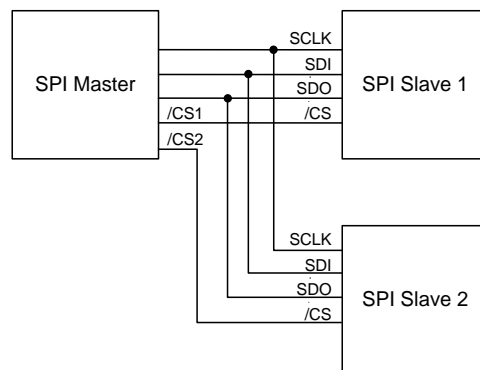
SPI Address format

MSB							LSB
R/W	A6	A5	A4	A3	A2	A1	A0

SPI Data format

MSB							LSB
D7	D6	D5	D4	D3	D2	D1	D0

6. Supports Single or Burst Read/Writes.



Typical SPI Master / Slave Configuration



10 Serial Interface Considerations (MPU-6050)

10.1 MPU-6050 Supported Interfaces

The MPU-6050 supports I²C communications on both its primary (microprocessor) serial interface and its auxiliary interface.

10.2 Logic Levels

The MPU-6050's I/O logic levels are set to be VLOGIC, as shown in the table below. AUX_VDDIO must be set to 0.

I/O Logic Levels vs. AUX_VDDIO

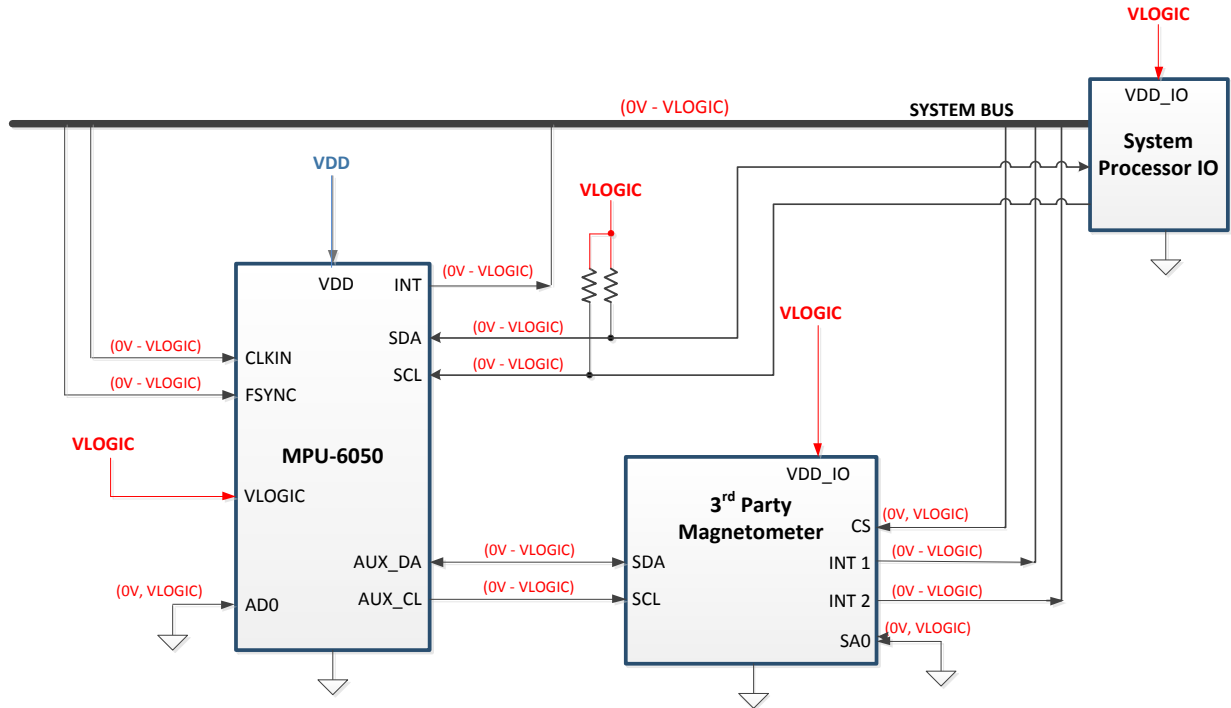
AUX_VDDIO	MICROPROCESSOR LOGIC LEVELS (Pins: SDA, SCL, AD0, CLKIN, INT)	AUXILLARY LOGIC LEVELS (Pins: AUX_DA, AUX_CL)
0	VLOGIC	VLOGIC

Note: The power-on-reset value for *AUX_VDDIO* is 0.

When *AUX_VDDIO* is set to 0 (its power-on-reset value), VLOGIC is the power supply voltage for both the microprocessor system bus and the auxiliary I²C bus, as shown in the figure of Section 10.3.

10.3 Logic Levels Diagram for AUX_VDDIO = 0

The figure below depicts a sample circuit with a third party magnetometer attached to the auxiliary I²C bus. It shows logic levels and voltage connections for AUX_VDDIO = 0. Note: Actual configuration will depend on the auxiliary sensors used.



I/O Levels and Connections for AUX_VDDIO = 0

Notes:

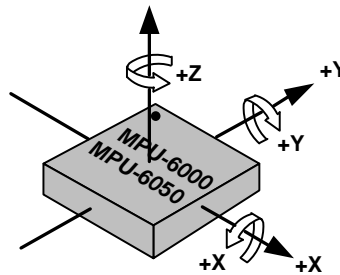
1. AUX_VDDIO determines the IO voltage levels of AUX_DA and AUX_CL (0 = set output levels relative to VLOGIC)
2. All other MPU-6050 logic IOs are referenced to VLOGIC.

11 Assembly

This section provides general guidelines for assembling InvenSense Micro Electro-Mechanical Systems (MEMS) gyros packaged in Quad Flat No leads package (QFN) surface mount integrated circuits.

11.1 Orientation of Axes

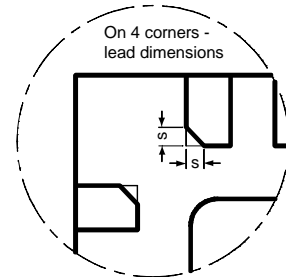
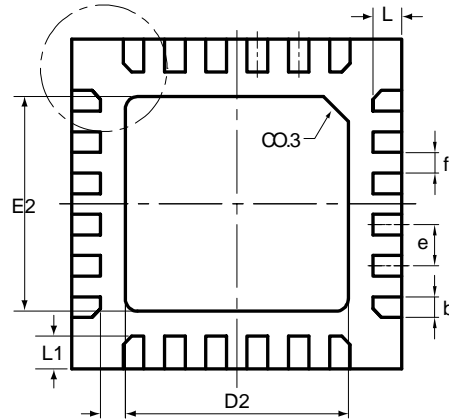
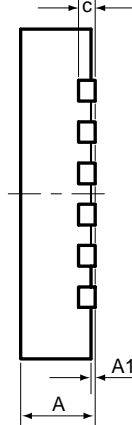
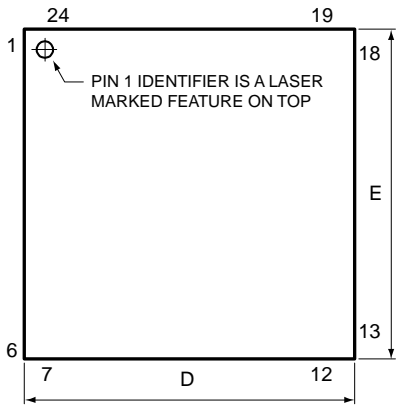
The diagram below shows the orientation of the axes of sensitivity and the polarity of rotation. Note the pin 1 identifier (•) in the figure.



Orientation of Axes of Sensitivity and
Polarity of Rotation

11.2 Package Dimensions

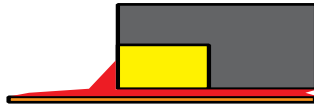
24 Lead QFN (4x4x0.9) mm NiPdAu Lead-frame finish



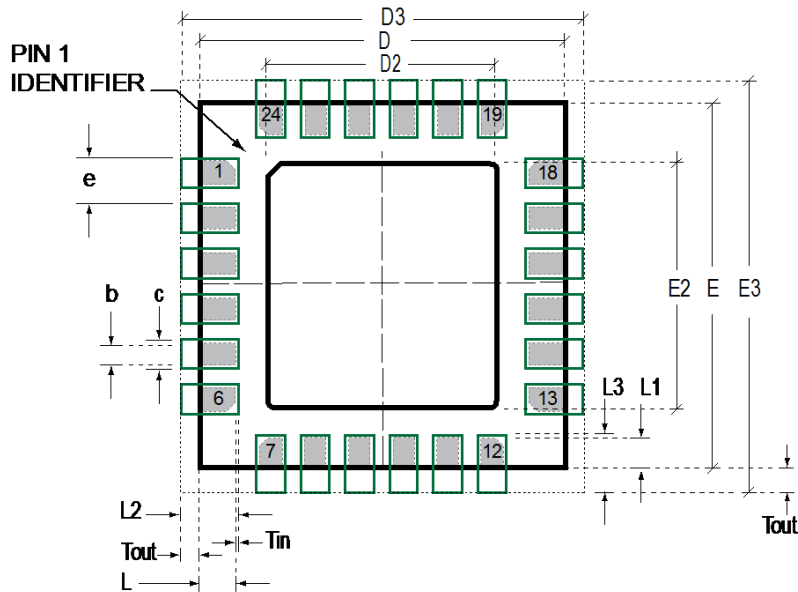
SYMBOLS	DIMENSIONS IN MILLIMETERS		
	MIN	NOM	MAX
A	0.85	0.90	0.95
A1	0.00	0.02	0.05
b	0.18	0.25	0.30
c	---	0.20 REF	---
D	3.90	4.00	4.10
D2	2.65	2.70	2.75
E	3.90	4.00	4.10
E2	2.55	2.60	2.65
e	---	0.50	---
f (e-b)	---	0.25	---
K	0.25	0.30	0.35
L	0.30	0.35	0.40
L1	0.35	0.40	0.45
s	0.05	---	0.15

11.3 PCB Design Guidelines

The Pad Diagram using a JEDEC type extension with solder rising on the outer edge is shown below. The Pad Dimensions Table shows pad sizing (mean dimensions) recommended for the MPU-60X0 product.



JEDEC type extension with solder rising on outer edge


PCB Layout Diagram

SYMBOLS	DIMENSIONS IN MILLIMETERS	NOM
Nominal Package I/O Pad Dimensions		
e	Pad Pitch	0.50
b	Pad Width	0.25
L	Pad Length	0.35
L1	Pad Length	0.40
D	Package Width	4.00
E	Package Length	4.00
D2	Exposed Pad Width	2.70
E2	Exposed Pad Length	2.60
I/O Land Design Dimensions (Guidelines)		
D3	I/O Pad Extent Width	4.80
E3	I/O Pad Extent Length	4.80
c	Land Width	0.35
Tout	Outward Extension	0.40
Tin	Inward Extension	0.05
L2	Land Length	0.80
L3	Land Length	0.85

PCB Dimensions Table (for PCB Lay-out Diagram)



11.4 Assembly Precautions

11.4.1 Gyroscope Surface Mount Guidelines

InvenSense MEMS Gyros sense rate of rotation. In addition, gyroscopes sense mechanical stress coming from the printed circuit board (PCB). This PCB stress can be minimized by adhering to certain design rules:

When using MEMS gyroscope components in plastic packages, PCB mounting and assembly can cause package stress. This package stress in turn can affect the output offset and its value over a wide range of temperatures. This stress is caused by the mismatch between the Coefficient of Linear Thermal Expansion (CTE) of the package material and the PCB. Care must be taken to avoid package stress due to mounting.

Traces connected to pads should be as symmetric as possible. Maximizing symmetry and balance for pad connection will help component self alignment and will lead to better control of solder paste reduction after reflow.

Any material used in the surface mount assembly process of the MEMS gyroscope should be free of restricted RoHS elements or compounds. Pb-free solders should be used for assembly.

11.4.2 Exposed Die Pad Precautions

The MPU-60X0 has very low active and standby current consumption. The exposed die pad is not required for heat sinking, and should not be soldered to the PCB. Failure to adhere to this rule can induce performance changes due to package thermo-mechanical stress. There is no electrical connection between the pad and the CMOS.

11.4.3 Trace Routing

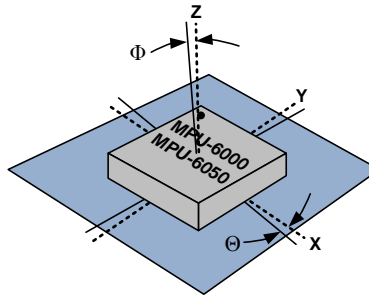
Routing traces or vias under the gyro package such that they run under the exposed die pad is prohibited. Routed active signals may harmonically couple with the gyro MEMS devices, compromising gyro response. These devices are designed with the drive frequencies as follows: X = $33\pm 3\text{KHz}$, Y = $30\pm 3\text{KHz}$, and Z = $27\pm 3\text{KHz}$. To avoid harmonic coupling don't route active signals in non-shielded signal planes directly below, or above the gyro package. Note: For best performance, design a ground plane under the e-pad to reduce PCB signal noise from the board on which the gyro device is mounted. If the gyro device is stacked under an adjacent PCB board, design a ground plane directly above the gyro device to shield active signals from the adjacent PCB board.

11.4.4 Component Placement

Do not place large insertion components such as keyboard or similar buttons, connectors, or shielding boxes at a distance of less than 6 mm from the MEMS gyro. Maintain generally accepted industry design practices for component placement near the MPU-60X0 to prevent noise coupling and thermo-mechanical stress.

11.4.5 PCB Mounting and Cross-Axis Sensitivity

Orientation errors of the gyroscope and accelerometer mounted to the printed circuit board can cause cross-axis sensitivity in which one gyro or accel responds to rotation or acceleration about another axis, respectively. For example, the X-axis gyroscope may respond to rotation about the Y or Z axes. The orientation mounting errors are illustrated in the figure below.



Package Gyro & Accel Axes (- - -) Relative to PCB Axes (———) with Orientation Errors (Θ and Φ)

The table below shows the cross-axis sensitivity as a percentage of the gyroscope or accelerometer's sensitivity for a given orientation error, respectively.

Cross-Axis Sensitivity vs. Orientation Error

Orientation Error (θ or Φ)	Cross-Axis Sensitivity ($\sin\theta$ or $\sin\Phi$)
0°	0%
0.5°	0.87%
1°	1.75%

The specifications for cross-axis sensitivity in Section 6.1 and Section 6.2 include the effect of the die orientation error with respect to the package.

11.4.6 MEMS Handling Instructions

MEMS (Micro Electro-Mechanical Systems) are a time-proven, robust technology used in hundreds of millions of consumer, automotive and industrial products. MEMS devices consist of microscopic moving mechanical structures. They differ from conventional IC products, even though they can be found in similar packages. Therefore, MEMS devices require different handling precautions than conventional ICs prior to mounting onto printed circuit boards (PCBs).

The MPU-60X0 has been qualified to a shock tolerance of 10,000g. InvenSense packages its gyroscopes as it deems proper for protection against normal handling and shipping. It recommends the following handling precautions to prevent potential damage.

- Do not drop individually packaged gyroscopes, or trays of gyroscopes onto hard surfaces. Components placed in trays could be subject to g-forces in excess of 10,000g if dropped.
- Printed circuit boards that incorporate mounted gyroscopes should not be separated by manually snapping apart. This could also create g-forces in excess of 10,000g.
- Do not clean MEMS gyroscopes in ultrasonic baths. Ultrasonic baths can induce MEMS damage if the bath energy causes excessive drive motion through resonant frequency coupling.

11.4.7 ESD Considerations

Establish and use ESD-safe handling precautions when unpacking and handling ESD-sensitive devices.

- Store ESD sensitive devices in ESD safe containers until ready for use. The Tape-and-Reel moisture-sealed bag is an ESD approved barrier. The best practice is to keep the units in the original moisture sealed bags until ready for assembly.

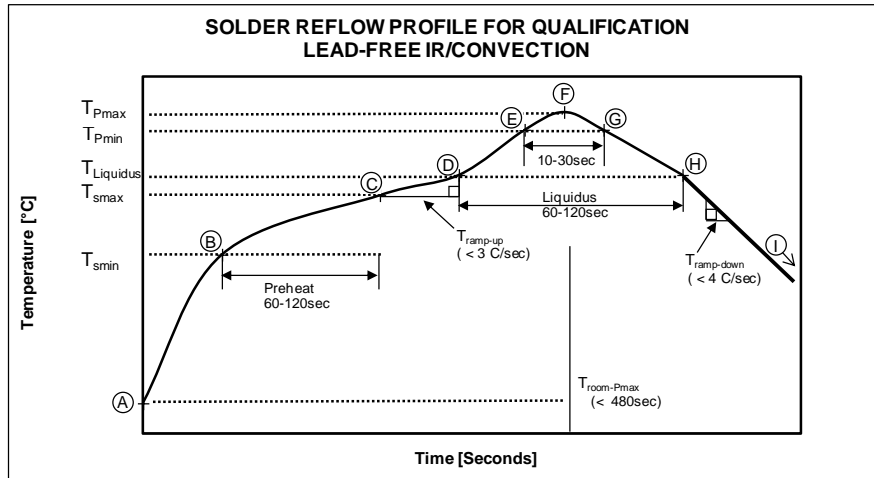
Restrict all device handling to ESD protected work areas that measure less than 200V static charge. Ensure that all workstations and personnel are properly grounded to prevent ESD.

11.4.8 Reflow Specification

Qualification Reflow: The MPU-60X0 was qualified in accordance with IPC/JEDEC J-STD-020D.1. This standard classifies proper packaging, storage and handling in order to avoid subsequent thermal and mechanical damage during the solder reflow attachment phase of PCB assembly.

The qualification preconditioning process specifies a sequence consisting of a bake cycle, a moisture soak cycle (in a temperature humidity oven), and three consecutive solder reflow cycles, followed by functional device testing.

The peak solder reflow classification temperature requirement for package qualification is (260 +5/-0°C) for lead-free soldering of components measuring less than 1.6 mm in thickness. The qualification profile and a table explaining the set-points are shown below:



Temperature Set Points Corresponding to Reflow Profile Above

Step	Setting	CONSTRAINTS		
		Temp (°C)	Time (sec)	Max. Rate (°C/sec)
A	T _{room}	25		
B	T _{Smin}	150		
C	T _{Smax}	200	60 < t _{EG} < 120	
D	T _{Liquidus}	217		r _(TLiquidus-TPmax) < 3
E	T _{Pmin} [255°C, 260°C]	255		r _(TLiquidus-TPmax) < 3
F	T _{Pmax} [260°C, 265°C]	260	t _{AF} < 480	r _(TLiquidus-TPmax) < 3
G	T _{Pmin} [255°C, 260°C]	255	10 < t _{EG} < 30	r _(TPmax-TLiquidus) < 4
H	T _{Liquidus}	217	60 < t _{DH} < 120	
I	T _{room}	25		

Notes: Customers must never exceed the Classification temperature (T_{Pmax} = 260°C).
 All temperatures refer to the topside of the QFN package, as measured on the package body surface.

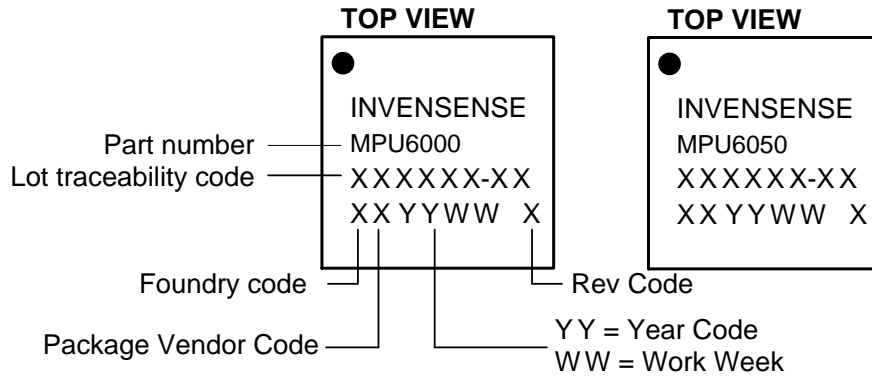
Production Reflow: Check the recommendations of your solder manufacturer. For optimum results, use lead-free solders that have lower specified temperature profiles (T_{Pmax} ~ 235°C). Also use lower ramp-up and ramp-down rates than those used in the qualification profile. Never exceed the maximum conditions that we used for qualification, as these represent the maximum tolerable ratings for the device.

11.5 Storage Specifications

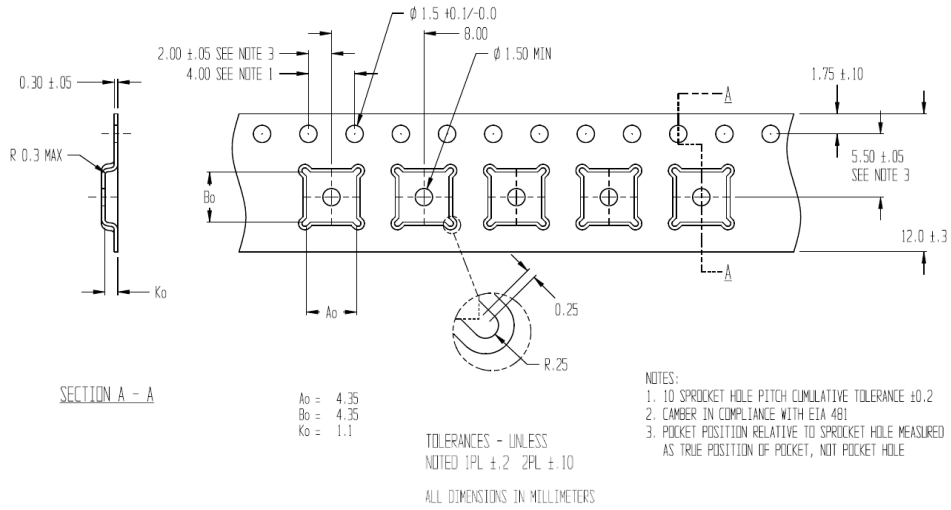
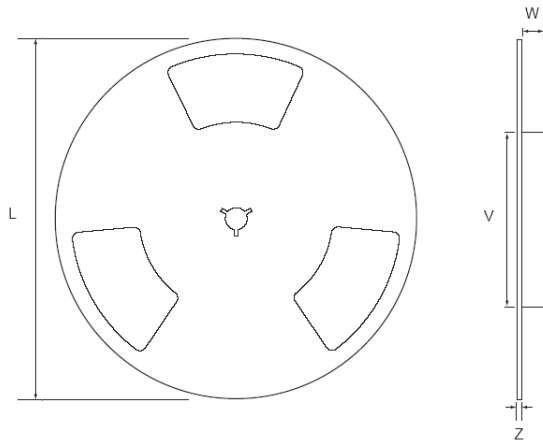
The storage specification of the MPU-60X0 conforms to IPC/JEDEC J-STD-020D.1 Moisture Sensitivity Level (MSL) 3.

Calculated shelf-life in moisture-sealed bag	12 months -- Storage conditions: <40°C and <90% RH
After opening moisture-sealed bag	168 hours -- Storage conditions: ambient ≤30°C at 60%RH

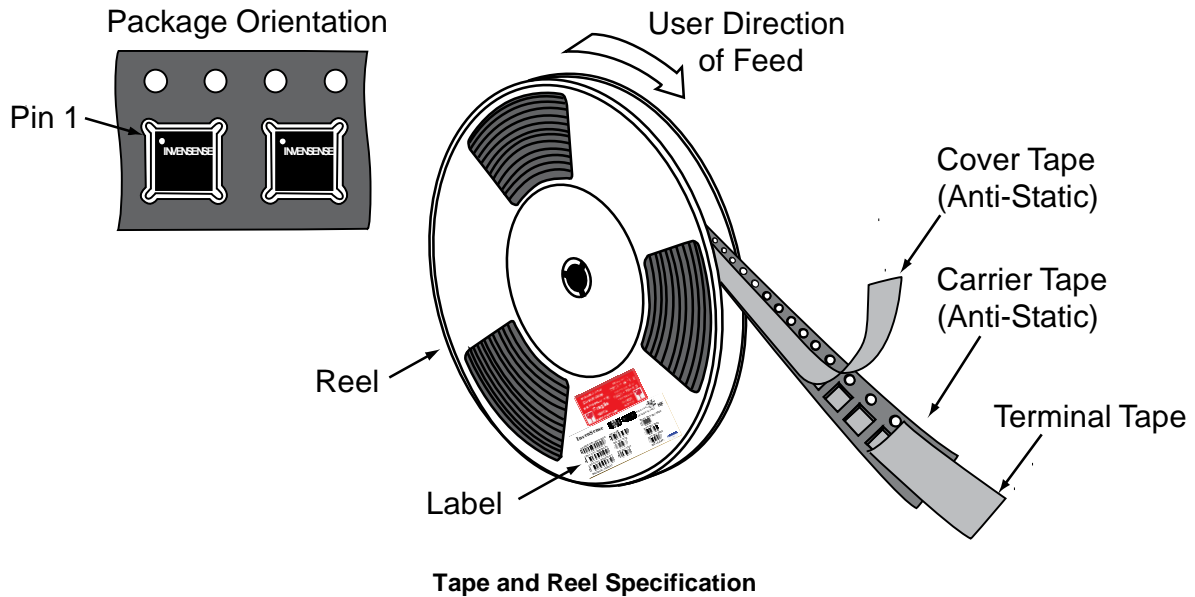
11.6 Package Marking Specification



Package Marking Specification

11.7 Tape & Reel Specification

Tape Dimensions

Reel Outline Drawing
Reel Dimensions and Package Size

PACKAGE SIZE	REEL (mm)			
	L	V	W	Z
4x4	330	102	12.8	2.3



Reel Specifications

Quantity Per Reel	5,000
Reels per Box	1
Boxes Per Carton (max)	5
Pcs/Carton (max)	25,000

11.8 Label



Barcode Label



Location of Label on Reel



11.9 Packaging



REEL – with Barcode & Caution labels



Vacuum-Sealed Moisture Barrier Bag with ESD, MSL3, Caution, and Barcode Labels



MSL3 Label



Caution Label



ESD Label



Inner Bubble Wrap



Pizza Box




























Pizza Boxes Placed in Foam-Lined Shipper Box



Outer Shipper Label

11.10 Representative Shipping Carton Label

 From: InvenSense Taiwan, Ltd. 1F, 9 Prosperity 1st Road, Hsinchu Science Park, HsinChu City, 30078, Taiwan TEL: +886 3 6686999 FAX: +886 3 6686777		INV. NO: 111013-99 Ship To: Customer Name Street Address City, State, Country ZIP Attn: Buyer Name Phone: Buyer Phone Number
SUPP PROD ID: MPU-6050 		
LOT#: Q2R994-F1 	LOT#: 	
QTY: 5615 	QTY: 0 	
LOT#: Q3X785-G1 	LOT#: 	
QTY: 4385 	QTY: 0 	
LOT#: Q3Y196-02 	LOT#: 	
QTY: 5000 	QTY: 0 	
LOT#: 	LOT#: 	
QTY: 0 	QTY: 0 	
Total Quantity/Carton 15000 	Weight: (KG) 4.05 	
Pb-free  Shipping Carton: Category (e4) HF MSL3  1 OF 3   		

	MPU-6000/MPU-6050 Product Specification	Document Number: PS-MPU-6000A-00 Revision: 3.4 Release Date: 08/19/2013
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12 Reliability

12.1 Qualification Test Policy

InvenSense's products complete a Qualification Test Plan before being released to production. The Qualification Test Plan for the MPU-60X0 followed the JESD47I Standards, "Stress-Test-Driven Qualification of Integrated Circuits," with the individual tests described below.

12.2 Qualification Test Plan

Accelerated Life Tests

TEST	Method/Condition	Lot Quantity	Sample / Lot	Acc / Reject Criteria
(HTOL/LFR) High Temperature Operating Life	JEDEC JESD22-A108D, Dynamic, 3.63V biased, T _j >125°C [read-points 168, 500, 1000 hours]	3	77	(0/1)
(HAST) Highly Accelerated Stress Test ⁽¹⁾	JEDEC JESD22-A118A Condition A, 130°C, 85%RH, 33.3 psia. unbiased, [read-point 96 hours]	3	77	(0/1)
(HTS) High Temperature Storage Life	JEDEC JESD22-A103D, Cond. A, 125°C Non-Bias Bake [read-points 168, 500, 1000 hours]	3	77	(0/1)

Device Component Level Tests

TEST	Method/Condition	Lot Quantity	Sample / Lot	Acc / Reject Criteria
(ESD-HBM) ESD-Human Body Model	JEDEC JS-001-2012, (2KV)	1	3	(0/1)
(ESD-MM) ESD-Machine Model	JEDEC JESD22-A115C, (250V)	1	3	(0/1)
(LU) Latch Up	JEDEC JESD-78D Class II (2), 125°C; ±100mA	1	6	(0/1)
(MS) Mechanical Shock	JEDEC JESD22-B104C, Mil-Std-883, Method 2002.5, Cond. E, 10,000g's, 0.2ms, ±X, Y, Z – 6 directions, 5 times/direction	3	5	(0/1)
(VIB) Vibration	JEDEC JESD22-B103B, Variable Frequency (random), Cond. B, 5-500Hz, X, Y, Z – 4 times/direction	3	5	(0/1)
(TC) Temperature Cycling ⁽¹⁾	JEDEC JESD22-A104D Condition G [-40°C to +125°C], Soak Mode 2 [5], 1000 cycles	3	77	(0/1)

Board Level Tests

TEST	Method/Condition	Lot Quantity	Sample / Lot	Acc / Reject Criteria
(BMS) Board Mechanical Shock	JEDEC JESD22-B104C, Mil-Std-883, Method 2002.5, Cond. E, 10000g's, 0.2ms, ±X, Y, Z – 6 directions, 5 times/direction	1	5	(0/1)
(BTC) Board Temperature Cycling ⁽¹⁾	JEDEC JESD22-A104D Condition G [-40°C to +125°C], Soak mode 2 [5], 1000 cycles	1	40	(0/1)

(1) Tests are preceded by MSL3 Preconditioning in accordance with JEDEC JESD22-A113F

	MPU-6000/MPU-6050 Product Specification	Document Number: PS-MPU-6000A-00 Revision: 3.4 Release Date: 08/19/2013
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13 Environmental Compliance

The MPU-6000/MPU-6050 is RoHS and Green compliant.

The MPU-6000/MPU-6050 is in full environmental compliance as evidenced in report HS-MPU-6000, Materials Declaration Data Sheet.

Environmental Declaration Disclaimer:

InvenSense believes this environmental information to be correct but cannot guarantee accuracy or completeness. Conformity documents for the above component constitutes are on file. InvenSense subcontracts manufacturing and the information contained herein is based on data received from vendors and suppliers, which has not been validated by InvenSense.

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Click [here](#) for production status of specific part numbers.

MAX30102

High-Sensitivity Pulse Oximeter and Heart-Rate Sensor for Wearable Health

General Description

The MAX30102 is an integrated pulse oximetry and heart-rate monitor module. It includes internal LEDs, photodetectors, optical elements, and low-noise electronics with ambient light rejection. The MAX30102 provides a complete system solution to ease the design-in process for mobile and wearable devices.

The MAX30102 operates on a single 1.8V power supply and a separate 3.3V power supply for the internal LEDs. Communication is through a standard I²C-compatible interface. The module can be shut down through software with zero standby current, allowing the power rails to remain powered at all times.

Applications

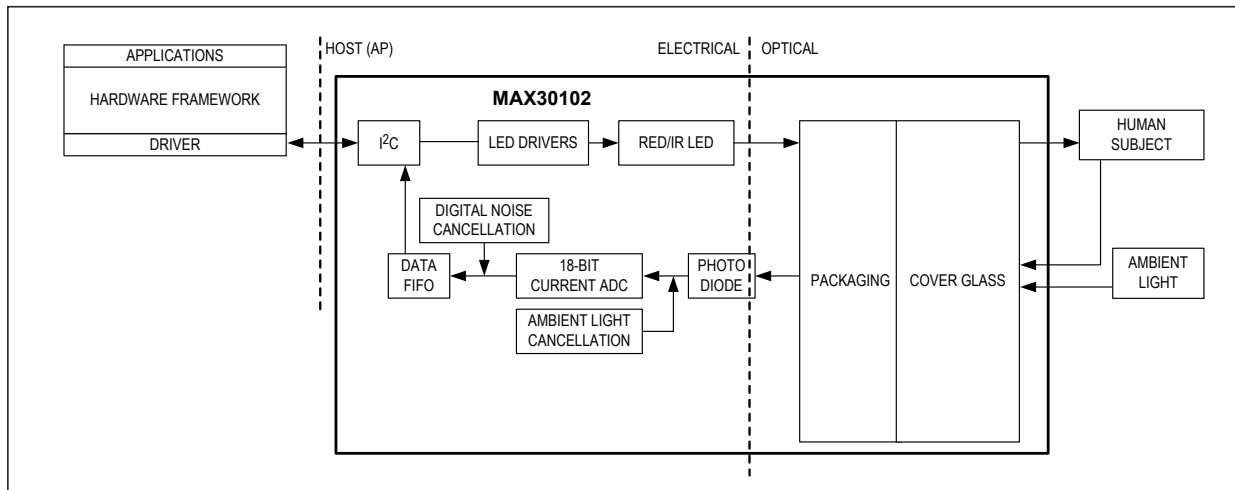
- Wearable Devices
- Fitness Assistant Devices
- Smartphones
- Tablets

Benefits and Features

- Heart-Rate Monitor and Pulse Oximeter Sensor in LED Reflective Solution
- Tiny 5.6mm x 3.3mm x 1.55mm 14-Pin Optical Module
 - Integrated Cover Glass for Optimal, Robust Performance
- Ultra-Low Power Operation for Mobile Devices
 - Programmable Sample Rate and LED Current for Power Savings
 - Low-Power Heart-Rate Monitor (< 1mW)
 - Ultra-Low Shutdown Current (0.7 μ A, typ)
- Fast Data Output Capability
 - High Sample Rates
- Robust Motion Artifact Resilience
 - High SNR
- -40°C to +85°C Operating Temperature Range

[Ordering Information](#) appears at end of data sheet.

System Diagram



Absolute Maximum Ratings

V _{DD} to GND	-0.3V to +2.2V	Continuous Power Dissipation (T _A = +70°C)	
GND to PGND	-0.3V to +0.3V	OESIP (derate 5.5mW/°C above +70°C)	440mW
V _{LED+} to PGND.....	-0.3V to +6.0V	Operating Temperature Range.....	-40°C to +85°C
All Other Pins to GND	-0.3V to +6.0V	Junction Temperature	+90°C
Output Short-Circuit Current Duration	Continuous	Soldering Temperature (reflow)	+260°C
Continuous Input Current into Any Terminal	±20mA	Storage Temperature Range	-40°C to +105°C
ESD, Human Body Model (HBM).....	2.5kV		
Latchup Immunity	±250mA		

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only; functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Package Information

PACKAGE TYPE: 14 OESIP	
Package Code	F143A5MK+1
Outline Number	21-1048
Land Pattern Number	90-0602
THERMAL RESISTANCE, FOUR-LAYER BOARD	
Junction to Ambient (θ _{JA})	180°C/W
Junction to Case (θ _{JC})	150°C/W

Package thermal resistances were obtained using the method described in JEDEC specification JESD51-7, using a four-layer board. For detailed information on package thermal considerations, refer to www.maximintegrated.com/thermal-tutorial.

For the latest package outline information and land patterns (footprints), go to www.maximintegrated.com/packages. Note that a "+", "#", or "-" in the package code indicates RoHS status only. Package drawings may show a different suffix character, but the drawing pertains to the package regardless of RoHS status.

Electrical Characteristics

(V_{DD} = 1.8V, V_{LED+} = 5.0V, T_A = -40°C to +85°C, unless otherwise noted. Typical values are at T_A = +25°C) (Note 1)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
POWER SUPPLY						
Power-Supply Voltage	V _{DD}	Guaranteed by RED and IR count tolerance	1.7	1.8	2.0	V
LED Supply Voltage V _{LED+} to PGND	V _{LED+}	Guaranteed by PSRR of LED driver	3.1	3.3	5.0	V
Supply Current	I _{DD}	SpO ₂ and HR mode, PW = 215µs, 50sps		600	1200	µA
		IR only mode, PW = 215µs, 50sps		600	1200	
Supply Current in Shutdown	I _{SHDN}	T _A = +25°C, MODE = 0x80		0.7	10	µA

Electrical Characteristics (continued)(V_{DD} = 1.8V, V_{LED+} = 5.0V, T_A = -40°C to +85°C, unless otherwise noted. Typical values are at T_A = +25°C) (Note 1)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
PULSE OXIMETRY/HEART-RATE SENSOR CHARACTERISTICS						
ADC Resolution				18		bits
Red ADC Count (Note 2)	REDC	LED1_PA = 0x0C, LED_PW = 0x01, SPO2_SR = 0x05, ADC_RGE = 0x00		65536		Counts
IR ADC Count (Note 2)	IRC	LED2_PA = 0x0C, LED_PW = 0x01, SPO2_SR = 0x05 ADC_RGE = 0x00		65536		Counts
Dark Current Count	LED_DCC	LED1_PA = LED2_PA = 0x00, LED_PW = 0x03, SPO2_SR = 0x01 ADC_RGE = 0x02		30	128	Counts
				0.01	0.05	% of FS
DC Ambient Light Rejection	ALR	ADC counts with finger on sensor under direct sunlight (100K lux), ADC_RGE = 0x3, LED_PW = 0x03, SPO2_SR = 0x01	Red LED	2		Counts
			IR LED	2		Counts
ADC Count—PSRR (V _{DD})	PSRR _{VDD}	1.7V < V _{DD} < 2.0V, LED_PW = 0x01, SPO2_SR = 0x05		0.25	1	% of FS
		Frequency = DC to 100kHz, 100mV _{p,p}		10		LSB
ADC Count—PSRR (LED Driver Outputs)	PSRR _{LED}	3.1V < V _{LED+} , < 5.0V, LED1_PA = LED2_PA = 0x0C, LED_PW = 0x01, SPO2_SR = 0x05		0.05	1	% of FS
		Frequency = DC to 100kHz, 100mV _{p,p}		10		LSB
ADC Clock Frequency	CLK		10.32	10.48	10.64	MHz
ADC Integration Time	INT	LED_PW = 0x00		69		μs
		LED_PW = 0x01		118		
		LED_PW = 0x02		215		
		LED_PW = 0x03		411		
Slot Timing (Timing Between Sequential Channel Samples; e.g., Red Pulse Rising Edge To IR Pulse Rising Edge)	INT	LED_PW = 0x00		427.1		μs
		LED_PW = 0x01		524.7		
		LED_PW = 0x02		720.0		
		LED_PW = 0x03		1106.6		
COVER GLASS CHARACTERISTICS (Note 3)						
Hydrolytic Resistance Class		Per DIN ISO 719		HGB 1		

Electrical Characteristics (continued)(V_{DD} = 1.8V, V_{LED+} = 5.0V, T_A = -40°C to +85°C, unless otherwise noted. Typical values are at T_A = +25°C) (Note 1)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
IR LED CHARACTERISTICS (Note 3)						
LED Peak Wavelength	λ_P	I _{LED} = 20mA, T _A = +25°C	870	880	900	nm
Full Width at Half Max	$\Delta\lambda$	I _{LED} = 20mA, T _A = +25°C		30		nm
Forward Voltage	V _F	I _{LED} = 20mA, T _A = +25°C		1.4		V
Radiant Power	P _O	I _{LED} = 20mA, T _A = +25°C		6.5		mW
RED LED CHARACTERISTICS (Note 3)						
LED Peak Wavelength	λ_P	I _{LED} = 20mA, T _A = +25°C	650	660	670	nm
Full Width at Half Max	$\Delta\lambda$	I _{LED} = 20mA, T _A = +25°C		20		nm
Forward Voltage	V _F	I _{LED} = 20mA, T _A = +25°C		2.1		V
Radiant Power	P _O	I _{LED} = 20mA, T _A = +25°C		9.8		mW
PHOTODETECTOR CHARACTERISTICS (Note 3)						
Spectral Range of Sensitivity	λ (QE > 50%)	QE: Quantum Efficiency	600		900	nm
Radiant Sensitive Area	A			1.36		mm ²
Dimensions of Radiant Sensitive Area	L x W			1.38 x 0.98		mm x mm
INTERNAL DIE TEMPERATURE SENSOR						
Temperature ADC Acquisition Time	T _T	T _A = +25°C		29		ms
Temperature Sensor Accuracy	T _A	T _A = +25°C		±1		°C
Temperature Sensor Minimum Range	T _{MIN}			-40		°C
Temperature Sensor Maximum Range	T _{MAX}			85		°C
DIGITAL INPUT CHARACTERISTICS: SCL, SDA						
Input High Voltage	V _{IH}	V _{DD} = 2V	0.7 x V _{DD}			V
Input Low Voltage	V _{IL}	V _{DD} = 2V			0.3 x V _{DD}	V
Hysteresis Voltage	V _H			0.2		V
Input Leakage Current	I _{IN}	V _{IN} = GND or V _{DD} (STATIC)		±0.05	±1	µA
DIGITAL OUTPUT CHARACTERISTICS: SDA, INT̄						
Output Low Voltage	V _{OL}	I _{SINK} = 6mA			0.2	V

Electrical Characteristics (continued)

($V_{DD} = 1.8V$, $V_{LED+} = 5.0V$, $T_A = -40^{\circ}C$ to $+85^{\circ}C$, unless otherwise noted. Typical values are at $T_A = +25^{\circ}C$) (Note 1)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
I²C TIMING CHARACTERISTICS (SDA, SDA, \overline{INT}) (Note 3)						
I ² C Write Address				AE		Hex
I ² C Read Address				AF		Hex
Serial Clock Frequency	f_{SCL}		0		400	kHz
Bus Free Time Between STOP and START Conditions	t_{BUF}		1.3			μs
Hold Time (Repeated) START Condition	$t_{HD,STA}$		0.6			μs
SCL Pulse-Width Low	t_{LOW}		1.3			μs
SCL Pulse-Width High	t_{HIGH}		0.6			μs
Setup Time for a Repeated START Condition	$t_{SU,STA}$		0.6			μs
Data Hold Time	$t_{HD,DAT}$		0		900	ns
Data Setup Time	$t_{SU,DAT}$		100			ns
Setup Time for STOP Condition	$t_{SU,STO}$		0.6			μs
Pulse Width of Suppressed Spike	t_{SP}		0		50	ns
Bus Capacitance	C_B				400	pF
SDA and SCL Receiving Rise Time	t_R		$20 + 0.1C_B$		300	ns
SDA and SCL Receiving Fall Time	t_{RF}		$20 + 0.1C_B$		300	ns
SDA Transmitting Fall Time	t_{TF}				300	ns

Note 1: All devices are 100% production tested at $T_A = +25^{\circ}C$. Specifications over temperature limits are guaranteed by Maxim Integrated's bench or proprietary automated test equipment (ATE) characterization.

Note 2: Specifications are guaranteed by Maxim Integrated's bench characterization and by 100% production test using proprietary ATE setup and conditions.

Note 3: Guaranteed by design and characterization. Not tested in final production.

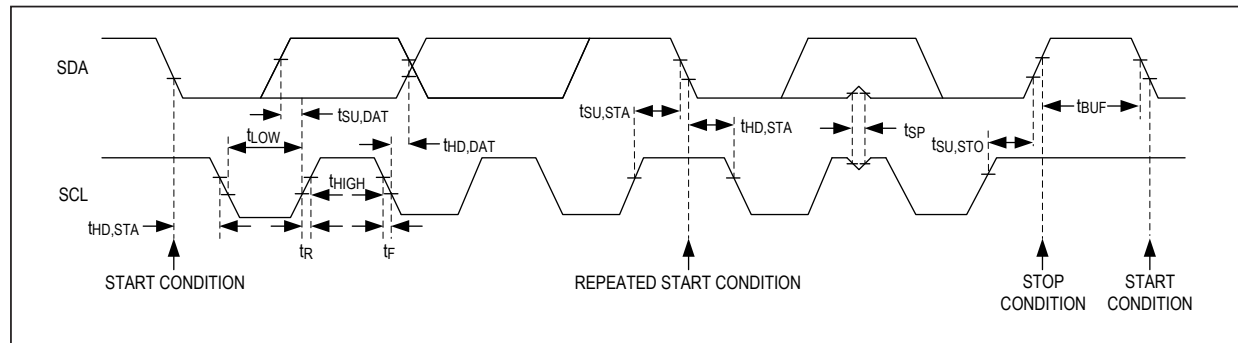
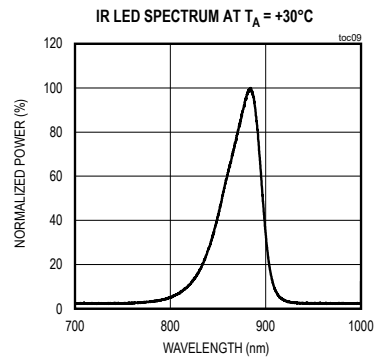
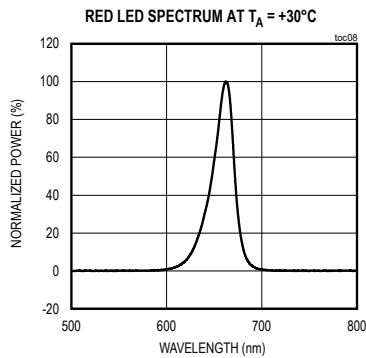
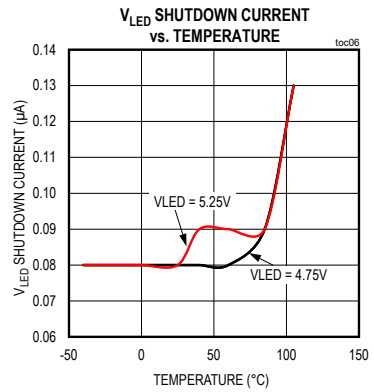
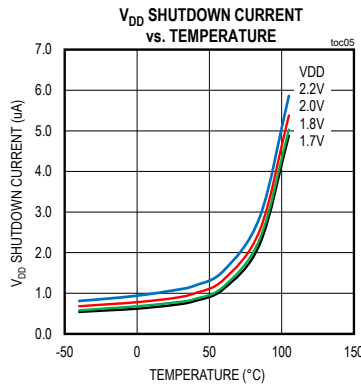
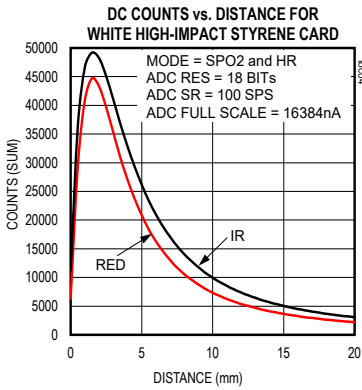
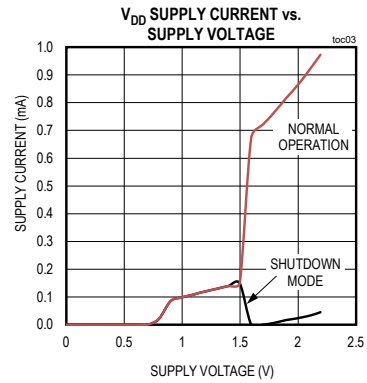
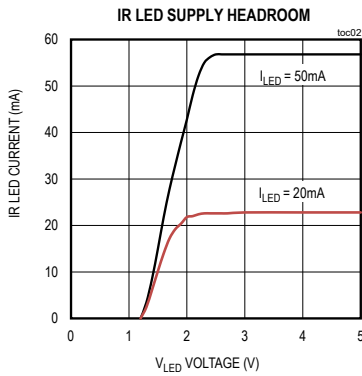
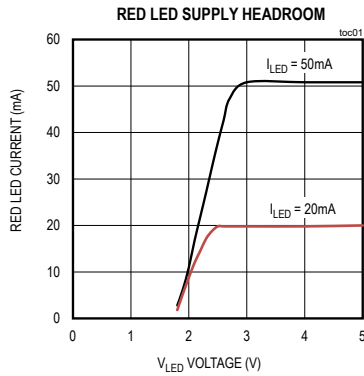


Figure 1. I²C-Compatible Interface Timing Diagram

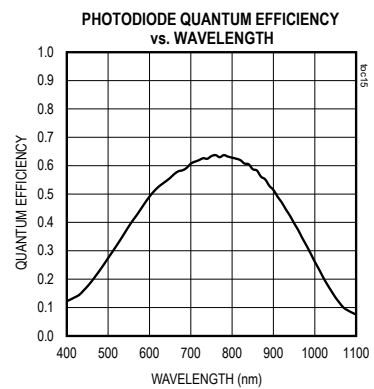
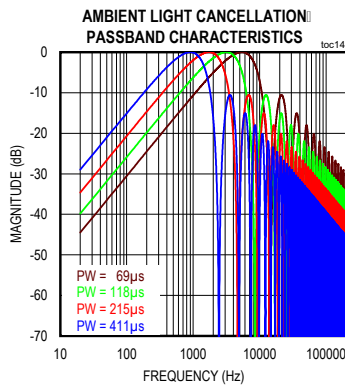
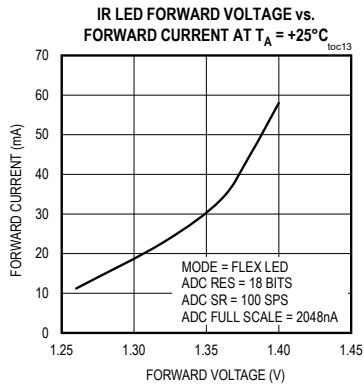
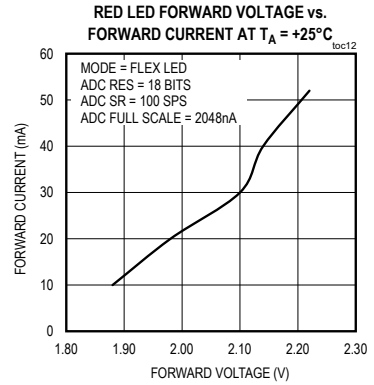
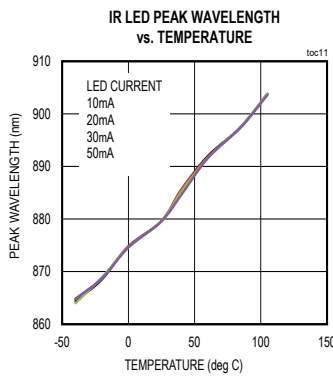
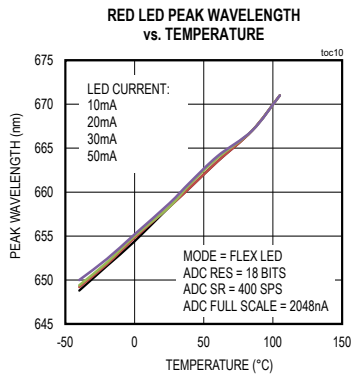
Typical Operating Characteristics

($V_{DD} = 1.8V$, $V_{LED+} = 5.0V$, $T_A = +25^{\circ}C$, \overline{RST} , unless otherwise noted.)

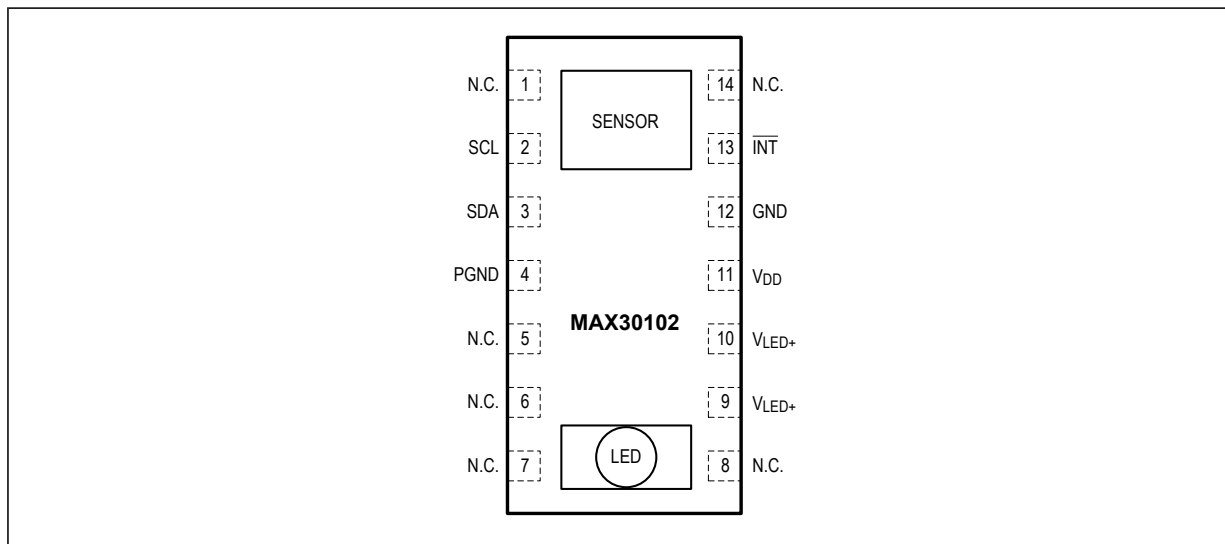


Typical Operating Characteristics (continued)

($V_{DD} = 1.8V$, $V_{LED+} = 5.0V$, $T_A = +25^{\circ}C$, \overline{RST} , unless otherwise noted.)



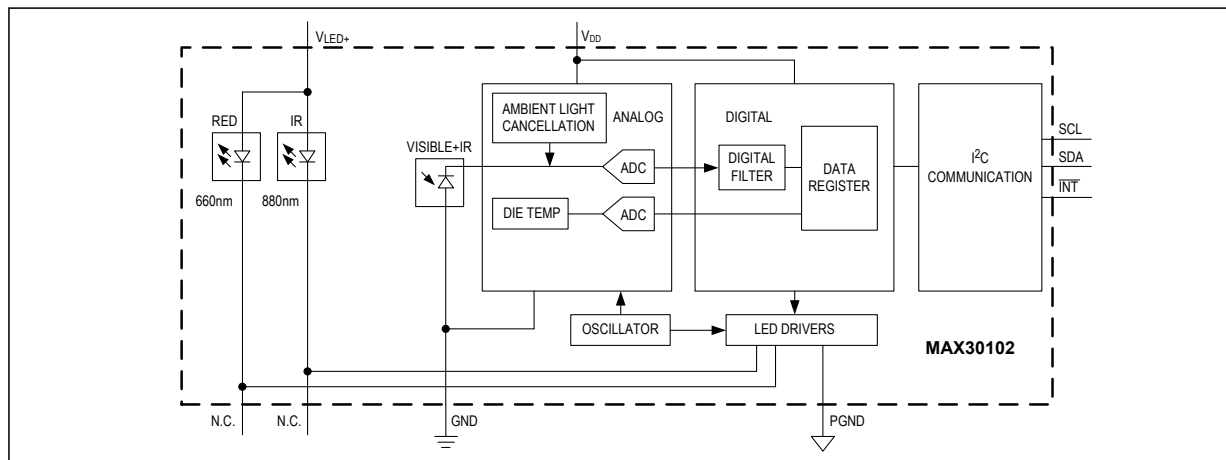
Pin Configuration



Pin Description

PIN	NAME	FUNCTION
1, 5, 6, 7, 8, 14	N.C.	No Connection. Connect to PCB pad for mechanical stability.
2	SCL	I ² C Clock Input
3	SDA	I ² C Data, Bidirectional (Open-Drain)
4	PGND	Power Ground of the LED Driver Blocks
9	V _{LED+}	LED Power Supply (anode connection). Use a bypass capacitor to PGND for best performance.
10	V _{LED+}	
11	V _{DD}	Analog Power Supply Input. Use a bypass capacitor to GND for best performance.
12	GND	Analog Ground
13	$\overline{\text{INT}}$	Active-Low Interrupt (Open-Drain). Connect to an external voltage with a pullup resistor.

Functional Diagram



Detailed Description

The MAX30102 is a complete pulse oximetry and heart-rate sensor system solution module designed for the demanding requirements of wearable devices. The device maintains a very small solution size without sacrificing optical or electrical performance. Minimal external hardware components are required for integration into a wearable system.

The MAX30102 is fully adjustable through software registers, and the digital output data can be stored in a 32-deep FIFO within the IC. The FIFO allows the MAX30102 to be connected to a microcontroller or processor on a shared bus, where the data is not being read continuously from the MAX30102's registers.

SpO₂ Subsystem

The SpO₂ subsystem of the MAX30102 contains ambient light cancellation (ALC), a continuous-time sigma-delta ADC, and a proprietary discrete time filter. The ALC has an internal Track/Hold circuit to cancel ambient light and increase the effective dynamic range. The SpO₂ ADC has programmable full-scale ranges from 2µA to 16µA. The ALC can cancel up to 200µA of ambient current.

The internal ADC is a continuous time oversampling sigma-delta converter with 18-bit resolution. The ADC

sampling rate is 10.24MHz. The ADC output data rate can be programmed from 50sps (samples per second) to 3200sps.

Temperature Sensor

The MAX30102 has an on-chip temperature sensor for calibrating the temperature dependence of the SpO₂ subsystem. The temperature sensor has an inherent resolution of 0.0625°C.

The device output data is relatively insensitive to the wavelength of the IR LED, where the Red LED's wavelength is critical to correct interpretation of the data. An SpO₂ algorithm used with the MAX30102 output signal can compensate for the associated SpO₂ error with ambient temperature changes.

LED Driver

The MAX30102 integrates Red and IR LED drivers to modulate LED pulses for SpO₂ and HR measurements. The LED current can be programmed from 0 to 50mA with proper supply voltage. The LED pulse width can be programmed from 69µs to 411µs to allow the algorithm to optimize SpO₂ and HR accuracy and power consumption based on use cases.

Register Maps and Descriptions

REGISTER	B7	B6	B5	B4	B3	B2	B1	B0	REG ADDR	POR STATE	R/W
STATUS											
Interrupt Status 1	A_FULL	PPG_RDY	ALC_OVF					PWR_RDY	0x00	0x00	R
Interrupt Status 2							DIE_TEMP_RDY		0x01	0x00	R
Interrupt Enable 1	A_FULL_EN	PPG_RDY_EN	ALC_OVF_EN						0x02	0x00	R/W
Interrupt Enable 2							DIE_TEMP_RDY_EN		0x03	0x00	R/W
FIFO											
FIFO Write Pointer				FIFO_WR_PTR[4:0]					0x04	0x00	R/W
Overflow Counter				OVF_COUNTER[4:0]					0x05	0x00	R/W
FIFO Read Pointer				FIFO_RD_PTR[4:0]					0x06	0x00	R/W
FIFO Data Register	FIFO_DATA[7:0]								0x07	0x00	R/W
CONFIGURATION											
FIFO Configuration	SMP_AVE[2:0]		FIFO_ROLL_OVER_EN	FIFO_A_FULL[3:0]				0x08	0x00	R/W	
Mode Configuration	SHDN	RESET				MODE[2:0]			0x09	0x00	R/W
SpO ₂ Configuration	0 (Reserved)	SPO2_ADC_RGE [1:0]		SPO2_SR[2:0]		LED_PW[1:0]			0x0A	0x00	R/W
RESERVED									0x0B	0x00	R/W
LED Pulse Amplitude	LED1_PA[7:0]								0x0C	0x00	R/W
	LED2_PA[7:0]								0x0D	0x00	R/W
RESERVED									0x0E	0x00	R/W
RESERVED									0x0F	0x00	R/W
Multi-LED Mode Control Registers		SLOT2[2:0]				SLOT1[2:0]			0x11	0x00	R/W
		SLOT4[2:0]				SLOT3[2:0]			0x12	0x00	R/W

Register Maps and Descriptions (continued)

REGISTER	B7	B6	B5	B4	B3	B2	B1	B0	REG ADDR	POR STATE	R/W
RESERVED									0x13–0x17	0xFF	R/W
RESERVED									0x18–0x1E	0x00	R
DIE TEMPERATURE											
Die Temp Integer	TINT[7:0]								0x1F	0x00	R
Die Temp Fraction					TFRAC[3:0]				0x20	0x00	R
Die Temperature Config								TEMP_EN	0x21	0x00	R/W
RESERVED									0x22–0x2F	0x00	R/W
PART ID											
Revision ID	REV_ID[7:0]								0xFE	0XX*	R
Part ID	PART_ID[7]								0xFF	0x15	R

*XX denotes a 2-digit hexadecimal number (00 to FF) for part revision identification. Contact Maxim Integrated for the revision ID number assigned for your product.

Interrupt Status (0x00–0x01)

REGISTER	B7	B6	B5	B4	B3	B2	B1	B0	REG ADDR	POR STATE	R/W
Interrupt Status 1	A_FULL	PPG_RDY	ALC_OVF					PWR_RDY	0x00	0x00	R
Interrupt Status 2							DIE_TEMP_RDY		0x01	0x00	R

Whenever an interrupt is triggered, the MAX30102 pulls the active-low interrupt pin into its low state until the interrupt is cleared.

A_FULL: FIFO Almost Full Flag

In SpO₂ and HR modes, this interrupt triggers when the FIFO write pointer has a certain number of free spaces remaining. The trigger number can be set by the FIFO_A_FULL[3:0] register. The interrupt is cleared by reading the Interrupt Status 1 register (0x00).

PPG_RDY: New FIFO Data Ready

In SpO₂ and HR modes, this interrupt triggers when there is a new sample in the data FIFO. The interrupt is cleared by reading the Interrupt Status 1 register (0x00), or by reading the FIFO_DATA register.

ALC_OVF: Ambient Light Cancellation Overflow

This interrupt triggers when the ambient light cancellation function of the SpO₂/HR photodiode has reached its maximum limit, and therefore, ambient light is affecting the output of the ADC. The interrupt is cleared by reading the Interrupt Status 1 register (0x00).

PWR_RDY: Power Ready Flag

On power-up or after a brownout condition, when the supply voltage V_{DD} transitions from below the undervoltage lockout (UVLO) voltage to above the UVLO voltage, a power-ready interrupt is triggered to signal that the module is powered-up and ready to collect data.

DIE_TEMP_RDY: Internal Temperature Ready Flag

When an internal die temperature conversion is finished, this interrupt is triggered so the processor can read the temperature data registers. The interrupt is cleared by reading either the Interrupt Status 2 register (0x01) or the TFRAC register (0x20).

The interrupts are cleared whenever the interrupt status register is read, or when the register that triggered the interrupt is read. For example, if the SpO₂ sensor triggers an interrupt due to finishing a conversion, reading either the FIFO data register or the interrupt register clears the interrupt pin (which returns to its normal HIGH state). This also clears all the bits in the interrupt status register to zero.

Interrupt Enable (0x02-0x03)

REGISTER	B7	B6	B5	B4	B3	B2	B1	B0	REG ADDR	POR STATE	R/W
Interrupt Enable 1	A_FULL_EN	PPG_RDY_EN	ALC_OVF_EN						0x02	0x00	R/W
Interrupt Enable 2							DIE_TEMP_RDY_EN		0x03	0x00	R/W

Each source of hardware interrupt, with the exception of power ready, can be disabled in a software register within the MAX30102 IC. The power-ready interrupt cannot be disabled because the digital state of the module is reset upon a brownout condition (low power supply voltage), and the default condition is that all the interrupts are disabled. Also, it is important for the system to know that a brownout condition has occurred, and the data within the module is reset as a result.

The unused bits should always be set to zero for normal operation.

FIFO (0x04–0x07)

REGISTER	B7	B6	B5	B4	B3	B2	B1	B0	REG ADDR	POR STATE	R/W
FIFO Write Pointer				FIFO_WR_PTR[4:0]					0x04	0x00	R/W
Over Flow Counter				OVF_COUNTER[4:0]					0x05	0x00	R/W
FIFO Read Pointer				FIFO_RD_PTR[4:0]					0x06	0x00	R/W
FIFO Data Register	FIFO_DATA[7:0]								0x07	0x00	R/W

FIFO Write Pointer

The FIFO Write Pointer points to the location where the MAX30102 writes the next sample. This pointer advances for each sample pushed on to the FIFO. It can also be changed through the I²C interface when MODE[2:0] is 010, 011, or 111.

FIFO Overflow Counter

When the FIFO is full, samples are not pushed on to the FIFO, samples are lost. OVF_COUNTER counts the number of samples lost. It saturates at 0x1F. When a complete sample is “popped” (i.e., removal of old FIFO data and shifting the samples down) from the FIFO (when the read pointer advances), OVF_COUNTER is reset to zero.

FIFO Read Pointer

The FIFO Read Pointer points to the location from where the processor gets the next sample from the FIFO through the I²C interface. This advances each time a sample is popped from the FIFO. The processor can also write to this pointer after reading the samples to allow rereading samples from the FIFO if there is a data communication error.

FIFO Data Register

The circular FIFO depth is 32 and can hold up to 32 samples of data. The sample size depends on the number of LED channels (a.k.a. channels) configured as active. As each channel signal is stored as a 3-byte data signal, the FIFO width can be 3 bytes or 6 bytes in size.

The FIFO_DATA register in the I²C register map points to the next sample to be read from the FIFO. FIFO_RD_PTR points to this sample. Reading FIFO_DATA register, does not automatically increment the I²C register address. Burst reading this register, reads the same address over and over. Each sample is 3 bytes of data per channel (i.e., 3 bytes for RED, 3 bytes for IR, etc.).

The FIFO registers (0x04–0x07) can all be written and read, but in practice only the FIFO_RD_PTR register should be written to in operation. The others are automatically incremented or filled with data by the MAX30102. When starting a new SpO₂ or heart rate conversion, it is recommended to first clear the FIFO_WR_PTR, OVF_COUNTER, and FIFO_RD_PTR registers to all zeroes (0x00) to ensure the FIFO is empty and in a known state. When reading the MAX30102 registers in one burst-read I²C transaction, the register address pointer typically increments so that the next byte of data sent is from the next register, etc. The exception to this is the FIFO data register, register 0x07. When reading this register, the address pointer does not increment, but the FIFO_RD_PTR does. So the next byte of data sent represents the next byte of data available in the FIFO.

Reading from the FIFO

Normally, reading registers from the I²C interface autoincrements the register address pointer, so that all the registers can be read in a burst read without an I²C start event. In the MAX30102, this holds true for all registers except for the FIFO_DATA register (register 0x07).

Reading the FIFO_DATA register does not automatically increment the register address. Burst reading this register reads data from the same address over and over. Each sample comprises multiple bytes of data, so multiple bytes should be read from this register (in the same transaction) to get one full sample.

The other exception is 0xFF. Reading more bytes after the 0xFF register does not advance the address pointer back to 0x00, and the data read is not meaningful.

FIFO Data Structure

The data FIFO consists of a 32-sample memory bank that can store IR and Red ADC data. Since each sample consists of two channels of data, there are 6 bytes of data for each sample, and therefore 192 total bytes of data can be stored in the FIFO.

The FIFO data is left-justified as shown in Table 1; in other words, the MSB bit is always in the bit 17 data position regardless of ADC resolution setting. See Table 2 for a visual presentation of the FIFO data structure.

Table 1. FIFO Data is Left-Justified

ADC Resolution	FIFO_DATA[17]	FIFO_DATA[16]	...	FIFO_DATA[12]	FIFO_DATA[11]	FIFO_DATA[10]	FIFO_DATA[9]	FIFO_DATA[8]	FIFO_DATA[7]	FIFO_DATA[6]	FIFO_DATA[5]	FIFO_DATA[4]	FIFO_DATA[3]	FIFO_DATA[2]	FIFO_DATA[1]	FIFO_DATA[0]
18-bit	█	█		█	█	█	█	█	█	█	█	█	█	█	█	█
17-bit	█	█		█	█	█	█	█	█	█	█	█	█	█	█	█
16-bit	█	█		█	█	█	█	█	█	█	█	█	█	█	█	█
15-bit	█	█		█	█	█	█	█	█	█	█	█	█	█	█	█

FIFO Data Contains 3 Bytes per Channel

The FIFO data is left-justified, meaning that the MSB is always in the same location regardless of the ADC resolution setting. FIFO DATA[18] – [23] are not used. Table 2 shows the structure of each triplet of bytes (containing the 18-bit ADC data output of each channel).

Each data sample in SpO₂ mode comprises two data triplets (3 bytes each). To read one sample, requires an I²C read command for each byte. Thus, to read one sample in SpO₂ mode, requires 6 I²C byte reads. The FIFO read pointer is automatically incremented after the first byte of each sample is read.

Write/Read Pointers

Write/Read pointers are used to control the flow of data in the FIFO. The write pointer increments every time a new sample is added to the FIFO. The read pointer is incremented every time a sample is read from the FIFO. To reread a sample from the FIFO, decrement its value by one and read the data register again.

The FIFO write/read pointers should be cleared (back to 0x00) upon entering SpO₂ mode or HR mode, so that there is no old data represented in the FIFO. The pointers are automatically cleared if V_{DD} is power-cycled or V_{DD} drops below its UVLO voltage.

BYTE 1							FIFO_DATA[17]	FIFO_DATA[16]
BYTE 2	FIFO_DATA[15]	FIFO_DATA[14]	FIFO_DATA[13]	FIFO_DATA[12]	FIFO_DATA[11]	FIFO_DATA[10]	FIFO_DATA[9]	FIFO_DATA[8]
BYTE 3	FIFO_DATA[7]	FIFO_DATA[6]	FIFO_DATA[5]	FIFO_DATA[4]	FIFO_DATA[3]	FIFO_DATA[2]	FIFO_DATA[1]	FIFO_DATA[0]

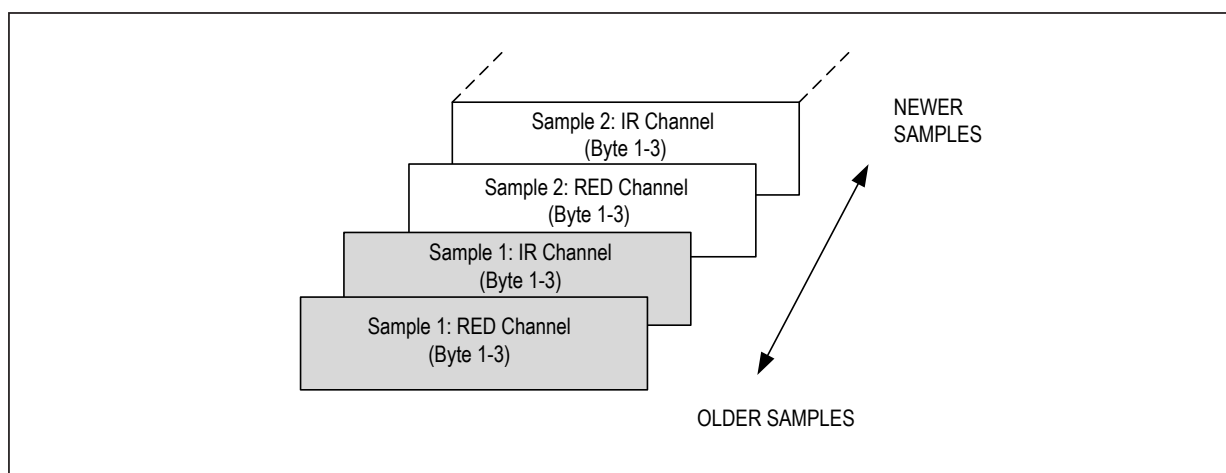


Figure 2. Graphical Representation of the FIFO Data Register. It shows IR and Red in SpO₂ Mode.

Pseudo-Code Example of Reading Data from FIFO

First transaction: Get the FIFO_WR_PTR:

```

START;
Send device address + write mode
Send address of FIFO_WR_PTR;
REPEATED_START;
Send device address + read mode
Read FIFO_WR_PTR;
STOP;

```

The central processor evaluates the number of samples to be read from the FIFO:

```

NUM_AVAILABLE_SAMPLES = FIFO_WR_PTR - FIFO_RD_PTR

```

(Note: pointer wrap around should be taken into account)

```

NUM_SAMPLES_TO_READ = < less than or equal to NUM_AVAILABLE_SAMPLES >

```

Second transaction: Read NUM_SAMPLES_TO_READ samples from the FIFO:

```

START;
Send device address + write mode
Send address of FIFO_DATA;
REPEATED_START;
Send device address + read mode
for (i = 0; i < NUM_SAMPLES_TO_READ; i++) {
Read FIFO_DATA;
Save LED1[23:16];
Read FIFO_DATA;
Save LED1[15:8];
Read FIFO_DATA;
Save LED1[7:0];
Read FIFO_DATA;
Save LED2[23:16];
Read FIFO_DATA;
Save LED2[15:8];
Read FIFO_DATA;
Save LED2[7:0];
Read FIFO_DATA;
}
STOP;
START;
Send device address + write mode
Send address of FIFO_RD_PTR;
Write FIFO_RD_PTR;
STOP;

```

Third transaction: Write to FIFO_RD_PTR register. If the second transaction was successful, FIFO_RD_PTR points to the next sample in the FIFO, and this third transaction is not necessary. Otherwise, the processor updates the FIFO_RD_PTR appropriately, so that the samples are reread.

FIFO Configuration (0x08)

REGISTER	B7	B6	B5	B4	B3	B2	B1	B0	REG ADDR	POR STATE	R/W
FIFO Configuration	SMP_AVE[2:0]			FIFO_ROL LOVER_EN	FIFO_A_FULL[3:0]				0x08	0x00	R/W

Bits 7:5: Sample Averaging (SMP_AVE)

To reduce the amount of data throughput, adjacent samples (in each individual channel) can be averaged and decimated on the chip by setting this register.

Table 3. Sample Averaging

SMP_AVE[2:0]	NO. OF SAMPLES AVERAGED PER FIFO SAMPLE
000	1 (no averaging)
001	2
010	4
011	8
100	16
101	32
110	32
111	32

Bit 4: FIFO Rolls on Full (FIFO_ROLLOVER_EN)

This bit controls the behavior of the FIFO when the FIFO becomes completely filled with data. If FIFO_ROLLOVER_EN is set (1), the FIFO address rolls over to zero and the FIFO continues to fill with new data. If the bit is not set (0), then the FIFO is not updated until FIFO_DATA is read or the WRITE/READ pointer positions are changed.

Bits 3:0: FIFO Almost Full Value (FIFO_A_FULL)

This register sets the number of data samples (3 bytes/sample) remaining in the FIFO when the interrupt is issued. For example, if this field is set to 0x0, the interrupt is issued when there is 0 data samples remaining in the FIFO (all 32 FIFO words have unread data). Furthermore, if this field is set to 0xF, the interrupt is issued when 15 data samples are remaining in the FIFO (17 FIFO data samples have unread data).

FIFO_A_FULL[3:0]	EMPTY DATA SAMPLES IN FIFO WHEN INTERRUPT IS ISSUED	UNREAD DATA SAMPLES IN FIFO WHEN INTERRUPT IS ISSUED
0x0h	0	32
0x1h	1	31
0x2h	2	30
0x3h	3	29
...
0xFh	15	17

Mode Configuration (0x09)

REGISTER	B7	B6	B5	B4	B3	B2	B1	B0	REG ADDR	POR STATE	R/W
Mode Configuration	SHDN	RESET				MODE[2:0]			0x09	0x00	R/W

Bit 7: Shutdown Control (SHDN)

The part can be put into a power-save mode by setting this bit to one. While in power-save mode, all registers retain their values, and write/read operations function as normal. All interrupts are cleared to zero in this mode.

Bit 6: Reset Control (RESET)

When the RESET bit is set to one, all configuration, threshold, and data registers are reset to their power-on-state through a power-on reset. The RESET bit is cleared automatically back to zero after the reset sequence is completed.

Note: Setting the RESET bit does not trigger a PWR_RDY interrupt event.

Bits 2:0: Mode Control

These bits set the operating state of the MAX30102. Changing modes does not change any other setting, nor does it erase any previously stored data inside the data registers.

Table 4. Mode Control

MODE[2:0]	MODE	ACTIVE LED CHANNELS
000	Do not use	
001	Do not use	
010	Heart Rate mode	Red only
011	SpO ₂ mode	Red and IR
100–110	Do not use	
111	Multi-LED mode	Red and IR

SpO₂ Configuration (0x0A)

REGISTER	B7	B6	B5	B4	B3	B2	B1	B0	REG ADDR	POR STATE	R/W
SpO ₂ Configuration		SPO2_ADC_RGE[1:0]		SPO2_SR[2:0]			LED_PW[1:0]		0x0A	0x00	R/W

Bits 6:5: SpO₂ ADC Range Control

This register sets the SpO₂ sensor ADC's full-scale range as shown in [Table 5](#).

Table 5. SpO₂ ADC Range Control (18-Bit Resolution)

SPO2_ADC_RGE[1:0]	LSB SIZE (pA)	FULL SCALE (nA)
00	7.81	2048
01	15.63	4096
10	31.25	8192
11	62.5	16384

Bits 4:2: SpO₂ Sample Rate Control

These bits define the effective sampling rate with one sample consisting of one IR pulse/conversion and one Red pulse/conversion.

The sample rate and pulse width are related in that the sample rate sets an upper bound on the pulse width time. If the user selects a sample rate that is too high for the selected LED_PW setting, the highest possible sample rate is programmed instead into the register.

Table 6. SpO₂ Sample Rate Control

SPO2_SR[2:0]	SAMPLES PER SECOND
000	50
001	100
010	200
011	400
100	800
101	1000
110	1600
111	3200

See Table 11 and Table 12 for Pulse Width vs. Sample Rate information.

Bits 1:0: LED Pulse Width Control and ADC Resolution

These bits set the LED pulse width (the IR and Red have the same pulse width), and therefore, indirectly sets the integration time of the ADC in each sample. The ADC resolution is directly related to the integration time.

Table 7. LED Pulse Width Control

LED_PW[1:0]	PULSE WIDTH (μs)	ADC RESOLUTION (bits)
00	69 (68.95)	15
01	118 (117.78)	16
10	215 (215.44)	17
11	411 (410.75)	18

LED Pulse Amplitude (0x0C–0x0D)

REGISTER	B7	B6	B5	B4	B3	B2	B1	B0	REG ADDR	POR STATE	R/W
LED Pulse Amplitude	LED1_PA[7:0]								0x0C	0x00	R/W
	LED2_PA[7:0]								0x0D	0x00	R/W

These bits set the current level of each LED as shown in [Table 8](#).

Table 8. LED Current Control

LEDx_PA [7:0], RED_PA[7:0], or IR_PA[7:0]	TYPICAL LED CURRENT (mA)*
0x00h	0.0
0x01h	0.2
0x02h	0.4
...	...
0x0Fh	3.0
...	...
0x1Fh	6.2
...	...
0x3Fh	12.6
...	...
0x7Fh	25.4
...	...
0xFFh	51.0

*Actual measured LED current for each part can vary widely due to the trimming methodology.

Multi-LED Mode Control Registers (0x11–0x12)

REGISTER	B7	B6	B5	B4	B3	B2	B1	B0	REG ADDR	POR STATE	R/W
Multi-LED Mode Control Registers			SLOT2[2:0]				SLOT1[2:0]		0x11	0x00	R/W
			SLOT4[2:0]				SLOT3[2:0]		0x12	0x00	R/W

In multi-LED mode, each sample is split into up to four time slots, SLOT1 through SLOT4. These control registers determine which LED is active in each time slot, making for a very flexible configuration.

Table 9. Multi-LED Mode Control Registers

SLOTx[2:0] Setting	WHICH LED IS ACTIVE	LED PULSE AMPLITUDE SETTING
000	None (time slot is disabled)	N/A (Off)
001	LED1 (Red)	LED1_PA[7:0]
010	LED2 (IR)	LED2_PA[7:0]
011	None	N/A (Off)
100	None	N/A (Off)
101	Reserved	Reserved
110	Reserved	Reserved
111	Reserved	Reserved

Each slot generates a 3-byte output into the FIFO. One sample comprises all active slots, for example if SLOT1 and SLOT2 are non-zero, then one sample is 2 x 3 = 6 bytes.

The slots should be enabled in order (i.e., SLOT1 should not be disabled if SLOT2 is enabled).

Temperature Data (0x1F–0x21)

REGISTER	B7	B6	B5	B4	B3	B2	B1	B0	REG ADDR	POR STATE	R/W
Die Temp Integer	TINT[7]								0x1F	0x00	R
Die Temp Fraction					TFRAC[3:0]				0x20	0x00	R
Die Temperature Config								TEMP_EN	0x21	0x00	R/W

Temperature Integer

The on-board temperature ADC output is split into two registers, one to store the integer temperature and one to store the fraction. Both should be read when reading the temperature data, and the equation below shows how to add the two registers together:

$$T_{\text{MEASURED}} = T_{\text{INTEGER}} + T_{\text{FRACTION}}$$

This register stores the integer temperature data in 2's complement format, where each bit corresponds to 1°C.

Table 10. Temperature Integer

REGISTER VALUE (hex)	TEMPERATURE (°C)
0x00	0
0x01	+1
...	...
0x7E	+126
0x7F	+127
0x80	-128
0x81	-127
...	...
0xFE	-2
0xFF	-1

Temperature Fraction

This register stores the fractional temperature data in increments of 0.0625°C. If this fractional temperature is paired with a negative integer, it still adds as a positive fractional value (e.g., -128°C + 0.5°C = -127.5°C).

Temperature Enable (TEMP_EN)

This is a self-clearing bit which, when set, initiates a single temperature reading from the temperature sensor. This bit clears automatically back to zero at the conclusion of the temperature reading when the bit is set to one.

Applications Information

Sample Rate and Performance

The maximum sample rate for the ADC depends on the selected pulse width, which in turn, determines the ADC resolution. For instance, if the pulse width is set to 69µs then the ADC resolution is 15 bits, and all sample rates are selectable. However, if the pulse width is set to 411µs, then the samples rates are limited. The allowed sample rates for both SpO₂ and HR Modes are summarized in the [Table 11](#) and [Table 12](#).

Power Considerations

The LED waveforms and their implication for power supply design are discussed in this section.

The LEDs in the MAX30102 are pulsed with a low duty cycle for power savings, and the pulsed currents can cause ripples in the V_{LED+} power supply. To ensure these pulses do not translate into optical noise at the LED outputs, the power supply must be designed to handle these. Ensure that the resistance and inductance from the power supply (battery, DC/DC converter, or LDO) to the pin is much smaller than 1Ω, and that there is at least 1µF of power supply bypass capacitance to a good ground plane. The capacitance should be located as close as physically possible to the IC.

Table 11. SpO₂ Mode (Allowed Settings)

SAMPLES PER SECOND	PULSE WIDTH (µs)			
	69	118	215	411
50	○	○	○	○
100	○	○	○	○
200	○	○	○	○
400	○	○	○	○
800	○	○	○	
1000	○	○		
1600	○			
3200				
Resolution (bits)	15	16	17	18

Table 12. HR Mode (Allowed Settings)

SAMPLES PER SECOND	PULSE WIDTH (µs)			
	69	118	215	411
50	○	○	○	○
100	○	○	○	○
200	○	○	○	○
400	○	○	○	○
800	○	○	○	○
1000	○	○	○	○
1600	○	○	○	
3200	○			
Resolution (bits)	15	16	17	18

In the Heart Rate mode, only the Red LED is used to capture optical data and determine the user's heart rate and/or photoplethysmogram (PPG).

SpO₂ Temperature Compensation

The MAX30102 has an accurate on-board temperature sensor that digitizes the IC's internal temperature upon command from the I²C master. The temperature has an effect on the wavelength of the red and IR LEDs. While the device output data is relatively insensitive to the wavelength of the IR LED, the red LED's wavelength is critical to correct interpretation of the data.

[Table 13](#) shows the correlation of red LED wavelength versus the temperature of the LED. Since the LED die heats up with a very short thermal time constant (tens of microseconds), the LED wavelength should be calculated according to the current level of the LED and the temperature of the IC. Use [Table 13](#) to estimate the temperature.

Red LED Current Settings vs. LED Temperature Rise

Add the temperature rise to the module temperature reading to estimate the LED temperature and output wavelength. The LED temperature estimate is valid even with very short pulse widths, due to the fast thermal time constant of the LED.

Interrupt Pin Functionality

The active-low interrupt pin pulls low when an interrupt is triggered. The pin is open-drain, which means it normally requires a pullup resistor or current source to an external voltage supply (up to +5V from GND). The interrupt pin is not designed to sink large currents, so the pullup resistor value should be large, such as 4.7kΩ.

Table 13. RED LED Current Settings vs. LED Temperature Rise

RED LED CURRENT SETTING	RED LED DUTY CYCLE (% OF LED PULSE WIDTH TO SAMPLE TIME)	ESTIMATED TEMPERATURE RISE (ADD TO TEMP SENSOR MEASUREMENT) (°C)
00000001 (0.2mA)	8	0.1
11111010 (50mA)	8	2
00000001 (0.2mA)	16	0.3
11111010 (50mA)	16	4
00000001 (0.2mA)	32	0.6
11111010 (50mA)	32	8

Timing for Measurements and Data Collection

Slot Timing in Multi-LED Modes

The MAX30102 can support two LED channels of sequential processing (Red and IR). Table 14 below displays the four possible channel slot times associated with each pulse width setting. Figure 3 shows an example of channel slot timing for a SpO₂ mode application with a 1kHz sample rate.

Table 14. Slot Timing

PULSE-WIDTH SETTING (μs)	CHANNEL SLOT TIMING (TIMING PERIOD BETWEEN PULSES) (μs)	CHANNEL-CHANNEL TIMING (RISING EDGE-TO-RISING EDGE) (μs)
69	358	427
118	407	525
215	505	720
411	696	1107

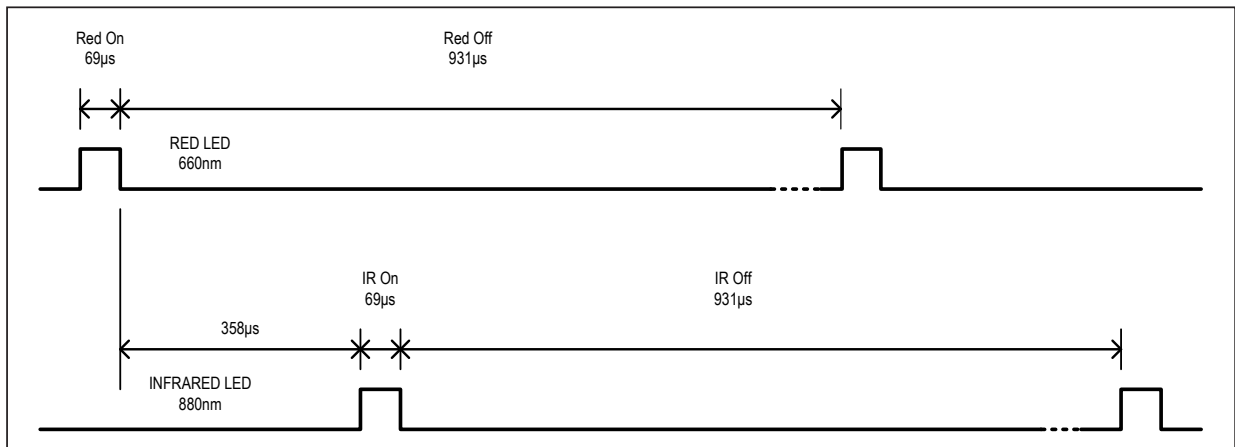


Figure 3. Channel Slot Timing for the SpO₂ Mode with a 1kHz Sample Rate

Timing in SpO₂ Mode

The internal FIFO stores up to 32 samples, so that the system processor does not need to read the data after every sample. The temperature does not need to be sampled very often—once a second or every few seconds should be sufficient.

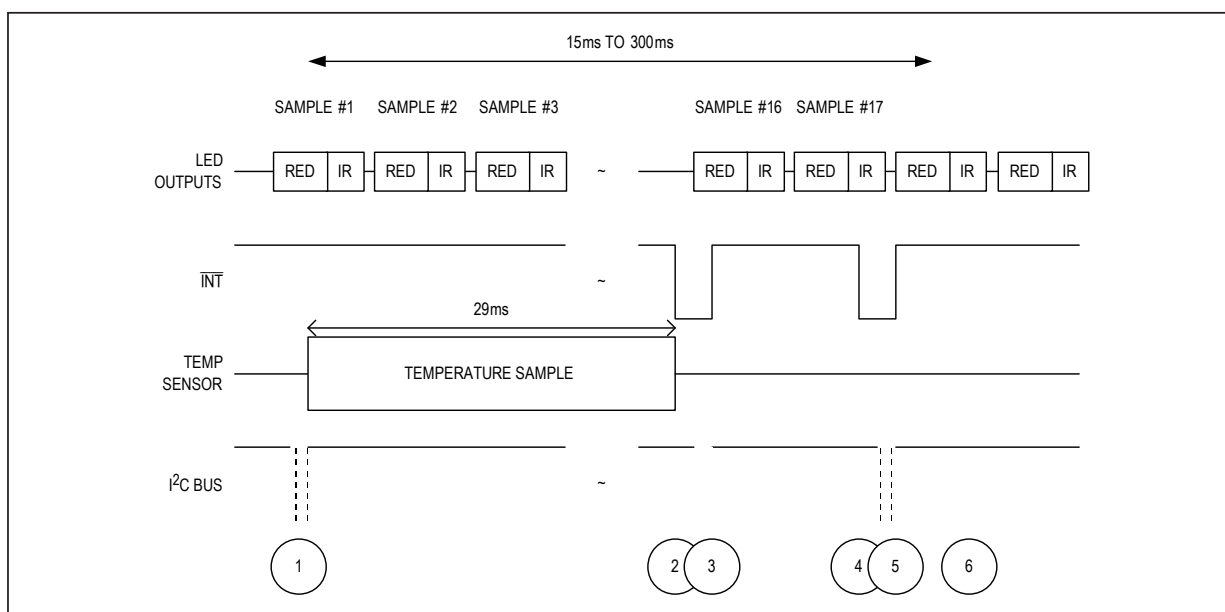


Figure 4. Timing for Data Acquisition and Communication When in SpO₂ Mode

Table 15. Events Sequence for Figure 4 in SpO₂ Mode

EVENT	DESCRIPTION	COMMENTS
1	Enter into SpO ₂ Mode. Initiate a Temperature measurement.	I ² C Write Command sets MODE[2:0] = 0x03 and A_FULL_EN. Then to enable and initiate a single temperature measurement, set TEMP_EN and DIE_TEMP_RDY_EN.
2	Temperature Measurement Complete, Interrupt Generated	DIE_TEMP_RDY interrupt triggers, alerting the central processor to read the data.
3	Temp Data is Read, Interrupt Cleared	
4	FIFO is Almost Full, Interrupt Generated	Interrupt is generated when the FIFO almost full threshold is reached.
5	FIFO Data is Read, Interrupt Cleared	
6	Next Sample is Stored	New Sample is stored at the new read pointer location. Effectively, it is now the first sample in the FIFO.

Timing in HR Mode

The internal FIFO stores up to 32 samples, so that the system processor does not need to read the data after every sample. In HR mode (Figure 5), unlike in SpO₂ mode, temperature information is not necessary to interpret the data. The user can select either the red LED or the infrared LED channel for heart rate measurements.

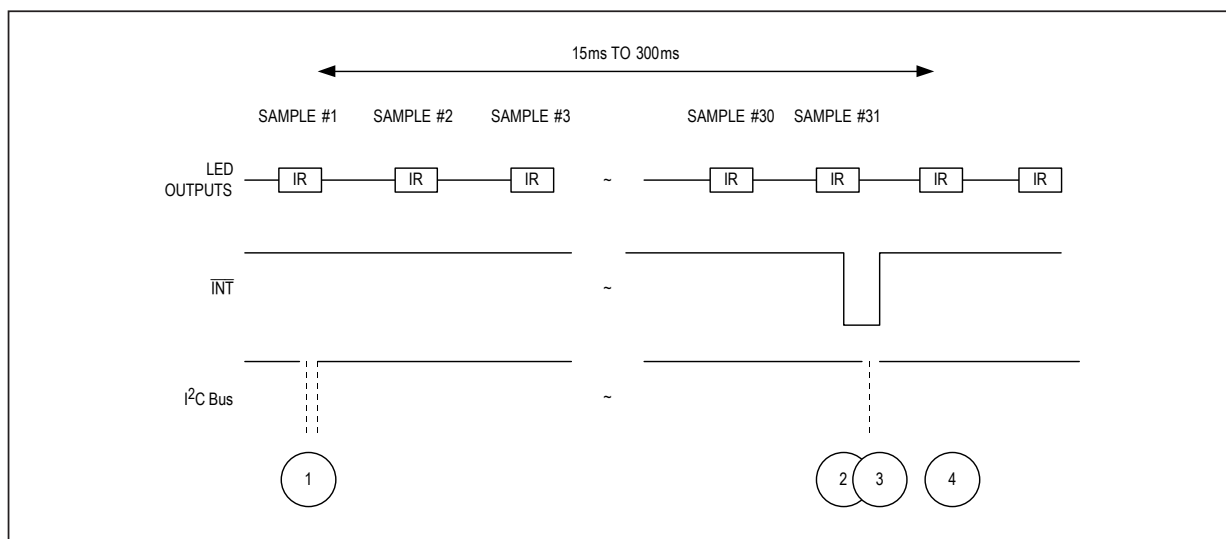


Figure 5. Timing for Data Acquisition and Communication When in HR Mode

Table 16. Events Sequence for Figure 5 in HR Mode

EVENT	DESCRIPTION	COMMENTS
1	Enter into Mode	I ² C Write Command sets MODE[2:0] = 0x02. Mask the A_FULL_EN Interrupt.
2	FIFO is Almost Full, Interrupt Generated	Interrupt is generated when the FIFO has only one empty space left.
3	FIFO Data is Read, Interrupt Cleared	
4	Next Sample is Stored	New sample is stored at the new read pointer location. Effectively, it is now the first sample in the FIFO.

Power Sequencing and Requirements

Power-Up Sequencing

Figure 6. shows the recommended power-up sequence for the MAX30102.

It is recommended to power the V_{DD} supply first, before the LED power supplies (V_{LED+}). The interrupt and I²C pins can be pulled up to an external voltage even when the power supplies are not powered up.

After the power is established, an interrupt occurs to alert the system that the MAX30102 is ready for operation. Reading the I²C interrupt register clears the interrupt, as shown in Figure 6.

Power-Down Sequencing

The MAX30102 is designed to be tolerant of any power supply sequencing on power-down.

I²C Interface

The MAX30102 features an I²C/SMBus-compatible, 2-wire serial interface consisting of a serial data line (SDA) and a serial clock line (SCL). SDA and SCL facilitate communication between the MAX30102 and the master at clock rates up to 400kHz. Figure 1 shows the 2-wire interface timing diagram. The master generates SCL and initiates data transfer on the bus. The master device writes data to the MAX30102 by transmitting the proper slave address followed by data. Each transmit sequence is framed by a START (S) or REPEATED START (Sr) condition and a STOP (P) condition. Each word transmitted to the MAX30102 is 8 bits long and is followed by an acknowledge clock pulse. A master reading data from the MAX30102 transmits the proper slave address followed by a series of nine SCL pulses.

The MAX30102 transmits data on SDA in sync with the master-generated SCL pulses. The master acknowledges receipt of each byte of data. Each read sequence is framed by a START (S) or REPEATED START (Sr) condition, a not acknowledge, and a STOP (P) condition. SDA operates as both an input and an open-drain output. A pullup resistor, typically greater than 500Ω, is required on SDA. SCL operates only as an input. A pullup resistor, typically greater than 500Ω, is required on SCL if there are multiple masters on the bus, or if the single master has an open-drain SCL output. Series resistors in line with SDA and SCL are optional. Series resistors protect the digital inputs of the MAX30102 from high voltage spikes on the bus lines and minimize crosstalk and undershoot of the bus signals.

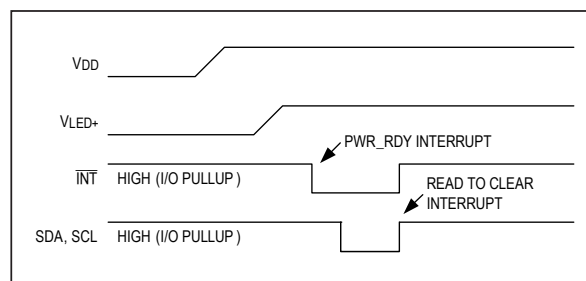


Figure 6. Power-Up Sequence of the Power Supply Rails

Bit Transfer

One data bit is transferred during each SCL cycle. The data on SDA must remain stable during the high period of the SCL pulse. Changes in SDA while SCL is high are control signals. See the [START and STOP Conditions](#) section.

START and STOP Conditions

SDA and SCL idle high when the bus is not in use. A master initiates communication by issuing a START condition. A START condition is a high-to-low transition on SDA with SCL high. A STOP condition is a low-to-high transition on SDA while SCL is high (Figure 7). A START condition from the master signals the beginning of a transmission to the device. The master terminates transmission, and frees the bus, by issuing a STOP condition. The bus remains active if a REPEATED START condition is generated instead of a STOP condition.

Early STOP Conditions

The MAX30102 recognizes a STOP condition at any point during data transmission except if the STOP condition occurs in the same high pulse as a START condition. For proper operation, do not send a STOP condition during the same SCL high pulse as the START condition.

Slave Address

A bus master initiates communication with a slave device by issuing a START condition followed by the 7-bit slave ID. When idle, the MAX30102 waits for a START condition followed by its slave ID. The serial interface compares each slave ID bit by bit, allowing the interface to power down and disconnect from SCL immediately if an incorrect slave ID is detected. After recognizing a START condition followed by the correct slave ID, the MAX30102 is programmed to accept or send data. The LSB of the slave ID word is the read/write (R/W) bit. R/W indicates whether the master is writing to or reading data from the MAX30102 ($R/\bar{W} = 0$ selects a write condition, $R/\bar{W} = 1$ selects a read condition).

After receiving the proper slave ID, the MAX30102 issues an ACK by pulling SDA low for one clock cycle.

The MAX30102 slave ID consists of seven fixed bits, B7–B1 (set to 0b1010111). The most significant slave ID bit (B7) is transmitted first, followed by the remaining bits. [Table 17](#) shows the possible slave IDs of the device.

Acknowledge

The acknowledge bit (ACK) is a clocked 9th bit that the MAX30102 uses to handshake receipt each byte of data when in write mode ([Figure 8](#)). The MAX30102 pulls down SDA during the entire master-generated 9th clock pulse if the previous byte is successfully received. Monitoring ACK allows for detection of unsuccessful data transfers. An unsuccessful data transfer occurs if a receiving device is busy or if a system fault has occurred. In the event of an unsuccessful data transfer, the bus master retries communication. The master pulls down SDA

during the 9th clock cycle to acknowledge receipt of data when the MAX30102 is in read mode. An acknowledge is sent by the master after each read byte to allow data transfer to continue. A not-acknowledge is sent when the master reads the final byte of data from the MAX30102, followed by a STOP condition.

Write Data Format

For the write operation, send the slave ID as the first byte followed by the register address byte and then one or more data bytes. The register address pointer increments automatically after each byte of data received, so for example the entire register bank can be written by at one time. Terminate the data transfer with a STOP condition. The write operation is shown in [Figure 9](#).

The internal register address pointer increments automatically, so writing additional data bytes fill the data registers in order.

Table 17. Slave ID Description

B7	B6	B5	B4	B3	B2	B1	B0	WRITE ADDRESS	READ ADDRESS
1	0	1	0	1	1	1	R/W	0xAE	0xAF

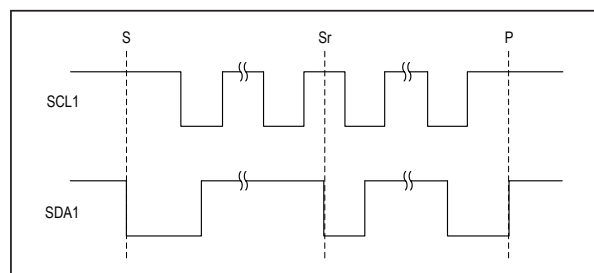


Figure 7. START, STOP, and REPEATED START Conditions

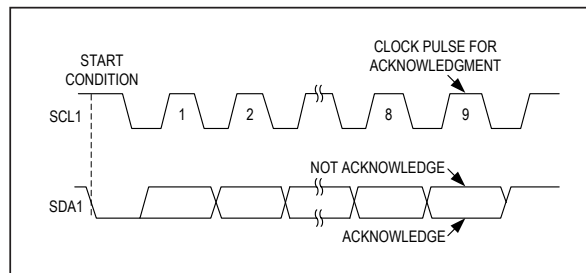


Figure 8. Acknowledge

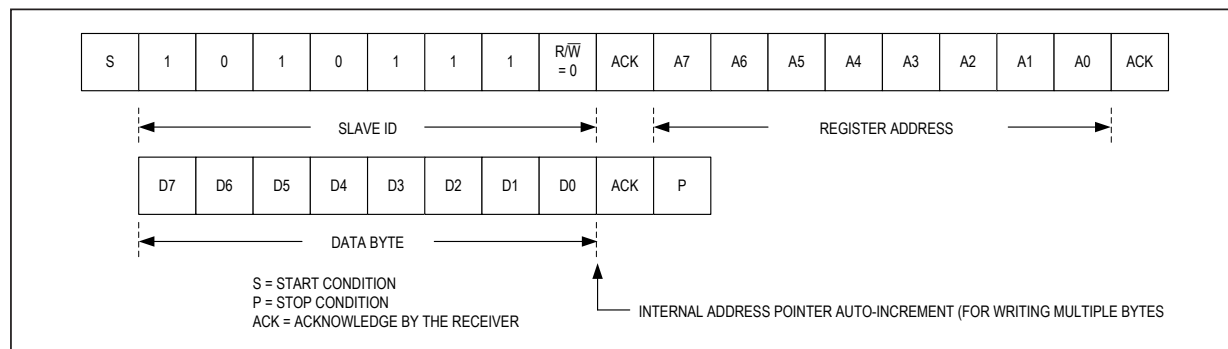


Figure 9. Writing One Data Byte to the MAX30102

Read Data Format

For the read operation, two I²C operations must be performed. First, the slave ID byte is sent followed by the I²C register that you wish to read. Then a REPEAT START (Sr) condition is sent, followed by the read slave ID. The MAX30102 then begins sending data beginning with the register selected in the first operation. The read pointer increments automatically, so the device continues sending data from additional registers in sequential order until a STOP (P) condition is received. The exception to this is the FIFO_DATA register, at which the read pointer no longer increments when reading additional bytes. To

read the next register after FIFO_DATA, an I²C write command is necessary to change the location of the read pointer.

Figure 10 and Figure 11 show the process of reading one byte and multiple bytes of data.

An initial write operation is required to send the read register address.

Data is sent from registers in sequential order, starting from the register selected in the initial I²C write operation. If the FIFO_DATA register is read, the read pointer will not automatically increment, and subsequent bytes of data will contain the contents of the FIFO.

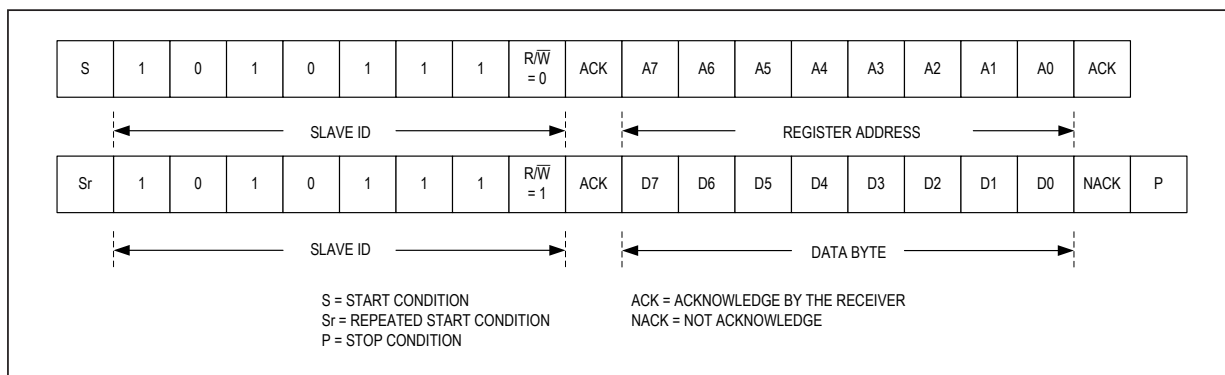


Figure 10. Reading One Byte of Data from MAX30102

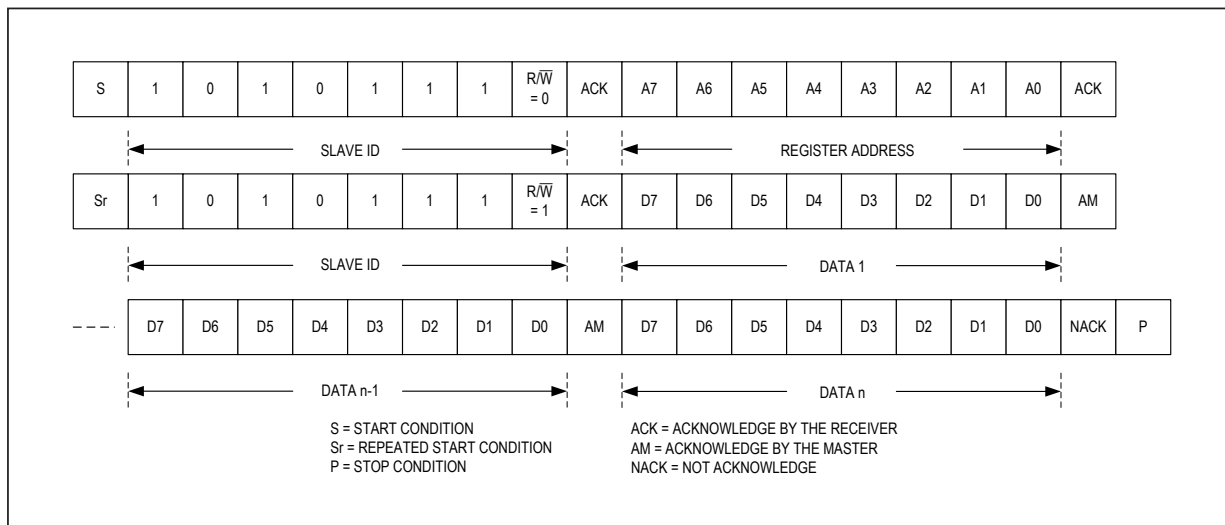
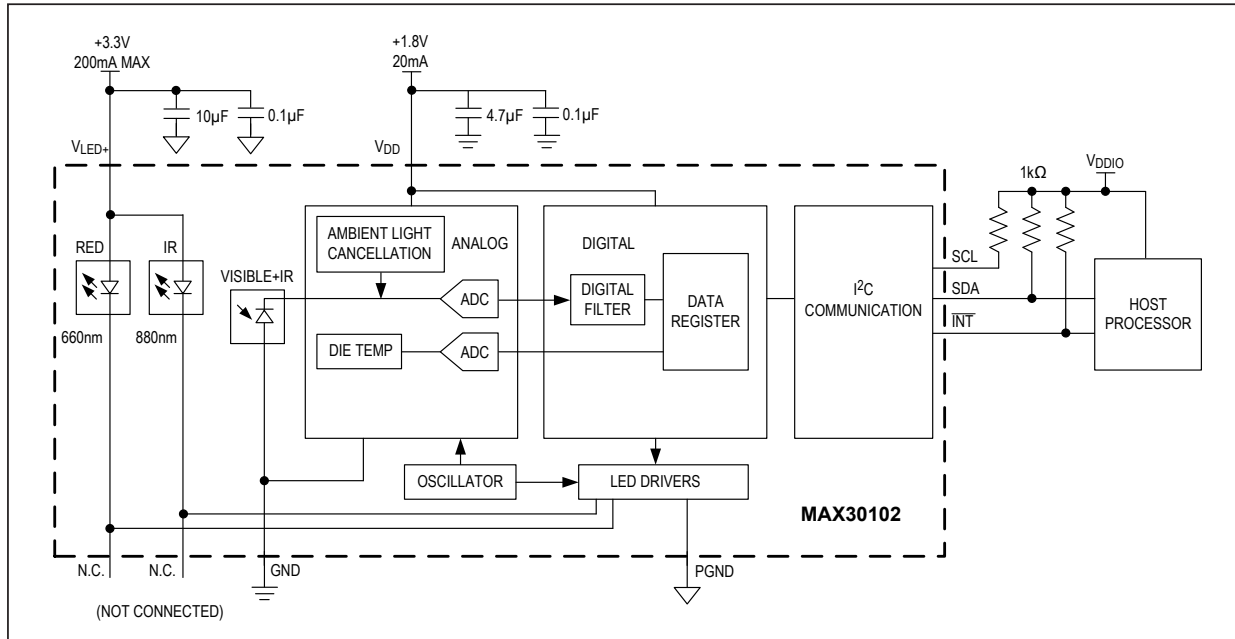


Figure 11. Reading Multiple Bytes of Data from the MAX30102

Typical Application Circuit



Ordering Information

PART	TEMP RANGE	PIN-PACKAGE
MAX30102EFD+T	-40°C to +85°C	14-Lead OESIP (0.8mm Pin Pitch)

+Denotes lead(Pb)-free/RoHS-compliant package.

T = Tape and reel.

Revision History

REVISION NUMBER	REVISION DATE	DESCRIPTION	PAGES CHANGED
0	9/15	Initial release	—
1	10/18	Updated the <i>General Description</i> , <i>Applications</i> , <i>Absolute Maximum Ratings</i> , <i>Electrical Characteristics</i> , <i>Pin Description</i> , <i>Timing in SpO₂ Mode</i> , <i>Power-Up Sequencing</i> sections; updated the <i>System Diagram</i> , <i>Pin Configuration</i> , and <i>Functional Diagram</i> ; updated the <i>Register Map</i> , Interrupt Status (0x00–0x01), Interrupt Enable (0x02–0x03), FIFO (0x04–0x07), LED Pulse Amplitude (0x0C–0x0D), Table 8, Multi-LED Mode Control Registers (0x11–0x12), Table 9, Temperature Data (0x1F–0x21), Table 13, Table 15, Table 16; replaced the <i>Typical Application Circuit</i> ; removed the <i>Proximity Function</i> section and the Proximity Mode Interrupt Threshold (0x30) register	1–5, 8–14, 18 20–24, 26–28, 31

For pricing, delivery, and ordering information, please visit Maxim Integrated's online storefront at <https://www.maximintegrated.com/en/storefront/storefront.html>.

Maxim Integrated cannot assume responsibility for use of any circuitry other than circuitry entirely embodied in a Maxim Integrated product. No circuit patent licenses are implied. Maxim Integrated reserves the right to change the circuitry and specifications without notice at any time. The parametric values (min and max limits) shown in the Electrical Characteristics table are guaranteed. Other parametric values quoted in this data sheet are provided for guidance.

NCP612, NCV612

Voltage Regulator - CMOS, Low Iq, SC70-5

100 mA

The NCP612/NCV612 series of fixed output linear regulators are designed for handheld communication equipment and portable battery powered applications which require low quiescent. The NCP612/NCV612 series features an ultra-low quiescent current of 40 μ A. Each device contains a voltage reference unit, an error amplifier, a PMOS power transistor, resistors for setting output voltage, current limit, and temperature limit protection circuits.

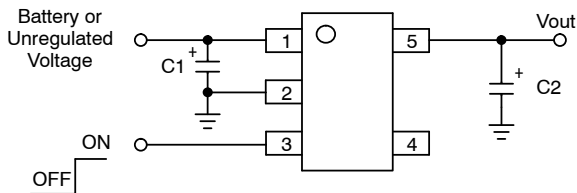
The NCP612/NCV612 has been designed to be used with low cost ceramic capacitors. The device is housed in the micro-miniature SC70-5 surface mount package. Standard voltage versions are 1.5, 1.8, 2.5, 2.7, 2.8, 3.0, 3.1, 3.3, 3.7, and 5.0 V.

Features

- Low Quiescent Current of 40 μ A Typical
- Low Dropout Voltage of 230 mV at 100 mA and 3.0 V V_{out}
- Low Output Voltage Option
- Output Voltage Accuracy of 2.0%
- Temperature Range of -40°C to 85°C (NCP612)
Temperature Range of -40°C to 125°C (NCV612)
- NCV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and PPAP Capable
- These are Pb-Free Devices

Typical Applications

- Cellular Phones
- Battery Powered Consumer Products
- Hand-Held Instruments
- Camcorders and Cameras



This device contains 86 active transistors

Figure 1. Typical Application Diagram



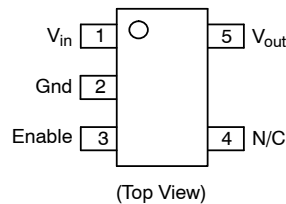
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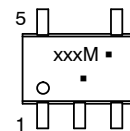


SC70-5
CASE 419A

PIN CONNECTIONS



MARKING DIAGRAM



xxx = Specific Device Code

M = Date Code*

▪ = Pb-Free Package

(Note: Microdot may be in either location)

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 8 of this data sheet.

NCP612, NCV612

PIN FUNCTION DESCRIPTION

Pin No.	Pin Name	Description
1	V _{in}	Positive power supply input voltage.
2	Gnd	Power supply ground.
3	Enable	This input is used to place the device into low-power standby. When this input is pulled low, the device is disabled. If this function is not used, Enable should be connected to V _{in} .
4	N/C	No internal connection.
5	V _{out}	Regulated output voltage.

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Input Voltage	V _{in}	0 to 6.0	V
Enable Voltage	Enable	-0.3 to V _{in} +0.3	V
Output Voltage	V _{out}	-0.3 to V _{in} +0.3	V
Power Dissipation and Thermal Characteristics Power Dissipation Thermal Resistance, Junction-to-Ambient	P _D R _{θJA}	Internally Limited 300	W °C/W
Operating Junction Temperature	T _J	+150	°C
Operating Ambient Temperature	T _A	-40 to +125	°C
Storage Temperature	T _{stg}	-55 to +150	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

- This device series contains ESD protection and exceeds the following tests:
Human Body Model 2000 V per MIL-STD-883, Method 3015
Machine Model Method 200 V
- Latch-up capability (85°C) ±200 mA DC with trigger voltage.

ELECTRICAL CHARACTERISTICS

(V_{in} = V_{out(nom.)} + 1.0 V, V_{enable} = V_{in}, C_{in} = 1.0 μF, C_{out} = 1.0 μF, T_J = 25°C, unless otherwise noted.)

Characteristic	Symbol	Min	Typ	Max	Unit
Output Voltage (T _A = 25°C, I _{out} = 10 mA)	V _{out}				V
1.5 V		1.455	1.5	1.545	
1.8 V		1.746	1.8	1.854	
2.5 V		2.425	2.5	2.575	
2.7 V		2.646	2.7	2.754	
2.8 V		2.744	2.8	2.856	
3.0 V		2.940	3.0	3.060	
3.1 V		3.038	3.1	3.162	
3.3 V		3.234	3.3	3.366	
3.7 V		3.626	3.7	3.774	
5.0 V		4.900	5.0	5.100	
Output Voltage (T _A = -40°C to 85°C, I _{out} = 10 mA)	V _{out}				V
1.5 V		1.455	1.5	1.545	
1.8 V		1.746	1.8	1.854	
2.5 V		2.425	2.5	2.575	
2.7 V		2.619	2.7	2.781	
2.8 V		2.716	2.8	2.884	
3.0 V		2.910	3.0	3.090	
3.1 V		3.007	3.1	3.193	
3.3 V		3.201	3.3	3.399	
3.7 V		3.626	3.7	3.774	
5.0 V		4.900	5.0	5.100	

NCP612, NCV612

ELECTRICAL CHARACTERISTICS (continued)

($V_{in} = V_{out(nom.)} + 1.0\text{ V}$, $V_{enable} = V_{in}$, $C_{in} = 1.0\ \mu\text{F}$, $C_{out} = 1.0\ \mu\text{F}$, $T_J = 25^\circ\text{C}$, unless otherwise noted.)

Characteristic	Symbol	Min	Typ	Max	Unit
Output Voltage ($T_A = -40^\circ\text{C}$ to 125°C , $I_{out} = 10\text{ mA}$) NCV612 Only 1.5 V 1.8 V 2.5 V 2.7 V 2.8 V 3.0 V 3.1 V 3.3 V 5.0 V	V_{out}	1.440 1.728 2.400 2.592 2.688 2.880 2.976 3.201 4.850	1.5 1.8 2.5 2.7 2.8 3.0 3.1 3.3 5.0	1.560 1.872 2.600 2.808 2.912 3.120 3.224 3.399 5.150	V
Output Voltage ($T_A = -40^\circ\text{C}$ to 85°C , $I_{out} = 100\text{ mA}$) 1.5 V 1.8 V 2.5 V 2.7 V 2.8 V 3.0 V 3.1 V 3.3 V 3.7 V 5.0 V	V_{out}	1.440 1.728 2.400 2.592 2.688 2.880 2.976 3.201 3.589 4.850	1.5 1.8 2.5 2.7 2.8 3.0 3.1 3.3 3.7 5.0	1.560 1.872 2.600 2.808 2.912 3.120 3.224 3.399 3.811 5.150	V
Line Regulation ($I_{out} = 10\text{ mA}$) 1.5 V–4.4 V ($V_{in} = V_{out(nom.)} + 1.0\text{ V}$ to 6.0 V) 4.5 V–5.0 V ($V_{in} = 5.5\text{ V}$ to 6.0 V)	Reg_{line}	– –	1.0 1.0	3.0 3.0	mV/V
Load Regulation ($I_{out} = 1.0\text{ mA}$ to 100 mA)	Reg_{load}	–	0.3	0.8	mV/mA
Output Current ($V_{out} = (V_{out} \text{ at } I_{out} = 100\text{ mA}) - 3\%$) 1.5 V–3.9 V ($V_{in} = V_{out(nom.)} + 2.0\text{ V}$) 4.0 V–5.0 V ($V_{in} = 6.0\text{ V}$)	$I_{o(nom.)}$	100 100	200 200	– –	mA
Dropout Voltage ($T_A = -40^\circ\text{C}$ to 85°C , $I_{out} = 100\text{ mA}$, Measured at $V_{out(nom.)} - 3.0\%$) 1.5 V 1.8 V 2.5 V 2.7 V 2.8 V 3.0 V 3.1 V 3.3 V 3.7 V 5.0 V	$V_{in} - V_{out}$	– – – – – – – – – –	530 420 270 270 250 230 210 200 180 160	680 560 380 380 380 380 380 380 380 300	mV
Ground Current (Enable Input = V_{in} , $I_{out} = 1.0\text{ mA}$ to $I_{o(nom.)}$)	I_{GND}	–	40	90	μA
Quiescent Current ($T_A = -40^\circ\text{C}$ to 85°C) (Enable Input = 0 V) (Enable Input = V_{in} , $I_{out} = 1.0\text{ mA}$ to $I_{o(nom.)}$)	I_Q	– –	0.03 40	1.0 90	μA
Output Short Circuit Current ($V_{out} = 0\text{ V}$) 1.5 V–3.9 V ($V_{in} = V_{out(nom.)} + 2.0\text{ V}$) 4.0 V–5.0 V ($V_{in} = 6.0\text{ V}$)	$I_{out(max)}$	150 150	300 300	600 600	mA
Output Voltage Noise ($f = 100\text{ Hz}$ to 100 kHz) $I_{out} = 30\text{ mA}$, $C_{out} = 1\ \mu\text{F}$	V_n	–	100	–	μV_{rms}
Enable Input Threshold Voltage (Voltage Increasing, Output Turns On, Logic High) (Voltage Decreasing, Output Turns Off, Logic Low)	$V_{th(en)}$	0.95 –	– –	– 0.3	V
Output Voltage Temperature Coefficient	T_C	–	± 100	–	ppm/ $^\circ\text{C}$

3. Maximum package power dissipation limits must be observed.

$$PD = \frac{T_J(max) - T_A}{R_{\theta JA}}$$

4. Low duty cycle pulse techniques are used during testing to maintain the junction temperature as close to ambient as possible.

NCP612, NCV612

TYPICAL CHARACTERISTICS

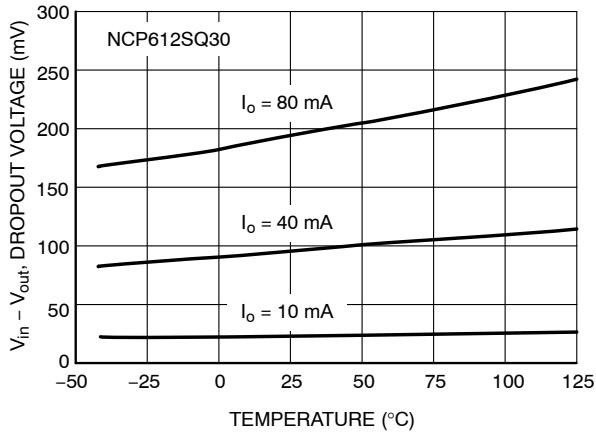


Figure 2. Dropout Voltage vs. Temperature

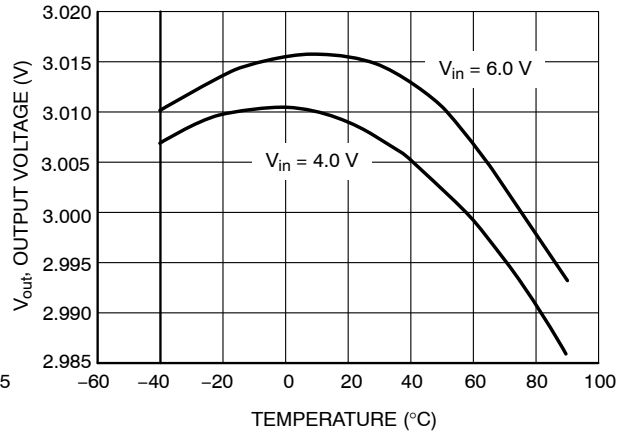


Figure 3. Output Voltage vs. Temperature

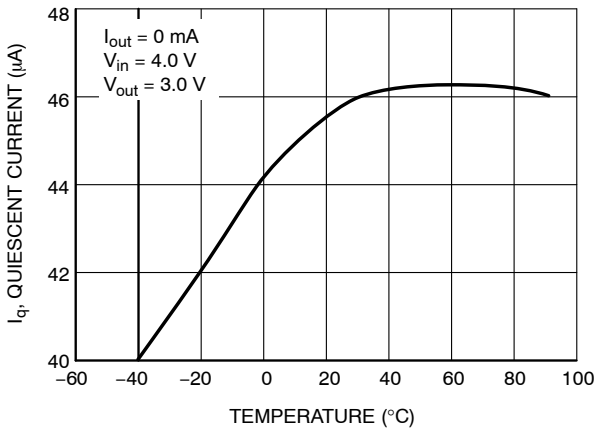


Figure 4. Quiescent Current vs. Temperature

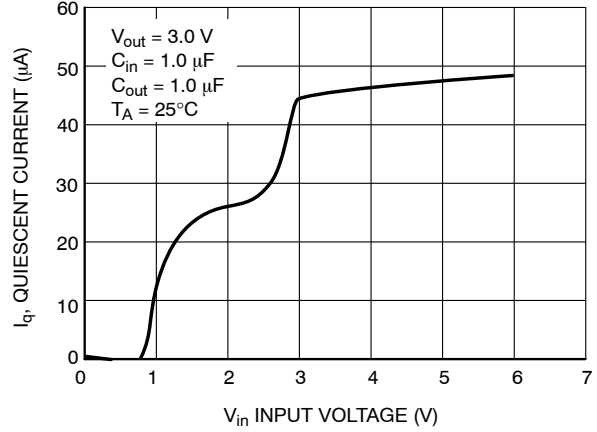


Figure 5. Quiescent Current vs. Input Voltage

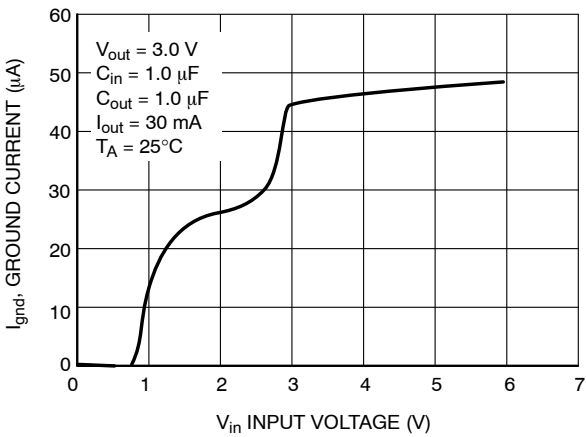


Figure 6. Ground Pin Current vs. Input Voltage

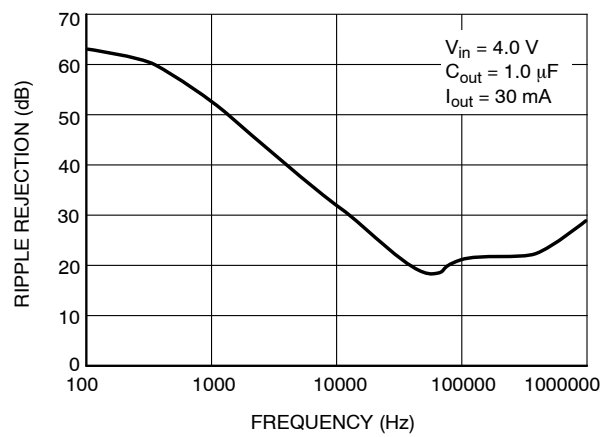


Figure 7. Ripple Rejection vs. Frequency

NCP612, NCV612

TYPICAL CHARACTERISTICS

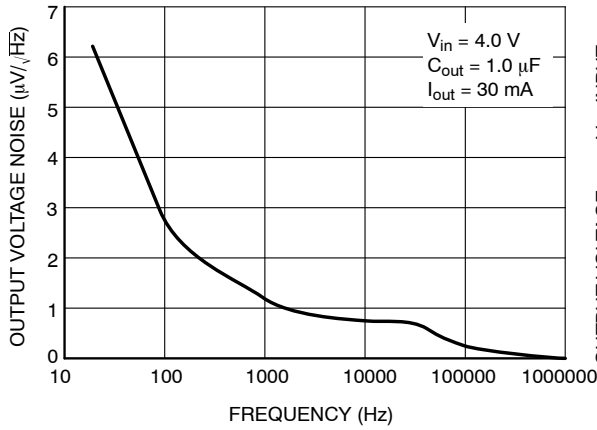


Figure 8. Output Noise Density

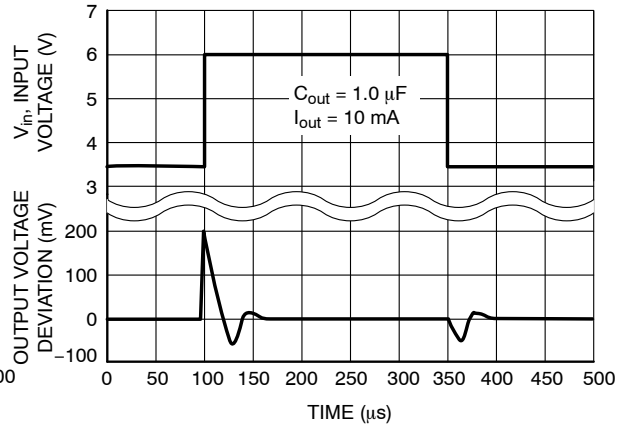


Figure 9. Line Transient Response

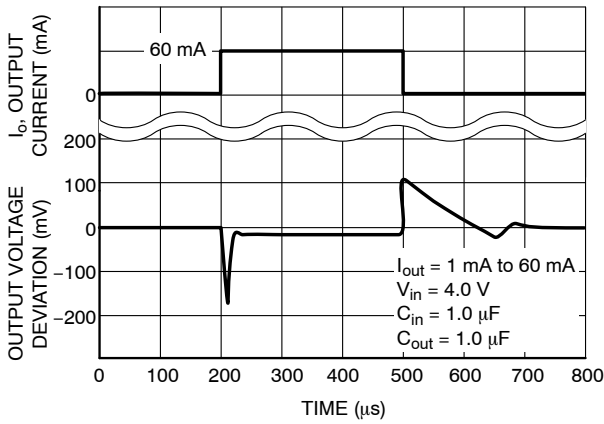


Figure 10. Load Transient Response

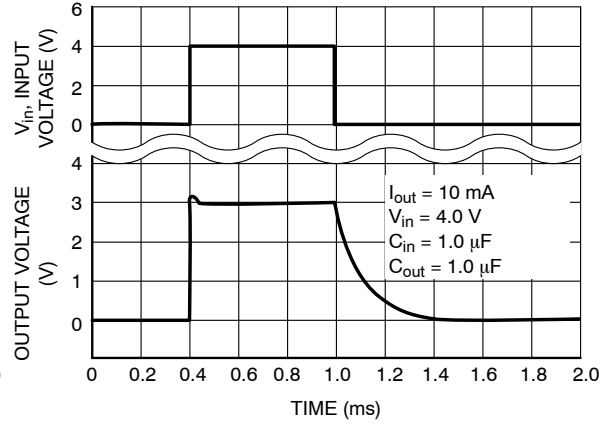


Figure 11. Turn-on Response

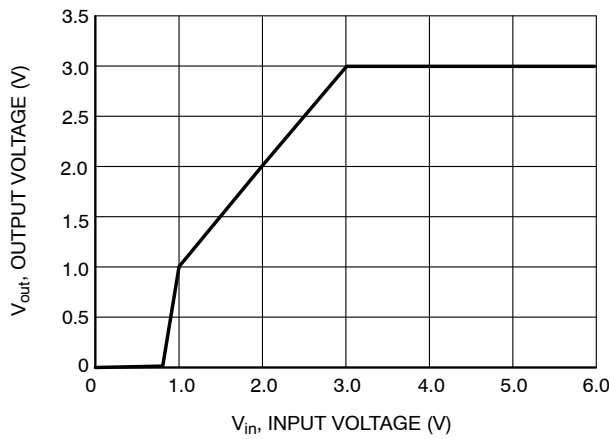


Figure 12. Output Voltage vs. Input Voltage

NCP612, NCV612

DEFINITIONS

Load Regulation

The change in output voltage for a change in output current at a constant temperature.

Dropout Voltage

The input/output differential at which the regulator output no longer maintains regulation against further reductions in input voltage. Measured when the output drops 3.0% below its nominal. The junction temperature, load current, and minimum input supply requirements affect the dropout level.

Maximum Power Dissipation

The maximum total dissipation for which the regulator will operate within its specifications.

Quiescent Current

The quiescent current is the current which flows through the ground when the LDO operates without a load on its output: internal IC operation, bias, etc. When the LDO becomes loaded, this term is called the Ground current. It is actually the difference between the input current (measured through the LDO input pin) and the output current.

Line Regulation

The change in output voltage for a change in input voltage. The measurement is made under conditions of low dissipation or by using pulse technique such that the average chip temperature is not significantly affected.

Line Transient Response

Typical over and undershoot response when input voltage is excited with a given slope.

Thermal Protection

Internal thermal shutdown circuitry is provided to protect the integrated circuit in the event that the maximum junction temperature is exceeded. When activated at typically 160°C, the regulator turns off. This feature is provided to prevent failures from accidental overheating.

Maximum Package Power Dissipation

The maximum power package dissipation is the power dissipation level at which the junction temperature reaches its maximum operating value, i.e. 150°C. Depending on the ambient power dissipation and thus the maximum available output current.

NCP612, NCV612

APPLICATIONS INFORMATION

A typical application circuit for the NCP612/NCV612 is shown in Figure 1, front page.

Input Decoupling (C1)

A 1.0 μF capacitor either ceramic or tantalum is recommended and should be connected close to the NCP612/NCV612 package. Higher values and lower ESR will improve the overall line transient response.

TDK capacitor: C2012X5R1C105K, or C1608X5R1A105K

Output Decoupling (C2)

The NCP612/NCV612 is a stable regulator and does not require any specific Equivalent Series Resistance (ESR) or a minimum output current. Capacitors exhibiting ESRs ranging from a few $\text{m}\Omega$ up to 5.0Ω can thus safely be used. The minimum decoupling value is $1.0 \mu\text{F}$ and can be augmented to fulfill stringent load transient requirements. The regulator accepts ceramic chip capacitors as well as tantalum capacitors. Larger values improve noise rejection and load regulation transient response.

TDK capacitor: C2012X5R1C105K, C1608X5R1A105K, or C3216X7R1C105K

Enable Operation

The enable pin will turn on the regulator when pulled high and turn off the regulator when pulled low. These limits of threshold are covered in the electrical specification section of this data sheet. If the enable is not used then the pin should be connected to V_{in} .

Hints

Please be sure the V_{in} and Gnd lines are sufficiently wide. When the impedance of these lines is high, there is a chance to pick up noise or cause the regulator to malfunction.

Set external components, especially the output capacitor, as close as possible to the circuit, and make leads as short as possible.

Thermal

As power across the NCP612/NCV612 increases, it might become necessary to provide some thermal relief. The maximum power dissipation supported by the device is dependent upon board design and layout. Mounting pad configuration on the PCB, the board material and also the ambient temperature effect the rate of temperature rise for the part. This is stating that when the NCP612/NCV612 has good thermal conductivity through the PCB, the junction temperature will be relatively low with high power dissipation applications.

The maximum dissipation the package can handle is given by:

$$P_D = \frac{T_J(\text{max}) - T_A}{R_{\theta JA}}$$

If junction temperature is not allowed above the maximum 125°C , then the NCP612/NCV612 can dissipate up to 330 mW @ 25°C .

The power dissipated by the NCP612/NCV612 can be calculated from the following equation:

$$P_{\text{tot}} = [V_{\text{in}} * I_{\text{gnd}}(\text{lout})] + [V_{\text{in}} - V_{\text{out}}] * I_{\text{out}}$$

or

$$V_{\text{inMAX}} = \frac{P_{\text{tot}} + V_{\text{out}} * I_{\text{out}}}{I_{\text{gnd}} + I_{\text{out}}}$$

If an 100 mA output current is needed then the ground current from the data sheet is $40 \mu\text{A}$. For an NCP612/NCV612 (3.0 V), the maximum input voltage will then be 6.0 V (Limited by maximum input voltage).

NCP612, NCV612

ORDERING INFORMATION

Device	Nominal Output Voltage	Marking	Package	Shipping [†]
NCP612SQ15T2G	1.5	LHO	SC70-5 (Pb-Free)	3000 Units/Tape & Reel
NCP612SQ18T2G	1.8	LHP		
NCP612SQ25T2G	2.5	LHQ		
NCP612SQ27T2G	2.7	LHR		
NCP612SQ28T2G	2.8	LHS		
NCP612SQ30T2G	3.0	LHT		
NCP612SQ31T2G	3.1	LHU		
NCP612SQ33T2G	3.3	LHV		
NCP612SQ37T2G	3.7	LKH		
NCP612SQ50T2G	5.0	LHW		
NCV612SQ15T2G*	1.5	LHO		
NCV612SQ18T2G*	1.8	LHP		
NCV612SQ25T2G*	2.5	LHQ		
NCV612SQ27T2G*	2.7	LHR		
NCV612SQ28T2G*	2.8	LHS		
NCV612SQ30T2G*	3.0	LHT		
NCV612SQ31T2G*	3.1	LHU		
NCV612SQ33T2G*	3.3	LHV		
NCV612SQ37T2G*	3.7	LKH		
NCV612SQ50T2G*	5.0	LHW		

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

*NCV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and PPAP Capable.

MECHANICAL CASE OUTLINE PACKAGE DIMENSIONS

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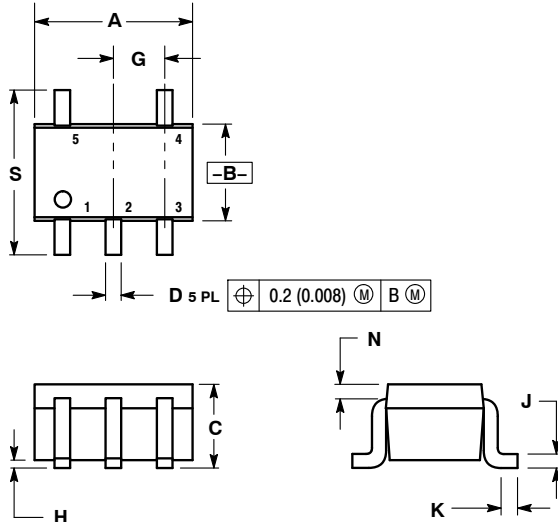


SC-88A (SC-70-5/SOT-353)
CASE 419A-02
ISSUE L

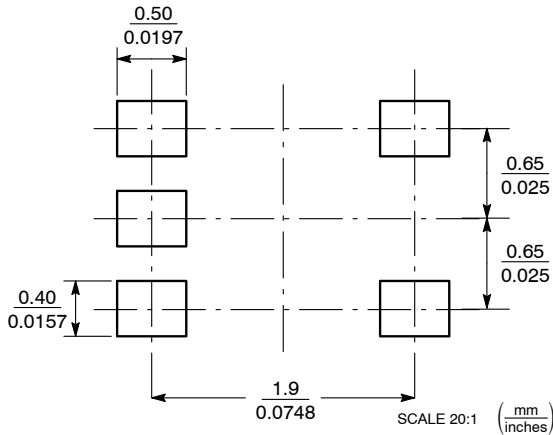


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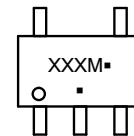


NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. 419A-01 OBSOLETE. NEW STANDARD 419A-02.
4. DIMENSIONS A AND B DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.071	0.087	1.80	2.20
B	0.045	0.053	1.15	1.35
C	0.031	0.043	0.80	1.10
D	0.004	0.012	0.10	0.30
G	0.026 BSC		0.65 BSC	
H	---	0.004	---	0.10
J	0.004	0.010	0.10	0.25
K	0.004	0.012	0.10	0.30
N	0.008 REF		0.20 REF	
S	0.079	0.087	2.00	2.20

GENERIC MARKING DIAGRAM*



- XXX = Specific Device Code
- M = Date Code
- = Pb-Free Package

(Note: Microdot may be in either location)

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "▪", may or may not be present. Some products may not follow the Generic Marking.

STYLE 1:
PIN 1. BASE
2. EMITTER
3. BASE
4. COLLECTOR
5. COLLECTOR

STYLE 2:
PIN 1. ANODE
2. EMITTER
3. BASE
4. COLLECTOR
5. CATHODE

STYLE 3:
PIN 1. ANODE 1
2. N/C
3. ANODE 2
4. CATHODE 2
5. CATHODE 1

STYLE 4:
PIN 1. SOURCE 1
2. DRAIN 1/2
3. SOURCE 1
4. GATE 1
5. GATE 2

STYLE 5:
PIN 1. CATHODE
2. COMMON ANODE
3. CATHODE 2
4. CATHODE 3
5. CATHODE 4

STYLE 6:
PIN 1. EMITTER 2
2. BASE 2
3. EMITTER 1
4. COLLECTOR
5. COLLECTOR 2/BASE 1

STYLE 7:
PIN 1. BASE
2. EMITTER
3. BASE
4. COLLECTOR
5. COLLECTOR


STYLE 8:
PIN 1. CATHODE
2. COLLECTOR
3. N/C
4. BASE
5. EMITTER

STYLE 9:
PIN 1. ANODE
2. CATHODE
3. ANODE
4. ANODE
5. ANODE

Note: Please refer to datasheet for style callout. If style type is not called out in the datasheet refer to the device datasheet pinout or pin assignment.

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[NCV612SQ50T2G](#) [NCV612SQ37T2G](#)

TLV755P 500-mA, Low I_Q , Small Size, Low Dropout Regulator

1 Features

- Input Voltage Range: 1.44 V to 5.5 V
- Available in Fixed-Output Voltages:
 - 0.6 V to 5 V (50-mV Steps)
- Low I_Q : 25 μ A (Typical)
- Low Dropout:
 - 220 mV (Maximum) at 500 mA (3.3 V_{OUT})
- Output Accuracy: 1% (Typical)
- Built-In Soft-Start With Monotonic V_{OUT} Rise
- Foldback Current Limit
- Active Output Discharge
- High PSRR: 45 dB at 100 kHz
- Stable With a 1- μ F Ceramic Output Capacitor
- Packages:
 - 2.9-mm x 1.6-mm SOT-23-5
 - 1-mm x 1-mm X2SON-4
 - 2 mm x 2 mm WSON-6

2 Applications

- Set-Top Boxes, TV, and Gaming Consoles
- Portable and Battery-Powered Equipment
- Desktop, Notebooks, and Ultrabooks
- Tablets and Remote Controls
- White Goods and Appliances
- Grid Infrastructure and Protection Relays
- Camera Modules and Image Sensors

3 Description

The TLV755P low-dropout regulator (LDO) device is an ultra-small, low quiescent current LDO that sources 500 mA with good line and load transient performance. The TLV755P is optimized for a wide variety of applications by supporting an input voltage range from 1.44 V to 5.5 V. To minimize cost and solution size, the device is offered in fixed output voltages ranging from 0.6 V to 5 V to support the lower core voltages of modern microcontroller (MCUs). Additionally, the TLV755 has a low I_Q with enable functionality to minimize standby power. This device features an internal soft-start to lower inrush current, thus providing a controlled voltage to the load and minimizing the input voltage drop during start up. When shutdown, the device actively pulls down the output to quickly discharge the outputs and ensure a known start-up state.

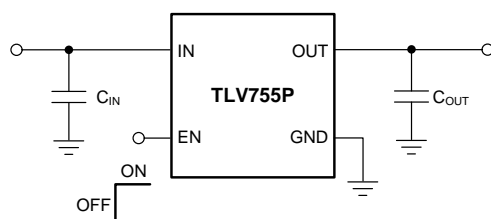
The TLV755P is stable with small ceramic output capacitors allowing for a small overall solution size. A precision band-gap and error amplifier provides a typical accuracy of 1%. All device versions have integrated thermal shutdown, current limit, and undervoltage lockout (UVLO). The TLV755P has an internal foldback current limit that helps reduce the thermal dissipation during short-circuit events.

Device Information⁽¹⁾

PART NUMBER	PACKAGE	BODY SIZE (NOM)
TLV755P	X2SON (4)	1.00 mm x 1.00 mm
	SOT-23 (5)	2.90 mm x 1.60 mm
	SON (6)	2.00 mm x 2.00 mm

(1) For all available packages, see the orderable addendum at the end of the data sheet.

Typical Application



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Startup Waveform

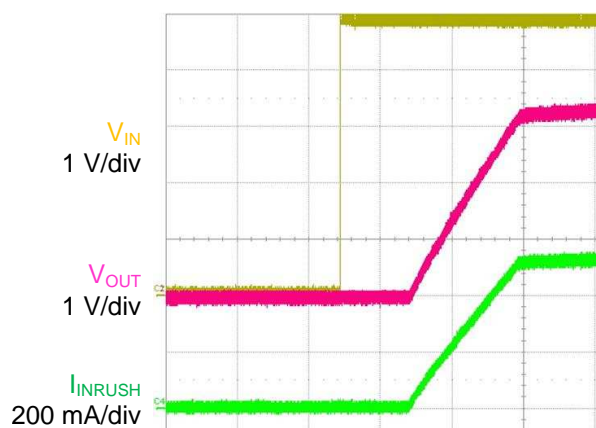


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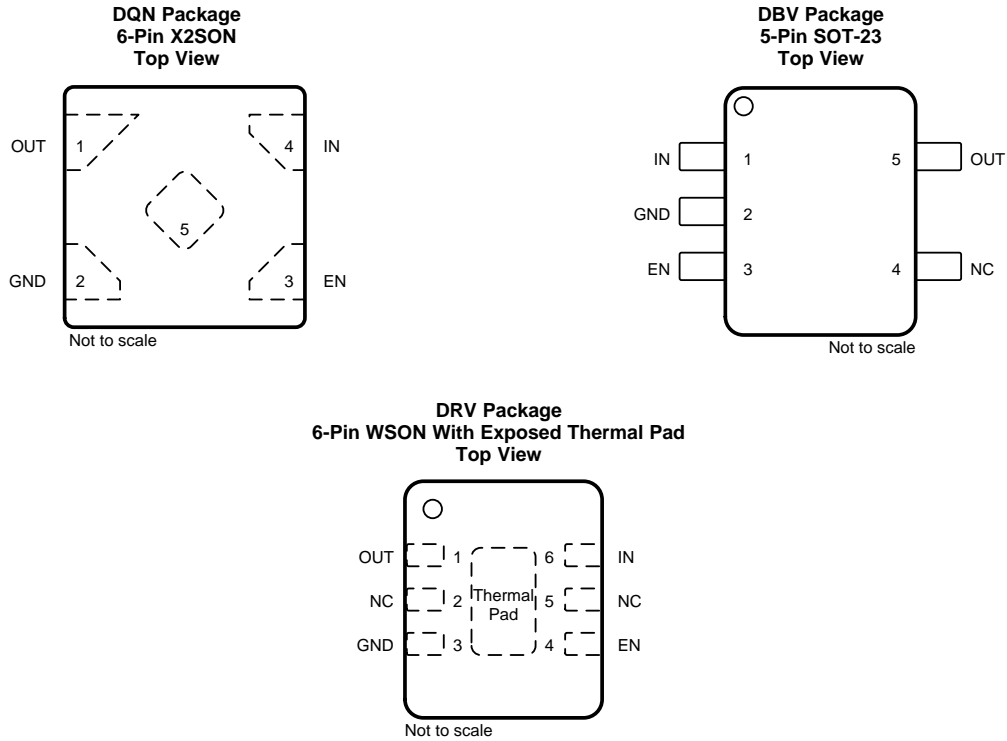
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4 Revision History

DATE	REVISION	NOTES
November 2017	*	Initial release.

ADVANCE INFORMATION

5 Pin Configuration and Functions



NC = no internal connection.

Pin Functions

NAME	PIN			I/O	DESCRIPTION
	DQN	DBV	DRV		
EN	3	3	4	I	Enable pin. Drive EN greater than V_{HI} to turn on the regulator. Drive EN less than V_{LO} to place the LDO into shutdown mode.
GND	2	2	3	—	Ground pin.
IN	4	1	6	I	Input pin. A capacitor with a value of 1 μ F or larger is required from this pin to ground ⁽¹⁾ . See the Input and Output Capacitor Selection section for more information.
NC	—	4	2, 5	—	No internal connection.
OUT	1	5	1	O	Regulated output voltage pin. A capacitor with a value of 1 μ F or larger is required from this pin to ground ⁽¹⁾ . See the Input and Output Capacitor Selection section for more information.
Thermal pad	—	—	Pad	—	Connect the thermal pad to a large-area ground plane. The thermal pad is internally connected to GND.

(1) The nominal input and output capacitance must be greater than 0.47 μ F; throughout this document the nominal derating on these capacitors is 50%. Take care to ensure that the effective capacitance at the pin is greater than 0.47 μ F.

6 Specifications

6.1 Absolute Maximum Ratings

 over operating free-air temperature range (unless otherwise noted)⁽¹⁾

		MIN	MAX	UNIT
Voltage	Supply, V_{IN}	-0.3	6	V
	Enable, V_{EN}	-0.3	6	
	Output, V_{OUT}	-0.3	$V_{IN} + 0.3$ ⁽²⁾	
Temperature	Operating junction, T_J	-40	150	°C
	Storage, T_{stg}	-65	150	

- (1) Stresses beyond those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under *Recommended Operating Conditions*. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) The absolute maximum rating is $V_{IN} + 0.3$ V or 6 V, whichever is smaller.

6.2 ESD Ratings

		VALUE	UNIT
$V_{(ESD)}$	Electrostatic discharge	Human-body model (HBM), per ANSI/ESDA/JEDEC JS-001 ⁽¹⁾	±1000
		Charged-device model (CDM), per JEDEC specification JESD22-C101 ⁽²⁾	±500

- (1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process. Manufacturing with less than 500-V HBM is possible with the necessary precautions.
- (2) JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process. Manufacturing with less than 250-V CDM is possible with the necessary precautions.

6.3 Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted)

		MIN	NOM	MAX	UNIT
C_{IN}	Input capacitor	1			µF
C_{OUT}	Output capacitor	1		200	µF
V_{IN}	Input voltage	1.44		5.5	V
V_{OUT}	Output voltage	0.6		5	V
I_{OUT}	Output current	0		500	mA
V_{EN}	Enable voltage	0		5.5	V
f_{EN}	Enable toggle frequency			10	kHz
T_J	Junction temperature	-40		125	°C

6.4 Thermal Information

THERMAL METRIC ⁽¹⁾		TLV755P			UNIT
		DQN (X2SON)	DBV (SOT-23)	DRV (WSON)	
		4 PINS	5 PINS	6 PINS	
$R_{\theta JA}$	Junction-to-ambient thermal resistance	168.4	231.1	100.2	°C/W
$R_{\theta JC(top)}$	Junction-to-case (top) thermal resistance	139.1	118.4	108.5	°C/W
$R_{\theta JB}$	Junction-to-board thermal resistance	101.4	64.4	64.3	°C/W
Ψ_{JT}	Junction-to-top characterization parameter	5.6	28.4	10.4	°C/W
Ψ_{JB}	Junction-to-board characterization parameter	101.7	63.8	64.8	°C/W
$R_{\theta JC(bot)}$	Junction-to-case (bottom) thermal resistance	88.4	N/A	34.7	°C/W

- (1) For more information about traditional and new thermal metrics, see the [Semiconductor and IC Package Thermal Metrics](#) application report.

6.5 Electrical Characteristics

over operating free-air temperature range ($T_J = -40^\circ\text{C}$ to $+125^\circ\text{C}$), $V_{IN} = V_{OUT} + 0.5\text{ V}$ or 1.44 V (whichever is greater), $I_{OUT} = 1\text{ mA}$, $V_{EN} = V_{IN}$, and $C_{IN} = C_{OUT} = 1\ \mu\text{F}$ (unless otherwise noted); all typical values are at $T_J = 25^\circ\text{C}$

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT			
V_{IN}	Input voltage	1.44		5.5	V			
V_{OUT}	Output voltage	0.6		5	V			
Output accuracy	$T_J = 25^\circ\text{C}$	-1%		1%				
	$-40^\circ\text{C} \leq T_J \leq +85^\circ\text{C}$, $V_{OUT} \geq 1\text{ V}$	-1%		1%				
	$-40^\circ\text{C} \leq T_J \leq +85^\circ\text{C}$, $0.6\text{ V} \leq V_{OUT} < 1\text{ V}$	-10		10	mV			
	$V_{OUT} \geq 1\text{ V}$	-1.5%		1.5%				
	$0.6\text{ V} \leq V_{OUT} < 1\text{ V}$	-15		15	mV			
$(\Delta V_{OUT})_{\Delta V_{IN}} / V_{OUT}$	Line regulation $V_{OUT} + 0.5\text{ V}^{(1)} \leq V_{IN} \leq 5.5\text{ V}$	$V_{OUT} > 1.5\text{ V}$	0.01%					
$\Delta V_{OUT} / \Delta I_{OUT}$	Load regulation $0.1\text{ mA} \leq I_{OUT} \leq 500\text{ mA}$, $V_{IN} \geq 2.4\text{ V}$	DQN package	0.018		V/A			
		DBV package	0.030					
		DRV package	0.022					
I_{GND}	Ground current $T_J = 25^\circ\text{C}$, $I_{OUT} = 0\text{ mA}$	$-40^\circ\text{C} \leq T_J \leq +85^\circ\text{C}$, $I_{OUT} = 0\text{ mA}$	14	25	31	μA		
		$-40^\circ\text{C} \leq T_J \leq +125^\circ\text{C}$, $I_{OUT} = 0\text{ mA}$			40			
I_{SHDN}	Shutdown current $V_{EN} = 0\text{ V}$, $1.44\text{ V} \leq V_{IN} \leq 5.5\text{ V}$, $-40^\circ\text{C} \leq T_J \leq +125^\circ\text{C}$		0.1	1	μA			
I_{CL}	Output current limit $V_{IN} = V_{OUT} + V_{DO(MAX)} + 0.25\text{ V}$	$V_{OUT} = V_{OUT} - 0.2\text{ V}$, $V_{OUT} \leq 1.5\text{ V}$	600	720	865	mA		
		$V_{OUT} = 0.9 \times V_{OUT}$, $1.5\text{ V} < V_{OUT} \leq 4.5\text{ V}$	600	720	865			
I_{SC}	Short-circuit current limit $V_{OUT} = 0\text{ V}$		355		mA			
V_{DO}	Dropout voltage ⁽²⁾	$I_{OUT} = 500\text{ mA}$, $-40^\circ\text{C} \leq T_J \leq +85^\circ\text{C}$	$0.6\text{ V} \leq V_{OUT} < 0.8\text{ V}$		675	700	mV	
			$0.8\text{ V} \leq V_{OUT} < 1\text{ V}$		600	650		
			$1\text{ V} \leq V_{OUT} < 1.2\text{ V}$		550	575		
			$1.2\text{ V} \leq V_{OUT} < 1.5\text{ V}$		500	525		
			$1.5\text{ V} \leq V_{OUT} < 1.8\text{ V}$		350	400		
			$1.8\text{ V} \leq V_{OUT} < 2.5\text{ V}$		325	375		
			$2.5\text{ V} \leq V_{OUT} < 3.3\text{ V}$		250	300		
			$3.3\text{ V} \leq V_{OUT} \leq 5.0\text{ V}$		150	212		
		$I_{OUT} = 500\text{ mA}$, $-40^\circ\text{C} \leq T_J \leq +125^\circ\text{C}$	$0.6\text{ V} \leq V_{OUT} < 0.8\text{ V}$			725		
			$0.8\text{ V} \leq V_{OUT} < 1\text{ V}$			675		
			$1\text{ V} \leq V_{OUT} < 1.2\text{ V}$			600		
			$1.2\text{ V} \leq V_{OUT} < 1.5\text{ V}$			550		
			$1.5\text{ V} \leq V_{OUT} < 1.8\text{ V}$			425		
			$1.8\text{ V} \leq V_{OUT} < 2.5\text{ V}$			400		
			$2.5\text{ V} \leq V_{OUT} < 3.3\text{ V}$			325		
			$3.3\text{ V} \leq V_{OUT} \leq 5.0\text{ V}$			238		
PSRR	Power-supply rejection ratio	$f = 1\text{ kHz}$, $V_{IN} = V_{OUT} + 1\text{ V}$, $I_{OUT} = 50\text{ mA}$		52		dB		
		$f = 100\text{ kHz}$, $V_{IN} = V_{OUT} + 1\text{ V}$, $I_{OUT} = 50\text{ mA}$		46				
		$f = 1\text{ MHz}$, $V_{IN} = V_{OUT} + 1\text{ V}$, $I_{OUT} = 50\text{ mA}$		52				
V_n	Output noise voltage $BW = 10\text{ Hz to } 100\text{ kHz}$, $V_{OUT} = 1.2\text{ V}$, $I_{OUT} = 50\text{ mA}$		71.5		μV_{RMS}			
V_{UVLO}	Undervoltage lockout V_{IN} rising	1.21	1.3	1.44	V			
$V_{UVLO, HYST}$	Undervoltage lockout hysteresis V_{IN} falling		40		mV			

(1) $V_{IN} = 1.44\text{ V}$ for $V_{OUT} < 0.9\text{ V}$.

(2) Dropout is measured when V_{OUT} is 5% below $V_{OUT(NOM)}$.

Electrical Characteristics (continued)

over operating free-air temperature range ($T_J = -40^{\circ}\text{C}$ to $+125^{\circ}\text{C}$), $V_{IN} = V_{OUT} + 0.5\text{ V}$ or 1.44 V (whichever is greater), $I_{OUT} = 1\text{ mA}$, $V_{EN} = V_{IN}$, and $C_{IN} = C_{OUT} = 1\text{ }\mu\text{F}$ (unless otherwise noted); all typical values are at $T_J = 25^{\circ}\text{C}$

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
t_{STR}	Startup time Time from EN assertion to $0.95 \times V_{OUT}$		400		μs
V_{HI}	EN pin high voltage (enabled)	0.9			V
V_{LO}	EN pin low voltage (enabled)			0.4	V
I_{EN}	Enable pin current EN = 5.5 V, $V_{IN} = 5.5\text{ V}$		10		nA
$R_{PULLDOWN}$	Pulldown resistance $V_{IN} = 3.3\text{ V}$		120		Ω
T_{SD}	Thermal shutdown Shutdown, temperature increasing		165		$^{\circ}\text{C}$
	Reset, temperature decreasing		155		

ADVANCE INFORMATION

6.6 Typical Characteristics

at operating temperature $T_J = 25^\circ\text{C}$, $V_{IN} = V_{OUT(NOM)} + 0.5\text{ V}$ or 1.4 V (whichever is greater), $I_{OUT} = 1\text{ mA}$, $V_{EN} = V_{IN}$, and $C_{IN} = C_{OUT} = 1\text{ }\mu\text{F}$ (unless otherwise noted)

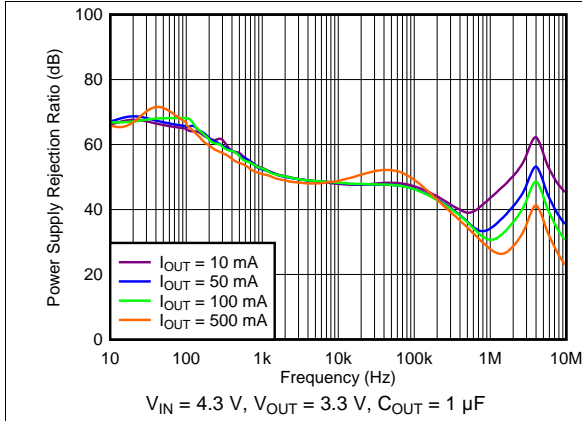


Figure 1. PSRR vs Frequency and I_{OUT}

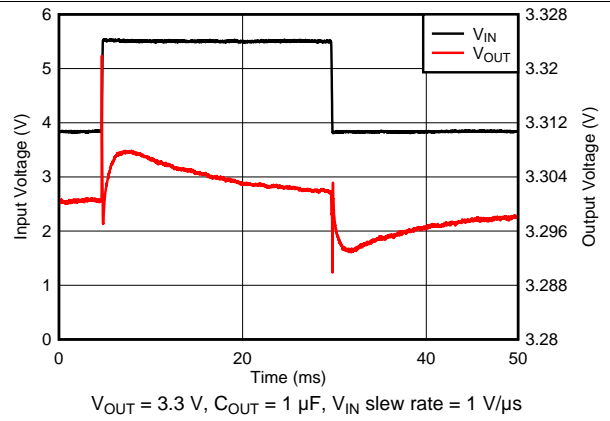


Figure 2. Line Transient

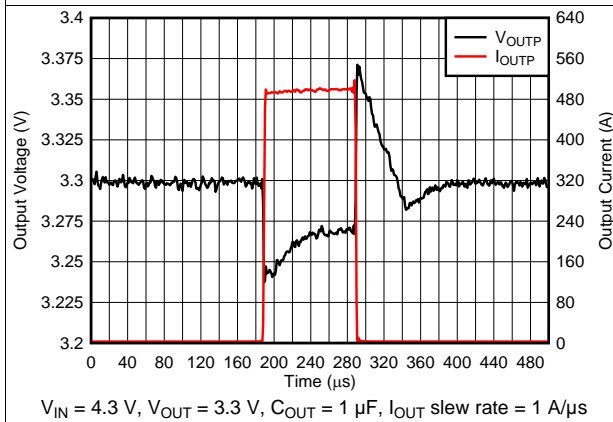


Figure 3. 1-mA to 500-mA Load Transient

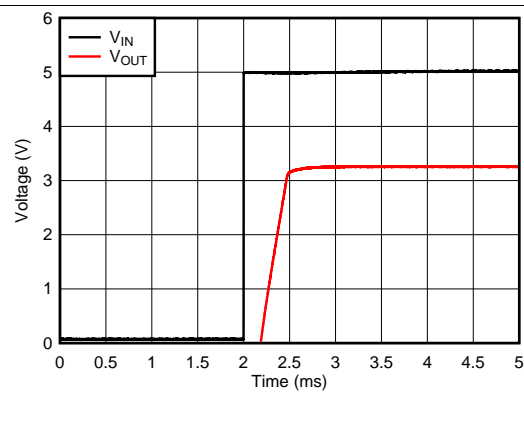


Figure 4. $V_{IN} = V_{EN}$ Power-Up

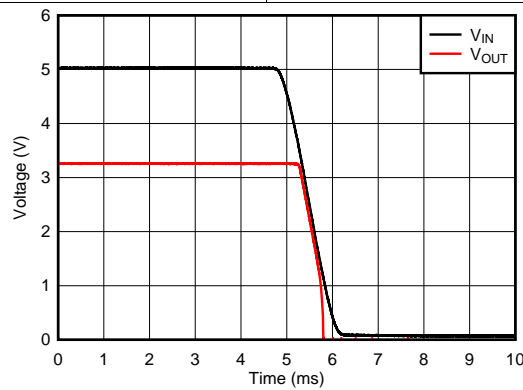


Figure 5. $V_{IN} = V_{EN}$ Shutdown

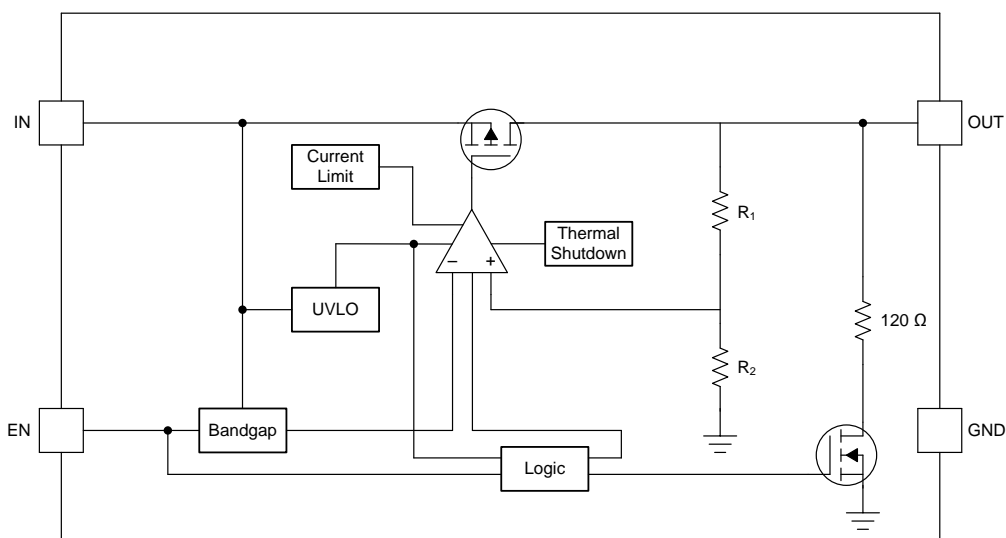
7 Detailed Description

7.1 Overview

The TLV755P belongs to a family of next-generation, low-dropout regulators (LDOs). This device consumes low quiescent current and delivers excellent line and load transient performance. The TLV755P is optimized for a wide variety of applications by supporting an input voltage range from 1.4 V to 5.5 V. To minimize cost and solution size, the device is offered in fixed output voltages ranging from 0.6 V to 5 V to support the lower core voltages of modern MCUs.

This regulator offers foldback current limit, shutdown, and thermal protection. The operating junction temperature is -40°C to $+125^{\circ}\text{C}$.

7.2 Functional Block Diagram



NOTE: $R_1 + R_2 = \text{TBD}$.

7.3 Feature Description

7.3.1 Undervoltage Lockout (UVLO)

An undervoltage lockout (UVLO) circuit disables the output until the input voltage is greater than the rising UVLO voltage (V_{UVLO}). This circuit ensures that the device does not exhibit any unpredictable behavior when the supply voltage is lower than the operational range of the internal circuitry. When V_{IN} is less than V_{UVLO} , the output is connected to ground with a 120- Ω pull-down resistor.

7.3.2 Enable (EN)

The enable pin (EN) is active high. Enable the device by forcing the EN pin to exceed V_{HI} . Turn off the device by forcing the EN pin below V_{LO} . If shutdown capability is not required, connect EN to IN.

The device has an internal pull-down resistor that connects a 120- Ω resistor to ground when the device is disabled. The discharge time after disabling depends on the output capacitance (C_{OUT}) and the load resistance (R_{L}) in parallel with the 120- Ω pull-down resistor. Equation 1 calculates the time constant τ :

$$\tau = \frac{120 \cdot R_{\text{L}}}{120 + R_{\text{L}}} \cdot C_{\text{OUT}} \quad (1)$$

Feature Description (continued)

7.3.3 Internal Foldback Current Limit

The TLV755P has an internal current limit that protects the regulator during fault conditions. The current limit is a hybrid brick-wall scheme until the output voltage is less than $0.4 \times V_{OUT(NOM)}$. When the voltage drops below $0.4 \times V_{OUT(NOM)}$, a foldback current limit is implemented that scales back the current as the output voltage approaches GND. When the output shorts, the LDO supplies a typical current of I_{SC} . The output voltage is not regulated when the device is in current limit. In this condition, the output voltage is the product of the regulated current and the load resistance. When the device output shorts, the PMOS pass transistor dissipates power $[(V_{IN} - V_{OUT}) \times I_{SC}]$ until thermal shutdown is triggered and the device turns off. After the device cools down, the internal thermal shutdown circuit turns the device back on. If the fault condition continues, the device cycles between current limit and thermal shutdown.

The foldback current-limit circuit limits the current that is allowed through the device to current levels lower than the minimum current limit at nominal V_{OUT} current limit (I_{CL}) during start up. [Figure 6](#) shows typical current limit values. If the output is loaded by a constant-current load during start up, or if the output voltage is negative when the device is enabled, then the load current demanded by the load may exceed the foldback current limit and the device may not rise to the full output voltage. For constant-current loads, disable the output load until the output rises to the nominal voltage.

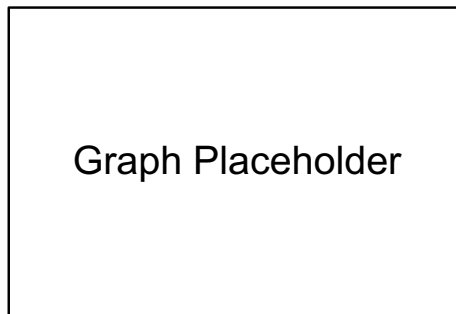


Figure 6. TLV755 Current Limit vs V_{OUT}

7.3.4 Thermal Shutdown

Thermal shutdown protection disables the output when the junction temperature rises to approximately 165°C. Disabling the device eliminates the power dissipated by the device, allowing the device to cool. When the junction temperature cools to approximately 155°C, the output circuitry is enabled again. Depending on power dissipation, thermal resistance, and ambient temperature, the thermal protection circuit may cycle on and off. This cycling limits regulator dissipation and protects the circuit from damage as a result of overheating.

Activating the thermal shutdown feature usually indicates excessive power dissipation as a result of the product of the $(V_{IN} - V_{OUT})$ voltage and the load current. For reliable operation, limit junction temperature to a maximum of 125°C. To estimate the margin of safety in a complete design, increase the ambient temperature until the thermal protection is triggered; use worst-case loads and signal conditions.

The internal protection circuitry protects against overload conditions but is not intended to be activated in normal operation. Continuously running the device into thermal shutdown degrades device reliability.

7.4 Device Functional Modes

Table 1 lists a comparison between the normal, dropout, and disabled modes of operation.

Table 1. Device Functional Modes Comparison

OPERATING MODE	PARAMETER			
	V _{IN}	EN	I _{OUT}	T _J
Normal ⁽¹⁾	V _{IN} > V _{OUT(NOM)} + V _{DO}	V _{EN} > V _{HI}	I _{OUT} < I _{CL}	T _J < T _{SD}
Dropout ⁽¹⁾	V _{IN} < V _{OUT(NOM)} + V _{DO}	V _{EN} > V _{HI}	—	T _J < T _{SD}
Disabled ⁽²⁾	V _{IN} < V _{UVLO}	V _{EN} < V _{LO}	—	T _J > T _{SD}

(1) All table conditions must be met.

(2) The device is disabled when any condition is met.

7.4.1 Normal Operation

The device regulates to the nominal output voltage when all following conditions are met:

- The input voltage is greater than the nominal output voltage plus the dropout voltage (V_{OUT(NOM)} + V_{DO})
- The enable voltage has previously exceeded the enable rising threshold voltage and has not decreased below the enable falling threshold
- The output current is less than the current limit (I_{OUT} < I_{CL})
- The device junction temperature is less than the thermal shutdown temperature (T_J < T_{SD})

7.4.2 Dropout Operation

If the input voltage is lower than the nominal output voltage plus the specified dropout voltage, but all other conditions are met for normal operation, the device operates in dropout. In this mode, the output voltage tracks the input voltage. During this mode, the transient performance of the device degrades because the pass device is in a triode state and no longer controls the current through the LDO. Line or load transients in dropout can result in large output-voltage deviations.

When the device is in a steady dropout state (defined as when the device is in dropout, V_{IN} < V_{OUT(NOM)} + V_{DO}, right after being in a normal regulation state, but not during startup), the pass-FET is driven as hard as possible when the control loop is out of balance. During the normal time required for the device to regain regulation, V_{IN} ≥ V_{OUT(NOM)} + V_{DO}, V_{OUT} can overshoot V_{OUT(NOM)} during fast transients.

7.4.3 Disabled

The output is shut down by forcing the enable pin below V_{LO}. When disabled, the pass device is turned off, internal circuits are shut down, and the output voltage is actively discharged to ground by an internal switch from the output to ground. The active pulldown resistor is on when sufficient input voltage is provided.

8 Application and Implementation

NOTE

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

8.1 Application Information

8.1.1 Input and Output Capacitor Selection

The TLV755P requires an output capacitance of 0.47 μF or larger for stability. Use X5R- and X7R-type ceramic capacitors because these capacitors have minimal variation in capacitance value and equivalent series resistance (ESR) over temperature. When selecting a capacitor for a specific application, consider the dc bias characteristics for the capacitor. Higher output voltages cause a significant derating of the capacitor. As a general rule, ceramic capacitors must be derated by 50%. For best performance, TI recommends a maximum output capacitance value of 200 μF .

Place a 1- μF capacitor on the input pin of the LDO. Some input supplies have a high impedance, which places the input capacitor on the input supply and reduces the input impedance. This capacitor counteracts reactive input sources and improves transient response and PSRR. If the input supply has a high impedance over a large range of frequencies, several input capacitors are used in parallel to lower the impedance over frequency. Use a higher-value capacitor if large, fast, rise-time load transients are expected, or if the device is located several inches from the input power source.

8.1.2 Dropout Voltage

Use a PMOS pass transistor achieves low dropout. When $(V_{\text{IN}} - V_{\text{OUT}})$ is less than the dropout voltage (V_{DO}), the PMOS pass device is in the linear region of operation and the input-to-output resistance is the $R_{\text{DS(ON)}}$ of the PMOS pass element. V_{DO} scales linearly with the output current because the PMOS device functions like a resistor in dropout mode. As with any linear regulator, PSRR and transient response degrade as $(V_{\text{IN}} - V_{\text{OUT}})$ approaches dropout operation. [Figure 7](#) shows typical dropout values.

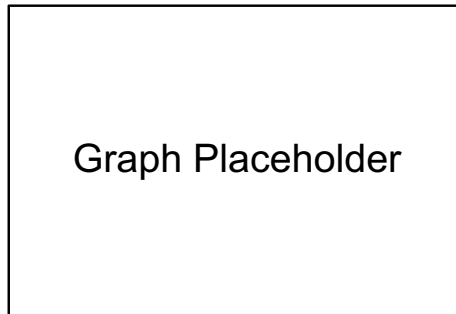


Figure 7. Dropout vs V_{IN}

Application Information (continued)

8.1.3 Exiting Dropout

Some applications have transients that place the LDO into dropout, such as slower ramps on V_{IN} for start-up. As with other LDOs, the output overshoots on recovery from these conditions. Figure 8 shows that a ramping input supply causes an LDO to overshoot on start-up when the slew rate and voltage levels are in the correct range. Use an enable signal to avoid this condition.

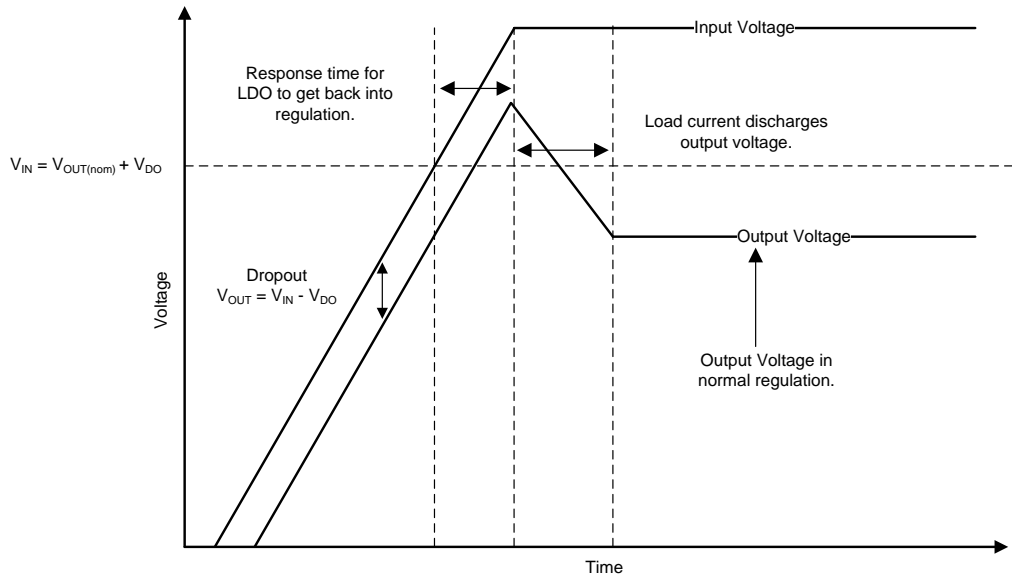


Figure 8. Startup Into Dropout

8.1.4 Reverse Current

As with most LDOs, excessive reverse current can damage this device.

Reverse current flows through the body diode on the pass element instead of the normal conducting channel. At high magnitudes, this current flow degrades the long-term reliability of the device as a result of one of the following conditions:

- Degradation caused by electromigration
- Excessive heat dissipation
- Potential for a latch-up condition

Application Information (continued)

Conditions where reverse current can occur are outlined in this section, all of which can exceed the absolute maximum rating of $V_{OUT} > V_{IN} + 0.3\text{ V}$:

- If the device has a large C_{OUT} and the input supply collapses with little or no load current
- The output is biased when the input supply is not established
- The output is biased above the input supply

If reverse current flow is expected in the application, external protection must be used to protect the device. Figure 9 shows one approach of protecting the device.

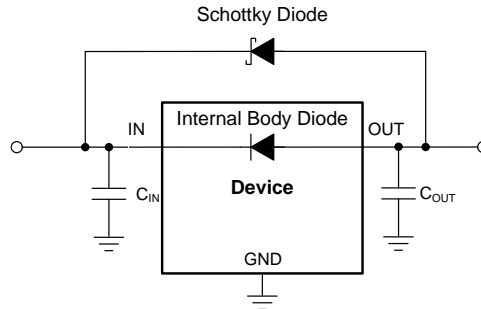


Figure 9. Example Circuit for Reverse Current Protection Using a Schottky Diode

8.1.5 Power Dissipation (P_D)

Circuit reliability demands that proper consideration is given to device power dissipation, location of the circuit on the printed circuit board (PCB), and correct sizing of the thermal plane. The PCB area around the regulator must be as free of other heat-generating devices as possible that cause added thermal stresses.

As a first-order approximation, power dissipation in the regulator depends on the input-to-output voltage difference and load conditions. Use Equation 2 to approximate P_D :

$$P_D = (V_{IN} - V_{OUT}) \times I_{OUT} \quad (2)$$

Power dissipation must be minimized to achieve greater efficiency. This minimizing process is achieved by selecting the correct system voltage rails. Proper selection helps obtain the minimum input-to-output voltage differential. The low dropout of the device allows for maximum efficiency across a wide range of output voltages.

The main heat conduction path for the device is through the thermal pad on the package. As such, the thermal pad must be soldered to a copper pad area under the device. This pad area contains an array of plated vias that conduct heat to inner plane areas or to a bottom-side copper plane.

The maximum power dissipation determines the maximum allowable junction temperature (T_J) for the device. According to Equation 3, power dissipation and junction temperature are most often related by the junction-to-ambient thermal resistance ($R_{\theta JA}$) of the combined PCB, device package, and the temperature of the ambient air (T_A).

$$T_J = T_A + R_{\theta JA} \times P_D \quad (3)$$

Unfortunately, this thermal resistance ($R_{\theta JA}$) is dependent on the heat-spreading capability built into the particular PCB design, and therefore varies according to the total copper area, copper weight, and location of the planes. The $R_{\theta JA}$ value recorded in the table is determined by the JEDEC standard, PCB, and copper-spreading area. The $R_{\theta JA}$ value is only used as a relative measure of package thermal performance. $R_{\theta JA}$ is the sum of the DRV package junction-to-case (bottom) thermal resistance ($R_{\theta JC(bot)}$) plus the thermal resistance contribution by the PCB copper.

Application Information (continued)

8.1.5.1 Estimating Junction Temperature

The JEDEC standard recommends the use of psi (Ψ) thermal metrics to estimate the junction temperatures of the LDO when in-circuit on a typical PCB board application. These metrics are not thermal resistances, but offer practical and relative means of estimating junction temperatures. These psi metrics are independent of the copper-spreading area. The key thermal metrics (Ψ_{JT} and Ψ_{JB}) are used in accordance with Equation 4 and are given in the table.

$$\Psi_{JT}: T_J = T_T + \Psi_{JT} \times P_D$$

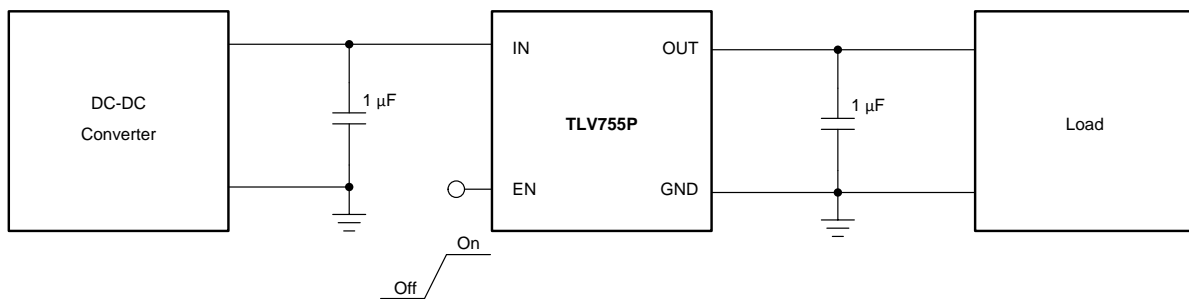
$$\Psi_{JB}: T_J = T_B + \Psi_{JB} \times P_D$$

where:

- P_D is the power dissipated as described in Equation 2
 - T_T is the temperature at the center-top of the device package, and
 - T_B is the PCB surface temperature measured 1 mm from the device package and centered on the package edge
- (4)

8.2 Typical Application

This application shows a typical use case for the TLV755, where the device converts from 2.5 V to 1.8 V for a common MCU core rail.



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Figure 10. TLV755P Typical Application

8.2.1 Design Requirements

Table 2 lists the design requirements for this application.

Table 2. Design Parameters

PARAMETER	DESIGN REQUIREMENT
Input voltage	2.5 V
Output voltage	1.8 V
Input current	400 mA (maximum)
Output load	300-mA dc
Maximum ambient temperature	85°C

ADVANCE INFORMATION

8.2.2 Detailed Design Procedure

8.2.2.1 Input Current

During normal operation, the input current to the LDO is approximately equal to the output current of the LDO. During startup, the input current is higher as a result of the inrush current charging the output capacitor. Use [Equation 5](#) to calculate the current through the input.

$$I_{OUT(t)} = \left[\frac{C_{OUT} \times dV_{OUT}(t)}{dt} \right] + \left[\frac{V_{OUT}(t)}{R_{LOAD}} \right]$$

where:

- $V_{OUT}(t)$ is the instantaneous output voltage of the turnon ramp
 - $dV_{OUT}(t) / dt$ is the slope of the V_{OUT} ramp
 - R_{LOAD} is the resistive load impedance
- (5)

8.2.2.2 Thermal Dissipation

The junction temperature can be determined using the junction-to-ambient thermal resistance ($R_{\theta JA}$) and the total power dissipation (P_D). Use [Equation 6](#) to calculate the power dissipation. As [Equation 7](#) shows, multiply P_D by $R_{\theta JA}$ and add the ambient temperature (T_A) to calculate the junction temperature (T_J).

$$P_D = (I_{GND} + I_{OUT}) \times (V_{IN} - V_{OUT}) \tag{6}$$

$$T_J = R_{\theta JA} \times P_D + T_A \tag{7}$$

If the ($T_{J(MAX)}$) value does not exceed 125°C, use [Equation 8](#) to calculate the maximum ambient temperature. [Equation 9](#) calculates the maximum ambient temperature with a value of 103.39°C.

$$T_{A(MAX)} = T_{J(MAX)} - R_{\theta JA} \times P_D \tag{8}$$

$$T_{A(MAX)} = 125^\circ\text{C} - 102.9 \times (2.5\text{ V} - 1.8\text{ V}) \times (0.3\text{ A}) = 103.39^\circ\text{C} \tag{9}$$

9 Power Supply Recommendations

Connect a low output impedance power supply directly to the IN pin of the TLV755P. If the input source is reactive, consider using multiple input capacitors in parallel with the 1- μ F input capacitor to lower the input supply impedance over frequency.

10 Layout

10.1 Layout Guidelines

- Place input and output capacitors as close as possible to the device
- Use copper planes for device connections to optimize thermal performance
- Place thermal vias around the device to distribute the heat

10.2 Layout Examples

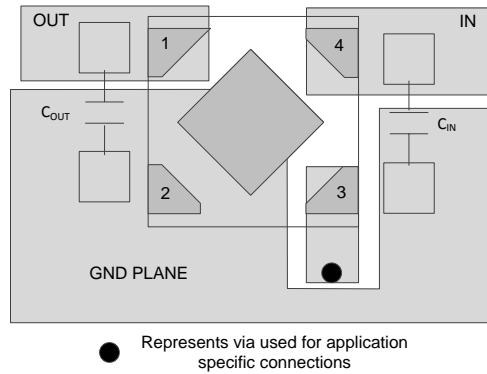


Figure 11. Layout Example: DQN Package

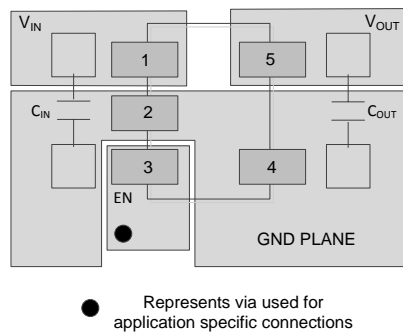


Figure 12. Layout Example: DBV Package

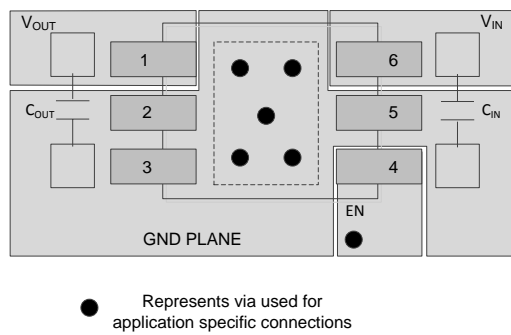


Figure 13. Layout Example: DRV Package

ADVANCE INFORMATION

11 Device and Documentation Support

11.1 Device Support

11.1.1 Device Nomenclature

Table 3. Device Nomenclature⁽¹⁾⁽²⁾

PRODUCT	V _{OUT}
TLV755xx(x)Pyyyz	xx(x) is the nominal output voltage. For output voltages with a resolution of 100 mV, two digits are used in the ordering number; otherwise, three digits are used (for example, 28 = 2.8 V; 125 = 1.25 V). P indicates an active output discharge feature. All members of the TLV755 family will actively discharge the output when the device is disabled. yyy is the package designator. z is the package quantity. R is for reel (3000 pieces), T is for tape (250 pieces).

- (1) For the most current package and ordering information see the Package Option Addendum at the end of this document, or visit the device product folder on www.ti.com.
- (2) Output voltages from 0.6 V to 5 V in 50-mV increments are available. Contact the factory for details and availability.

11.2 Receiving Notification of Documentation Updates

To receive notification of documentation updates, navigate to the device product folder on ti.com. In the upper right corner, click on *Alert me* to register and receive a weekly digest of any product information that has changed. For change details, review the revision history included in any revised document.

11.3 Community Resources

The following links connect to TI community resources. Linked contents are provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's [Terms of Use](#).

TI E2E™ Online Community *TI's Engineer-to-Engineer (E2E) Community*. Created to foster collaboration among engineers. At e2e.ti.com, you can ask questions, share knowledge, explore ideas and help solve problems with fellow engineers.

Design Support *TI's Design Support* Quickly find helpful E2E forums along with design support tools and contact information for technical support.

11.4 Trademarks

E2E is a trademark of Texas Instruments.
All other trademarks are the property of their respective owners.

11.5 Electrostatic Discharge Caution



This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

11.6 Glossary

[SLYZ022](#) — *TI Glossary*.

This glossary lists and explains terms, acronyms, and definitions.

12 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.



www.ti.com

PACKAGE OPTION ADDENDUM

24-Apr-2018

PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
PTLV75507PDQNR	ACTIVE	X2SON	DQN	4	3000	TBD	Call TI	Call TI	-40 to 125		Samples
PTLV75509PDBVR	ACTIVE	SOT-23	DBV	5	3000	TBD	Call TI	Call TI	-40 to 125		Samples
PTLV75510PDBVR	ACTIVE	SOT-23	DBV	5	3000	TBD	Call TI	Call TI	-40 to 125		Samples
PTLV75510PDQNR	ACTIVE	X2SON	DQN	4	3000	TBD	Call TI	Call TI	-40 to 125		Samples
PTLV75512PDBVR	ACTIVE	SOT-23	DBV	5	3000	TBD	Call TI	Call TI	-40 to 125		Samples
PTLV75512PDQNR	ACTIVE	X2SON	DQN	4	3000	TBD	Call TI	Call TI	-40 to 125		Samples
PTLV75515PDBVR	ACTIVE	SOT-23	DBV	5	3000	TBD	Call TI	Call TI	-40 to 125		Samples
PTLV75515PDQNR	ACTIVE	X2SON	DQN	4	3000	TBD	Call TI	Call TI	-40 to 125		Samples
PTLV75518PDBVR	ACTIVE	SOT-23	DBV	5	3000	TBD	Call TI	Call TI	-40 to 125		Samples
PTLV75518PDQNR	ACTIVE	X2SON	DQN	4	3000	TBD	Call TI	Call TI	-40 to 125		Samples
PTLV75519PDBVR	ACTIVE	SOT-23	DBV	5	3000	TBD	Call TI	Call TI	-40 to 125		Samples
PTLV75519PDQNR	ACTIVE	X2SON	DQN	4	3000	TBD	Call TI	Call TI	-40 to 125		Samples
PTLV75525PDBVR	ACTIVE	SOT-23	DBV	5	3000	TBD	Call TI	Call TI	-40 to 125		Samples
PTLV75525PDQNR	ACTIVE	X2SON	DQN	4	3000	TBD	Call TI	Call TI	-40 to 125		Samples
PTLV75528PDBVR	ACTIVE	SOT-23	DBV	5	3000	TBD	Call TI	Call TI	-40 to 125		Samples
PTLV75528PDQNR	ACTIVE	X2SON	DQN	4	3000	TBD	Call TI	Call TI	-40 to 125		Samples
PTLV75529PDBVR	ACTIVE	SOT-23	DBV	5	3000	TBD	Call TI	Call TI	-40 to 125		Samples
PTLV75530PDBVR	ACTIVE	SOT-23	DBV	5	3000	TBD	Call TI	Call TI	-40 to 125		Samples
PTLV75530PDQNR	ACTIVE	X2SON	DQN	4	3000	TBD	Call TI	Call TI	-40 to 125		Samples
PTLV75533PDBVR	ACTIVE	SOT-23	DBV	5	3000	TBD	Call TI	Call TI	-40 to 125		Samples



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PACKAGE OPTION ADDENDUM

24-Apr-2018

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
PTLV75533PDQNR	ACTIVE	X2SON	DQN	4	3000	TBD	Call TI	Call TI	-40 to 125		Samples
TLV75507PDQNR	PREVIEW	X2SON	DQN	4	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	KD	
TLV75507PDQNT	PREVIEW	X2SON	DQN	4	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	KD	
TLV75509PDBVR	PREVIEW	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 125		
TLV75509PDQNR	PREVIEW	X2SON	DQN	4	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	AX	
TLV75509PDQNT	PREVIEW	X2SON	DQN	4	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	AX	
TLV75510PDBVR	PREVIEW	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU CU SN	Level-1-260C-UNLIM	-40 to 125	1FPF	
TLV75510PDQNR	PREVIEW	X2SON	DQN	4	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	KE	
TLV75510PDQNT	PREVIEW	X2SON	DQN	4	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	KE	
TLV75512PDBVR	PREVIEW	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 125		
TLV75512PDQNR	PREVIEW	X2SON	DQN	4	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	AG	
TLV75512PDQNT	PREVIEW	X2SON	DQN	4	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	AG	
TLV75515PDBVR	PREVIEW	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 125		
TLV75515PDQNR	PREVIEW	X2SON	DQN	4	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	KF	
TLV75515PDQNT	PREVIEW	X2SON	DQN	4	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	KF	
TLV75518PDBVR	PREVIEW	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 125		
TLV75518PDQNR	PREVIEW	X2SON	DQN	4	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	AI	
TLV75518PDQNT	PREVIEW	X2SON	DQN	4	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	AI	



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PACKAGE OPTION ADDENDUM

24-Apr-2018

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
TLV75519PDBVR	PREVIEW	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 125		
TLV75519PDQNR	PREVIEW	X2SON	DQN	4	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	B5	
TLV75519PDQNT	PREVIEW	X2SON	DQN	4	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	B5	
TLV75525PDBVR	PREVIEW	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 125		
TLV75525PDQNR	PREVIEW	X2SON	DQN	4	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	AJ	
TLV75525PDQNT	PREVIEW	X2SON	DQN	4	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	AJ	
TLV75528PDBVR	PREVIEW	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 125		
TLV75528PDQNR	PREVIEW	X2SON	DQN	4	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	KG	
TLV75528PDQNT	PREVIEW	X2SON	DQN	4	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	KG	
TLV75529PDBVR	PREVIEW	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 125		
TLV75530PDBVR	PREVIEW	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 125		
TLV75530PDQNR	PREVIEW	X2SON	DQN	4	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	KI	
TLV75530PDQNT	PREVIEW	X2SON	DQN	4	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	KI	
TLV75533PDBVR	PREVIEW	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 125		
TLV75533PDQNR	PREVIEW	X2SON	DQN	4	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	AN	
TLV75533PDQNT	PREVIEW	X2SON	DQN	4	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	AN	

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.



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PACKAGE OPTION ADDENDUM

24-Apr-2018

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.
OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ **RoHS:** TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of ≤ 1000 ppm threshold. Antimony trioxide based flame retardants must also meet the ≤ 1000 ppm threshold requirement.

⁽³⁾ **MSL, Peak Temp.** - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

⁽⁴⁾ There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

⁽⁵⁾ Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "--" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

⁽⁶⁾ **Lead/Ball Finish** - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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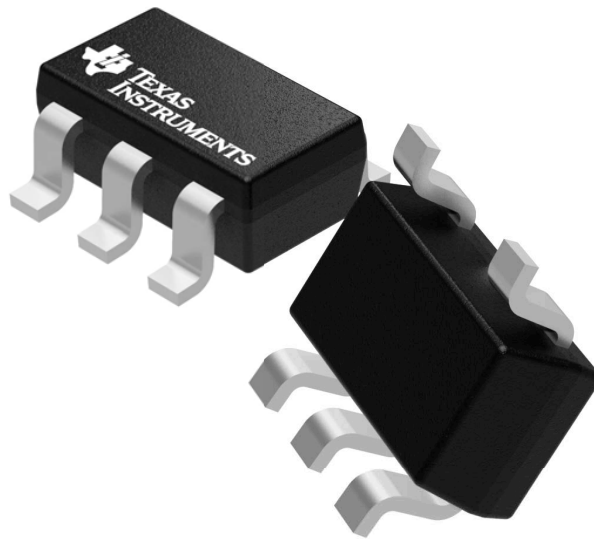
In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

GENERIC PACKAGE VIEW

DBV 5

SOT-23 - 1.45 mm max height

SMALL OUTLINE TRANSISTOR



Images above are just a representation of the package family, actual package may vary.
Refer to the product data sheet for package details.

4073253/P

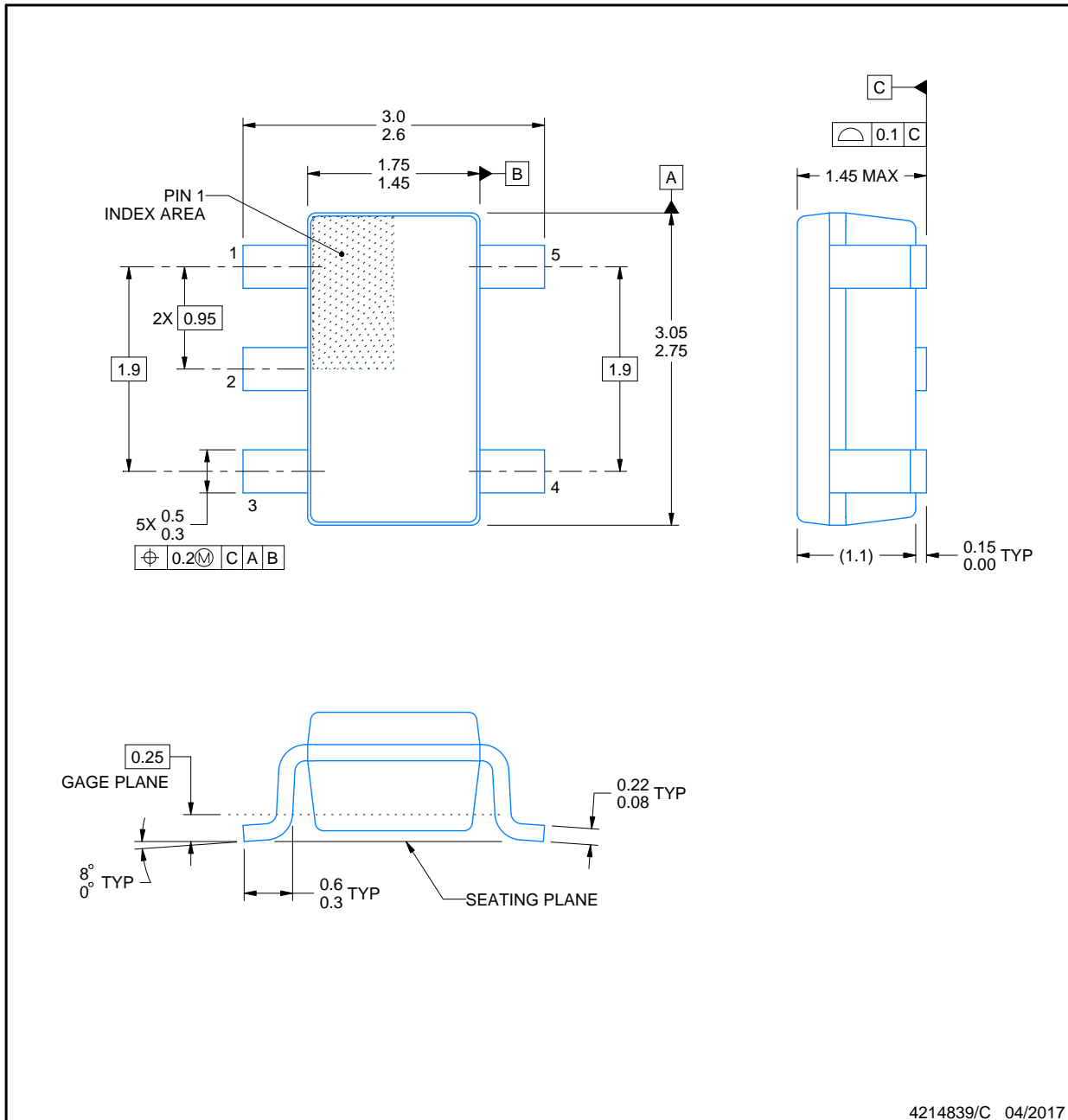


DBV0005A

PACKAGE OUTLINE

SOT-23 - 1.45 mm max height

SMALL OUTLINE TRANSISTOR



NOTES:

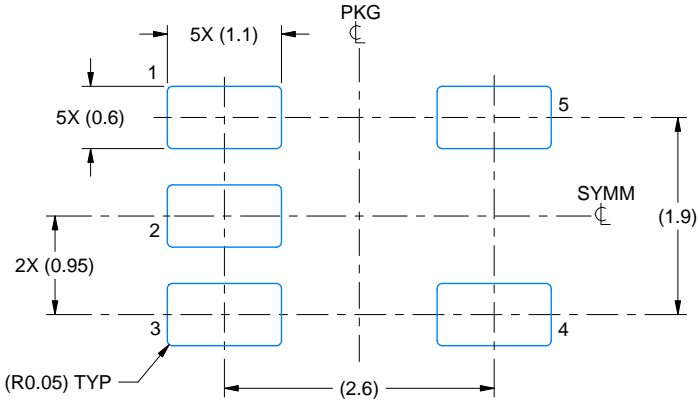
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. Reference JEDEC MO-178.

EXAMPLE BOARD LAYOUT

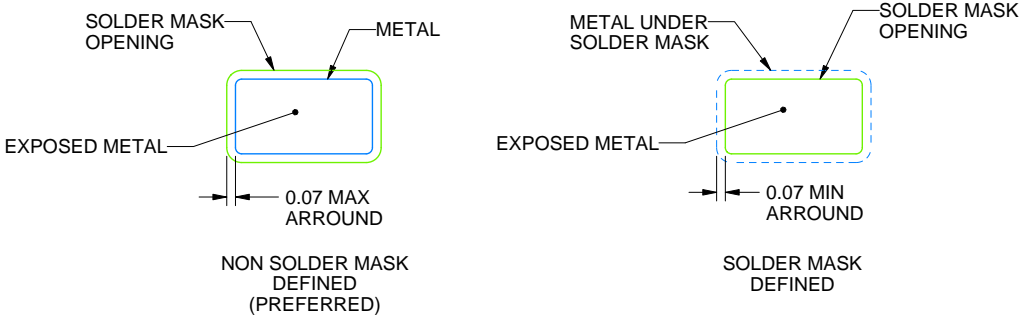
DBV0005A

SOT-23 - 1.45 mm max height

SMALL OUTLINE TRANSISTOR



LAND PATTERN EXAMPLE
EXPOSED METAL SHOWN
SCALE:15X



SOLDER MASK DETAILS

4214839/C 04/2017

NOTES: (continued)

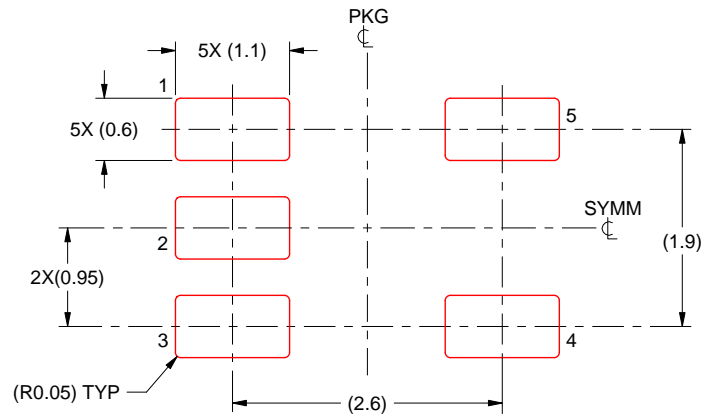
- 4. Publication IPC-7351 may have alternate designs.
- 5. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

EXAMPLE STENCIL DESIGN

DBV0005A

SOT-23 - 1.45 mm max height

SMALL OUTLINE TRANSISTOR



SOLDER PASTE EXAMPLE
BASED ON 0.125 mm THICK STENCIL
SCALE:15X

4214839/C 04/2017

NOTES: (continued)

6. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
7. Board assembly site may have different recommendations for stencil design.

DQN 4

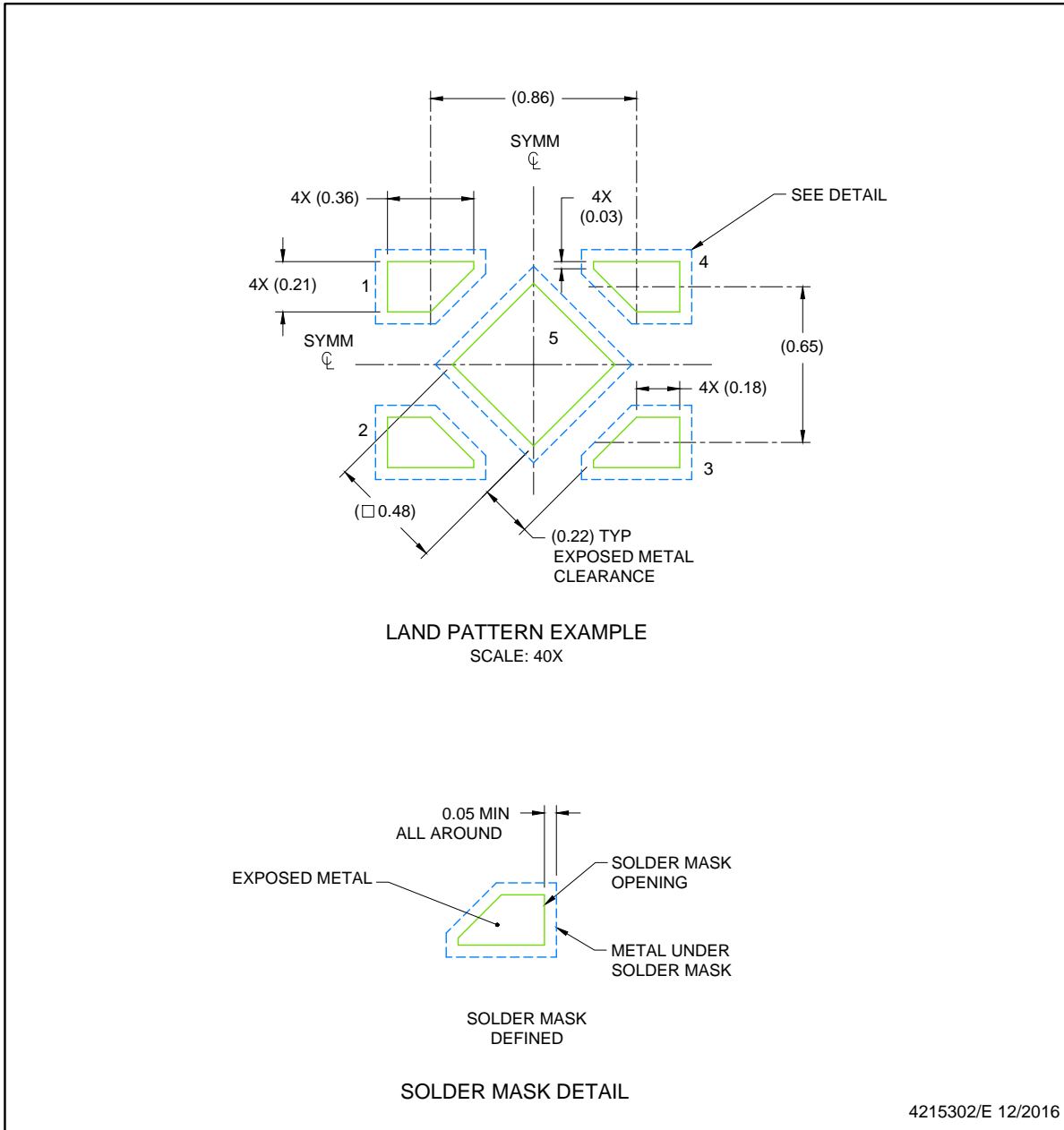
GENERIC PACKAGE VIEW
X2SON - 0.4 mm max height

PLASTIC SMALL OUTLINE - NO LEAD



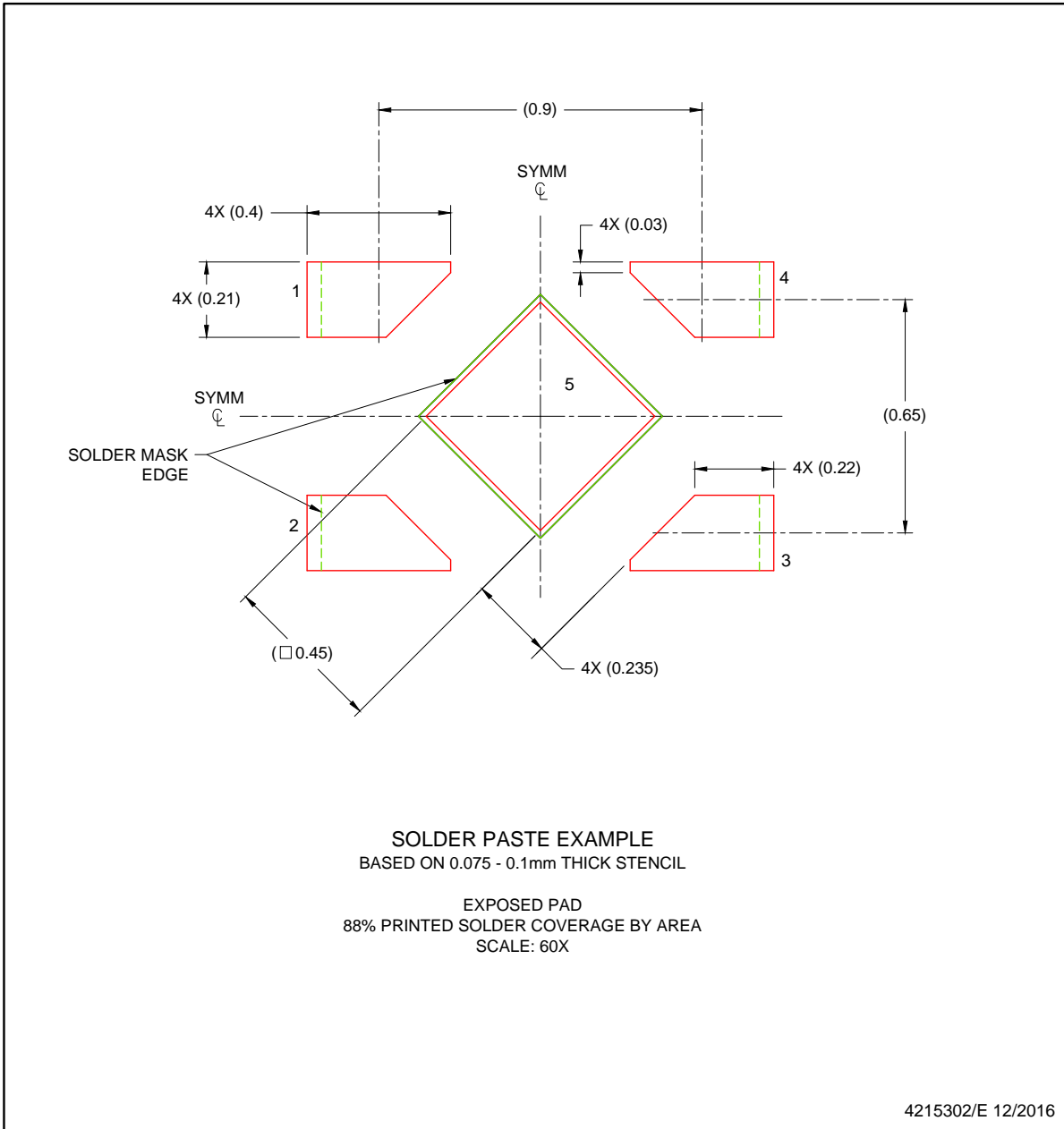
Images above are just a representation of the package family, actual package may vary.
Refer to the product data sheet for package details.

4210367/F



NOTES: (continued)

7. This package is designed to be soldered to a thermal pad on the board. For more information, see Texas Instruments literature number SLUA271 (www.ti.com/lit/slue271).
8. If any vias are implemented, it is recommended that vias under paste be filled, plugged or tented.



NOTES: (continued)

9. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.

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TP4056 1A Standalone Linear Li-Ion Battery Charger with Thermal Regulation in SOP-8

DESCRIPTION

The TP4056 is a complete constant-current/constant-voltage linear charger for single cell lithium-ion batteries. Its SOP package and low external component count make the TP4056 ideally suited for portable applications. Furthermore, the TP4056 can work within USB and wall adapter.

No blocking diode is required due to the internal PMOSFET architecture and have prevent to negative Charge Current Circuit. Thermal feedback regulates the charge current to limit the die temperature during high power operation or high ambient temperature. The charge voltage is fixed at 4.2V, and the charge current can be programmed externally with a single resistor. The TP4056 automatically terminates the charge cycle when the charge current drops to 1/10th the programmed value after the final float voltage is reached.

TP4056 Other features include current monitor, under voltage lockout, automatic recharge and two status pin to indicate charge termination and the presence of an input voltage.

FEATURES

- Programmable Charge Current Up to 1000mA
- No MOSFET, Sense Resistor or Blocking Diode Required
- Complete Linear Charger in SOP-8 Package for Single Cell Lithium-Ion Batteries
- Constant-Current/Constant-Voltage
- Charges Single Cell Li-Ion Batteries Directly from USB Port
- Preset 4.2V Charge Voltage with 1.5% Accuracy
- Automatic Recharge
- two Charge Status Output Pins
- C/10 Charge Termination
- 2.9V Trickle Charge Threshold (TP4056)
- Soft-Start Limits Inrush Current
- Available Radiator in 8-Lead SOP Package, the Radiator need connect GND or impending

ABSOLUTE MAXIMUM RATINGS

- Input Supply Voltage(V_{CC}): -0.3V~8V
- TEMP: -0.3V~10V
- CE: -0.3V~10V
- BAT Short-Circuit Duration: Continuous
- BAT Pin Current: 1200mA
- PROG Pin Current: 1200uA
- Maximum Junction Temperature: 145°C
- Operating Ambient Temperature Range: -40°C~85°C
- Lead Temp.(Soldering, 10sec): 260°C

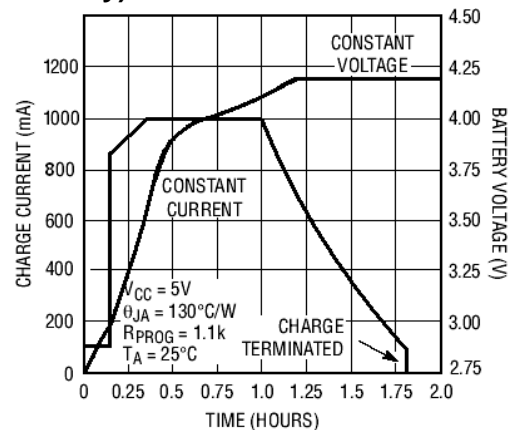
APPLICATIONS

- Cellular Telephones, PDAs, GPS
- Charging Docks and Cradles
- Digital Still Cameras, Portable Devices
- USB Bus-Powered Chargers,Chargers

PACKAGE/ORDER INFORMATION

photo	ORDER PART NUMBER
	TP4056-42-SOP8-PP
	PART MARKING TP4056

Complete Charge Cycle (1000mAh Battery)



TEMP(Pin 1) :Temperature Sense Input Connecting TEMP pin to NTC thermistor's output in Lithium ion battery pack. If TEMP pin's voltage is below 45% or above 80% of supply voltage V_{IN} for more than 0.15S, this means that battery's temperature is too high or too low, charging is suspended. The temperature sense function can be disabled by grounding the TEMP pin.

PROG(Pin 2): Constant Charge Current Setting and Charge Current Monitor Pin charge current is set by connecting a resistor R_{ISET} from this pin to GND. When in precharge mode, the ISET pin's voltage is regulated to 0.2V. When in constant charge current mode, the ISET pin's voltage is regulated to 2V. In all modes during charging, the voltage on ISET pin can be used to measure the charge current as follows:

GND(Pin3): Ground Terminal

$$I_{BAT} = \frac{V_{PROG}}{R_{PROG}} \times 1200 \quad (V_{PROG}=1V)$$

Vcc(Pin 4): Positive Input Supply Voltage V_{IN} is the power supply to the internal circuit. When V_{IN} drops to within 30mv of the BAT pin voltage, TP4056 enters low power sleep mode, dropping BAT pin's current to less than 2uA.

BAT(Pin5): Battery Connection Pin. Connect the positive terminal of the battery to BAT pin. BAT pin draws less than 2uA current in chip disable mode or in sleep mode. BAT pin provides charge current to the battery and provides regulation voltage of 4.2V.

\overline{STDBY} (Pin6): Open Drain Charge Status Output When the battery Charge Termination, the \overline{STDBY} pin is pulled low by an internal switch, otherwise \overline{STDBY} pin is in high impedance state.

\overline{CHRG} (Pin7): Open Drain Charge Status Output When the battery is being charged, the \overline{CHRG} pin is pulled low by an internal switch, otherwise \overline{CHRG} pin is in high impedance state.

CE(Pin8): Chip Enable Input. A high input will put the device in the normal operating mode. Pulling the CE pin to low level will put the YP4056 into disable mode. The CE pin can be driven by TTL or CMOS logic level.

ELECTRICAL CHARACTERISTICS

The ● denotes specifications which apply over the full operating temperature range, otherwise specifications are at $T_A=25^\circ\text{C}$, $V_{CC}=5V$, unless otherwise noted.

SYMBOL	PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS	
V_{CC}	Input Supply Voltage	●	4.0	5	8.0	V	
I_{CC}	Input Supply Current	Charge Mode, $R_{PROG} = 1.2k$	●	150	500	μA	
		StandbyMode(Charge Terminated)	●	55	100	μA	
		Shutdown Mode (R_{PROG} Not Connected, $V_{CC} < V_{BAT}$, or $V_{CC} < V_{UV}$)	●	55	100	μA	
V_{FLOAL}	Regulated Output (Float) Voltage	$0^\circ\text{C} \leq T_A \leq 85^\circ\text{C}$, $I_{BAT}=40\text{mA}$	4.137	4.2	4.263	V	
I_{BAT}	BAT Pin Current Text condition: $V_{BAT}=4.0V$	$R_{PROG} = 2.4k$, Current Mode	●	450	500	550	mA
		$R_{PROG} = 1.2k$, Current Mode	●	950	1000	1050	mA
		Standby Mode, $V_{BAT} = 4.2V$	●	0	-2.5	-6	μA
I_{TRIKL}	Trickle Charge Current	$V_{BAT} < V_{TRIKL}$, $R_{PROG}=1.2K$	●	120	130	140	mA
V_{TRIKL}	Trickle Charge Threshold Voltage	$R_{PROG}=1.2K$, V_{BAT} Rising		2.8	2.9	3.0	V
V_{TRHYS}	Trickle Charge Hysteresis Voltage	$R_{PROG}=1.2K$		60	80	100	mV
T_{LIM}	Junction Temperature in Constant Temperature Mode			145		$^\circ\text{C}$	

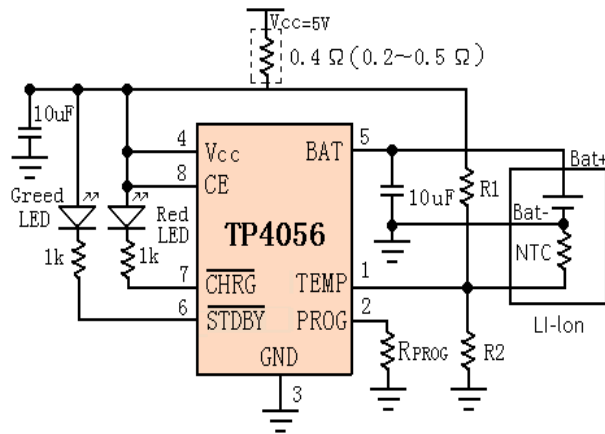
indicator light state

Charge state	Red LED $\overline{\text{CHRG}}$	Green LED $\overline{\text{STDBY}}$
charging	bright	extinguish
Charge Termination	extinguish	bright
Vin too low; Temperature of battery too low or too high; no battery	extinguish	extinguish
BAT PIN Connect 10u Capacitance; No battery	Green LED bright, Red LED Coruscate T=1-4 S	

Rprog Current Setting

R _{PROG} (k)	I _{BAT} (mA)
10	130
5	250
4	300
3	400
2	580
1.66	690
1.5	780
1.33	900
1.2	1000

TYPICAL APPLICATIONS



TP4056 1A Standalone Linear Li-Ion Battery Charger with Thermal Regulation in SOP-8

DESCRIPTION

The TP4056 is a complete constant-current/constant-voltage linear charger for single cell lithium-ion batteries. Its SOP package and low external component count make the TP4056 ideally suited for portable applications. Furthermore, the TP4056 can work within USB and wall adapter.

No blocking diode is required due to the internal PMOSFET architecture and have prevent to negative Charge Current Circuit. Thermal feedback regulates the charge current to limit the die temperature during high power operation or high ambient temperature. The charge voltage is fixed at 4.2V, and the charge current can be programmed externally with a single resistor. The TP4056 automatically terminates the charge cycle when the charge current drops to 1/10th the programmed value after the final float voltage is reached.

TP4056 Other features include current monitor, under voltage lockout, automatic recharge and two status pin to indicate charge termination and the presence of an input voltage.

FEATURES

- Programmable Charge Current Up to 1000mA
- No MOSFET, Sense Resistor or Blocking Diode Required
- Complete Linear Charger in SOP-8 Package for Single Cell Lithium-Ion Batteries
- Constant-Current/Constant-Voltage
- Charges Single Cell Li-Ion Batteries Directly from USB Port
- Preset 4.2V Charge Voltage with 1.5% Accuracy
- Automatic Recharge
- two Charge Status Output Pins
- C/10 Charge Termination
- 2.9V Trickle Charge Threshold (TP4056)
- Soft-Start Limits Inrush Current
- Available Radiator in 8-Lead SOP Package, the Radiator need connect GND or impending

ABSOLUTE MAXIMUM RATINGS

- Input Supply Voltage(V_{CC}): -0.3V~8V
- TEMP: -0.3V~10V
- CE: -0.3V~10V
- BAT Short-Circuit Duration: Continuous
- BAT Pin Current: 1200mA
- PROG Pin Current: 1200uA
- Maximum Junction Temperature: 145°C
- Operating Ambient Temperature Range: -40°C~85°C
- Lead Temp.(Soldering, 10sec): 260°C

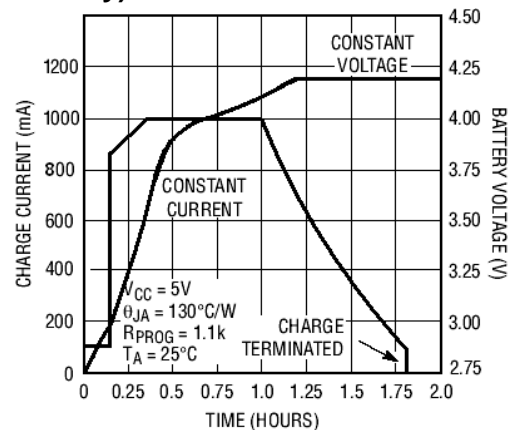
APPLICATIONS

- Cellular Telephones, PDAs, GPS
- Charging Docks and Cradles
- Digital Still Cameras, Portable Devices
- USB Bus-Powered Chargers,Chargers

PACKAGE/ORDER INFORMATION

SOP-8	
photo	ORDER PART NUMBER
	TP4056-42-SOP8-PP
	PART MARKING TP4056

Complete Charge Cycle (1000mAh Battery)



TEMP(Pin 1) :Temperature Sense Input Connecting TEMP pin to NTC thermistor's output in Lithium ion battery pack. If TEMP pin's voltage is below 45% or above 80% of supply voltage V_{IN} for more than 0.15S, this means that battery's temperature is too high or too low, charging is suspended. The temperature sense function can be disabled by grounding the TEMP pin.

PROG(Pin 2): Constant Charge Current Setting and Charge Current Monitor Pin charge current is set by connecting a resistor R_{ISET} from this pin to GND. When in precharge mode, the ISET pin's voltage is regulated to 0.2V. When in constant charge current mode, the ISET pin's voltage is regulated to 2V. In all modes during charging, the voltage on ISET pin can be used to measure the charge current as follows:

GND(Pin3): Ground Terminal

$$I_{BAT} = \frac{V_{PROG}}{R_{PROG}} \times 1200 \quad (V_{PROG}=1V)$$

Vcc(Pin 4): Positive Input Supply Voltage V_{IN} is the power supply to the internal circuit. When V_{IN} drops to within 30mv of the BAT pin voltage, TP4056 enters low power sleep mode, dropping BAT pin's current to less than 2uA.

BAT(Pin5): Battery Connection Pin. Connect the positive terminal of the battery to BAT pin. BAT pin draws less than 2uA current in chip disable mode or in sleep mode. BAT pin provides charge current to the battery and provides regulation voltage of 4.2V.

\overline{STDBY} (Pin6): Open Drain Charge Status Output When the battery Charge Termination, the \overline{STDBY} pin is pulled low by an internal switch, otherwise \overline{STDBY} pin is in high impedance state.

\overline{CHRG} (Pin7): Open Drain Charge Status Output When the battery is being charged, the \overline{CHRG} pin is pulled low by an internal switch, otherwise \overline{CHRG} pin is in high impedance state.

CE(Pin8): Chip Enable Input. A high input will put the device in the normal operating mode. Pulling the CE pin to low level will put the YP4056 into disable mode. The CE pin can be driven by TTL or CMOS logic level.

ELECTRICAL CHARACTERISTICS

The ● denotes specifications which apply over the full operating temperature range, otherwise specifications are at $T_A=25^\circ\text{C}$, $V_{CC}=5V$, unless otherwise noted.

SYMBOL	PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS	
V_{CC}	Input Supply Voltage	●	4.0	5	8.0	V	
I_{CC}	Input Supply Current	Charge Mode, $R_{PROG} = 1.2k$	●	150	500	μA	
		StandbyMode(Charge Terminated)	●	55	100	μA	
		Shutdown Mode (R_{PROG} Not Connected, $V_{CC} < V_{BAT}$, or $V_{CC} < V_{UV}$)	●	55	100	μA	
V_{FLOAL}	Regulated Output (Float) Voltage	$0^\circ\text{C} \leq T_A \leq 85^\circ\text{C}$, $I_{BAT}=40\text{mA}$	4.137	4.2	4.263	V	
I_{BAT}	BAT Pin Current Text condition: $V_{BAT}=4.0V$	$R_{PROG} = 2.4k$, Current Mode	●	450	500	550	mA
		$R_{PROG} = 1.2k$, Current Mode	●	950	1000	1050	mA
		Standby Mode, $V_{BAT} = 4.2V$	●	0	-2.5	-6	μA
I_{TRIKL}	Trickle Charge Current	$V_{BAT} < V_{TRIKL}$, $R_{PROG}=1.2K$	●	120	130	140	mA
V_{TRIKL}	Trickle Charge Threshold Voltage	$R_{PROG}=1.2K$, V_{BAT} Rising		2.8	2.9	3.0	V
V_{TRHYS}	Trickle Charge Hysteresis Voltage	$R_{PROG}=1.2K$		60	80	100	mV
T_{LIM}	Junction Temperature in Constant Temperature Mode			145		$^\circ\text{C}$	

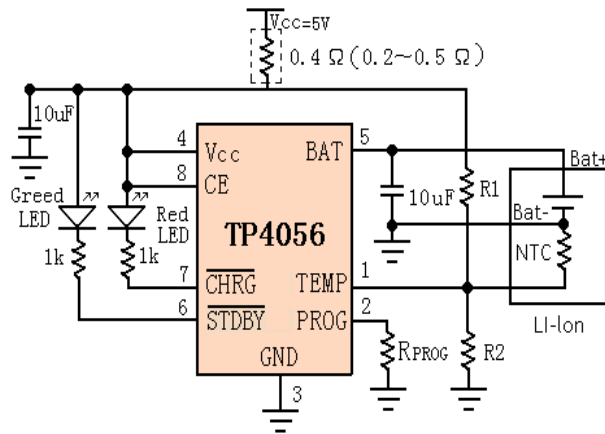
indicator light state

Charge state	Red LED $\overline{\text{CHRG}}$	Green LED $\overline{\text{STDBY}}$
charging	bright	extinguish
Charge Termination	extinguish	bright
Vin too low; Temperature of battery too low or too high; no battery	extinguish	extinguish
BAT PIN Connect 10u Capacitance; No battery	Green LED bright, Red LED Coruscate T=1-4 S	

Rprog Current Setting

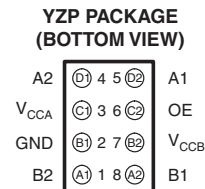
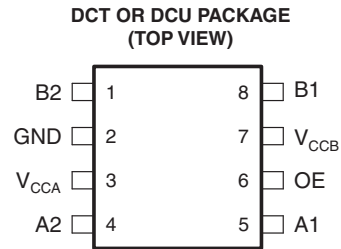
R _{PROG} (k)	I _{BAT} (mA)
10	130
5	250
4	300
3	400
2	580
1.66	690
1.5	780
1.33	900
1.2	1000

TYPICAL APPLICATIONS



FEATURES

- Available in the Texas Instruments NanoStar™ and NanoFree™ Packages
- 1.65 V to 3.6 V on A port and 2.3 V to 5.5 V on B port ($V_{CCA} \leq V_{CCB}$)
- V_{CC} Isolation Feature – If Either V_{CC} Input Is at GND, Both Ports Are in the High-Impedance State
- I_{off} Supports Partial-Power-Down Mode Operation
- Latch-Up Performance Exceeds 100 mA Per JESD 78, Class II
- ESD Protection Exceeds JESD 22
 - A Port
 - 2500-V Human-Body Model (A114-B)
 - 250-V Machine Model (A115-A)
 - 1500-V Charged-Device Model (C101)
 - B Port
 - 8-kV Human-Body Model (A114-B)
 - 250-V Machine Model (A115-A)
 - 1500-V Charged-Device Model (C101)



DESCRIPTION/ORDERING INFORMATION

This two-bit noninverting translator uses two separate configurable power-supply rails. The A port is designed to track V_{CCA} . V_{CCA} accepts any supply voltage from 1.65 V to 3.6 V. The B port is designed to track V_{CCB} . V_{CCA} must be less than or equal to V_{CCB} . V_{CCB} accepts any supply voltage from 2.3 V to 5.5 V. This allows for low-voltage bidirectional translation between any of the 1.8-V, 2.5-V, 3.3-V, and 5-V voltage nodes.

When the output-enable (OE) input is low, all outputs are placed in the high-impedance state.

To ensure the high-impedance state during power up or power down, OE should be tied to GND through a pulldown resistor; the minimum value of the resistor is determined by the current-sourcing capability of the driver.

ORDERING INFORMATION

T_A	PACKAGE ⁽¹⁾		ORDERABLE PART NUMBER	TOP-SIDE MARKING ⁽²⁾
–40°C to 85°C	NanoStar™ – WCSP (DSBGA) 0.23-mm Large Bump – YZP	Reel of 3000	TXS0102YZPR	
	SSOP – DCT	Reel of 3000	TXS0102DCTR	NFEZ_ _ _
		Tube of 250	TXS0102DCTT	NFEZ_ _ _
	VSSOP – DCU	Reel of 3000	TXS0102DCUR	_ _ NFE

- (1) Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.
- (2) DCT: The actual top-side marking has three additional characters that designate the year, month, and assembly/test site.
DCU: The actual top-side marking has one additional character that designates the assembly/test site.
YZP: The actual top-side marking has three preceding characters to denote year, month, and sequence code, and one following character to designate the assembly/test site. Pin 1 identifier indicates solder-bump composition (1 = SnPb, • = Pb-free).



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

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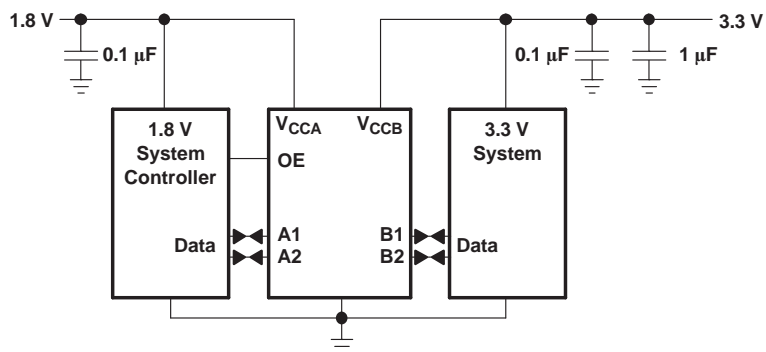
TXS0102
2-BIT BIDIRECTIONAL VOLTAGE-LEVEL TRANSLATOR
FOR OPEN-DRAIN APPLICATIONS

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PIN DESCRIPTION
(DCT AND DCU PACKAGES)

NO.	NAME	FUNCTION
1	B2	Input/output B. Referenced to V_{CCB} .
2	GND	Ground
3	V_{CCA}	A-port supply voltage. $1.65\text{ V} \leq V_{CCA} \leq 3.6\text{ V}$ and $V_{CCA} \leq V_{CCB}$
4	A2	Input/output A. Referenced to V_{CCA} .
5	A1	Input/output A. Referenced to V_{CCA} .
6	OE	3-state output mode enable. Pull OE low to place all outputs in 3-state mode. Referenced to V_{CCA} .
7	V_{CCB}	B-port supply voltage. $2.3\text{ V} \leq V_{CCB} \leq 5.5\text{ V}$
8	B1	Input/output B. Referenced to V_{CCB} .

TYPICAL OPERATING CIRCUIT



Absolute Maximum Ratings⁽¹⁾

over recommended operating free-air temperature range (unless otherwise noted)

		MIN	MAX	UNIT	
V _{CCA}	Supply voltage range	–0.5	4.6	V	
V _{CCB}	Supply voltage range	–0.5	6.5	V	
V _I	Input voltage range ⁽²⁾	A port	–0.5	4.6	V
		B port	–0.5	6.5	
V _O	Voltage range applied to any output in the high-impedance or power-off state ⁽²⁾	A port	–0.5	4.6	V
		B port	–0.5	6.5	
V _O	Voltage range applied to any output in the high or low state ⁽²⁾⁽³⁾	A port	–0.5	V _{CCA} + 0.5	V
		B port	–0.5	V _{CCB} + 0.5	
I _{IK}	Input clamp current		–50	mA	
I _{OK}	Output clamp current		–50	mA	
I _O	Continuous output current		±50	mA	
	Continuous current through V _{CCA} , V _{CCB} , or GND		±100	mA	
θ _{JA}	Package thermal impedance ⁽⁴⁾	DCT package	220	°C/W	
		DCU package	227		
		YZP package	102		
T _{stg}	Storage temperature range	–65	150	°C	

- (1) Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) The input and output negative-voltage ratings may be exceeded if the input and output current ratings are observed.
- (3) The value of V_{CCA} and V_{CCB} are provided in the recommended operating conditions table.
- (4) The package thermal impedance is calculated in accordance with JESD 51-7.

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Recommended Operating Conditions⁽¹⁾⁽²⁾

		V_{CCA}	V_{CCB}	MIN	MAX	UNIT
V_{CCA}	Supply voltage ⁽³⁾			1.65	3.6	V
V_{CCB}				2.3	5.5	
V_{IH}	High-level input voltage	A-port I/Os	2.3 V to 5.5 V	$V_{CCI} - 0.2$	V_{CCI}	V
				$V_{CCI} - 0.4$	V_{CCI}	
		B-port I/Os	$V_{CCI} - 0.4$	V_{CCI}		
	OE input			$V_{CCA} \times 0.65$	5.5	
V_{IL}	Low-level input voltage	A-port I/Os	2.3 V to 5.5 V	0	0.15	V
		B-port I/Os		0	0.15	
		OE input	0	$V_{CCA} \times 0.35$		
$\Delta t/\Delta v$	Input transition rise or fall rate	A-port I/Os, push-pull driving	2.3 V to 5.5 V		10	ns/V
		B-port I/Os, push-pull driving			10	
		Control input			10	
T_A	Operating free-air temperature			-40	85	°C

- (1) V_{CCI} is the supply voltage associated with the input port.
- (2) V_{CCO} is the supply voltage associated with the output port.
- (3) V_{CCA} must be less than or equal to V_{CCB} , and V_{CCA} must not exceed 3.6 V.

Electrical Characteristics⁽¹⁾⁽²⁾⁽³⁾

over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS	V _{CCA}	V _{CCB}	T _A = 25°C			–40°C to 85°C		UNIT
					MIN	TYP	MAX	MIN	MAX	
V _{OHA}		I _{OH} = –20 μA, V _{IB} ≥ V _{CCB} – 0.4 V	1.65 V to 3.6 V	2.3 V to 5.5 V				V _{CCA} × 0.67		V
V _{OLA}		I _{OL} = 1 mA, V _{IB} ≤ 0.15 V	1.65 V to 3.6 V	2.3 V to 5.5 V				0.4		V
V _{OHB}		I _{OH} = –20 μA, V _{IA} ≥ V _{CCA} – 0.2 V	1.65 V to 3.6 V	2.3 V to 5.5 V				V _{CCB} × 0.67		V
V _{OLB}		I _{OL} = 1 mA, V _{IA} ≤ 0.15 V	1.65 V to 3.6 V	2.3 V to 5.5 V				0.4		V
I _I	OE		1.65 V to 5.5 V	1.65 V to 5.5 V			±1		±2	μA
I _{off}	A port		0 V	0 to 5.5 V			±1		±2	μA
	B port		0 to 3.6 V	0 V			±1		±2	μA
I _{OZ}	A or B port		1.65 V to 5.5 V	2.3 V to 5.5 V			±1		±2	μA
I _{CCA}	V _I = V _O = open, I _O = 0		1.65 V to V _{CCB}	2.3 V to 5.5 V					2.4	μA
			3.6 V	0 V					2.2	
			0 V	5.5 V					–1	
I _{CCB}	V _I = V _O = open, I _O = 0		1.65 V to V _{CCB}	2.3 V to 5.5 V					12	μA
			3.6 V	0 V					–1	
			0 V	5.5 V					1	
I _{CCA} + I _{CCB}		V _I = V _{CCI} or GND, I _O = 0	1.65 V to V _{CCB}	2.3 V to 5.5 V					14.4	μA
C _I	OE		3.3 V	3.3 V			2.5		3.5	pF
C _{IO}	A or B port		3.3 V	3.3 V			10			pF
	A port						5		6	
	B port						6		7.5	

- (1) V_{CCI} is the V_{CC} associated with the input port.
- (2) V_{CCO} is the V_{CC} associated with the output port.
- (3) V_{CCA} must be less than or equal to V_{CCB}, and V_{CCA} must not exceed 3.6 V.

Timing Requirements

over recommended operating free-air temperature range, V_{CCA} = 1.8 V ± 0.15 V (unless otherwise noted)

				V _{CCB} = 2.5 V ± 0.2 V		V _{CC} = 3.3 V ± 0.3 V		V _{CC} = 5 V ± 0.5 V		UNIT
				MIN	MAX	MIN	MAX	MIN	MAX	
Data rate	Push-pull driving			21		22		24		Mbps
	Open-drain driving			1		1		1		
t _w	Pulse duration	Data inputs	Push-pull driving	47		45		41		ns
			Open-drain driving	500		500		500		

Timing Requirements

over recommended operating free-air temperature range, V_{CCA} = 2.5 V ± 0.2 V (unless otherwise noted)

				V _{CCB} = 2.5 V ± 0.2 V		V _{CC} = 3.3 V ± 0.3 V		V _{CC} = 5 V ± 0.5 V		UNIT
				MIN	MAX	MIN	MAX	MIN	MAX	
Data rate	Push-pull driving			20		22		24		Mbps
	Open-drain driving			1		1		1		
t _w	Pulse duration	Data inputs	Push-pull driving	50		45		41		ns
			Open-drain driving	500		500		500		

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Timing Requirements

over recommended operating free-air temperature range, $V_{CCA} = 3\text{ V} \pm 0.3\text{ V}$ (unless otherwise noted)

		$V_{CC} = 3.3\text{ V} \pm 0.3\text{ V}$		$V_{CC} = 5\text{ V} \pm 0.5\text{ V}$		UNIT
		MIN	MAX	MIN	MAX	
Data rate	Push-pull driving	23		24		Mbps
	Open-drain driving	1		1		
t_w Pulse duration	Push-pull driving	43		41		ns
	Open-drain driving	500		500		

Switching Characteristics

over recommended operating free-air temperature range, $V_{CCA} = 1.8\text{ V} \pm 0.15\text{ V}$ (unless otherwise noted)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	$V_{CCB} = 2.5\text{ V} \pm 0.2\text{ V}$		$V_{CCB} = 3.3\text{ V} \pm 0.3\text{ V}$		$V_{CCB} = 5\text{ V} \pm 0.5\text{ V}$		UNIT
				MIN	MAX	MIN	MAX	MIN	MAX	
t_{PHL}	A	B	Push-pull driving	5.3		5.4		6.8		ns
			Open-drain driving	2.3	8.8	2.4	9.6	2.6	10	
t_{PLH}			Push-pull driving	6.8		7.1		7.5		
			Open-drain driving	45	260	36	208	27	198	
t_{PHL}	B	A	Push-pull driving	4.4		4.5		4.7		ns
			Open-drain driving	1.9	5.3	1.1	4.4	1.2	4	
t_{PLH}			Push-pull driving	5.3		4.5		0.5		
			Open-drain driving	45	175	36	140	27	102	
t_{en}	OE	A or B	200		200		200		ns	
t_{dis}	OE	A or B	50		40		35		ns	
t_{rA}	A-port rise time		Push-pull driving	3.2	9.5	2.3	9.3	2	7.6	ns
			Open-drain driving	38	165	30	132	22	95	
t_{rB}	B-port rise time		Push-pull driving	4	10.8	2.7	9.1	2.7	7.6	ns
			Open-drain driving	34	145	23	106	10	58	
t_{fA}	A-port fall time		Push-pull driving	2	5.9	1.9	6	1.7	13.3	ns
			Open-drain driving	4.4	6.9	4.3	6.4	4.2	6.1	
t_{fB}	B-port fall time		Push-pull driving	2.9	13.8	2.8	16.2	2.8	16.2	ns
			Open-drain driving	6.9	13.8	7.5	16.2	7	16.2	
$t_{SK(O)}$	Channel-to-channel skew		0.7		0.7		0.7		ns	
Max data rate			Push-pull driving	21		22		24		Mbps
			Open-drain driving	1		1		1		

Switching Characteristics

 over recommended operating free-air temperature range, $V_{CCA} = 2.5 \text{ V} \pm 0.2 \text{ V}$ (unless otherwise noted)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	$V_{CCB} = 2.5 \text{ V}$ $\pm 0.2 \text{ V}$		$V_{CCB} = 3.3 \text{ V}$ $\pm 0.3 \text{ V}$		$V_{CCB} = 5 \text{ V}$ $\pm 0.5 \text{ V}$		UNIT
				MIN	MAX	MIN	MAX	MIN	MAX	
t_{PHL}	A	B	Push-pull driving		3.2		3.7		3.8	ns
			Open-drain driving	1.7	6.3	2	6	2.1	5.8	
t_{PLH}			Push-pull driving		3.5		4.1		4.4	
			Open-drain driving	43	250	36	206	27	190	
t_{PHL}	B	A	Push-pull driving		3		3.6		4.3	ns
			Open-drain driving	1.8	4.7	2.6	4.2	1.2	4	
t_{PLH}			Push-pull driving		2.5		1.6		1	
			Open-drain driving	44	170	37	140	27	103	
t_{en}	OE	A or B		200		200		200	ns	
t_{dis}	OE	A or B		50		40		35	ns	
t_{rA}	A-port rise time		Push-pull driving	2.8	7.4	2.6	6.6	1.8	5.6	ns
			Open-drain driving	34	149	28	121	24	89	
t_{rB}	B-port rise time		Push-pull driving	3.2	8.3	2.9	7.2	2.4	6.1	ns
			Open-drain driving	35	151	24	112	12	64	
t_{fA}	A-port fall time		Push-pull driving	1.9	5.7	1.9	5.5	1.8	5.3	ns
			Open-drain driving	4.4	6.9	4.3	6.2	4.2	5.8	
t_{fB}	B-port fall time		Push-pull driving	2.2	7.8	2.4	6.7	2.6	6.6	ns
			Open-drain driving	5.1	8.8	5.4	9.4	5.4	10.4	
$t_{SK(O)}$	Channel-to-channel skew			0.7		0.7		0.7	ns	
Max data rate			Push-pull driving	20		22		24	Mbps	
			Open-drain driving	1		1		1		

TXS0102

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Switching Characteristics

over recommended operating free-air temperature range, $V_{CCA} = 3.3 \text{ V} \pm 0.3 \text{ V}$ (unless otherwise noted)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	$V_{CCB} = 3.3 \text{ V} \pm 0.3 \text{ V}$		$V_{CCB} = 5 \text{ V} \pm 0.5 \text{ V}$		UNIT
				MIN	MAX	MIN	MAX	
t_{PHL}	A	B	Push-pull driving		2.4		3.1	ns
			Open-drain driving	1.3	4.2	1.4	4.6	
t_{PLH}			Push-pull driving		4.2		4.4	
			Open-drain driving	36	204	28	165	
t_{PHL}	B	A	Push-pull driving		2.5		3.3	ns
			Open-drain driving	1	124	1	97	
t_{PLH}			Push-pull driving		2.5		2.6	
			Open-drain driving	3	139	3	105	
t_{en}	OE	A or B		200		200	ns	
t_{dis}	OE	A or B		40		35	ns	
t_{rA}	A-port rise time		Push-pull driving	2.3	5.6	1.9	4.8	ns
			Open-drain driving	25	116	19	85	
t_{rB}	B-port rise time		Push-pull driving	2.5	6.4	2.1	7.4	ns
			Open-drain driving	26	116	14	72	
t_{fA}	A-port fall time		Push-pull driving	2	5.4	1.9	5	ns
			Open-drain driving	4.3	6.1	4.2	5.7	
t_{fB}	B-port fall time		Push-pull driving	2.3	7.4	2.4	7.6	ns
			Open-drain driving	5	7.6	4.8	8.3	
$t_{SK(O)}$	Channel-to-channel skew			0.7		0.7	ns	
Max data rate			Push-pull driving	23		24	Mbps	
			Open-drain driving	1		1		

PRINCIPLES OF OPERATION

Applications

The TXS0102 can be used in level-translation applications for interfacing devices or systems operating at different interface voltages with one another. The TXS0102 is ideal for use in applications where an open-drain driver is connected to the data I/Os. The TXS0102 can also be used in applications where a push-pull driver is connected to the data I/Os, but the TXB0102 might be a better option for such push-pull applications.

Architecture

The TXS0102 architecture (see [Figure 1](#)) does not require a direction-control signal to control the direction of data flow from A to B or from B to A.

PRINCIPLES OF OPERATION (continued)

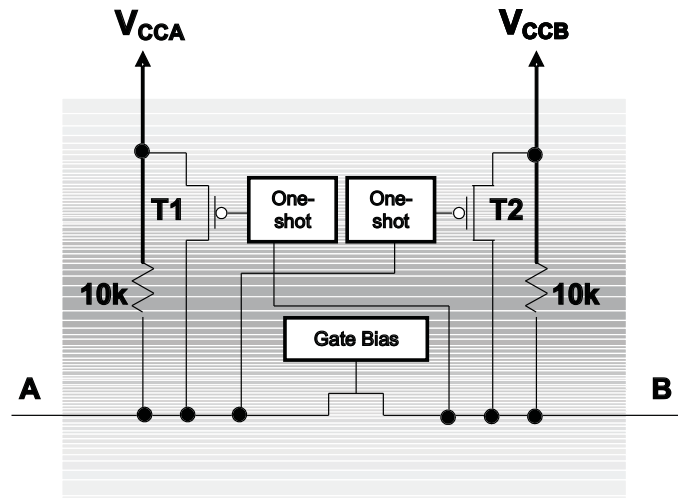


Figure 1. Architecture of a TXS01xx Cell

Each A-port I/O has an internal 10-k Ω pullup resistor to V_{CCA} , and each B-port I/O has an internal 10-k Ω pullup resistor to V_{CCB} . The output one-shots detect rising edges on the A or B ports. During a rising edge, the one-shot turns on the PMOS transistors (T1,T2) for a short duration, which speeds up the low-to-high transition.

Input Driver Requirements

The fall time (t_{fA} , t_{fB}) of a signal depends on the output impedance of the external device driving the data I/Os of the TXS0102. Similarly, the t_{pHL} and max data rates also depend on the output impedance of the external driver. The values for t_{fA} , t_{fB} , t_{pHL} , and maximum data rates in the data sheet assume that the output impedance of the external driver is less than 50 Ω .

Power Up

During operation, ensure that $V_{CCA} \leq V_{CCB}$ at all times. During power-up sequencing, $V_{CCA} \geq V_{CCB}$ does not damage the device, so any power supply can be ramped up first.

Enable and Disable

The TXS0102 has an OE input that is used to disable the device by setting OE low, which places all I/Os in the Hi-Z state. The disable time (t_{dis}) indicates the delay between the time when OE goes low and when the outputs actually get disabled (Hi-Z). The enable time (t_{en}) indicates the amount of time the user must allow for the one-shot circuitry to become operational after OE is taken high.

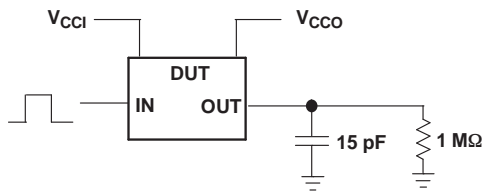
Pullup or Pulldown Resistors on I/O Lines

Each A-port I/O has an internal 10-k Ω pullup resistor to V_{CCA} , and each B-port I/O has an internal 10-k Ω pullup resistor to V_{CCB} . If a smaller value of pullup resistor is required, an external resistor must be added from the I/O to V_{CCA} or V_{CCB} (in parallel with the internal 10-k Ω resistors).

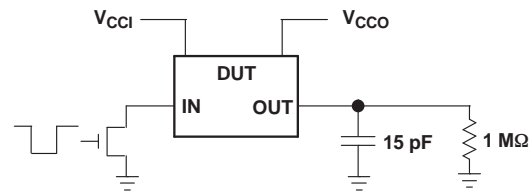
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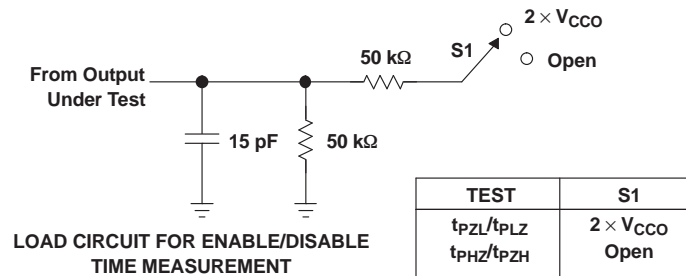
PARAMETER MEASUREMENT INFORMATION



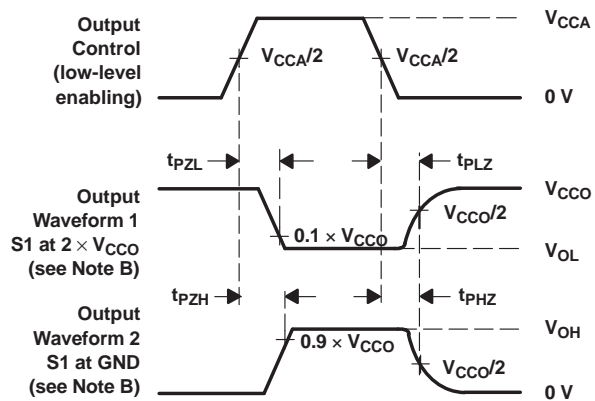
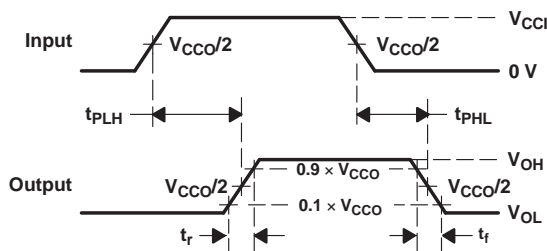
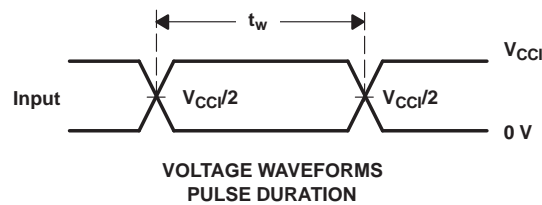
DATA RATE, PULSE DURATION, PROPAGATION DELAY, OUTPUT RISE AND FALL TIME MEASUREMENT USING A PUSH-PULL DRIVER



DATA RATE, PULSE DURATION, PROPAGATION DELAY, OUTPUT RISE AND FALL TIME MEASUREMENT USING AN OPEN-DRAIN DRIVER



LOAD CIRCUIT FOR ENABLE/DISABLE TIME MEASUREMENT



- NOTES:
- A. C_L includes probe and jig capacitance.
 - B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
 - C. All input pulses are supplied by generators having the following characteristics: $PRR \leq 10$ MHz, $Z_O = 50 \Omega$, $dv/dt \geq 1$ V/ns.
 - D. The outputs are measured one at a time, with one transition per measurement.
 - E. t_{PLZ} and t_{PHZ} are the same as t_{dis} .
 - F. t_{PZL} and t_{PZH} are the same as t_{en} .
 - G. t_{PLH} and t_{PHL} are the same as t_{pd} .
 - H. V_{CCI} is the V_{CC} associated with the input port.
 - I. V_{CCO} is the V_{CC} associated with the output port.
 - J. All parameters and waveforms are not applicable to all devices.

Figure 2. Load Circuit and Voltage Waveforms

PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
TXS0102DCUR	ACTIVE	US8	DCU	8	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSELETE: TI has discontinued the production of the device.

⁽²⁾ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

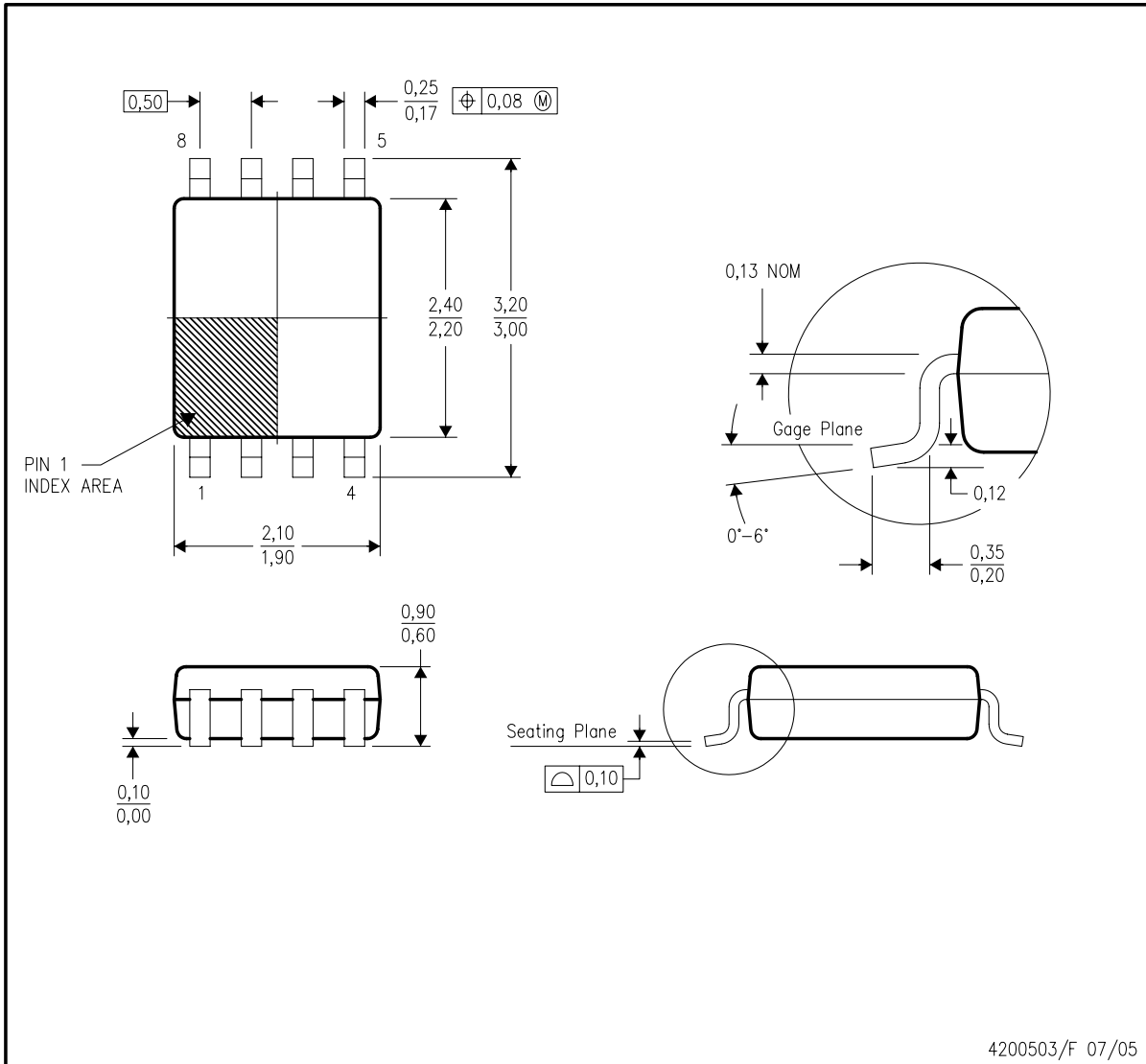
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MECHANICAL DATA

DCU (R-PDSO-G8)

PLASTIC SMALL-OUTLINE PACKAGE (DIE DOWN)



- NOTES:
- A. All linear dimensions are in millimeters.
 - B. This drawing is subject to change without notice.
 - C. Body dimensions do not include mold flash or protrusion. Mold flash and protrusion shall not exceed 0.15 per side.
 - D. Falls within JEDEC MO-187 variation CA.

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